

# CMOS 32-BIT SINGLE CHIP MICROCOMPUTER S1C33S01 S1C33S01 PRODUCT PART S1C33S01 FUNCTION PART



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# S1C33S01 Technical Manual

This manual describes the hardware specifications of the Seiko Epson original 32-bit microcomputer S1C33S01.

## S1C33S01 PRODUCT PART

Describes the hardware specifications of the S1C33S01 except for details of the peripheral circuits.

### S1C33S01 FUNCTION PART

Describes details of all the peripheral circuit blocks for the S1C33 Family microcomputers.

Refer to the "S1C33000 Core CPU Manual" for details of the S1C33000 32-bit RISC CPU .

## New configuration of product number

Starting April 1, 2001, the configuration of product number descriptions will be changed as listed below. To order from April 1, 2001 please use these product numbers. For further information, please contact Epson sales representative.



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# S1C33S01 PRODUCT PART

# 1 Outline

The S1C33S01 is a Seiko Epson original 32-bit microcomputer. It features high speed, low power consumption, and low-voltage operation, and is ideal for portable products that require high-speed data processing. The S1C33S01 consists of an S1C33000 32-bit RISC type CPU as its core, peripheral circuits including a bus control unit, interrupt controller, timers, and serial interface, and also RAM. A high-speed oscillation circuit and PLL, and a low-speed clock input circuit, are also included, supporting high-speed operation, power-saving operation, and high-speed realtime clock functions. Use of the internal MAC (multiplication and accumulation) function also facilitates the design of systems requiring DSP functions, such as voice synthesis applications.

# 1.1 Features

## Core CPU

Seiko Epson original 32-bit RISC CPU S1C33000 built-in

- Basic instruction set: 105 instructions (16-bit fixed size)
- Sixteen 32-bit general-purpose register
- 32-bit ALU and 8-bit shifter
- Multiplication/division instructions and MAC (multiplication and accumulation) instruction are available
- 20 ns of minimum instruction execution time at 50 MHz operation

### Internal memory

RAM: 8K bytes

#### Internal peripheral circuits

Oscillation circuit:	High-speed (OSC3) oscillation circuit 33 MHz max.				
	Crystal/ceramic oscillator or external clock input				
	Low-speed (OSC1) oscillation circuit 32.768 kHz typ.				
	Crystal osci	llator or externa	l clock input		
Timers:	8-bit timer	4 channels			
	16-bit timer	6 channels			
	Watchdog timer	(16-bit timer 0	's function)		
	Clock timer	1 channel (wit	h alarm function)		
Serial interface:	2 channels (clock-synchronous system, asynchronous system and IrI				
	interface are selectabl	le)			
Interrupt controller:	Input interrupt		10 types (programmable)		
	16-bit programmable	timer interrupt	12 types		
	8-bit programmable t	imer interrupt	4 types		
	6 types				
	Clock timer interrupt 1				
General-purpose input	Shared with address bus and peripheral circuit I/O pins				
and output ports:	I/O port 29 bits				

## External bus interface

BCU (bus control unit) built-in

- 24-bit address bus (internal 28-bit processing) Upper 4 bits shared with I/O port pins
- 16-bit data bus
- Data size is selectable from 8 bits and 16 bits in each area.
- Little-endian memory access; big-endian may be set in each area.
- Memory mapped I/O
- Chip enable and wait control circuits built-in
- DRAM direct interface function built-in Supports fast page mode and EDO page mode. Supports self-refresh and CAS-before RAS refresh.
- Supports burst ROM.

#### 1 OUTLINE

## Operating conditions and power consumption

-	-	
Operating voltage:	Core (VDD)	1.8 V to 3.6 V
Operating clock frequency:	CPU	50 MHz max. (when core voltage = $3.3 \text{ V} \pm 0.3 \text{ V}$ )
Operating temperature:	-40 to 85°C	
Power consumption:	During SLEEP	4 μW typ.
	During HALT	100 mW typ.
		(3.3 V, 50 MHz)
	During execution	195 mW typ.
		(3.3 V. 50 MHz)

Note: • The values of power consumption during execution were measured when a test program that consisted of 55% load instructions, 23% arithmetic operation instructions, 1% mac instruction, 12% branch instructions and 9% ext instruction was being continuously executed.

## Supply form

QFP15-100pin plastic package

# 1.2 Block Diagram



Figure 1.2.1 S1C33S01 Block Diagram

# 1.3.1 Pin Layout Diagram (plastic package)

## QFP15-100pin



No.	Pin name	No.	Pin name	No.	Pin name	No.	Pin name
1	#WRL/#WR/#WE	26	A0/#BSL	51	A21/P34/#BUSREQ	76	P14/FOSC1/DCLK
2	#WRH/#BSH	27	A1	52	A22/P35/#BUSACK	77	P13/EXCL3/T8UF3/DPCO
3	#RD	28	A2	53	#CE9/P32	78	P12/EXCL2/T8UF2/DST2
4	#EMEMRD	29	A3	54	A23/P07/#SRDY1	79	P11/EXCL1/T8UF1/DST1
5	#LCAS	30	Vdd	55	P06/#SCLK1	80	P10/EXCL0/T8UF0/DST0
6	#HCAS	31	A4	56	P05/SOUT1	81	PLLS0
7	Vss	32	A5	57	P04/SIN1	82	PLLS1
8	D0	33	A6	58	Vss	83	PLLC
9	D1	34	A7	59	OSC1	84	Vss
10	D2	35	Vss	60	OSC2	85	#X2SPD
11	D3	36	A8	61	Vdd	86	OSC3
12	D4	37	A9	62	#RESET	87	OSC4
13	D5	38	A10	63	#NMI	88	ICEMD
14	Vdd	39	A11	64	EA10MD0	89	#CE10EX
15	D6	40	Vdd	65	EA10MD1	90	#CE10IN
16	D7	41	A12	66	Vss	91	Vdd
17	D8	42	A13	67	#CE8/P31/#BUSGET/#GARD	92	BCLK
18	D9	43	A14	68	P30/#WAIT	93	#CE6/P20/#DRD
19	D10	44	A15	69	P03/#SRDY0	94	#CE7/P21/#DWE/#GAAS
20	D11	45	Vss	70	P02/SCLK0	95	P22/TM0
21	Vss	46	A16	71	P01/SOUT0	96	P23/TM1
22	D12	47	A17	72	P00/SIN0	97	P24/TM2
23	D13	48	A18	73	#CE5/P16/EXCL5	98	P25/TM3
24	D14	49	A19	74	#CE4/P15/EXCL4	99	P26/TM4
25	D15	50	A20/P33	75	DSIO	100	P27/TM5

Figure 1.3.1 Pin Layout Diagram (QFP15-100pin)

# 1.3.2 Pin Functions

Pin name	Pin No.	I/O	Pull-up	Function
Vdd	14, 30, 40,	1	-	Power supply (+)
	61, 91			
Vss	7, 21, 35, 45,	-	-	Power supply (-); GND
	58, 66, 84			

Table 1.3.2 List of Pins for External Bus Interface Signals

Table 1.3.1	List of Pins for Power Supply System

Pin name	Pin No.	I/O	Pull-up	Function	
A0	26	0	-	A0: Address bus (A0) when SBUSST (D3/0x4812E) = "0" (default)	
#BSL				#BSL: Bus strobe (low byte) signal when SBUSST (D3/0x4812E) = "1"	
A[19:1]	27–29, 31–34, 36–39, 41–44, 46–49	0	-	Address bus (A1 to A19)	
A23 P07 #SRDY	54	I/O	_	A23: Address bus (A23) when CFA23 (D7/0x40300) = "0" (default) P07: I/O port when CFA23 (D7/0x40300) = "1" and CFP07 (D7/0x402D0) = "0" #SRDY: Serial I/F Ch. 1 ready signal input/output/when CFA23 (D7/0x40300) = "1" and CFP07 (D7/0x402D0) = "1"	
A22 P35 #BUSACK	52	I/O	-	A22: Address bus (A22) when CFA22 (D6/0x40300) = "0" (default) P35: I/O port when CFA22 (D6/0x40300) = "1" and CFP35 (D5/0x02DC) = "0" #BUSACK: Bus acknowledge output when CFA22 (D6/0x40300) = "1" and CFP35 (D5/0x02DC) = "1"	
A21 P34 #BUSREQ #CE6	51	I/O	-	A21: Address bus (A21) when CFA21 (D5/0x40300) = "0" (default) P34: I/O port when CFA21 (D5/0x40300) = "1" and CFP34 (D4/0x402DC) = "0" #BUSREQ: Bus release request input when CFA21 (D5/0x40300) = "1", CFP34 (D4/0x402DC) = "1", and IOC34 (D4/0x402DE) = "0" #CE6: Area 6 chip enable when CFA21 (D5/0x40300) = "1", CFP34 (D4/0x402DC) = "1", and IOC34 (D4/0x402DE) = "1"	
A20	50	I/O	-	A20: Address bus (A20) when CFA20 (D5/0x40300) = "0" (default)	
D[15:0]	8–13, 15–20, 21–25	I/O	-	Data bus (D0 to D15)	
#CE10EX	89	0	-	Area 10 chip enable for external memory	
#CE10IN	90	0	_	Area 10 chip enable for internal ROM emulation	
#CE9 P32	53	I/O	-	#CE9: Area 9 chip enable when CFCE9 (D5/0x40301) = "0" (default) * Output can be changed to #CE17, #CE9+#CE10 by CEFUNC[1:0] (D[A:9]/0x48130) P32: I/O port when CECE9 (D5/0x40301) = "1"	
#CE8 P31 #BUSGET	67	I/O	-	#CE8: Area 8 chip enable when CFCE8 (D4/0x40301) = "0" (default) * Output can be changed to #RAS1, #CE14, #RAS3 by CEFUNC[1:0] (D[A:9]/0x48130), A8DRA (D8/0x48128), and A14DRA (D8/0x48122)	
#GARD				P31: I/O port when CFCE8 (D4/0x40301) = "1", CFP31 (D1/0x402DC) = "0", and CFEX3 (D3/0x402DF) = "0"	
				<pre>#BUSGET: Bus status monitor signal output when CFCE8 (D4/0x40301) = "1", CFP31 (D1/0x402DC) = "1", and CFEX3 (D3/0x402DF) = "0"</pre>	
				#GARD: Area read signal output for GA when CFCE8 (D4/0x40301) = "1" and CFEX3 (D3/0x402DF) = "1"	

Pin name	Pin No.	I/O	Pull-up		Function
#CE7	94	I/O	-	#CE7:	Area 7 chip enable when CFCE7 (D3/0x40301) = "0" (default)
P21					* Output can be changed to #RAS0, #CE13, #RAS2 by CEFUNC[1:0]
#DWE					(D[A:9]/0x48130), A7DRA (D7/0x48128), and A13DRA (D7/0x48122)
#GAAS				P21:	I/O port when CFCE7 (D3/0x40301) = "1", CFP21 (D1/0x402D8) = "0", and
					CFEX2 (D2/0x402DF) = "0"
				#DWE:	DRAM write signal output for successive RAS mode when CFCE7
					(D3/0x40301) = "1", CFP21 (D1/0x402D8) = "1", and CFEX2(D2/0x402DF) =
					"0"
				#GAAS:	Area address strobe output for GA when CFCE7 (D3/0x40301) = "1" and
					CFEX2 (D2/0x402DF) = "1"
#CE6	93	I/O	-	#CE6:	Area 6 chip enable when CFCE6 (D2/0x40301) = "0" (default)
P20				Dee	* Output can be changed to #CE7+#CE8 by CEFUNC[1:0] (D[A:9]/0x48130)
#DRD				P20:	I/O port when CFCE6 $(D2/0x40301) = "1"$ and CFP20 $(D0/0x402D8) = "0"$
				#DRD:	DRAM read signal output for successive RAS mode when CFCE6
#0FF	70	1/0		#OF5.	(D2/0X40301) = 1 and CFP20 $(D0/0X402D8) = 1$
#CE5	73	1/0	-	#CE5:	Area 5 chip enable when CFCE5 $(D1/0X40301) = 0^{\circ}$ (default)
					* Output can be changed to #CE15, #CE15+#CE16 by CEFONC[1.0]
LAGES				P16.	(D[A, 9]/0x40130) I/O port when CECE5 (D1/0x40301) - "1" and CEP16 (D6/0x402D4) - "0"
				EXCL5	16-bit timer 5 event counter input when CECE5 $(D1/0x40301) = "1"$ CEP16
				L/IOLO.	(D6/0x402D4) = "1", and $IOC16 (D6/0x402D6) = "0"$
#CE4	74	I/O	_	#CE4:	Area 4 chip enable when CFCE4 (D0/0x40301) = "0" (default)
P15					* Output can be changed to #CE11. #CE11+#CE12 by CEFUNC[1:0]
EXCL4					(D[A:9]/0x48130)
				P15:	I/O port when CFCE4 (D0/0x40301) = "1" and CFP15 (D5/0x402D4) = "0"
				EXCL4:	16-bit timer 4 event counter input when CFCE4 (D0/0x40301) = "1", CFP15
					(D5/0x402D4) = "1", and IOC15 (D5/0x402D6) = "0"
#RD	3	0	-	Read signa	al
#EMEMRD	4	0	-	Read signa	al for internal ROM emulation memory
#WRL	1	0	-	#WRL:	Write (low byte) signal when SBUSST (D3/0x4812E) = "0" (default)
#WR				#WR:	Write signal when SBUSST (D3/0x4812E) = "1"
#WE				#WE:	DRAM write signal
#WRH	2	0	-	#WRH:	Write (high byte) signal when SBUSST (D3/0x4812E) = "0" (default)
#BSH				#BSH:	Bus strobe (high byte) signal when SBUSST (D3/0x4812E) = "1"
#HCAS	6	0	-	#HCAS:	DRAM column address strobe (high byte) signal
#LCAS	5	0	-	#LCAS:	DRAM column address strobe (low byte) signal
BCLK	92	0	-	Bus clock of	butput
P30	68	I/O	-	P30:	I/O port when CFP30 (D0/0x402DC) = "0" (default)
#WAIT				#WAIT:	Wait cycle request input when CFP30 (D0/0x402DC) = "1"
#CE4&5				#CE4&5:	Areas 4&5 chip enable when CFP30 (D0/0x402DC) = "1" and IOC30 $(D0/0x402DC) = "4"$
#0F0	07	1/0		#OF0:	$(D0/0X403DE) = 1^{-1}$
#CE8	67	1/0	-	#CE8:	Area 8 chip enable when CFCE8 (D4/0x40301) = $"0"$ (default)
P31 #DUCCET					* Output can be changed to #RAS1, #CE14, #RAS3 by CEFUNC[1:0]
#GARD				D31.	(D[A, 9]/0x40130), AODRA $(D0/0x40120)$ , and A14DRA $(D0/0x40122)$
#OARD				1 51.	CEEX3 (D3/0x402DE) = "0"
				#BUSGET	Bus status monitor signal output when CECE8 $(D4/0x40301) = "1"$ CEP31
					(D1/0x402DC) = "1", and CFEX3 (D3/0x402DF) = "0"
				#GARD:	Area read signal output for GA when CFCE8 (D4/0x40301) = "1" and CFEX3
					(D3/0x402DF) = "1"
#CE9	53	I/O	-	#CE9:	Area 9 chip enable when CFCE9 (D5/0x40301) = "0" (default)
P32					* Output can be changed to #CE17, #CE9+#CE10 by CEFUNC[1:0]
					(D[A:9]/0x48130)
		L		P32:	I/O port when CFCE9 (D5/0x40301) = "1"
A20	50	I/O	-	A20:	Address bus (A20) when CFA20 (D5/0x40300) = "0" (default)
P33		I	1	P33:	I/O port when CFA20 (D5/0x40300) = "1"

Pin name	Pin No.	I/O	Pull-up	Function				
A21	51	I/O	-	A21: Address bus (A21) when CFA21 (D5/0x40300) = "0" (default)				
P34				<sup>2</sup> 34: I/O port when CFA21 (D5/0x40300) = "1" and CFP34 (D4/0x402DC) = "0"				
#BUSREQ				#BUSREQ: Bus release request input when CFA21 (D5/0x40300) = "1", CFP34				
#CE6				(D4/0x402DC) = "1", and IOC34 (D4/0x402DE) = "0"				
				#CE6: Area 6 chip enable when CFA21 (D5/0x40300) = "1", CFP34 (D4/0x402DC)				
				= "1", and IOC34 (D4/0x402DE) = "1"				
A22	52	I/O	-	A22: Address bus (A22) when CFA22 (D6/0x40300) = "0" (default)				
P35				P35: I/O port when CFA22 (D6/0x40300) = "1" and CFP35 (D5/0x02DC) = "0"				
#BUSACK				#BUSACK: Bus acknowledge output when CFA22 (D6/0x40300) = "1" and CFP35				
				(D5/0x02DC) = "1"				

Pin name	Pin No.	I/O	Pull-up	Function								
OSC1	59	1	-	Low-speed (OSC1) oscillation input (32 kHz crystal oscillator or external clock input)								
OSC2	60	0	-	Low-speed (OS	Low-speed (OSC1) oscillation output							
OSC3	86	- I	-	High-speed (O	SC3) oscill	ation input (crystal/	ceramic oscillat	or or external clock input)				
OSC4	87	0	1	High-speed (O	SC3) oscill	ation output						
PLLS[1:0]	82, 81	I	_	PLL set-up pins 1 1 0 0	9 PLLS0 1 0 1 0	fin (fosc3) 10–25MHz – 10–12.5MHz PLL is not used	fout (fpscin) 20–50MHz – 40–50MHz –					
PLLC	83	I/O	_	Capacitor conn	Capacitor connecting pin for PL							

Table 1.3.3	List of Pins for Clock Generator

Table 1.3.4	List of Other Pins
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Pin name	Pin No.	I/O	Pull-up	Function					
ICEMD	88	Ι	Pull-down	ligh-impedance control input pin					
				Ahen this pin is set to High, all the output pins go to the high-impedance state. This nables the S1C33 chip on the board to be isolated from the system.					
DSIO	75	I/O	Pull-up	erial I/O pin for debugging his pin is used to communicate with th	e debugging tool S5U1C33000H.				
#X2SPD	85	-	-	lock doubling mode set-up pin : CPU clock = bus clock × 1, 0: CPU c	lock = bus clock × 2				
#NMI	63	Т	Pull-up	NMI request input pin					
#RESET	62	Ι	Pull-up	nitial reset input pin					
EA10MD1	65	I	Pull-up	rea 10 boot mode selection					
EA10MD0	64	Ι	-	EA10MD1 EA10MD0	Mode				
				1 1 Externa	al ROM mode				
				1 0 Interna	ROM mode				
				0 1 -					
				0 0 Interna	ROM emulation mode				

Note: "#" in the pin names indicates that the signal is low active.

# 2 Power Supply

This chapter explains the operating voltage of the S1C33S01.

# 2.1 Power Supply Pins

The S1C33S01 has the power supply pins shown in Table 2.1.1.

	Table 2.1.1 Power Supply Pins										
Pin name	Pin No.	Function									
Vdd	14, 30, 40, 61, 91	Power supply (+) for the internal logic									
Vss	7, 21, 35, 45, 58, 66, 84	Power supply (-); GND									



Figure 2.1.1 Power Supply System

# 2.2 Operating Voltage (VDD, Vss)

The core CPU and internal peripheral circuits of the S1C33S01 operate with a voltage supplied between the VDD and VSS pins. The following operating voltage can be used:

VDD = 1.8 V to 3.6 V (Vss = GND)

**Note:** The S1C33S01 has 5 VDD pins and 7 Vss pins. Be sure to supply the operating voltage to all the pins. Do not open any of them.

The operating clock frequency range (OSC3) is 5 MHz to 50 MHz with this voltage.

# 3 Internal Memory

This chapter explains the internal memory configuration.

Figure 3.1 shows the S1C33S01 memory map.

Area	Address		Bus cycle	Device size
Area 3	0x00FFFFF			
		(December 1)		
		(Reserved)		
		T OF INIGAIC WATC USC		
	0x0080000			
Area 2	0x007FFFF		3 cycles fixed	16 bits
		(Reserved)		
		For CPU, debug mode		
	00060000			
A == = . 4	020060000		O evelas fived	0 an 40 hita
Area	0x005FFFF	(Mirror of internal 1/0)	2 cycles fixed	8 OF 16 DItS
	0~0050000			
	0x0030000			
	020047777	Internal I/O		
	0x0040000			
	0x003FFFF			
	0x0030000	(Mirror of internal I/O)		
Area 0	0x0002FFF		1 cycle fixed	32 bits
	0x0002000	(Mirror of internal RAM)		
	0x0001FFF			
	0x0001000			
	0x0000FFF	Internal RAM (8KP)		
	0x0000800			
	0x00007FF			
	0x0000000			

Figure 3.1 Memory Map

Area 2 is used in debug mode only and it cannot be accessed in user mode (normal program execution status).

# 3.1 ROM and Boot Address

The S1C33S01 does not have a built-in ROM.

In the S1C33S01 the boot address is fixed at 0x0C00000, and so external ROM/Flash should be used in Area 10. For setting up Area 10, refer to the "BCU (Bus Controller Unit)" section in the "S1C33S01 FUNCTION PART".

# 3.2 RAM

The S1C33S01 has a built-in 8KB RAM. The RAM is allocated to Area 0, address 0x0000000 to address 0x0001FFF.

The internal RAM is a 32-bit sized device and data can be read/written in 1 cycle regardless of data size (byte, half-word or word).

# **4** Peripheral Circuits

This chapter lists the built-in peripheral circuits and the I/O memory map. For details of the circuits, refer to the "S1C33S01 FUNCTION PART".

# 4.1 List of Peripheral Circuits

The S1C33S01 consists of the C33 ASIC Macro Blocks: C33 Core Block, and C33 Peripheral Block.

C33 Core Block	
CPU	S1C33000 32-bit RISC type CPU
BCU (Bus Control Unit)	24-bit external address bus and 16-bit data bus
	All the BCU functions can be used.
ITC (Interrupt Controller)	33 types of interrupts are available.
CLG (Clock Generator)	OSC3 oscillation circuit (33 MHz Max.), PLL and OSC1 oscillation circuit
	(32.768 kHz Typ.) built-in
DBG (Debug Unit)	Functional block for debugging with the ICD33 (In-Circuit Debugger for S1C33
	Family)
C33 Peripheral Block	
Prescaler	Programmable clock generator for peripheral circuits
8-bit programmable timer	4 channels with clock output function
16-bit programmable timer	6 channels with event counter, clock output and watchdog timer functions
Serial interface	2 channels (asynchronous mode, clock synchronous mode and IrDA are
	selectable.)
Input and I/O ports	29 bits of I/O ports (used for peripheral I/O)
Clock timer	1 channel with alarm function

# 4.2 I/O Memory Map

Register name	Address	Bit	Name	Function	Setting		Init.	R/W	Remarks
0 bit timer	0040440		Nume		000	ung		10,11	
8-bit timer	0040146 (P)	D7-4	-	R bit timer 2 clock coloction	-	- Divided elk	-	- D///	0 when being read.
CIOCK Select	(6)	D3	POTPCK3	0-bit times 2 clock selection	1 0/1	0 Divided cik.	0		0. Selected by
register		D2 D1	POTPCK2	8 bit timer 1 clock selection	1 0/1	0 Divided cik.	0		rogistor (0x40181)
			POTPCKO	8 bit timer 0 clock selection	1 0/1	0 Divided clk.	0	D/M	
		00	FOIFCRU	S-bit timer o clock selection		U Divided cik.		R/W	
16-bit timer 0	0040147	D7-4	-	reserved	-	-	-	-	0 when being read.
Clock control	(B)	D3	P16TON0	16-bit timer 0 clock control			0	R/W	0
register		D2	P161502	16-bit timer 0	P161S0[2:0]	Division ratio	0	R/W	e: selected by
		D1	P161501	CIOCK DIVISION RATIO SELECTION		0/4096	0		Prescaler clock select
		DU	P161500			0/1024	0		register (0x40181)
						0/256			10 bit times 0 and ba
						0/64			16-bit timer 0 can be
						0/4			used as a watchdog
						0/2			umer.
						0/1			
						0/1			
16-bit timer 1	0040148	D7-4	-	reserved	-	-	-	-	0 when being read.
clock control	(B)	D3	P16TON1	16-bit timer 1 clock control	1 On	0 Off	0	R/W	
register		D2	P161S12	16-bit timer 1	P161S1[2:0]	Division ratio	0	R/W	0: selected by
		D1	P161S11	clock division ratio selection		0/4096	0		Prescaler clock select
		DO	P161S10			0/1024	0		register (0x40181)
						0/256			
						0/64			
						0/16			
						0/2			
						0/4			
					0 0 0 0	0/1			
16-bit timer 2	0040149	D7-4	-	reserved	-	-	-	-	0 when being read.
clock control	(B)	D3	P16TON2	16-bit timer 2 clock control			0	R/W	
register		D2	P161522	16-bit timer 2	P16152[2:0]	Division ratio	0	R/W	e: selected by
			P101521	CIOCK DIVISION FALLO SELECTION		0/1024	0		Prescaler Clock Select
			F101320			0/256	0		
						0/230			
						0/04 A/16			
						6/10 A/4			
						6/2			
						0/2 0/1			
16-bit timor 3	0040144		_	reserved		0/1			0 when being read
clock control	(B)		P16TON3	16-bit timer 3 clock control	1 On	0.0#	0	R/W	o when being read.
register	(2)	D2	P16TS32	16-bit timer 3	P16TS3[2:0]	Division ratio	0	R/W	A: selected by
i ogioto:		D1	P16TS31	clock division ratio selection		0/4096	Ő		Prescaler clock select
		DO	P16TS30			θ/1024	0		register (0x40181)
					1 0 1	0/256			
					1 0 0	0/64			
					0 1 1	0/16			
					0 1 0	θ/4			
					0 0 1	θ/2			
					0 0 0	θ/1			
16-bit timer 4	004014B	D7–4	-	reserved		_	-	-	0 when being read.
clock control	(B)	D3	P16TON4	16-bit timer 4 clock control	1 On	0 Off	0	R/W	Ŭ
register		D2	P16TS42	16-bit timer 4	P16TS4[2:0]	Division ratio	0	R/W	θ: selected by
_		D1	P16TS41	clock division ratio selection	1 1 1	0/4096	0		Prescaler clock select
		D0	P16TS40		1 1 0	θ/1024	0		register (0x40181)
					1 0 1	θ/256			
					1 0 0	0/64			
					0 1 1	θ/16			
					0 1 0	θ/4			
					0 0 1	θ/2			
			1			θ/1	1		

Table 4.2.1 I/O Memory Map

(B) in [Address] indicates an 8-bit register and (HW) indicates a 16-bit register.

The meaning of the symbols described in [Init.] are listed below:

- 0, 1: Initial values that are set at initial reset.
- (However, the registers for the bus and input/output ports are not initialized at hot start.)
- X: Not initialized at initial reset.
- -: Not set in the circuit.

Register name	Address	Bit	Name	Function			S	etting	Init.	R/W	Remarks
16-bit timer 5	004014C	D7–4	-	reserved				-	-	-	0 when being read.
clock control	(B)	D3	P16TON5	16-bit timer 5 clock control	1 0	n		0 Off	0	R/W	
register		D2	P16TS52	16-bit timer 5	P16T	S5[	[2:0]	Division ratio	0	R/W	θ: selected by
		D1	P16TS51	clock division ratio selection	1	1	1	θ/4096	0		Prescaler clock select
		D0	P16TS50		1	1	0	θ/1024	0		register (0x40181)
					1	0	1	0/256			
					1	0	0	0/64			
					0	1	1	0/16			
					0	1	0	θ/4			
					0	0	1	θ/2			
					0	0	0	θ/1			
8-bit timer 0/1	004014D	D7	P8TON1	8-bit timer 1 clock control	1 0	n		0 Off	0	R/W	
clock control	(B)	D6	P8TS12	8-bit timer 1	P8TS	S1[2	2:0]	Division ratio	0	R/W	θ: selected by
register	. ,	D5	P8TS11	clock division ratio selection	1	1	1	0/4096	0		Prescaler clock select
		D4	P8TS10		1	1	0	0/2048	0		register (0x40181)
					1	0	1	0/1024			Ŭ ( )
					1	0	0	0/512			8-bit timer 1 can
					0	1	1	0/256			generate the OSC3
					0	1	0	0/128			oscillation-stabilize
					0	0	1	0/64			waiting period.
					0	0	0	0/32			01
		D3	P8TON0	8-bit timer 0 clock control	1 0	n		0 Off	0	R/W	
		D2	P8TS02	8-bit timer 0	P8TS	S0[2	2:0]	Division ratio	0	R/W	θ: selected by
		D1	P8TS01	clock division ratio selection	1	1	1	0/256	0		Prescaler clock select
		D0	P8TS00		1	1	0	θ/128	0		register (0x40181)
					1	0	1	0/64			
					1	0	0	0/32			8-bit timer 0 can
					0	1	1	θ/16			generate the DRAM
					0	1	0	θ/8			refresh clock.
					0	0	1	θ/4			
					0	0	0	θ/2			
8-bit timer 2/3	004014E	D7	P8TON3	8-bit timer 3 clock control	1 0	n		0 Off	0	R/W	
clock control	(B)	D6	P8TS32	8-bit timer 3	P8TS	S3[2	2:0]	Division ratio	0	R/W	θ: selected by
register		D5	P8TS31	clock division ratio selection	1	1	1	0/256	0		Prescaler clock select
		D4	P8TS30		1	1	0	θ/128	0		register (0x40181)
					1	0	1	0/64			
					1	0	0	θ/32			8-bit timer 3 can
					0	1	1	θ/16			generate the clock for
					0	1	0	θ/8			the serial I/F Ch.1.
					0	0	1	θ/4			
					0	0	0	θ/2			
		D3	P8TON2	8-bit timer 2 clock control	1 0	n		0 Off	0	R/W	
		D2	P8TS22	8-bit timer 2	P8TS	S2[2	2:0]	Division ratio	0	R/W	θ: selected by
		D1	P8TS21	clock division ratio selection	1	1	1	0/4096	0		Prescaler clock select
		DO	P8TS20			1	0	0/2048	0		register (0x40181)
						0	1	θ/64			
						0	0	0/32			8-bit timer 2 can
						1	1	0/16			generate the clock for
						<u>'</u>	0	6/8			the serial I/F Ch.0.
						U	1	θ/4 0/0			
			L		0	υ	υ	0/2			

Register name	Address	Bit	Name	Function	Setting				1	Init.	R/W	Remarks
Clock timer	0040151	D7-2	-	reserved	Ť			_		_	-	0 when being read.
Run/Stop	(B)	D1	TCRST	Clock timer reset		1	Reset	0	Invalid	Х	W	0 when being read.
register		D0	TCRUN	Clock timer Run/Stop control		1	Run	0	Stop	Х	R/W	
Clock timer	0040152	D7	TCISE2	Clock timer interrupt factor	T	TC	CISE[2:0]	Inte	rrupt factor	Х	R/W	
interrupt	(B)	D6	TCISE1	selection		1	1 1		None	х		
control register		D5	TCISE0			1	1 0		Day	Х		
						1	0 1		Hour			
						1	0 0		Minute			
						0			1 Hz			
						0			2 Hz			
						0			0 ⊓∠ 32 ⊔7			
		D4	TCASE2	Clock timer alarm factor selection	,  -	TC	ASE[2:0]	Ala	orm factor	x	R/W	
		D3	TCASE1		ŀ	1		7 110	Dav	X		
		D2	TCASE0			х	1 X		Hour	х		
						х	X 1		Minute			
						0	0 0		None			
		D1	TCIF	Interrupt factor generation flag		1	Generated	0	Not generated	Х	R/W	Reset by writing 1.
		D0	TCAF	Alarm factor generation flag		1	Generated	0	Not generated	Х	R/W	Reset by writing 1.
Clock timer	0040153	D7	TCD7	Clock timer data 1 Hz		1	High	0	Low	Х	R	
divider register	(B)	D6	TCD6	Clock timer data 2 Hz	_	1	High	0	Low	Х	R	
		D5	TCD5	Clock timer data 4 Hz		1	High	0	Low	X	R	
		D4	TCD4	Clock timer data 8 Hz		1	High	0	Low	X	R	
		D3	TCD3	Clock timer data 16 Hz		1	High	0	LOW	X	R	
		D2	TCD2	Clock timer data 64 Hz	+	1	High	0	Low	X	R	
		D0	TCD0	Clock timer data 128 Hz		1	High	0	Low	X	R	
Clock timer	0040154	D7-6	-	reserved	T	_		_		_	-	0 when being read.
second	(B)	D5	TCMD5	Clock timer second counter data			0 to 59	) sec	onds	Х	R	
register		D4	TCMD4	TCMD5 = MSB						х		
		D3	TCMD3	TCMD0 = LSB						Х		
		D2	TCMD2							Х		
		D1	TCMD1							Х		
		D0	TCMD0		_					Х		
Clock timer	0040155	D7-6	-	reserved				-		_	-	0 when being read.
minute register	(B)	D5	TCHD5	Clock timer minute counter data			0 to 59	9 min	utes	X	R/W	
		D4 D3	теноз							×		
		D3	TCHD2							x		
		D1	TCHD1							Х		
		D0	TCHD0							Х		
Clock timer	0040156	D7–5	-	reserved				-		-	-	0 when being read.
hour register	(B)	D4	TCDD4	Clock timer hour counter data			0 to 2	23 ho	urs	Х	R/W	
		D3	TCDD3	TCDD4 = MSB						Х		
		D2	TCDD2	TCDD0 = LSB						Х		
		D1	TCDD1							X		
		DU	TCDDU		+					X		
day (low and a)	0040157		TCND7	Clock timer day counter data			U to 65	535 dor 1	days	×	K/W	
register	(8)	D6	TCND5	TCND0 = I SB			(IOw-OF		55015)	×		
		D4	TCND4							x		
		D3	TCND3							Х		
		D2	TCND2							Х		
		D1	TCND1							Х		
		D0	TCND0							Х		
Clock timer	0040158	D7	TCND15	Clock timer day counter data			0 to 65	5535	days	Х	R/W	
day (high-	(B)	D6	TCND14	(high-order 8 bits)			(high-o	rder 8	3 bits)	Х		
order) register		D5	TCND13	ICND15 = MSB						X		
		D4 D3	TCND12							×		
		D2	TCND10							x		
		D1	TCND9							х		
		D0	TCND8							х		
Clock timer	0040159	D7–6	-	reserved	Ť	_		-		-	-	0 when being read.
minute	(B)	D5	TCCH5	Clock timer minute comparison	T		0 to 59	9 min	utes	Х	R/W	
comparison		D4	TCCH4	data	(	(No	ote) Can be	e set	within 0–63.	Х		
register		D3	тсснз	TCCH5 = MSB						Х		
		D2	TCCH2	TCCH0 = LSB						Х		
			TCCH1							×		

Register name	Address	Bit	Name	Function	Setting		R/W	Remarks
Clock timer	004015A	D7–5	-	reserved	_		-	0 when being read.
hour	(B)	D4	TCCD4	Clock timer hour comparison data	0 to 23 hours	Х	R/W	
comparison		D3	TCCD3	TCCD4 = MSB	(Note) Can be set within 0-31.	Х		
register		D2	TCCD2	TCCD0 = LSB		Х		
		D1	TCCD1					
		D0	TCCD0			Х		
Clock timer	004015B	D7–5	-	reserved	_	-	-	0 when being read.
day	(B)	D4	TCCN4	Clock timer day comparison data	0 to 31 days	Х	R/W	Compared with
comparison		D3	TCCN3	TCCN4 = MSB		Х		TCND[4:0].
register		D2	TCCN2	TCCN0 = LSB		Х		
		D1	TCCN1					
		D0	TCCN0			Х		

Register name	Address	Bit	Name	Function		Sett	ing	J	Init.	R/W	Remarks
8-bit timer 0	0040160	D7–3	-	reserved					-	-	0 when being read.
control register	(B)	D2	PTOUT0	8-bit timer 0 clock output control	1	On	0	Off	0	R/W	<u> </u>
, see a second	( )	D1	PSET0	8-bit timer 0 preset	1	Preset	0	Invalid	_	W	0 when being read.
		D0	PTRUN0	8-bit timer 0 Run/Stop control	1	Run	0	Stop	0	R/W	<u> </u>
8-bit timer 0	0040161	D7	RI D07	8-bit timer 0 reload data		0 to	25	5	x	R/W	
reload data	(B)	D6	RI D06	BI D07 = MSB		0.00	201		x	10.11	
register	(5)	D5	RI D05	RLD00 = LSB					x		
regiotoi		D4	RI D04						x		
		D3	RI D03						x		
		D2	RI D02						x		
		D1	RI D01						x		
		D0	RLD00						x		
8-bit timer 0	0040162	D7	PTD07	8-bit timer 0 counter data		0 to	25	5	x	R	
counter data	(B)	D6	PTD06			0.00	201	5	x		
register	(5)	D5	PTD05	PTD00 = ISB					x		
regiotoi		D4	PTD04	1 1000 - 200					x		
		D3	PTD03						x		
		D2	PTD02						x		
		D1	PTD01						x		
		D0	PTD00						x		
8-bit timer 1	0040164	D7-3	_	reserved					-	_	0 when being read
control register	(B)	D2	PTOUT1	8-bit timer 1 clock output control	1	On	0	Off	0	R/W	o mon boing road.
g	(-)	D1	PSET1	8-bit timer 1 preset	1	Preset	0	Invalid	-	W	0 when being read.
		D0	PTRUN1	8-bit timer 1 Run/Stop control	1	Run	0	Stop	0	R/W	<u> </u>
8-bit timer 1	0040165	D7	RI D17	8-bit timer 1 reload data		0 to	25	5	X	R/M	
reload data	(B)	D6	RI D16	BLD17 = MSB		0.10	20,	5	x	10.00	
register	(5)	D5	RI D15	RLD10 = LSB					x		
regiotoi		D4	RI D14						x		
		D3	RI D13						x		
		D2	RI D12						x		
		D1	RLD11						x		
		D0	RLD10						x		
8-bit timer 1	0040166	D7	PTD17	8-bit timer 1 counter data		0 to	25	5	X	R	
counter data	(B)	D6	PTD16	PTD17 = MSB		0.00	201		x		
register	(-)	D5	PTD15	PTD10 = ISB					x		
<b>3</b>		D4	PTD14						X		
		D3	PTD13						x		
		D2	PTD12						X		
		D1	PTD11						X		
		D0	PTD10						Х		
8-bit timer 2	0040168	D7–3	-	reserved		-	-		-	-	0 when being read.
control register	(B)	D2	PTOUT2	8-bit timer 2 clock output control	1	On	0	Off	0	R/W	
		D1	PSET2	8-bit timer 2 preset	1	Preset	0	Invalid	-	W	0 when being read.
		D0	PTRUN2	8-bit timer 2 Run/Stop control	1	Run	0	Stop	0	R/W	
8-bit timer 2	0040169	D7	RLD27	8-bit timer 2 reload data		0 to	25	5	Х	R/W	
reload data	(B)	D6	RLD26	RLD27 = MSB					X		
register		D5	RLD25	RLD20 = LSB					X		
		D4	RLD24						X		
		D3	RLD23						Х		
		D2	RLD22						X		
		D1	RLD21						X		
		D0	RLD20						Х		
8-bit timer 2	004016A	D7	PTD27	8-bit timer 2 counter data		0 to	25	5	Х	R	
counter data	(B)	D6	PTD26	PTD27 = MSB					Х		
register		D5	PTD25	PTD20 = LSB					X		
		D4	PTD24						X		
		D3	PTD23						X		
		D2	PTD22						X		
		D1	PTD21						X		
		D0	PTD20						Х		

Register name	Address	Bit	Name	Function	Setting					R/W	Remarks
8-bit timer 3	004016C	D7-3	-	reserved		-	-		-	-	0 when being read.
control register	(B)	D2	PTOUT3	8-bit timer 3 clock output control	1	1 On 0 0		Off	0	R/W	
		D1	PSET3	8-bit timer 3 preset	1	Preset	0	Invalid	-	W	0 when being read.
		D0	PTRUN3	8-bit timer 3 Run/Stop control	1	Run	0	Stop	0	R/W	
8-bit timer 3	004016D	D7	RLD37	8-bit timer 3 reload data	0 to 255			Х	R/W		
reload data	(B)	D6	RLD36	RLD37 = MSB					X		
register		D5	RLD35	RLD30 = LSB					Х		
		D4	RLD34						Х		
		D3	RLD33						Х		
		D2	RLD32						Х		
		D1	RLD31						Х		
		D0	RLD30						Х		
8-bit timer 3	004016E	D7	PTD37	8-bit timer 3 counter data		0 to	25	5	Х	R	
counter data	(B)	D6	PTD36	PTD37 = MSB					Х		
register		D5	PTD35	PTD30 = LSB					Х		
		D4	PTD34						Х		
		D3	PTD33						Х		
		D2	PTD32						Х		
		D1	PTD31						X		
		D0	PTD30						Х		

Register name	Address	Bit	Name	Function		Setti	ng	Init.	R/W	Remarks
Watchdog	0040170	D7	WRWD	EWD write protection	1	Write enabled	Write-protect	0	R/W	
timer write-	(B)	D6-0	-	-		-		-	-	0 when being read.
protect register										
Watchdog	0040171	D7–2	-	_		-		-	-	0 when being read.
timer enable	(B)	D1	EWD	Watchdog timer enable	1	NMI enabled	NMI disabled	0	R/W	
register		D0	-	-		_		-	-	0 when being read.

Register name	Address	Bit	Name	Function	Setting			Init.	R/W	Remarks
Power control	0040180	D7	CLKDT1	System clock division ratio	CLK	DT[1:0]	Division ratio	0	R/W	
register	(B)	D6	CLKDT0	selection	1	1	1/8	0		
					1	0	1/4			
					0	1	1/2			
					0	0	1/1			
		D5	PSCON	Prescaler On/Off control	10	n	0 Off	1	R/W	
		D4–3	-	reserved				0	-	Writing 1 not allowed.
		D2	CLKCHG	CPU operating clock switch	10	SC3	0 OSC1	1	R/W	
		D1	SOSC3	High-speed (OSC3) oscillation On/Off	10	n	0 Off	1	R/W	
		D0	SOSC1	Low-speed (OSC1) oscillation On/Off	10	'n	0 Off	1	R/W	
Prescaler clock	0040181	D7–1	-	reserved			-	0	-	
select register	(B)	D0	PSCDT0	Prescaler clock selection	1 O	SC1	0 OSC3/PLL	0	R/W	
Clock option	0040190	D7-4	-	-			-	-	-	0 when being read.
register	(B)	D3	HLT2OP	HALT clock option	1 O	'n	0 Off	0	R/W	
		D2	8T1ON	OSC3-stabilize waiting function	10	ff	0 On	1	R/W	
		D1	-	reserved			-	0	-	Writing 1 not allowed.
		D0	PF1ON	OSC1 external output control	10	n	0 Off	0	R/W	
Power control	004019E	D7	CLGP7	Power control register protect flag	Writir	ng 10010 <sup>-</sup>	110 (0x96)	0	R/W	
protect register	(B)	D6	CLGP6		remo	ves the w	rite protection of	0		
		D5	CLGP5		the p	ower con	trol register	0		
		D4	CLGP4		(0x40	180) and	I the clock option	0		
		D3	CLGP3		regist	ter (0x40	190).	0		
		D2	CLGP2		Writir	ng anothe	r value set the	0		
		D1	CLGP1		write	protectio	n.	0		
		D0	CLGP0					0		

Register name	Address	Bit	Name	Function	Setting In		Init.	R/W	Remarks			
Serial I/F Ch.0	00401E0	D7	TXD07	Serial I/F Ch.0 transmit data			0x0 to 0	xFF(	0x7F)	Х	R/W	7-bit asynchronous
transmit data	(B)	D6	TXD06	TXD07(06) = MSB						Х		mode does not use
register		D5	TXD05	TXD00 = LSB						Х		TXD07.
		D4	TXD04							Х		
		D3	TXD03							Х		
		D2	TXD02							Х		
		D1	TXD01							Х		
		D0	TXD00							Х		
Serial I/F Ch.0	00401E1	D7	RXD07	Serial I/F Ch.0 receive data			0x0 to 0	xFF(	0x7F)	Х	R	7-bit asynchronous
receive data	(B)	D6	RXD06	RXD07(06) = MSB						Х		mode does not use
register		D5	RXD05	RXD00 = LSB						Х		RXD07 (fixed at 0).
		D4	RXD04							Х		
		D3	RXD03							Х		
		D2	RXD02							Х		
		D1	RXD01							Х		
		D0	RXD00							Х		
Serial I/F Ch.0	00401E2	D7–6	-	_				-		-	-	0 when being read.
status register	(B)	D5	TEND0	Ch.0 transmit-completion flag	1	Tra	Insmitting	0	End	0	R	
		D4	FER0	Ch.0 flaming error flag	1	Err	or	0	Normal	0	R/W	Reset by writing 0.
		D3	PER0	Ch.0 parity error flag	1	Err	or	0	Normal	0	R/W	Reset by writing 0.
		D2	OER0	Ch.0 overrun error flag	1	Err	or	0	Normal	0	R/W	Reset by writing 0.
		D1	TDBE0	Ch.0 transmit data buffer empty	1	Err	npty	0	Buffer full	1	R	
		D0	RDBF0	Ch.0 receive data buffer full	1	Bu	ffer full	0	Empty	0	R	
Serial I/F Ch.0	00401E3	D7	TXEN0	Ch.0 transmit enable	1	En	abled	0	Disabled	0	R/W	
control register	(B)	D6	RXEN0	Ch.0 receive enable	1	En	abled	0	Disabled	0	R/W	
		D5	EPR0	Ch.0 parity enable	1	Wi	th parity	0	No parity	Х	R/W	Valid only in
		D4	PMD0	Ch.0 parity mode selection	1	Od	d	0	Even	Х	R/W	asynchronous mode.
		D3	STPB0	Ch.0 stop bit selection	1	2 b	oits	0	1 bit	Х	R/W	
		D2	SSCK0	Ch.0 input clock selection	1	#S	CLK0	0	Internal clock	Х	R/W	
		D1	SMD01	Ch.0 transfer mode selection	S	MD	0[1:0]	Tra	nsfer mode	Х	R/W	
		D0	SMD00		-	1	1 8	-bit a	synchronous	Х		
					-	1	0 7	-bit a	synchronous			
					(	0	1	Cloc	sync. Slave			
						0	0 (	Clock	sync. Master			
Serial I/F Ch.0	00401E4	D7–5	-	_				-		-	-	0 when being read.
IrDA register	(B)	D4	DIVMD0	Ch.0 async. clock division ratio	1	1/8	3	0	1/16	X	R/W	
		D3	IRTL0	Ch.0 IrDA I/F output logic inversion	1	Inv	rerted	0	Direct	<u>X</u>	R/W	Valid only in
		D2	IRRLO	Ch.0 IrDA I/F input logic inversion	1	Inv	erted	0	Direct	X	R/W	asynchronous mode.
			IKMD01	Ch.U Interface mode selection	IR		0[1:0]	l,	⊢ mode	X	R/W	
		00	IKMD00			1		r	eserved	Х		
						1	0	I	IDA 1.0			
								r	eserved			
					(	υ	0	G	eneral I/F			

Register name	Address	Bit	Name	Function	Setting		Init.	R/W	Remarks			
Serial I/F Ch.1	00401E5	D7	TXD17	Serial I/F Ch.1 transmit data			0x0 to 0	xFF(	0x7F)	Х	R/W	7-bit asynchronous
transmit data	(B)	D6	TXD16	TXD17(16) = MSB						Х		mode does not use
register		D5	TXD15	TXD10 = LSB						Х		TXD17.
		D4	TXD14							Х		
		D3	TXD13							Х		
		D2	TXD12							Х		
		D1	TXD11							Х		
		D0	TXD10							Х		
Serial I/F Ch.1	00401E6	D7	RXD17	Serial I/F Ch.1 receive data			0x0 to 0	xFF(	0x7F)	Х	R	7-bit asynchronous
receive data	(B)	D6	RXD16	RXD17(16) = MSB						Х		mode does not use
register		D5	RXD15	RXD10 = LSB						Х		RXD17 (fixed at 0).
		D4	RXD14							Х		
		D3	RXD13							Х		
		D2	RXD12							Х		
		D1	RXD11							Х		
		D0	RXD10							Х		
Serial I/F Ch.1	00401E7	D7-6	-	-				-		-	-	0 when being read.
status register	(B)	D5	TEND1	Ch.1 transmit-completion flag	1	Tra	nsmitting	0	End	0	R	
		D4	FER1	Ch.1 flaming error flag	1	Err	or	0	Normal	0	R/W	Reset by writing 0.
		D3	PER1	Ch.1 parity error flag	1	Err	or	0	Normal	0	R/W	Reset by writing 0.
		D2	OER1	Ch.1 overrun error flag	1	Err	or	0	Normal	0	R/W	Reset by writing 0.
		D1	TDBE1	Ch.1 transmit data buffer empty	1	Em	npty	0	Buffer full	1	R	
		D0	RDBF1	Ch.1 receive data buffer full	1	But	ffer full	0	Empty	0	R	
Serial I/F Ch.1	00401E8	D7	TXEN1	Ch.1 transmit enable	1	En	abled	0	Disabled	0	R/W	
control register	(B)	D6	RXEN1	Ch.1 receive enable	1	En	abled	0	Disabled	0	R/W	
		D5	EPR1	Ch.1 parity enable	1	Wit	th parity	0	No parity	Х	R/W	Valid only in
		D4	PMD1	Ch.1 parity mode selection	1	Od	d	0	Even	Х	R/W	asynchronous mode.
		D3	STPB1	Ch.1 stop bit selection	1	2 b	its	0	1 bit	Х	R/W	
		D2	SSCK1	Ch.1 input clock selection	1	#S	CLK1	0	Internal clock	Х	R/W	
		D1	SMD11	Ch.1 transfer mode selection	S	MD	1[1:0]	Trai	nsfer mode	Х	R/W	
		D0	SMD10			1	1 8	-bit a	synchronous	Х		
						1	0 7	-bit a	synchronous			
						0	1 (	Clock	sync. Slave			
					(	0	0 0	Clock	sync. Master			
Serial I/F Ch.1	00401E9	D7–5	-	-				-		-	-	0 when being read.
IrDA register	(B)	D4	DIVMD1	Ch.1 async. clock division ratio	1	1/8		0	1/16	Х	R/W	
		D3	IRTL1	Ch.1 IrDA I/F output logic inversion	1	Inv	erted	0	Direct	X	R/W	Valid only in
		D2	IRRL1	Ch.1 IrDA I/F input logic inversion	1	Inv	erted	0	Direct	X	R/W	asynchronous mode.
		D1	IRMD11	Ch.1 interface mode selection	IR	MD	1[1:0]	l/	'F mode	X	R/W	
		DO	IRMD10			1	1	r	eserved	Х		
						1	0	I	rda 1.0			
							1	r	eserved			
			1		(	υ	0	Ge	eneral I/F			

Register name	Address	Bit	Name	Function	Setting	Init.	R/W	Remarks
Port input 0/1	0040260	D7	-	reserved	-	-	-	0 when being read.
interrupt	(B)	D6	PP1L2	Port input 1 interrupt level	0 to 7	Х	R/W	-
priority register		D5	PP1L1			Х		
		D4	PP1L0			Х		
		D3	-	reserved		-	-	0 when being read.
		D2	PP0L2	Port input 0 interrupt level	0 to 7	X	R/W	
		D1	PP0L1			X		
		DO	PPOLO			X		
Port input 2/3	0040261	D7	-	reserved	-	-	-	0 when being read.
interrupt	(B)	D6	PP3L2	Port input 3 interrupt level	0 to 7	X	R/W	
priority register		D5	PP3L1					
		D4 D3	-	reserved	_		_	0 when being read
		D2	PP2I 2	Port input 2 interrupt level	0 to 7	x	R/W	o when being read.
		D1	PP2L1			X		
		D0	PP2L0			X		
Key input	0040262	D7	-	reserved	_	-	_	0 when being read.
interrupt	(B)	D6	PK1L2	Key input 1 interrupt level	0 to 7	Х	R/W	<u> </u>
priority register		D5	PK1L1			Х		
		D4	PK1L0			Х		
		D3	-	reserved	-	-	-	0 when being read.
		D2	PK0L2	Key input 0 interrupt level	0 to 7	X	R/W	
		D1	PK0L1			X		
		DO	PKOLO			X		
16-bit timer 0/1	0040266	D7	-	reserved	-	-	-	0 when being read.
interrupt	(B)	D6	P16T12	16-bit timer 1 interrupt level	0 to 7	X	R/W	
priority register		D5	P16111					
		D4 D3	-	reserved	_	_	_	0 when being read
		D2	P16T02	16-bit timer 0 interrupt level	0 to 7	x	R/W	o when being read.
		D1	P16T01			X		
		D0	P16T00			x		
16-bit timer 2/3	0040267	D7	-	reserved	_	-	_	0 when being read.
interrupt	(B)	D6	P16T32	16-bit timer 3 interrupt level	0 to 7	Х	R/W	Ŭ
priority register		D5	P16T31			Х		
		D4	P16T30			Х		
		D3	-	reserved	-	-	-	0 when being read.
		D2	P16T22	16-bit timer 2 interrupt level	0 to 7	X	R/W	
			P16121			X		
10121			P10120					
interrunt	0040200 (B)		- P16T52	16-bit timer 5 interrupt level		- X	- R/M	o when being read.
priority register	(2)	D5	P16T51		0107	x	1011	
		D4	P16T50			x		
		D3	-	reserved	-	-	-	0 when being read.
		D2	P16T42	16-bit timer 4 interrupt level	0 to 7	Х	R/W	
		D1	P16T41			X		
		D0	P16T40			Х		
8-bit timer,	0040269	D7	-	reserved		-	-	0 when being read.
serial I/F Ch.0	(B)	D6	PSIO02	Serial interface Ch.0	0 to 7	X	R/W	
interrupt		D5	PSIO01	Interrupt level		X		
priority register		D4	P51000	reserved		×		0 when being read
		D3 D2	P8TM2	8-bit timer 0-3 interrupt level	0 to 7	×		o when being read.
		D1	P8TM1		0107	x	10.00	
		DO	P8TM0			x		
Serial I/F Ch.1.	004026A	D7–3	<b> </b> _	reserved	-	-		0 when being read.
interrupt	(B)	D2	PSIO12	Serial interface Ch.1	0 to 7	Х	R/W	Ŭ Ŭ
priority register		D1	PSIO11	interrupt level		X		
		D0	PSIO10			Х		
Clock timer	004026B	D7–3	-	reserved	_	-	_	Writing 1 not allowed.
interrupt	(B)	D2	PCTM2	Clock timer interrupt level	0 to 7	Х	R/W	
priority register		D1	PCTM1			X		
		D0	PCTM0			X		

Register name	Address	Bit	Name	Function		Set	ting	3	Init.	R/W	Remarks
Port input 4/5	004026C	D7	-	reserved	İ	-	_		_	_	0 when being read
interrupt	(B)	D6	PP5L2	Port input 5 interrupt level	$\vdash$	0 t	07		x	R/W	o mon boing roadi
priority register	(-)	D5	PP5L1	· ·····					x		
		D4	PP5L0						x		
		D3	-	reserved			-		-	-	0 when being read.
		D2	PP4L2	Port input 4 interrupt level		0 t	o 7		Х	R/W	-
		D1	PP4L1						Х		
		D0	PP4L0						Х		
Port input 6/7	004026D	D7	-	reserved		-	-		-	-	0 when being read.
interrupt	(B)	D6	PP7L2	Port input 7 interrupt level		0 t	o 7		Х	R/W	-
priority register		D5	PP7L1						Х		
		D4	PP7L0						Х		
		D3	-	reserved		-	-		-	-	0 when being read.
		D2	PP6L2	Port input 6 interrupt level		0 t	o 7		Х	R/W	
		D1	PP6L1						Х		
		D0	PP6L0						Х		
Key input,	0040270	D7–6	-	reserved		-	-		-	-	0 when being read.
port input 0-3	(B)	D5	EK1	Key input 1	1	Enabled	0	Disabled	0	R/W	
interrupt		D4	EK0	Key input 0					0	R/W	
enable register		D3	EP3	Port input 3					0	R/W	
		D2	EP2	Port input 2	1				0	R/W	
		D1	EP1	Port input 1					0	R/W	
		D0	EP0	Port input 0					0	R/W	
16-bit timer 0/1	0040272	D7	E16TC1	16-bit timer 1 comparison A	1	Enabled	0	Disabled	0	R/W	
interrupt	(B)	D6	E16TU1	16-bit timer 1 comparison B					0	R/W	
enable register		D5–4	-	reserved		-	-		-	-	0 when being read.
		D3	E16TC0	16-bit timer 0 comparison A	1	Enabled	0	Disabled	0	R/W	
		D2	E16TU0	16-bit timer 0 comparison B					0	R/W	
		D1–0	-	reserved			-		-	-	0 when being read.
16-bit timer 2/3	0040273	D7	E16TC3	16-bit timer 3 comparison A	1	Enabled	0	Disabled	0	R/W	
interrupt	(B)	D6	E16TU3	16-bit timer 3 comparison B					0	R/W	
enable register		D5–4	-	reserved		-	-		-	-	0 when being read.
		D3	E16TC2	16-bit timer 2 comparison A	1	Enabled	0	Disabled	0	R/W	
		D2	E16TU2	16-bit timer 2 comparison B					0	R/W	
		D1–0	-	reserved			-		-	-	0 when being read.
16-bit timer 4/5	0040274	D7	E16TC5	16-bit timer 5 comparison A	1	Enabled	0	Disabled	0	R/W	
interrupt	(B)	D6	E16TU5	16-bit timer 5 comparison B					0	R/W	
enable register		D5-4	-	reserved	.		-	<b>.</b>	-	-	0 when being read.
		D3	E16TC4	16-bit timer 4 comparison A	1	Enabled	0	Disabled	0	R/W	
		D2	E16104	16-bit timer 4 comparison B	-				0	R/W	O when heing read
		DI-0	-	reserved	_		_		_	_	0 when being read.
8-bit timer	0040275	D7-4	-				-	B: 11 1	-	-	0 when being read.
Interrupt	(B)	D3	E81U3	8-bit timer 3 underflow	1	Enabled	0	Disabled	0	R/W	
enable register		D2	E81U2	8-bit timer 2 underflow	-				0	R/W	
				8-bit timer 0 underflow	-				0		
Carial I/E	0040070		20100		$\vdash$		L			17/17	O when he'r r r r i'
Serial I/F	0040270 (B)	D7-6	-	RIE Ch 1 transmit huffar amptu	1	- Fachlad	_	Dischlad	-	-	o when being read.
enable registor	(8)		ESRX1	SIF Ch 1 receive buffer full	1'	LIIauleu	0	Disabled	0	R/M	
chasie register		D3	ESERR1	SIF Ch.1 receive error	1				0	R/W	
		D2	ESTX0	SIF Ch.0 transmit buffer empty	1				0	R/W	
		D1	ESRX0	SIF Ch.0 receive buffer full					0	R/W	
		D0	ESERR0	SIF Ch.0 receive error					0	R/W	
Port input 4–7	0040277	D7-6	_	reserved	t		_		_	_	0 when being read
clock timer.	(B)	D5	EP7	Port input 7	1	Enabled	0	Disabled	0	R/W	o whom boing road.
interrupt	(-)	D4	EP6	Port input 6	1		1		0	R/W	1
enable register		D3	EP5	Port input 5	1		1		Ō	R/W	1
		D2	EP4	Port input 4	1		1		0	R/W	1
		D1	ЕСТМ	Clock timer	1		1		0	R/W	1
		D0	-	reserved	T	•	-	•	0	R/W	Writing 1 not allowed.
Key input.	0040280	D7-6	-	reserved	İ	-	_		-	_	0 when being read
port input 0-3	(B)	D5	FK1	Key input 1	1	Factor is	0	No factor is	Х	R/W	
interrupt factor	. ,	D4	FK0	Key input 0	1	generated		generated	Х	R/W	1
flag register		D3	FP3	Port input 3	1	-		-	Х	R/W	1
		D2	FP2	Port input 2	]				X	R/W	]
		D1	FP1	Port input 1	]				Х	R/W	
		D0	FP0	Port input 0	1				Х	R/W	

Register name	Address	Bit	Name	Function			Set	tinę	3		Init.	R/W	Remarks
16-bit timer 0/1	0040282	D7	F16TC1	16-bit timer 1 comparison A	1	Fact	or is	0	No f	actor is	Х	R/W	
interrupt factor	(B)	D6	F16TU1	16-bit timer 1 comparison B		gene	erated		gene	erated	Х	R/W	
flag register		D5–4	-	reserved			-	-			-	-	0 when being read.
		D3	F16TC0	16-bit timer 0 comparison A	1	Fact	or is	0	No f	actor is	Х	R/W	
		D2	F16TU0	16-bit timer 0 comparison B		gene	erated		gene	erated	Х	R/W	
		D1-0	-	reserved			-	-			-	-	0 when being read.
16-bit timer 2/3	0040283	D7	F16TC3	16-bit timer 3 comparison A	1	Fact	or is	0	No f	actor is	Х	R/W	
interrupt factor	(B)	D6	F16TU3	16-bit timer 3 comparison B		gene	erated		gene	erated	Х	R/W	
flag register		D5-4	-	reserved	4	Feet	-	-	Nof	o oto r i o	- -	- D/M	0 when being read.
		D3	F10102	16-bit timer 2 comparison B	1'	raci	aratod	0	non	actor	Ŷ		
		D1-0	-	reserved		gent	-	_	gen	Jacu	_	_	0 when being read
16-bit timer 4/5	0040284	D7	F16TC5	16-bit timer 5 comparison A	1	Fact	or is	0	No f	actor is	X	R/\//	o mon boing road.
interrupt factor	(B)	D6	F16TU5	16-bit timer 5 comparison B	1	aene	erated	ľ	aene	erated	X	R/W	
flag register	(-)	D5-4	-	reserved		3	-	-	3		_	-	0 when being read.
		D3	F16TC4	16-bit timer 4 comparison A	1	Fact	or is	0	No f	actor is	Х	R/W	
		D2	F16TU4	16-bit timer 4 comparison B		gene	erated		gene	erated	Х	R/W	
		D1–0	-	reserved			-	-			-	-	0 when being read.
8-bit timer	0040285	D7–4	-	reserved			-	-			-	-	0 when being read.
interrupt factor	(B)	D3	F8TU3	8-bit timer 3 underflow	1	Fact	or is	0	No f	actor is	Х	R/W	
flag register		D2	F8TU2	8-bit timer 2 underflow		gene	erated		gene	erated	Х	R/W	
		D1	F8TU1	8-bit timer 1 underflow							X	R/W	
		DO	F8100	8-bit timer 0 underflow							X	R/W	
Serial I/F	0040286 (B)	D7-6	-	reserved	4	Feet	-	-	Nof	o oto r io	- V	- D//	0 when being read.
flag register	(6)	D5	FSIAT	SIF Ch.1 transmit builer empty	'	raci	oris			actoris	Ŷ		
nag register		D4	FSERR1	SIF Ch.1 receive error		yen	erateu		yen	Flateu	X	R/W	
		D2	FSTX0	SIF Ch.0 transmit buffer empty							X	R/W	
		D1	FSRX0	SIF Ch.0 receive buffer full	1						Х	R/W	
		D0	FSERR0	SIF Ch.0 receive error							Х	R/W	
Port input 4–7,	0040287	D7–6	-	reserved				-			-	-	0 when being read.
clock timer,	(B)	D5	FP7	Port input 7	1	Fac	tor is	0	No f	actor is	Х	R/W	
interrupt factor		D4	FP6	Port input 6		gen	erated		gen	erated	X	R/W	
flag register		D3	FP5	Port input 5							X	R/W	
		D2 D1	FP4	Clock timer							X	R/W	
		D0	-	reserved		I		_	I		X	R/W	Writing 1 not allowed.
Flag set/reset	004029F	D7–1	-	reserved			-	_			_	_	
method select	(B)	D0	RSTONLY	Interrupt factor flag reset method	1	Res	et only	0	RD/	WR	1	R/W	
register				selection									
Port input	00402C6	D7	SPT31	FPT3 interrupt input port selection		11	10	(	01	00	0	R/W	
interrupt select	(B)	D6	SPT30		P	23	P03		-	-	0		
register 1		D5	SPT21	FPT2 interrupt input port selection		11	10	(	01	00	0	R/W	
		D4	SP120	EPT1 interrupt input part selection	P	'22 11	P02		-	-	0	D/\//	
		D3	SPT10	in Firm interrupt input port selection	P	11 221	P01		-	-	0	10/00	
		D1	SPT01	FPT0 interrupt input port selection		11	10		01	00	0	R/W	
		D0	SPT00		P	20	P00		-	-	0		
Port input	00402C7	D7	SPT71	FPT7 interrupt input port selection		11	10		01	00	0	R/W	
interrupt select	(B)	D6	SPT70		P	27	P07	F	<b>'</b> 33	-	0		
register 2		D5	SPT61	FPT6 interrupt input port selection		11	10		01	00	0	R/W	
		D4	SPT60		P	26	P06	F	232	-	0	-	
		D3	SPT51	FPT5 interrupt input port selection		11	10		01	00	0	R/W	
		D2	SP150	EPT4 interrupt input part selection	P	'25 11	P05	F	01	-	0	D/\//	
		D0	SPT40	in the menuplimput port selection	P	24	P04		-	-	0	10,00	
Port input	00402C8	 D7	SPPT7	FPT7 input polarity selection	1	Hio	h level	0	Lo	w level	1	R/W	
interrupt	(B)	 D6	SPPT6	FPT6 input polarity selection	1		or	ľ		or	1	R/W	
input polarity		D5	SPPT5	FPT5 input polarity selection		Risi	ng edge		F	alling	1	R/W	
select register		D4	SPPT4	FPT4 input polarity selection					6	edge	1	R/W	
		D3	SPPT3	FPT3 input polarity selection							1	R/W	
		D2	SPPT2	FPT2 input polarity selection							1	R/W	
			SPP11	EPT0 input polarity selection							1	R/W	
1	1			I I I O INPUL POIAILLY SELECTION	1 1	i i			i i			11/11	

Register name	Address	Bit	Name	Function		Set	ting	J	Init.	R/W	Remarks
Port input	00402C9	D7	SEPT7	FPT7 edge/level selection	1	Edge	0	Level	1	R/W	
interrupt	(B)	D6	SEPT6	FPT6 edge/level selection			-		1	R/W	
edge/level	( )	D5	SEPT5	FPT5 edge/level selection	1				1	R/W	
select register		D4	SEPT4	FPT4 edge/level selection					1	R/W	
, C		D3	SEPT3	FPT3 edge/level selection	1				1	R/W	
		D2	SEPT2	FPT2 edge/level selection					1	R/W	
		D1	SEPT1	FPT1 edge/level selection	1				1	R/W	
		D0	SEPT0	FPT0 edge/level selection					1	R/W	
Key input	00402CA	D7-4	-	reserved		-	-		_	_	0 when being read.
interrupt select	(B)	D3	SPPK11	FPK1 interrupt input port selection		11 10	(	01 00	0	R/W	<u> </u>
register	.,	D2	SPPK10		P2	[7:4] P0[7:4]			0		
		D1	SPPK01	FPK0 interrupt input port selection	· ·	11 10	(	01 00	0	R/W	
		D0	SPPK00		P2	[4:0] P0[4:0]			0		
Key input	00402CC	D7–5	-	reserved	İ		_		-	_	0 when being read.
interrupt	(B)	 D4	SCPK04	FPK04 input comparison	1	Hiah	0	Low	0	R/W	
(FPK0) input	( )	D3	SCPK03	FPK03 input comparison		5	-		0	R/W	
comparison		D2	SCPK02	FPK02 input comparison	1				0	R/W	
register		D1	SCPK01	FPK01 input comparison	1				0	R/W	
-		D0	SCPK00	FPK00 input comparison	1				0	R/W	
Key input	00402CD	D7–4	-	reserved		-	_		-	-	0 when being read.
interrupt	(B)	D3	SCPK13	FPK13 input comparison	1	High	0	Low	0	R/W	
(FPK1) input		D2	SCPK12	FPK12 input comparison	1	-			0	R/W	
comparison		D1	SCPK11	FPK11 input comparison					0	R/W	
register		D0	SCPK10	FPK10 input comparison					0	R/W	
Key input	00402CE	D7–5	-	reserved		-	-		-	-	0 when being read.
interrupt	(B)	D4	SMPK04	FPK04 input mask	1	Interrupt	0	Interrupt	0	R/W	
(FPK0) input		D3	SMPK03	FPK03 input mask		enabled		disabled	0	R/W	
mask register		D2	SMPK02	FPK02 input mask					0	R/W	
		D1	SMPK01	FPK01 input mask					0	R/W	
		D0	SMPK00	FPK00 input mask					0	R/W	
Key input	00402CF	D7–4	-	reserved		-	-		-	-	0 when being read.
interrupt	(B)	D3	SMPK13	FPK13 input mask	1	Interrupt	0	Interrupt	0	R/W	
(FPK1) input		D2	SMPK12	FPK12 input mask		enabled		disabled	0	R/W	
mask register		D1	SMPK11	FPK11 input mask					0	R/W	
		D0	SMPK10	FPK10 input mask					0	R/W	
P0 function	00402D0	D7	CFP07	P07 function selection	1	#SRDY1	0	P07	0	R/W	Extended functions
select register	(B)	D6	CFP06	P06 function selection	1	#SCLK1	0	P06	0	R/W	(0x402DF)
		D5	CFP05	P05 function selection	1	SOUT	0	P05	0	R/W	
		D4	CFP04	P04 function selection			0	P04	0		
		03	CEP03	P03 function selection	1	#SRDTU	0	P03	0		
		D2	CEP01	P01 function selection		SOLITO	0	P02	0	R/W	
			CEP00	P00 function selection	1	SINO	0	P00	0	R/W	
B0 I/O port data	00402D1	D7	D07D	P07 I/O port data	1	High	0	Low			
register	(B)	D6	POED	P06 I/O port data	1'	Fight	0	LOW	0	R/W	
register	(5)	D5	P05D	P05 I/O port data					0	R/W	
		D3	P04D	P04 I/O port data					0	R/W	
		D3	P03D	P03 I/O port data					0	R/W	
		D2	P02D	P02 I/O port data					0	R/W	
		D1	P01D	P01 I/O port data					0	R/W	
		D0	P00D	P00 I/O port data					0	R/W	
P0 I/O control	00402D2	D7	IOC07	P07 I/O control	1	Output	0	Input	0	R/W	
register	(B)	D6	IOC06	P06 I/O control	1				0	R/W	
		D5	IOC05	P05 I/O control	1				0	R/W	
		D4	IOC04	P04 I/O control	1				0	R/W	
		D3	IOC03	P03 I/O control	1				0	R/W	
		D2	IOC02	P02 I/O control					0	R/W	
		D1	IOC01	P01 I/O control					0	R/W	
		D0	IOC00	P00 I/O control					0	R/W	

Register name	Address	Bit	Name	Function		Set	ting	9	Init.	R/W	Remarks	
P1 function	00402D4	D7	-	reserved		-	-		-	_	0 when being read.	
select register	(B)	D6	CFP16	P16 function selection	1	EXCL5	0	P16	0	R/W	<u> </u>	
3	. ,	D5	CFP15	P15 function selection	1	EXCL4	0	P15	0	R/W		
		D4	CFP14	P14 function selection	1	FOSC1	0	P14	0	R/W	Extended functions	
		D3	CFP13	P13 function selection	1	EXCL3	0	P13	0	R/W	(0x402DF)	
						T8UF3					· · ·	
		D2	CFP12	P12 function selection	1	EXCL2	0	P12	0	R/W		
						T8UF2						
		D1	CFP11	P11 function selection	1	EXCL1	0	P11	0	R/W		
						T8UF1						
		D0	CFP10	P10 function selection	1	EXCL0	0	P10	0	R/W		
						T8UF0						
P1 I/O port data	00402D5	D7	-	reserved		-	-		-	-	0 when being read.	
register	(B)	D6	P16D	P16 I/O port data	1	High	0	Low	0	R/W		
		D5	P15D	P15 I/O port data					0	R/W		
		D4	P14D	P14 I/O port data					0	R/W		
		D3	P13D	P13 I/O port data					0	R/W		
		D2	P12D	P12 I/O port data					0	R/W		
		D1	P11D	P11 I/O port data					0	R/W		
		D0	P10D	P10 I/O port data					0	R/W		
P1 I/O control	00402D6	D7	-	reserved		-	-		-	-	0 when being read.	
register	(B)	D6	IOC16	P16 I/O control	1	Output	0	Input	0	R/W		
		D5	IOC15	P15 I/O control					0	R/W		
		D4	IOC14	P14 I/O control					0	R/W		
		D3	IOC13	P13 I/O control					0	R/W		
		D2	IOC12	P12 I/O control					0	R/W		
		D1	10C11	P11 I/O control					0	R/W		
		Do	IOC10	P10 I/O control					0	R/W		
P2 function	00402D8	D7	CFP27	P27 function selection	1	TM5	0	P27	0	R/W		
select register	(B)	D6	CFP26	P26 function selection	1	TM4	0	P26	0	R/W		
		D5	CFP25	P25 function selection	1	TM3	0	P25	0	R/W		
		D4	CFP24	P24 function selection	1	1M2	0	P24	0	R/W		
		D3	CFP23	P23 function selection	1	TMT	0	P23	0	R/W		
		D2	CEP24	P22 function selection	1		0	P22	0		Ext. func (0x402DE)	
			CEP20	P20 function selection	1	#DRD	0	P20	0	R/W	LXI. IUIIC.(0X402DI )	
D2 I/O mart data	0040200	D7	01120		4	#DITD		120		DAV		
registor	(B)		P26D	P26 I/O port data	1'	nign		LOW	0			
register	(5)	D5	P25D	P25 I/O port data					0	R/W		
		D4	P24D	P24 I/O port data					0	R/W		
		D3	P23D	P23 I/O port data					0	R/W		
		D2	P22D	P22 I/O port data					0	R/W		
		D1	P21D	P21 I/O port data					0	R/W		
		D0	P20D	P20 I/O port data					0	R/W		
P2 I/O control	00402DA	D7	IOC27	P27 I/O control	1	Output	0	Input	0	R/W		
register	(B)	D6	IOC26	P26 I/O control	1				0	R/W		
_		D5	IOC25	P25 I/O control	1				0	R/W	1	
		D4	IOC24	P24 I/O control	1				0	R/W		
		D3	IOC23	P23 I/O control	1				0	R/W		
		D2	IOC22	P22 I/O control	1				0	R/W		
		D1	IOC21	P21 I/O control					0	R/W		
		D0	IOC20	P20 I/O control					0	R/W		
P3 function	00402DC	D7–6	-	reserved		-	-		-	-	0 when being read.	
select register	(B)	D5	CFP35	P35 function selection	1	#BUSACK	0	P35	0	R/W		
		D4	CFP34	P34 function selection	1	#BUSREQ	0	P34	0	R/W		
						#CE6						
		D3-2	-	reserved		-	-	5.4	0	R/W	Writing 1 not allowed.	
		D1	CFP31	P31 function selection	1	#BUSGET	0	P31	0	R/W	Ext. func.(0x402DF)	
		00	CFP30	P30 function selection	1	#WAIT	0	P30	0	R/W		
	00/00				-	#0E4/#0E5	I				Quebers 1	
P3 I/O port data	00402DD	D/-6	-	reserved		Lliah	-	Low	-	-	u when being read.	
register	(8)	05	P33D	P34 1/0 port data	$\{1, 2, 3\}$	riign		LOW				
		D4	P340	P33 I/O port data	1							
		03	P33D	P32 I/O port data	1					R/W		
			P31D	P31 I/O port data					0	R/M		
			PSID	P30 I/O port data	1					R/W		
1				1. 55 % C por uala	1	1		1		1 1 1 1 1 1	1	
Register name	Address	Bit	Name	Function			Set	ting	9	Init.	R/W	Remarks
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P3 I/O control	00402DE	D7-6	-	reserved			-	-		-	-	0 when being read.
register	(B)	D5	IOC35	P35 I/O control	1	Output		0	Input	0	R/W	Ť
-		D4	IOC34	P34 I/O control	1					0	R/W	
		D3	IOC33	P33 I/O control	1					0	R/W	
		D2	IOC32	P32 I/O control						0	R/W	
		D1	IOC31	P31 I/O control						0	R/W	
		D0	IOC30	P30 I/O control						0	R/W	
Port function	00402DF	D7–4	-	reserved			-	-		0	R/W	Writing 1 not allowed.
extension	(B)	D3	CFEX3	P31 port extended function	1	#GARD	)	0	P31, etc.	0	R/W	
register		D2	CFEX2	P21 port extended function	1	#GAAS	5	0	P21, etc.	0	R/W	
		D1	CFEX1	P10, P11, P13 port extended	1	DST0		0	P10, etc.	1	R/W	
				function		DST1			P11, etc.			
						DPC0			P13, etc.			
		D0	CFEX0	P12, P14 port extended function	1	DST2		0	P12, etc.	1	R/W	
						DCLK			P14, etc.			
Address bus	0040300	D7	CFA23	A23 function selection	1	P07 etc	c.	0	A23	0	R/W	
function select		D6	CFA22	A22 function selection	1	P35 etc	c.	0	A22	0	R/W	
register		D5	CFA21	A21 function selection	1	P34 etc	c.	0	A21	0	R/W	
		D4	CFA20	A20 function selection	1	P33		0	A20	0	R/W	
		D3-0	-	reserved			-	-		-	-	0 when being read.
Chip enable	0040301	D7-6	-	reserved			-			-	-	0 when being read.
function select		D5	CFCE9	#CE9 function selection	1	P32		0	#CE9, etc.	0	R/W	
register		D4	CFCE8	#CE8 function selection	1	P31, et	c.	0	#CE8, etc.	0	R/W	
		D3	CFCE7	#CE7 function selection	1	P21, et	c.	0	#CE7, etc.	0	R/W	
		D2	CFCE6	#CE6 function selection	1	P20, et	c.	0	#CE6, etc.	0	R/W	
		D1	CFCE5	#CE5 function selection	1	P16, et	с.	0	#CE5, etc.	0	R/W	
		D0	CFCE4	#CE4 function selection	1	P15, et	C.	0	#CE4, etc.	0	R/W	
Areas 18–15	0048120	DF	-	reserved			-	-		-	-	0 when being read.
set-up register	(HW)	DE	A18SZ	Areas 18–17 device size selection	1	8 bits		0	16 bits	0	R/W	
			A18DF1	Areas 18–17	A	8DF[1:0		um	ber of cycles	1	R/W	
		DC	A18DFU	output disable delay time					3.5	1		
									2.0			
									0.5			
		DB	_	reserved	L_		-	_	0.0	_	_	0 when being read
		DA	A18WT2	Areas 18–17 wait control	A1	8WT[2:0	01	W	ait cvcles	1	R/W	o mon boing road.
		D9	A18WT1		1		1		7	1		
		D8	A18WT0		1	1 0	0		6	1		
					1	0 1	1		5			
					1	0 0	0		4			
					0	1 1	1		3			
					0	1 (	0		2			
					0	0 1	1		1			
					0	0 0	0		0			
		D7	-	reserved			-	-		-	-	0 when being read.
		D6	A16SZ	Areas 16–15 device size selection	1	8 bits		0	16 bits	0	R/W	
		D5	A16DF1	Areas 16–15	A	6DF[1:0	0] Ni	um	ber of cycles	1	R/W	
		D4	A16DF0	output disable delay time	·				3.5	1		
									2.5			
									1.5			
		D2		record		0			0.5			0 when being read
		23	A16W/T2	Areas 16–15 wait control	Δ1	6\W/T[2·/	- 01		ait cycles	1		o when bellig lead.
			A16WT1	Areas 10-15 wait control	1	1 1	1	••	7	1	10/00	
		D0	A16WT0		1	$ _1 _0$			6			
					1		1		5	'		
					1	0 0	0		4			
					0		1		3			
					0	1 0	0		2			
					0	0 1	1		1			
					0	0 0	0		0			

Register name	Address	Bit	Name	Function			S	ettin	g	Init.	R/W	Remarks
Areas 14–13	0048122	DF-9	-	reserved				-		_	-	0 when being read.
set-up register	(HW)	D8	A14DRA	Area 14 DRAM selection	1	Jsec	b	0	Not used	0	R/W	-
		D7	A13DRA	Area 13 DRAM selection	1	Jsec	b	0	Not used	0	R/W	
		D6	A14SZ	Areas 14–13 device size selection	1 8	3 bit	s	0	16 bits	0	R/W	
		D5	A14DF1	Areas 14–13	A14	1DF	[1:0]	Num	ber of cycles	1	R/W	
		D4	A14DF0	output disable delay time	1		1		3.5	1		
					1		0		2.5			
					0		1		1.5			
		D3		reserved	0		0		0.5			0 when being read
		D3 D2	- 414WT2	Areas 14–13 wait control	A14	IW/T	[2.0]		/ait cycles	-	_ R/W	o when being read.
		D1	A14WT1		1	1	1		7	1		
		D0	A14WT0		1	1	0		6	1		
					1	0	1		5			
					1	0	0		4			
					0	1	1		3			
					0	1	0		2			
					0	0	1		1			
		DF 7			0	0	0		0			
Areas 12–11	(1111)		-	reserved	1	2 hit	_	-	16 hito	-	- D///	0 when being read.
set-up register	(ПVV)	D6	A1252	Areas 12–11 device size selection	A18		s [1·0]	Num	ber of cycles	1	R/W	
		D3	A12DF0	output disable delay time	1		1	Num	3.5	1	10.00	
			-		1		0		2.5			
					0		1		1.5			
					0		0		0.5			
		D3	-	reserved				-		-	-	0 when being read.
		D2	A12WT2	Areas 12–11 wait control	A18	SVV I	[2:0]	V	Vait cycles	1	R/W	
			A12WT1		1	1			6	1		
		00	~~~~			0			5	'		
					1	0	0		4			
					0	1	1		3			
					0	1	0		2			
					0	0	1		1			
					0	0	0		0			
Areas 10–9	0048126	DF	-	reserved				-		-	-	0 when being read.
set-up register	(HW)	DE	A10IR2	Area 10 internal ROM wait control	A1	0IR[	2:0]		ROM size	1	R/W	
				Alea To Internal ROM Size		1			∠ivid 1MB	1		
		00				0	1		512KB			
					1	0	0		256KB			
					0	1	1		128KB			
					0	1	0		64KB			
					0	0	1		32KB			
					0	0	0		16KB			
		DB	-	reserved			14.01	-	/-:+	-	-	0 when being read.
			A10BWI	hurst ROM	1		1	v	3	0	r./ v v	
		20		burst read cycle wait control	1		0		2	Ŭ		
					0		1		1			
					0		0		0			
		D8	A10DRA	Area 10 burst ROM selection	1	Jsec	b	0	Not used	0	R/W	
		D7	A9DRA	Area 9 burst ROM selection	1	Jsec	t -	0	Not used	0	R/W	
		D6	A105Z	Areas 10–9 device size selection	1 0		S [1:0]	Nur	To Dits	0	R/W	
		D3	A10DF0	output disable delay time	1		1	Null	3.5	1	10,00	
					1		0		2.5			
					0		1		1.5			
				-	0		0		0.5			
		D3	-	reserved	0.40	<u>۱۸/۳</u>	12.07	-	loit ovelee	-	- D/A/	U when being read.
		D2 D1	A10W12	Areas 10-9 wait control	A1(	1 1 1	[2:0]	V	valt cycles	1	K/VV	
		D0	A10WT0			1	0		6	1		
					1	0	1		5			
					1	0	0		4			
					0	1	1		3			
					0	1	0		2			
					0		1		1 0			

Register name	Address	Bit	Name	Function		Setting	Init.	R/W	Remarks
Areas 8–7	0048128	DF-9	-	reserved		_	-	_	0 when being read.
set-up register	(HW)	D8	A8DRA	Area 8 DRAM selection	1 Used	0 Not used	0	R/W	Ť
		D7	A7DRA	Area 7 DRAM selection	1 Used	0 Not used	0	R/W	
		D6	A8SZ	Areas 8–7 device size selection	1 8 bits	0 16 bits	0	R/W	
		D5	A8DF1	Areas 8–7	A8DF[1:0]	Number of cycles	1	R/W	
		D4	A8DF0	output disable delay time	1 1	3.5	1		
					1 0	2.5			
					0 1	1.5			
					0 0	0.5			
		D3	-	reserved			-	-	0 when being read.
		D2	A8WT2	Areas 8–7 wait control	A8WT[2:0	] Wait cycles	1	R/W	
		D1	A8WT1		1 1 1	7	1		
		D0	A8WT0		1 1 0	6	1		
					1 0 1	5			
					1 0 0	4			
					0 1 1	3			
					0 1 0	2			
					0 0 1	1			
					0 0 0	0			
Areas 6–4	004812A	DF-E	-	reserved		-	-	-	0 when being read.
set-up register	(HW)	DD	A6DF1	Area 6	A6DF[1:0]	Number of cycles	1	R/W	
		DC	A6DF0	output disable delay time		3.5	1		
						2.5			
						1.5			
				record	0 0	0.5			0 when being read
			- 46WT2	Area 6 wait control	A6\W/T[2·0	1 Wait cycles	1	= R/M	o when being read.
			A6WT1		1 1 1	7	1	1011	
		D8	A6WT0			6	1		
					1 0 1	5			
					1 0 0	4			
					0 1 1	3			
					0 1 0	2			
					0 0 1	1			
					0 0 0	0			
		D7	-	reserved		-	-	-	0 when being read.
		D6	A5SZ	Areas 5–4 device size selection	1 8 bits	0 16 bits	0	R/W	
		D5	A5DF1	Areas 5–4	A5DF[1:0]	Number of cycles	1	R/W	
		D4	A5DF0	output disable delay time		3.5	1		
						2.5			
						1.5			
		<b>D</b> 2		received	0 0	0.5			O when heing read
		D3 D2	- 45WT2	Areas 5–4 wait control	Δ5\W/T[2·0	1 Wait cycles	-	= R/M	o when being read.
		D1	A5WT1		1 1 1	7	1	1011	
		D0	A5WT0			6	1		
					1 0 1	5			
					1 0 0	4			
					0 1 1	3			
					0 1 0	2			
					0 0 1	1			
					0 0 0	0			
TTBR write	004812D	D7	TBRP7	TTBR register write protect	Writing 010	11001(0x59)	0	W	Undefined in read.
protect register	(B)	D6	TBRP6		removes th	e TTBR (0x48134)	0		
		D5	TBRP5		write protect	ction.	0		
		D4	TBRP4		Writing othe	er data sets the	0		
		D3	TBRP3		write protect	tion.	0		
		D2	TBRP2				0		
		D1	TBRP1				0		
1		00 1	I BRP0	1	1		10		1

Register name	Address	Bit	Name	Function			Se	ttin	7	Init	R/W	Remarks
Register name	Audi 033							L.	9 En alt la d		DAA	Remarka
Bus control	004812E		RECLK	BCLK output control	1	FD	xed at H	0	Enabled	0	R/W	
register	(HW)	DE	-					-		0	-	vvriting 1 not allowed.
		DD	RESIS	Burst ROM burst mode selection	1	8-8	successive	0	4-successive	0	R/W	
		DC	REDO	DRAM page mode selection	1	EL	00	0	Fast page	0	R/W	
		DB	RCA1	Column address size selection	F	RC/	4[1:0]		Size	0	R/W	
		DA	RCA0		· ·	1	1		11	0		
						1	0		10			
						0			9			
					(	0	0		8			
		D9	RPC2	Refresh enable	1	Er	nabled	0	Disabled	0	R/W	
		D8	RPC1	Refresh method selection	1	Se	elf-refresh	10	CBR-refresh	0	R/W	
		D7	RPC0	Refresh RPC delay setup	1	2.0	0	0	1.0	0	R/W	
		D6	RRA1	Refresh RAS pulse width		KR/	A[1:0] [	Num	ber of cycles	0	R/W	
		D5	RRAO	selection		1	1		5	0		
						1	0		4			
						0	1		3			
					(	0	0		2			
		D4	-	reserved				-		0	-	Writing 1 not allowed.
		D3	SBUSST	External interface method selection	1	#E	BSL	0	A0	0	R/W	
		D2	SEMAS	External bus master setup	1		usting	0	Nonexisten	t 0	R/W	
		U1	SEPD	External power-down control	1	E	habled	0	Disabled	0	R/W	
L		00	SWAITE		1	Er	INDIED	0	Disabled	0	K/W	
DRAM timing	0048130	DF-C	-	reserved		-		-		-	-	0 when being read.
set-up register	(HW)	DB	A3EEN	Area 3 emulation	1	Int	ernal RON	10	Emulation	1	R/W	
		DA	CEFUNC1	#CE pin function selection	CF	FU	NC[1:0]	#(	CE output	0	R/W	
		D9	CEFUNC0			1	X #	¢CE7	//8#CE17/18	0		
					L (	0	1	#C	E6#CE17			
					(	0	0	#C	E4#CE10			
		D8	CRAS	Successive RAS mode setup	1	SL		0	Normai	0	R/W	
			RPRC1	DRAM DAS procharge system coloction	R			Num	ber of cycles		R/W	
		00	RPRCU	RAS precharge cycles selection		1			4	0		
					Ι.	0			3			
						0			2 1			
		D5		reserved	<u> </u>	0	0					0 when being read
		D4	CASC1	DRAM		20	C[1:0]	dum	her of cycles	0	R/W	o when being read.
			CASCO	CAS cycles selection		1		vum	4	0		
		20	CACCO			1			3	ľ		
						0	1		2			
						0	0		1			
		D2	-	reserved		-	-	-		-	-	0 when being read.
		D1	RASC1	DRAM	R	AS	C[1:0]	Num	ber of cycles	0	R/W	, i i i i i i i i i i i i i i i i i i i
		D0	RASC0	RAS cycles selection		1	1		4	0		
					· ·	1	0		3			
					- (	0	1		2			
						0	0		1			
Access control	0048132	DF	A18IO	Area 18, 17 internal/external access	1	Int	ternal	0	External	0	R/W	
register	(HW)	DE	A16IO	Area 16, 15 internal/external access		ac	cess		access	0	R/W	1
		DD	A14IO	Area 14, 13 internal/external access						0	R/W	
		DC	A12IO	Area 12, 11 internal/external access						0	R/W	
		DB	-	reserved		-		-		0	-	0 when being read.
		DA	A8IO	Area 8, 7 internal/external access	1	Int	ternal	0	External	0	R/W	
		D9	A6IO	Area 6 internal/external access		ac	cess		access	0	R/W	
		D8	A5IO	Area 5, 4 internal/external access						0	R/W	
		D7	A18EC	Area 18, 17 endian control	1	Bi	g endian	0	Little endian	0	R/W	
		D6	A16EC	Area 16, 15 endian control						0	R/W	
		D5	A14EC	Area 14, 13 endian control						0	R/W	
		D4	A12EC	Area 12, 11 endian control						0	R/W	
		D3	A10EC	Area 10, 9 endian control						0	R/W	
		D2	A8EC	Area 8, 7 endian control						0	R/W	
		D1	A6EC	Area 6 endian control						0	R/W	
1		D0	A5EC	Area 5, 4 endian control		1				0	R/W	1

Register name	Address	Bit	Name	Function		(	Settir	ng	Init.	R/W	Remarks
TTBR low-	0048134	DF	TTBR15	Trap table base address [15:10]					0	R/W	
order register	(HW)	DE	TTBR14						0		
_		DD	TTBR13						0		
		DC	TTBR12						0		
		DB	TTBR11						0		
		DA	TTBR10						0		
		D9	TTBR09	Trap table base address [9:0]		Fi	xed a	at O	0	R	0 when being read.
		D8	TTBR08						0		Writing 1 not allowed.
		D7	TTBR07						0		
		D6	TTBR06						0		
		D5	TTBR05						0		
		D4	TTBR04						0		
		D3	TTBR03						0		
		D2	TTBR02						0		
			TTBROD								
		DU	TTDDOG	T					0		
TIBR nign-	0048136		TTER33	Trap table base address [31:28]		F	xea a	at U	0	ĸ	0 when being read.
order register	(ПVV)		TTPP24								writing i not allowed.
			TTERST								
		DB	TTBR2B	Tran table base address [27:16]	The	o initial va	ا ،میار		0	R/W	
			TTBR2A				nuc. v	5,000	<u> </u>	10,44	
			TTBR29								
		D9	TTBR28								
			TTBR27								
		D6	TTBR26								
		D5	TTBR25								
		D4	TTBR24								
		D3	TTBR23								
		D2	TTBR22								
		D1	TTBR21								
		D0	TTBR20								
G/A read signal	0048138	DF	A18AS	Area 18, 17 address strobe signal	1	Enabled	C	Disabled	0	R/W	
control register	(HW)	DE	A16AS	Area 16, 15 address strobe signal					0	R/W	
	. ,	DD	A14AS	Area 14, 13 address strobe signal	1				0	R/W	
		DC	A12AS	Area 12, 11 address strobe signal	1				0	R/W	
		DB	-	reserved			-		0	-	0 when being read.
		DA	A8AS	Area 8, 7 address strobe signal	1	Enabled	C	Disabled	0	R/W	
		D9	A6AS	Area 6 address strobe signal					0	R/W	
		D8	A5AS	Area 5, 4 address strobe signal					0	R/W	
		D7	A18RD	Area 18, 17 read signal	1	Enabled	C	Disabled	0	R/W	
		D6	A16RD	Area 16, 15 read signal					0	R/W	
		D5	A14RD	Area 14, 13 read signal					0	R/W	
		D4	A12RD	Area 12, 11 read signal					0	R/W	
		D3	-	reserved			_		0	-	0 when being read.
		D2	ASRD	Area 8, 7 read signal	1	Enabled		Disabled	0	R/W	
									0		
DCL K aslast	0049424		AJILD							10.00	O when heing read
register	(B)	D3		Area 1 access-speed	1	2 cycles	-		0		v when being read.
register	(5)	D3	-	reserved	• 1	2 090103		- Cycles	0	-	0 when being read
		D1	BCLKSEI 1	BCLK output clock selection	BCI	LKSEL[1·0	1	BCLK	0	R/W	s mon boing read.
		D0	BCLKSELO		1	1 1	1	PLL CLK	ō		
					1	1 0		SC3_CLK			
					C	) 1	1	BCU_CLK			
					0	0 0		CPU_CLK			

Register name	Address	Bit	Name	Function		Set	ting	9	Init.	R/W	Remarks
16-bit timer 0	0048180	DF	CR0A15	16-bit timer 0 comparison data A		0 to 6	655	35	Х	R/W	
comparison	(HW)	DE	CR0A14	CR0A15 = MSB					Х		
register A		DD	CR0A13	CR0A0 = LSB					Х		
		DC	CR0A12						Х		
		DB	CR0A11						Х		
		DA	CR0A10						Х		
		D9	CR0A9						Х		
		D8	CR0A8						Х		
		D7	CR0A7						Х		
		D6	CR0A6						Х		
		D5	CR0A5						Х		
		D4	CR0A4						Х		
		D3	CR0A3						Х		
		D2	CR0A2						X		
		D1	CRUA1						X		
		DU	CRUAU						X		
16-bit timer 0	0048182	DF	CR0B15	16-bit timer 0 comparison data B		0 to 6	555	35	X	R/W	
comparison	(HW)	DE	CR0B14	CR0B15 = MSB					X		
register B			CR0B13	CR0B0 = LSB					X		
			CRUB12						×		
			CROB11						Ŷ		
			CROBIO						Ŷ		
			CROBS						x		
		D7	CR0B7						x		
		D6	CR0B6						x		
		D5	CR0B5						X		
		D4	CR0B4						х		
		D3	CR0B3						х		
		D2	CR0B2						х		
		D1	CR0B1						Х		
		D0	CR0B0						Х		
16-bit timer 0	0048184	DF	TC015	16-bit timer 0 counter data		0 to 6	655	35	Х	R	
counter data	(HW)	DE	TC014	TC015 = MSB					Х		
register		DD	TC013	TC00 = LSB					Х		
		DC	TC012						Х		
		DB	TC011						Х		
		DA	TC010						X		
		D9	TC09						X		
			1008						×		
			TC07						Ŷ		
		D5	TC05						Ŷ		
			TC04						x		
		D3	TC03						x		
		D2	TC02						X		
		D1	TC01						х		
		D0	тс00						х		
16-bit timer 0	0048186	D7	-	reserved	İ	-	_		0	_	0 when being read
control register	(B)	D6	SELFM0	16-bit timer 0 fine mode selection	1	Fine mode	0	Normal	0	R/W	
		D5	SELCRB0	16-bit timer 0 comparison buffer	1	Enabled	0	Disabled	0	R/W	
		D4	OUTINV0	16-bit timer 0 output inversion	1	Invert	0	Normal	0	R/W	
		D3	CKSL0	16-bit timer 0 input clock selection	1	External clock	0	Internal clock	0	R/W	
		D2	PTM0	16-bit timer 0 clock output control	1	On	0	Off	0	R/W	
		D1	PRESET0	16-bit timer 0 reset	1	Reset	0	Invalid	0	W	0 when being read.
		D0	PRUN0	16-bit timer 0 Run/Stop control	1	Run	0	Stop	0	R/W	

Register name	Address	Bit	Name	Function		Sett	ting	9	Init.	R/W	Remarks
16-bit timer 1	0048188	DF	CR1A15	16-bit timer 1 comparison data A		0 to 6	655	35	Х	R/W	
comparison	(HW)	DE	CR1A14	CR1A15 = MSB					х		
register A		DD	CR1A13	CR1A0 = LSB					х		
-		DC	CR1A12						Х		
		DB	CR1A11						Х		
		DA	CR1A10						Х		
		D9	CR1A9						Х		
		D8	CR1A8						Х		
		D7	CR1A7						Х		
		D6	CR1A6						Х		
		D5	CR1A5						Х		
		D4	CR1A4						х		
		D3	CR1A3						Х		
		D2	CR1A2						Х		
		D1	CR1A1						Х		
		D0	CR1A0						Х		
16-bit timer 1	004818A	DF	CR1B15	16-bit timer 1 comparison data B		0 to 6	655	35	Х	R/W	
comparison	(HW)	DE	CR1B14	CR1B15 = MSB					Х		
register B		DD	CR1B13	CR1B0 = LSB					Х		
		DC	CR1B12						Х		
		DB	CR1B11						Х		
		DA	CR1B10						Х		
		D9	CR1B9						Х		
		D8	CR1B8						Х		
		D7	CR1B7						Х		
		D6	CR1B6						Х		
		D5	CR1B5						Х		
		D4	CR1B4						Х		
		D3	CR1B3						Х		
		D2	CR1B2						Х		
		D1	CR1B1						X		
		DO	CR1B0						X		
16-bit timer 1	004818C	DF	TC115	16-bit timer 1 counter data		0 to 6	555	35	X	R	
counter data	(HW)	DE	TC114	TC115 = MSB					X		
register		DD	10113	TC10 = LSB					X		
		DC	10112						X		
		DB	TC111						X		
		DA	TC110						X		
		D9	1019						X		
		D8	1018						X		
			TC16						Ŷ		
		Do	1016						Ŷ		
		D3	TC13						Ŷ		
		D4	TC12						v		
		D3	TC12						x		
			TC11						x		
		D0	TC10						x		
16-bit timer 1	004818F	D7	-	reserved			_		0	_	0 when being read
control register	(B)	D6	SELFM1	16-bit timer 1 fine mode selection	1	Fine mode	0	Normal	0	R/W	o mien being reau.
- since register	(-)	D5	SELCRB1	16-bit timer 1 comparison buffer	1	Enabled	0	Disabled	0	R/W	
		- D4	OUTINV1	16-bit timer 1 output inversion	1	Invert	0	Normal	0	R/W	
		D3	CKSL1	16-bit timer 1 input clock selection	1	External clock	0	Internal clock	0	R/W	
		D2	PTM1	16-bit timer 1 clock output control	1	On	0	Off	0	R/W	
		D1	PRESET1	16-bit timer 1 reset	1	Reset	0	Invalid	0	W	0 when being read.
		D0	PRUN1	16-bit timer 1 Run/Stop control	1	Run	0	Stop	0	R/W	

Register name	Address	Bit	Name	Function		Set	ting	9	Init.	R/W	Remarks
16-bit timer 2	0048190	DF	CR2A15	16-bit timer 2 comparison data A		0 to 6	655	35	Х	R/W	
comparison	(HW)	DE	CR2A14	CR2A15 = MSB					Х		
register A		DD	CR2A13	CR2A0 = LSB					Х		
		DC	CR2A12						Х		
		DB	CR2A11						Х		
		DA	CR2A10						Х		
		D9	CR2A9						Х		
		D8	CR2A8						Х		
		D7	CR2A7						Х		
		D6	CR2A6						Х		
		D5	CR2A5						Х		
		D4	CR2A4						Х		
		D3	CR2A3						Х		
		D2	CR2A2						Х		
		D1	CR2A1						Х		
		D0	CR2A0						Х		
16-bit timer 2	0048192	DF	CR2B15	16-bit timer 2 comparison data B		0 to 6	655	35	Х	R/W	
comparison	(HW)	DE	CR2B14	CR2B15 = MSB					Х		
register B		DD	CR2B13	CR2B0 = LSB					Х		
		DC	CR2B12						X		
		DB	CR2B11						X		
		DA	CR2B10						X		
		D9	CR2B9						X		
			CR2B8						×		
			CR2B/						Ŷ		
		D5	CR2B5						Ŷ		
		D3	CR2B4						x		
		D3	CR2B3						x		
		D2	CR2B2						x		
		D1	CR2B1						х		
		D0	CR2B0						х		
16-bit timer 2	0048194	DF	TC215	16-bit timer 2 counter data		0 to 6	655	35	Х	R	
counter data	(HW)	DE	TC214	TC215 = MSB					Х		
register		DD	TC213	TC20 = LSB					Х		
		DC	TC212						Х		
		DB	TC211						Х		
		DA	TC210						Х		
		D9	TC29						X		
		D8	TC28						X		
			102/						×		
		D6	TC26						×		
			TC23						Ŷ		
			TC23						x		
		D2	TC22						x		
		D1	TC21						Х		
		D0	TC20						х		
16-bit timer 2	0048196	D7	-	reserved		-	_		0	_	0 when being read.
control register	(B)	D6	SELFM2	16-bit timer 2 fine mode selection	1	Fine mode	0	Normal	0	R/W	<u> </u>
-		D5	SELCRB2	16-bit timer 2 comparison buffer	1	Enabled	0	Disabled	0	R/W	
		D4	OUTINV2	16-bit timer 2 output inversion	1	Invert	0	Normal	0	R/W	
		D3	CKSL2	16-bit timer 2 input clock selection	1	External clock	0	Internal clock	0	R/W	
		D2	PTM2	16-bit timer 2 clock output control	1	On	0	Off	0	R/W	
		D1	PRESET2	16-bit timer 2 reset	1	Reset	0	Invalid	0	W	0 when being read.
		D0	PRUN2	16-bit timer 2 Run/Stop control	1	Run	0	Stop	0	R/W	

Register name	Address	Bit	Name	Function		Sett	ting	9	Init.	R/W	Remarks
16-bit timer 3	0048198	DF	CR3A15	16-bit timer 3 comparison data A		0 to 6	555	35	Х	R/W	
comparison	(HW)	DE	CR3A14	CR3A15 = MSB					х		
register A	, ,	DD	CR3A13	CR3A0 = LSB					х		
		DC	CR3A12						х		
		DB	CR3A11						х		
		DA	CR3A10						х		
		D9	CR3A9						х		
		D8	CR3A8						х		
		D7	CR3A7						х		
		D6	CR3A6						х		
		D5	CR3A5						х		
		D4	CR3A4						х		
		D3	CR3A3						Х		
		D2	CR3A2						Х		
		D1	CR3A1						Х		
		D0	CR3A0						Х		
16-bit timer 3	004819A	DF	CR3B15	16-bit timer 3 comparison data B		0 to 6	55	35	Х	R/W	
comparison	(HW)	DE	CR3B14	CR3B15 = MSB					Х		
register B		DD	CR3B13	CR3B0 = LSB					Х		
		DC	CR3B12						Х		
		DB	CR3B11						Х		
		DA	CR3B10						Х		
		D9	CR3B9						X		
		D8	CR3B8						X		
		D7	CR3B7						X		
		D6	CR3B6						X		
		D5	CR3B5						X		
		D4	CR3B4						X		
		D3	CR3B3						X		
		D2	CR3B2								
			CR3DI						$\hat{\mathbf{v}}$		
	0040400		TODAC			0.4-0		05	×		
10-bit timer 3	(LIM)		TC214	TC215 - MSP		0 10 6	000	30	$\hat{\mathbf{v}}$	ĸ	
rogistor	(ПМ)		TC314	TC30 - I SB					Ŷ		
register			TC312	1030 - 135					x		
		DB	TC311						x		
		DA	TC310						x		
		D9	TC39						x		
		D8	TC38						x		
		D7	TC37						х		
		D6	TC36						х		
		D5	TC35						х		
		D4	TC34						х		
		D3	TC33						х		
		D2	TC32						Х		
		D1	TC31						Х		
		D0	TC30						Х		
16-bit timer 3	004819E	D7	-	reserved		-	-		0	-	0 when being read.
control register	(B)	D6	SELFM3	16-bit timer 3 fine mode selection	1	Fine mode	0	Normal	0	R/W	
		D5	SELCRB3	16-bit timer 3 comparison buffer	1	Enabled	0	Disabled	0	R/W	
		D4	OUTINV3	16-bit timer 3 output inversion	1	Invert	0	Normal	0	R/W	
		D3	CKSL3	16-bit timer 3 input clock selection	1	External clock	0	Internal clock	0	R/W	
		D2		16-bit timer 3 clock output control	1	Un	0	UTT	0	K/W	O when heing re!
			PRESEIS	16-bit timer 3 Run/Stop control	1	Run	0	Stop	0	R/M/	o when being read.
1		00	LI ILONO	TIO-DR IIIIO O RUI/OLUP CUILIO		LIVUII	0	Juliop		11/17	1

Register name	Address	Bit	Name	Function		Sett	ting	9	Init.	R/W	Remarks
16-bit timer 4	00481A0	DF	CR4A15	16-bit timer 4 comparison data A		0 to 6	555	35	Х	R/W	
comparison	(HW)	DE	CR4A14	CR4A15 = MSB					х		
register A		DD	CR4A13	CR4A0 = LSB					х		
-		DC	CR4A12						х		
		DB	CR4A11						х		
		DA	CR4A10						Х		
		D9	CR4A9						х		
		D8	CR4A8						Х		
		D7	CR4A7						х		
		D6	CR4A6						Х		
		D5	CR4A5						Х		
		D4	CR4A4						х		
		D3	CR4A3						Х		
		D2	CR4A2						Х		
		D1	CR4A1						Х		
		D0	CR4A0						Х		
16-bit timer 4	00481A2	DF	CR4B15	16-bit timer 4 comparison data B		0 to 6	555	35	Х	R/W	
comparison	(HW)	DE	CR4B14	CR4B15 = MSB					Х		
register B		DD	CR4B13	CR4B0 = LSB					Х		
		DC	CR4B12						Х		
		DB	CR4B11						Х		
		DA	CR4B10						Х		
		D9	CR4B9						Х		
		D8	CR4B8						Х		
		D7	CR4B7						Х		
		D6	CR4B6						Х		
		D5	CR4B5						Х		
		D4	CR4B4						Х		
		D3	CR4B3						Х		
		D2	CR4B2						X		
		D1	CR4B1						X		
		DU	CR4B0						X		
16-bit timer 4	00481A4	DF	TC415	16-bit timer 4 counter data		0 to 6	555	35	X	R	
counter data	(HW)	DE	TC414	TC415 = MSB					X		
register		DD	TC413	1C40 = LSB					X		
		DC	TC412						X		
		DB	TC411						X		
		DA	10410								
		D9	1049						$\hat{\mathbf{v}}$		
			TC40						Ŷ		
			TC47						Ŷ		
		D5	TC40						Ŷ		
		D4	TC44						x		
		D3	TC43						x		
		D2	TC42						x		
		D1	TC41						x		
		D0	TC40						x		
16-bit timer 4	00481A6	_ D7	_	reserved			_		0	-	0 when being read
control register	(B)	D6	SELFM4	16-bit timer 4 fine mode selection	1	Fine mode	0	Normal	0	R/W	e mon boing roudi
<b>3</b>		D5	SELCRB4	16-bit timer 4 comparison buffer	1	Enabled	0	Disabled	0	R/W	
		D4	OUTINV4	16-bit timer 4 output inversion	1	Invert	0	Normal	0	R/W	
		D3	CKSL4	16-bit timer 4 input clock selection	1	External clock	0	Internal clock	0	R/W	
		D2	PTM4	16-bit timer 4 clock output control	1	On	0	Off	0	R/W	
		D1	PRESET4	16-bit timer 4 reset	1	Reset	0	Invalid	0	W	0 when being read.
		D0	PRUN4	16-bit timer 4 Run/Stop control	1	Run	0	Stop	0	R/W	

Register name	Address	Bit	Name	Function		Sett	ting	3	Init.	R/W	Remarks
16-bit timer 5	00481A8	DF	CR5A15	16-bit timer 5 comparison data A		0 to 6	55	35	Х	R/W	
comparison	(HW)	DE	CR5A14	CR5A15 = MSB					х		
register A	, ,	DD	CR5A13	CR5A0 = LSB					х		
		DC	CR5A12						х		
		DB	CR5A11						х		
		DA	CR5A10						х		
		D9	CR5A9						х		
		D8	CR5A8						х		
		D7	CR5A7						х		
		D6	CR5A6						Х		
		D5	CR5A5						Х		
		D4	CR5A4						Х		
		D3	CR5A3						Х		
		D2	CR5A2						Х		
		D1	CR5A1						Х		
		D0	CR5A0						Х		
16-bit timer 5	00481AA	DF	CR5B15	16-bit timer 5 comparison data B		0 to 6	55	35	Х	R/W	
comparison	(HW)	DE	CR5B14	CR5B15 = MSB					X		
register B		DD	CR5B13	CR5B0 = LSB					X		
		DC	CR5B12						X		
		DB	CR5B11						X		
		DA	CR5B10						X		
		D9	CR5B9								
			CR5B8								
			CRSBI						Ŷ		
		D0	CR5B5						Ŷ		
			CR5B4						x		
		D3	CR5B3						x		
		D2	CR5B2						x		
		D1	CR5B1						x		
		D0	CR5B0						х		
16-bit timer 5	00481AC	DF	TC515	16-bit timer 5 counter data		0 to 6	55	35	Х	R	
counter data	(HW)	DE	TC514	TC515 = MSB					Х		
register		DD	TC513	TC50 = LSB					Х		
		DC	TC512						Х		
		DB	TC511						Х		
		DA	TC510						Х		
		D9	TC59						X		
		D8	TC58						X		
			1057						X		
			1030						$\hat{\mathbf{v}}$		
		D3	TC54						Ŷ		
		D3	TC53						x		
		D2	TC52						x		
		D1	TC51						x		
		D0	TC50						x		
16-bit timer 5	00481AE	D7	-	reserved	<u> </u>	_	_		0	_	0 when being read.
control register	(B)	D6	SELFM5	16-bit timer 5 fine mode selection	1	Fine mode	0	Normal	0	R/W	
-		D5	SELCRB5	16-bit timer 5 comparison buffer	1	Enabled	0	Disabled	0	R/W	
		D4	OUTINV5	16-bit timer 5 output inversion	1	Invert	0	Normal	0	R/W	
		D3	CKSL5	16-bit timer 5 input clock selection	1	External clock	0	Internal clock	0	R/W	
		D2	PTM5	16-bit timer 5 clock output control	1	On	0	Off	0	R/W	
		D1	PRESET5	16-bit timer 5 reset	1	Reset	0	Invalid	0	W	0 when being read.
		D0	PRUN5	16-bit timer 5 Run/Stop control	1	Run	0	Stop	0	R/W	1

# 5 Power-Down Control

This chapter describes the controls used to reduce power consumption of the device.

## Points on power saving

The current consumption of the device varies greatly with the CPU's operation mode, the system clocks used, and the peripheral circuits operated.

Current consumption	low←					→high
CPU/BCU	SLEEP	HALT2	Operating	HALT2	HALT(basic)	Operating
System clock	-	OSC1	OSC1	OSC3	OSC3	OSC3
OSC3 oscillation circuit	OFF	OFF	OFF	ON	ON	ON
Prescaler/peripheral circuit	STOP					RUN

To reduce power consumption of the device, it is important that as many unnecessary circuits as possible be turned off. In particular, peripheral circuits operating at a fast-clock rate consume a large amount of current, so design the program so that these circuits are turned off whenever unnecessary.

### Power-saving in standby modes

When CPU processing is unnecessary, such as when waiting for an interrupt from key entries or peripheral circuits, place the device in standby mode to reduce current consumption.

Standby mode	Method to enter the mode	Circuits/functions stopped
Basic HALT mode	Execute the halt instruction after setting	CPU only
	HLT2OP (D3)/Clock option register	
	(0x40190) to "0".	
	When the #BUSREQ signal is asserted from	
	an external bus master while SEPD (D1)/Bus	
	control register (0x4812E) = "1".	
HALT2 mode	Execute the halt instruction after setting	CPU, BCU, and bus clock
SLEEP mode	Execute the slp instruction.	CPU, BCU, bus clock, high-speed (OSC3)
		oscillation circuit, prescaler, and peripheral
		circuits that use the prescaler output clocks

HLT2OP (D3)/Clock option register (0x40190) that is used to select a HALT mode is set to "0" (basic HALT mode) at initial reset.

- **Notes:** In systems in which DRAM is connected directly to the device, the refresh function is turned off during HALT2 and SLEEP modes.
  - The standby mode is cleared by interrupt generation (except for the basic HALT mode, which is set using an external bus master). Therefore, before entering standby mode, set the related registers to allow an interrupt to be used to clear the standby mode to be generated.

The low-speed (OSC1) oscillation circuit and clock timer continue operating even during SLEEP mode. If they are unnecessary, these circuits can also be turned off.

Function	Control bit	"1"	"0"	Default
Low-speed (OSC1) oscillation ON/OFF control	SOSC1(D0)/	ON	OFF	ON
	Power control register(0x40180)			

#### Switching over the system clocks

Normally, the system is clocked by the high-speed (OSC3) oscillation clock. If high-speed operation is unnecessary, switch the system clock to the low-speed (OSC1) oscillation clock and turn off the high-speed (OSC3) oscillation circuit. This helps to reduce current consumption. However, if DRAM is connected directly to the device, note that the refresh function is also turned off.

Even during operation using the high-speed (OSC3) oscillation clock, power reduction can also be achieved through the use of a system clock derived from the OSC3 clock by dividing it (1/1, 1/2, 1/4, or 1/8).

Function	Control bit	"1"	"0"	Default
System clock switch over	CLKCHG(D2)/	OSC3	OSC1	OSC3
	Power control register(0x40180)			
High-speed (OSC3) oscillation ON/OFF control	SOSC3(D1)/	ON	OFF	ON
	Power control register(0x40180)			
System clock division ratio selection	CLKDT(D[7:6])/	"11" =	= 1/8	1/1
	Power control register(0x40180)	"10" =	= 1/4	
		"01" =	= 1/2	
		"00" =	= 1/1	

### Turning off the prescaler and peripheral circuits

Current consumption can be reduced by turning off the peripheral circuits operating at high speed as much as possible. The circuits listed below are operated using a clock generated by the prescaler:

- 16-bit programmable timers 0 to 5 (watchdog timer)
- 8-bit programmable timers 0 to 3 (DRAM refresh, serial interface)
- A/D converter

If none of these circuits need to be used, turn off the prescaler. If some of these circuits need to be used, turn off all other unnecessary circuits and stop clock supply from the prescaler to those circuits.

Function	Control bit	"1"	"0"	Default
Prescaler ON/OFF	PSCON(D5)/Power control register(0x40180)	ON	OFF	ON
16-bit timer 0 clock control	P16TON0(D3)/16-bit timer 0 clock control register(0x40147)	ON	OFF	OFF
16-bit timer 0 Run/Stop	PRUN0(D0)/16-bit timer 0 control register(0x48186)	RUN	STOP	STOP
16-bit timer 1 clock control	P16TON1(D3)/16-bit timer 1 clock control register(0x40148)	ON	OFF	OFF
16-bit timer 1 Run/Stop	PRUN1(D0)/16-bit timer 1 control register(0x4818E)	RUN	STOP	STOP
16-bit timer 2 clock control	P16TON2(D3)/16-bit timer 2 clock control register(0x40149)	ON	OFF	OFF
16-bit timer 2 Run/Stop	PRUN2(D0)/16-bit timer 2 control register(0x48196)	RUN	STOP	STOP
16-bit timer 3 clock control	P16TON3(D3)/16-bit timer 3 clock control register(0x4014A)	ON	OFF	OFF
16-bit timer 3 Run/Stop	PRUN3(D0)/16-bit timer 3 control register(0x4819E)	RUN	STOP	STOP
16-bit timer 4 clock control	P16TON4(D3)/16-bit timer 4 clock control register(0x4014B)	ON	OFF	OFF
16-bit timer 4 Run/Stop	PRUN4(D0)/16-bit timer 4 control register(0x481A6)	RUN	STOP	STOP
16-bit timer 5 clock control	P16TON5(D3)/16-bit timer 5 clock control register(0x4014C)	ON	OFF	OFF
16-bit timer 5 Run/Stop	PRUN5(D0)/16-bit timer 5 control register(0x481AE)	RUN	STOP	STOP
8-bit timer 0 clock control	P8TON0(D3)/8-bit timer 0/1 clock control register(0x4014D)	ON	OFF	OFF
8-bit timer 0 Run/Stop	PTRUN0(D0)/8-bit timer 0 control register(0x40160)	RUN	STOP	STOP
8-bit timer 1 clock control	P8TON1(D7)/8-bit timer 0/1 clock control register(0x4014D)	ON	OFF	OFF
8-bit timer 1 Run/Stop	PTRUN1(D0)/8-bit timer 1 control register(0x40164)	RUN	STOP	STOP
8-bit timer 2 clock control	P8TON2(D3)/8-bit timer 2/3 clock control register(0x4014E)	ON	OFF	OFF
8-bit timer 2 Run/Stop	PTRUN2(D0)/8-bit timer 2 control register(0x40168)	RUN	STOP	STOP
8-bit timer 3 clock control	P8TON3(D7)/8-bit timer 2/3 clock control register(0x4014E)	ON	OFF	OFF
8-bit timer 3 Run/Stop	PTRUN3(D0)/8-bit timer 3 control register(0x4016C)	RUN	STOP	STOP

The same clock source must be used for the prescaler operating clock and the CPU operating clock. Therefore, when operating the CPU in low-speed with the OSC1 clock, the prescaler input clock must be switched according to the CPU operating clock. In this case, in order to prevent a malfunction in the peripheral circuit, the prescaler should be turned off before switching the CPU operating clock. After the CPU operating clock has been switched, switch the prescaler operating clock and then turn the prescaler on.

Function	Control bit	"1"	"0"	Default
Prescaler operating clock	PSCDT0 (D0)/Prescaler clock select register(0x40181)	OSC1	OSC3/	OSC3/
switch over			PLL	PLL

# 6 Basic External Wiring Diagram



Note: The above table is simply an example, and is not guaranteed to work.

# 7 Precautions on Mounting

The following shows the precautions when designing the board and mounting the IC.

## **Oscillation Circuit**

- Oscillation characteristics change depending on conditions (board pattern, components used, etc.). In particular, when a ceramic oscillator or crystal oscillator is used, use the oscillator manufacturer's recommended values for constants such as capacitance and resistance.
- Disturbances of the oscillation clock due to noise may cause a malfunction. Consider the following points to prevent this:
  - (1) Components which are connected to the OSC3 (OSC1), OSC4 (OSC2) and PLLC pins, such as oscillators, resistors and capacitors, should be connected in the shortest line.
  - (2) As shown in the figure below, make a Vss pattern as large as possible at circumscription of the OSC3 (OSC1) and OSC4 (OSC2) pins and the components connected to these pins. The same applies to the PLLC pin.

Furthermore, do not use this Vss pattern to connect other components than the oscillation system.



(3) When supplying an external clock to the OSC3 (OSC1) pin, the clock source should be connected to the OSC3 (OSC1) pin in the shortest line.

Furthermore, do not connect anything else to the OSC4 (OSC2) pin.

• In order to prevent unstable operation of the oscillation circuit due to current leak between OSC3 (OSC1) and VDD, please keep enough distance between OSC3 (OSC1) and VDD or other signals on the board pattern.

#### **Reset Circuit**

- The power-on reset signal which is input to the #RESET pin changes depending on conditions (power rise time, components used, board pattern, etc.). Decide the time constant of the capacitor and resistor after enough tests have been completed with the application product.
- In order to prevent any occurrences of unnecessary resetting caused by noise during operating, components such as capacitors and resistors should be connected to the #RESET pin in the shortest line.

#### **Power Supply Circuit**

- Sudden power supply variation due to noise may cause malfunction. Consider the following points to prevent this:
  - (1) The power supply should be connected to the VDD, and VSS pins with patterns as short and large as possible.

#### 7 PRECAUTIONS ON MOUNTING

(2) When connecting between the VDD and VSS pins with a bypass capacitor, the pins should be connected as short as possible.



### **Arrangement of Signal Lines**

unit.

- In order to prevent generation of electromagnetic induction noise caused by mutual inductance, do not arrange a large current signal line near the circuits that are sensitive to noise such as the oscillation unit and analog input unit.
- When a signal line is parallel with a high-speed line in long distance or intersects a high-speed line, noise may generated by mutual interference between the signals and it may cause a malfunction. Do not arrange a high-speed signal line especially near circuits that are sensitive to noise such as the oscillation



# 8 Electrical Characteristics

## 8.1 Absolute Maximum Rating

			-	(Vss=	=0V
Item	Symbol	Condition	Rated value	Unit	*
Supply voltage	Vdd		-0.3 to +4.0	V	
Input voltage	VI		-0.3 to VDD+0.5	V	1
High-level output current	Іон	1 pin	-10	mA	
		Total of all pins	-40	mA	
Low-level output current	lol	1 pin	10	mA	
		Total of all pins	40	mA	
Storage temperature	Tstg		-65 to +150	°C	

 $\ast$  Note 1: -0.3 V to 7.0 V is permissible in the case of 5 V tolerant pins.

## 8.2 Recommended Operating Conditions

#### 1) 3.3 V single power source

,					(Vd	D, Vss=	=0V
Item	Symbol	Condition	Min.	Тур.	Max.	Unit	*
Supply voltage	Vdd		2.70	-	3.60	V	
Input voltage	VI		Vss	-	Vdd	V	1
CPU operating clock frequency	fCPU		-	-	50	MHz	
External bus clock frequency	fBUS		-	-	33	MHz	
Low-speed oscillation frequency	fosc1		-	32.768	-	kHz	
Operating temperature	Та		-40	25	85	°C	
Input rise time (normal input)	tri		-	_	50	ns	
Input fall time (normal input)	tfi		-	-	50	ns	
Input rise time (schmitt input)	tri		-	-	5	ms	
Input fall time (schmitt input)	tfi		-	-	5	ms	

#### 2) 2.0 V single power source

			-		(00	D, V33-	-0 v
Item	Symbol	Condition	Min.	Тур.	Max.	Unit	*
Supply voltage	Vdd		1.80	2.00	2.20	V	
Input voltage	VI		Vss	-	Vdd	V	1
CPU operating clock frequency	fcpu		-	-	20	MHz	
External bus clock frequency	fBUS		-	-	20	MHz	
Low-speed oscillation frequency	fosc1		-	32.768	I	kHz	
Operating temperature	Та		-40	25	85	°C	
Input rise time (normal input)	tri		-	-	100	ns	
Input fall time (normal input)	tfi		-	-	100	ns	
Input rise time (schmitt input)	tri		-	-	10	ms	
Input fall time (schmitt input)	tfi		-	-	10	ms	

\* Note 1: Vss to 5.5 V is permissible in the case of 5 V tolerant pins.

## 8.3 DC Characteristics

#### 1) 3.3 V single power source

(	(Unless otherwise specified:	VDD=2.7V to 3.6V,	Vss=0V, Ta	a=-40°C to +85°C)
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Item	Symbol	Conditio	on	Min.	Тур.	Max.	Unit	*
Static current consumption	IDDS	Static state, Tj=85°C		-	-	90	μA	
Input leakage current	lu –			-1	-	1	μA	
Off-state leakage current	loz					1	μΑ	
High-level output voltage	Vон	loн=-2mA (Type1), loн=-6mA (Type2), Vpp=Min.		Vdd -0.4	-	-	V	
Low-level output voltage	Vol	IoL=2mA (Type1), IoL=6mA (Type2), VDD=Min.		-	-	0.4	V	
High-level input voltage	Vін	CMOS level, VDD=Max.	2.4	1	-	V		
Low-level input voltage	VIL	CMOS level, VDD=Min.		-	-	0.4	V	
Positive trigger input voltage	VT+	LVTTL schmitt		1.1	-	2.4	V	
Negative trigger input voltage	Vt-	LVTTL schmitt		0.6	-	1.8	V	
Hysteresis voltage	Vн	LVTTL schmitt		0.1	-	-	V	
Pull-up resistor	Rpu	V⊫0V	Other than DSIO	80	200	480	kΩ	
			DSIO	40	100	240	kΩ	
Pull-down resistor	Rpd	V⊫Vɒɒ (#ICEMD)		40	100	240	kΩ	
Input pin capacitance	Сі	f=1MHz, Vdd=0V		-	-	10	pF	
Output pin capacitance	Co	f=1MHz, Vdd=0V		_	_	10	pF	
I/O pin capacitance	Сю	f=1MHz, VDD=0V		_	_	10	рF	

#### 2) 2.0 V single power source

(Unless otherwise specified: VDD=2V±0.2V, Vss=0V, Ta=-40°C to +85°C)

Item	Symbol	Conditio	on	Min.	Тур.	Max.	Unit	*
Static current consumption	IDDS	Static state, Tj=85°C		-	-	80	μA	
Input leakage current	ILI				-	1	μA	
Off-state leakage current	loz			-1	-	1	μA	
High-level output voltage	Vон	Iон=-0.6mA (Type1), Iон=-	2mA (Type2),	Vdd	-	-	V	
		VDD=Min.		-0.2				
Low-level output voltage	Vol	IoL=0.6mA (Type1), IoL=2r	mA (Type2),	-	-	0.2	V	
		Vdd=Min.	Vdd=Min.					
High-level input voltage	Viн	CMOS level, VDD=Max.	1.6	_	-	V		
Low-level input voltage	VIL	CMOS level, VDD=Min.		-	-	0.3	V	
Positive trigger input voltage	VT+	CMOS schmitt		0.4	-	1.6	V	
Negative trigger input voltage	Vt-	CMOS schmitt		0.3	-	1.4	V	
Hysteresis voltage	Vн	CMOS schmitt		0	-	-	V	
Pull-up resistor	Rpu	V⊫0V	Other than DSIO	120	480	1200	kΩ	
			DSIO	60	240	600	kΩ	
Pull-down resistor	Rpd	V⊫Vdd (#ICEMD)		60	240	600	kΩ	
Input pin capacitance	Сі	f=1MHz, Vdd=0V		-	-	10	рF	
Output pin capacitance	Co	f=1MHz, Vdd=0V		-	-	10	pF	
I/O pin capacitance	Сю	f=1MHz, VDD=0V		_	_	10	рF	

## 8.4 Current Consumption

#### 1) 3.3 V power source

(Unless otherwise specified: VDD=2.7V to 3.6V, Vss=0V, Ta=-40°C to +85°C)

Item	Symbol	Condition		Min.	Тур.	Max.	Unit	*
Operating current	IDD1	When CPU is operating	20MHz	-	23	27	mΑ	1
			33MHz	-	35	42		
			50MHz	-	49	58		
	IDD2	HALT mode	20MHz	-	11	13	mA	2
			33MHz	-	15	18		
			50MHz	-	20	29		
	IDD3	HALT2 mode	20MHz	-	1.0	1.2	mA	2
			33MHz	-	1.8	2.0		
			50MHz	-	2.7	3.2		
	IDD4	SLEEP mode		-	1	30	μA	4
Clock timer operating current	IDDCT	When clock timer only is o	perating	-	7	-	μA	5
		OSC1 oscillation: 32kHz						

#### 2) 2.0 V power source

(Unless otherwise specified: VDD=2.0V±0.2V, Vss=0V, Ta=-40°C to +85°C)

Item	Symbol	Condition	Min.	Тур.	Max.	Unit	*
Operating current	IDD1	When CPU is operating, 20MHz	-	12	14	mA	1
	IDD2	HALT mode, 20MHz	-	5	6	mA	2
	IDD3	HALT2 mode, 20MHz		0.4	1.0	mA	3
	IDD4	SLEEP mode	-	1	30	μA	4
Clock timer operating current	IDDCT	When clock timer only is operating	-	1.5	-	μA	5
		OSC1 oscillation: 32kHz					

## 8.5 AC Characteristics

## 8.5.1 Symbol Description

#### tcyc: Bus-clock cycle time

- In x1 mode,  $t_{CYC} = 50 \text{ ns} (20 \text{ MHz})$  when the CPU is operated with a 20-MHz clock
  - $t_{CYC} = 30 \text{ ns} (33 \text{ MHz})$  when the CPU is operated with a 33-MHz clock
- In x2 mode,  $t_{CYC} = 50$  ns (20 MHz) when the CPU is operated with a 40-MHz clock

 $t_{CYC} = 40 \text{ ns} (25 \text{ MHz})$  when the CPU is operated with a 50-MHz clock

#### WC: Number of wait cycles

Up to 7 cycles can be set for the number of cycles using the BCU control register. Furthermore, it can be extended to a desired number of cycles by setting the #WAIT pin from outside of the IC.

The minimum number of read cycles with no wait (0) inserted is 1 cycle.

The minimum number of write cycles with no wait cycle (0) inserted is 2 cycles. It does not change even if 1-wait cycle is set. The write cycle is actually extended when 2 or more wait cycles are set.

When inserting wait cycles by controlling the #WAIT pin from outside of the IC, pay attention to the timing of the #WAIT signal sampling. Read cycles are terminated at the cycle in which the #WAIT signal is negated. Write cycles are terminated at the following cycle after the #WAIT signal is negated.

C1, C2, C3, Cn: Cycle number

C1 indicates the first cycle when the BCU transfers data from/to an external memory or another device. Similarly, C2 and Cn indicate the second cycle and nth cycle, respectively.

Cw: Wait cycle Indicates that the cycle is wait cycle inserted.

## 8.5.2 AC Characteristics Measurement Condition

Signal detection level:	Input signal	High level	VIH = VDD - 0.4 V
		Low level	$V_{IL} = 0.4 V$
	Output signal	High level	VOH = 1/2 VDD
		Low level	VOL = 1/2 VDD
	The following	applies when	n OSC3 is external clock input:
	Input signal	High level	$V_{IH} = 1/2 V_{DD}$
		Low level	VIL = 1/2 VDD
Input signal waveform:	Rise time (109	$\% \rightarrow 90\% \text{ Ve}$	DD) 5 ns
	Fall time (90%	$b \rightarrow 10\% \text{ VD}$	D) 5 ns
Output load capacitanc	e:	CL = 50  pF	

## 8.5.3 C33 Block AC Characteristic Tables

#### **External clock input characteristics**

(Note) These AC characteristics apply to input signals from outside the IC. The OSC3 input clock must be within VDD to Vss voltage range.

#### 1) 3.3 V single power source

<b>U</b> .		(Unless otherwise spe	ecified: Vss=0V, Ta=-40°0	C to +8	5°C)
Item	Symbol	Min.	Max.	Unit	*
High-speed clock cycle time	tсз	30		ns	
OSC3 clock input duty	<b>t</b> C3ED	45	55	%	
OSC3 clock input rise time	tı⊧		5	ns	
OSC3 clock input fall time	tir		5	ns	
BCLK high-level output delay time	tcd1		35	ns	
BCLK low-level output delay time	tcd2		35	ns	
Minimum reset pulse width	trst	6.tcyc		ns	

#### 2) 2.0 V single power source

· · · · · · · · · · · · ·					
	(Unless otherv	vise specified: VDD=2.0V	±0.2V, Vss=0V, Ta=-40°0	C to +8	5°C)
Item	Symbol	Min.	Max.	Unit	*
High-speed clock cycle time	tсз	50		ns	
OSC3 clock input duty	<b>t</b> C3ED	45	55	%	
OSC3 clock input rise time	tıF		5	ns	
OSC3 clock input fall time	tir		5	ns	
BCLK high-level output delay time	tcd1		60	ns	
BCLK low-level output delay time	tCD2		60	ns	
Minimum reset pulse width	test	6.tcyc		ns	

### **BCLK clock output characteristics**

(Note) These AC characteristic values are applied only when the high-speed oscillation circuit is used.

#### 1) 3.3 V single power source

	(Unless otherw	ise specified: VDD=2.7V to	o 3.6V, Vss=0V, Ta=-40°C	C to +8	5°C
Item	Symbol	Min.	Max.	Unit	*
BCLK clock output duty	tсвр	40	60	%	

#### 2) 2.0 V single power source

	Jnless othe	rwise specified: VDD=2.0V	′±0.2V, Vss=0V, Ta=-40°C	c to +8	5°C)
Item	Symbol	Min.	Max.	Unit	*
BCLK clock output duty	tcbd	40	60	%	

## **Common characteristics**

#### 1) 3.3 V single power source

(Unless otherwise specified: VDD=2.7V to 3.6V, Vss=0V, Ta=-40°C to +85°C								
Item	Symbol	Min.	Max.	Unit	*			
Address delay time	tad	-	10	ns	1			
#CEx delay time (1)	tce1	-	10	ns				
#CEx delay time (2)	tce2	-	10	ns				
Wait setup time	twтs	15	-	ns				
Wait hold time	twтн	0	-	ns				
Read signal delay time (1)	trdd1		10	ns	2			
Read data setup time	trds	15		ns				
Read data hold time	trdh	0		ns				
Write signal delay time (1)	twrd1		10	ns	3			
Write data delay time (1)	twdd1		10	ns				
Write data delay time (2)	twdd2	0	10	ns				
Write data hold time	twdн	0		ns				

### 2) 2.0 V single power source

(Unless otherwise specified: VDD=2.0V±0.2V, Vss=0V, Ta=-40°C to +85°							
Item	Symbol	Min.	Max.	Unit	*		
Address delay time	tad	-	20	ns	1		
#CEx delay time (1)	tce1	-	20	ns			
#CEx delay time (2)	tce2	-	20	ns			
Wait setup time	twтs	40	-	ns			
Wait hold time	twтн	0	-	ns			
Read signal delay time (1)	trdd1		20	ns	2		
Read data setup time	trds	40		ns			
Read data hold time	<b>t</b> rdh	0		ns			
Write signal delay time (1)	twrd1		20	ns	3		
Write data delay time (1)	twdd1		20	ns			
Write data delay time (2)	twdd2	0	20	ns			
Write data hold time	twdh	0		ns			

\* note 1) This applies to the #BSH and #BSL timings.

2) This applies to the #GAAS and #GARD timings.

3) This applies to the #GAAS timing.

## **SRAM read cycle**

#### 1) 3.3 V single power source

<b>U</b> .	(Unless otherwi	se specified: VDD=2.7V to	o 3.6V, Vss=0V, Ta=-40°0	C to +8	5°C
Item	Symbol	Min.	Max.	Unit	*
Read signal delay time (2)	trdd2		10	ns	
Read signal pulse width	trdw	tcyc(0.5+WC)-10		ns	
Read address access time (1)	tACC1		tcyc(1+WC)-25	ns	
Chip enable access time (1)	tceac1		tcyc(1+WC)-25	ns	
Read signal access time (1)	trdac1		tcyc(0.5+WC)-25	ns	

#### 2) 2.0 V single power source

(Unless otherwise specified: VDD=2.0V±0.2V, Vss=0V, Ta=-40°C to +85°C)

Item	Symbol	Min.	Max.	Unit	*
Read signal delay time (2)	trdd2		10	ns	
Read signal pulse width	trdw	tcyc(0.5+WC)-10		ns	
Read address access time (1)	tACC1		tcyc(1+WC)-60	ns	
Chip enable access time (1)	tCEAC1		tcyc(1+WC)-60	ns	
Read signal access time (1)	trdac1		tcyc(0.5+WC)-60	ns	

#### SRAM write cycle

#### 1) 3.3 V single power source

(Unles	ss otherw	vise specified: VDD=2.7V to	0 3.6V, Vss=0V, Ta=-40°0	C to +8	5°C
Item	Symbol	Min.	Max.	Unit	*
Write signal delay time (2)	twrd2		10	ns	
Write signal pulse width	twrw	tcyc(1+WC)-10		ns	

....

#### 2) 2.0 V single power source

(U	nless othe	rwise specified: VDD=2.0V	/±0.2V, Vss=0V, Ta=-40°C	to +8	5°C	)
Item	Symbol	Min.	Max.	Unit	*	
Write signal delay time (2)	twrd2		20	ns		
Write signal pulse width	twrw	tcyc(1+WC)-20		ns		

20

ns

ns

## DRAM access cycle common characteristics

#### 1) 3.3 V single power source

	(Unless otherwi	ise specified: VDD=2.7V t	to 3.6V, Vss=0V, Ta=-40°	C to +8	5°C
Item	Symbol	Min.	Max.	Unit	*
#RAS signal delay time (1)	trasd1		10	ns	
#RAS signal delay time (2)	trasd2		10	ns	
#RAS signal pulse width	trasw	tcyc(2+WC)-10		ns	
#CAS signal delay time (1)	tcasd1		10	ns	
#CAS signal delay time (2)	tcasd2		10	ns	
#CAS signal pulse width	tcasw	tcyc(0.5+WC)-10		ns	
Read signal delay time (3)	trdd3		10	ns	
Read signal pulse width (2)	trdw2	tcyc(2+WC)-10		ns	
Write signal delay time (3)	twrd3		10	ns	
Write signal pulse width (2)	twrw2	tcyc(2+WC)-10		ns	

#### 2) 2.0 V single power source

Write signal delay time (3)

Write signal pulse width (2)

nless other	wise specified: VDD=2.0V	±0.2V, Vss=0V, Ta=-40°C	c to +8	5°C)
Symbol	Min.	Max.	Unit	*
trasd1		20	ns	
trasd2		20	ns	
trasw	tcyc(2+WC)-20		ns	
tCASD1		20	ns	
tCASD2		20	ns	
tcasw	tcyc(0.5+WC)-20		ns	
trdd3		20	ns	
trdw2	tcyc(2+WC)-20		ns	
	Ness other Symbol tRASD1 tRASD2 tRASW tCASD1 tCASD2 tCASD2 tCASW tRDD3 tRDW2	Inless otherwise specified: VDD=2.0V   Symbol Min.   tRASD1 trasD2   tRASW tcyc(2+WC)-20   tcASD1 tcASD2   tcASD1 tcyc(2+WC)-20   tcASD2 tcyc(0.5+WC)-20   tcASW tcyc(0.5+WC)-20   tRD3 tcyc(2+WC)-20	Inless otherwise specified: VbD=2.0V±0.2V, Vss=0V, Ta=-40°C   Symbol Min. Max.   tRASD1 20 20   tRASD2 20 20   tRASD1 20 20   tRASD2 20 20   tCASD1 20 20   tCASD2 20 20   tCASW tCYC(0.5+WC)-20 20   tRD3 20 20   tRDW2 tCYC(2+WC)-20 20	Inless otherwise specified: Vbb=2.0V±0.2V, Vss=0V, Ta=-40°C to +8   Symbol Min. Max. Unit   tRASD1 20 ns transport transport ns   tRASD2 20 ns transport transport ns transport transport transport transport ns transport transport ns transport transport ns transport transport ns transport transport transport transport ns transport t

tcyc(2+WC)-20

twrd3

twrw2

## DRAM random access cycle and DRAM fast-page cycle

#### 1) 3.3 V single power source

	Unless otherwise	specified: VDD=2.7V to	o 3.6V, Vss=0V, Ta=-40°C	C to +8	5°C
Item	Symbol	Min.	Max.	Unit	*
Column address access time	<b>t</b> ACCF		tcyc(1+WC)-25	ns	
#RAS access time	<b>t</b> RACF		tcyc(1.5+WC)-25	ns	
#CAS access time	<b>t</b> CACF		tcyc(0.5+WC)-25	ns	

#### 2) 2.0 V single power source

(Unless otherwise specified: VDD=2.0V±0.2V, Vss=0V, Ta=-40°C to +85°C)

Item	Symbol	Min.	Max.	Unit	*
Column address access time	<b>t</b> ACCF		tcyc(1+WC)-60	ns	
#RAS access time	<b>t</b> RACF		tcyc(1.5+WC)-60	ns	
#CAS access time	<b>t</b> CACF		tcyc(0.5+WC)-60	ns	

#### EDO DRAM random access cycle and EDO DRAM page cycle

#### 1) 3.3 V single power source

	(Unless otherwise	specified: VDD=2.7V t	o 3.6V, Vss=0V, Ta=-40°0	C to +8	5°C
Item	Symbol	Min.	Max.	Unit	*
Column address access time	TACCE		tcyc(1.5+WC)-25	ns	
#RAS access time	<b>TRACE</b>		tcyc(2+WC)-25	ns	
#CAS access time	<b>t</b> CACE		tcyc(1+WC)-20	ns	
Read data setup time	trds2	20		ns	

#### 2) 2.0 V single power source

(Unless otherwise specified: VDD=2.0V±0.2V, Vss=0V, Ta=-40°C to +85°C)

Item	Symbol	Min.	Max.	Unit	*
Column address access time	<b>t</b> ACCE		tcyc(1.5+WC)-60	ns	
#RAS access time	<b>t</b> RACE		tcyc(2+WC)-60	ns	
#CAS access time	<b>t</b> CACE		tcyc(1+WC)-60	ns	
Read data setup time	trds2	20		ns	

## **Burst ROM read cycle**

#### 1) 3.3 V single power source

	(Unless otherwise s	pecified: VDD=2.	7V to 3.6V, Vss=0V, Ta=-40°0	C to +8	5°C
Item	Symbol	Min.	Max.	Unit	*
Read address access time (2)	tACC2		tcyc(1+WC)-25	ns	
Chip enable access time (2)	tceac2		tcyc(1+WC)-25	ns	
Read signal access time (2)	trdac2		tcyc(0.5+WC)-25	ns	
Burst address access time	tассв		tcyc(1+WC)-25	ns	

#### 2) 2.0 V single power source

(Unless otherwise specified: VDD=2.0V±0.2V, Vss=0V, Ta=-40°C to +85°C)

Item	Symbol	Min.	Max.	Unit	*
Read address access time (2)	tACC2		tcyc(1+WC)-60	ns	
Chip enable access time (2)	tceac2		tcyc(1+WC)-60	ns	
Read signal access time (2)	trdac2		tcyc(0.5+WC)-60	ns	
Burst address access time	tассв		tcyc(1+WC)-60	ns	

### External bus master and NMI

## 1) 3.3 V single power source

(Unl	ess otherw	ise specified: VDD=2.7V to	o 3.6V, Vss=0V, Ta=-40°0	C to +8	5°C
Item	Symbol	Min.	Max.	Unit	*
#BUSREQ signal setup time	<b>t</b> BRQS	15		ns	
#BUSREQ signal hold time	<b>t</b> BRQH	0		ns	
#BUSACK signal output delay time	<b>t</b> BAKD		10	ns	
High-impedance $\rightarrow$ output delay time	tz2E		10	ns	
$Output \to high\text{-}impedance \ delay \ time$	tB2Z		10	ns	
#NMI pulse width	tnmiw	30		ns	

#### 2) 2.0 V single power source

5 1	(Unless other	wise specified: VDD=2.0	V±0.2V, Vss=0V, Ta=-40°	C to +8	5°C
ltem	Symbol	Min.	Max.	Unit	*
#BUSREQ signal setup time	<b>t</b> BRQS	40		ns	
#BUSREQ signal hold time	<b>t</b> BRQH	0		ns	
#BUSACK signal output delay time	<b>t</b> BAKD		20	ns	
High-impedance $\rightarrow$ output delay time	tz2E		20	ns	
$Output \rightarrow high-impedance delay time$	tB2Z		20	ns	
#NMI pulse width	<b>t</b> NMIW	90		ns	

## Input, Output and I/O port

## 1) 3.3 V single power source

(Unles	ss otherw	vise specified: VDD=2.7V to	o 3.6V, Vss=0V, Ta=-40°C	C to +8	5°C
Item	Symbol	Min.	Max.	Unit	*
Input data setup time	tinps	20		ns	
Input data hold time	tinph	10		ns	
Output data delay time	toutd		20	ns	

## 2) 2.0 V single power source

(Unless otherwise specified: VDD=2.0V±0.2V, Vss=0V, Ta=-40°C to +85°C
---

Item	Symbol	Min.	Max.	Unit	*
Input data setup time	tinps	40		ns	
Input data hold time	tinph	20		ns	
Output data delay time	toutd		30	ns	

## 8.5.4 C33 Block AC Characteristic Timing Charts

## Clock

(1) When an external clock is input (in x1 speed mode):







#### SRAM read cycle (basic cycle: 1 cycle)

\*1 tRDH is measured with respect to the first signal change (negation) from among the #RD, #CEx and A[23:0] signals.



#### SRAM read cycle (when a wait cycle is inserted)

\*1 tRDH is measured with respect to the first signal change (negation) from among the #RD, #CEx and A[23:0] signals.



## SRAM write cycle (basic cycle: 2 cycles)

#### SRAM write cycle (when wait cycles are inserted)





#### DRAM random access cycle (basic cycle)

\*1 tRDH is measured with respect to the first signal change (negation) of either the #RD or the A[23:0] signals.



#### DRAM fast-page access cycle

\*1 tRDH is measured with respect to the first signal change (negation) of either the #RD or the A[23:0] signals.



### EDO DRAM random access cycle (basic cycle)

\*1 tRDH is measured with respect to the first signal change (negation) of either the #RD or the #RASx signals.



#### EDO DRAM page access cycle

\*1 tRDH is measured with respect to the first signal change from among the #RD (negation), #RASx (negation) and #CAS (rise) signals.





### **DRAM self-refresh cycle**



## Burst ROM read cycle



\*1 tRDH is measured with respect to the first signal change (negation) from among the #RD, #CEx and A[23:0] signals.

#### **#BUSREQ, #BUSACK and #NMI timing**



\*1 eBUS\_OUT indicates the following pins: A[23:0], #RD, #WRL, #WRH, #HCAS, #LCAS, #CE[17:4], D[15:0]

## I/O port timing



## 8.6 Oscillation Characteristics

Oscillation characteristics change depending on conditions (board pattern, components used, etc.). Use the following characteristics as reference values. In particular, when a ceramic or crystal oscillator is used, use the oscillator manufacturer recommended values for constants such as capacitance and resistance.

## OSC1 crystal oscillation

(Unless otherwise specified: crystal=Q11C02RX<sup>#1</sup> 32.768kHz, Rf1=20MΩ, CG1=CD1=15pF<sup>#2</sup>)

Item	Symbol	Condition	Min.	Тур.	Max.	Unit	*
Operating temperature	Та	VDD=2.7V to 3.6V	-40		85	°C	
		VDD=1.9V to 2.2V	-40		85	°C	
		VDD=1.8V to 2.2V	0		70	°C	

#1 Q11C02RX: Crystal resonator made by Seiko Epson

#2 "CG1=CD1=15pF" includes board capacitance.

(Unless otherwise specified: VDD=3.3V, Vss=0V, crystal=Q11C02RX<sup>#1</sup> 32.768kHz,

Rf	1 <b>=20M</b> Ω	, CG1=C	01= <b>15</b> pF <sup>‡</sup>	<sup>#2</sup> , Ta=2	5°C)
		_			

Item	Symbol	Condition	Min.	Тур.	Max.	Unit	*
Oscillation start time	tsta1				3	sec	
External gate/drain capacitance	CG1, CD1	Cg1=CD1,	5		25	pF	
		including board capacitance					
Frequency/IC deviation	Δf/ΔIC		-10		10	ppm	
Frequency/power voltage deviation	$\Delta f/\Delta V$		-10		10	ppm/V	
Frequency adjustment range	Δf/ΔCG	CG=5 to 25pF	50			ppm	

#1 Q11C02RX: Crystal resonator made by Seiko Epson

#2 "CG1=CD1=15pF" includes board capacitance.

(Unless otherwise specified: VDD=2.0V, Vss=0V, crystal=Q11C02RX<sup>#1</sup> 32.768kHz, Pfr-20MO, Cot-Cot-15pF<sup>#2</sup> To-2500

		RI	1=2010152	, CG1=CL	01=15PF	‴², ra=2:	<u>J°C</u>
Item	Symbol	Condition	Min.	Тур.	Max.	Unit	*
Oscillation start time	tsta1				20	sec	
External gate/drain capacitance	CG1, CD1	C <sub>G1</sub> =C <sub>D1</sub> , including board capacitance	5		25	pF	
Frequency/IC deviation	Δf/ΔIC		-10		10	ppm	
Frequency/power voltage deviation	$\Delta f/\Delta V$		-10		10	ppm/V	
Frequency adjustment range	∆f/∆CG	CG=5 to 25pF	50			ppm	

#1 Q11C02RX: Crystal resonator made by Seiko Epson

#2 "CG1=CD1=15pF" includes board capacitance.

## **OSC3** crystal oscillation

Note: A "crystal resonator that uses a fundamental" should be used for the OSC3 crystal oscillation circuit.

(Unless otherwise specified: VDD=3.3V, Vss=0V, crystal=Q22MA306<sup>#1</sup> 33.8688MHz,

		,
$Rf_{2=1}M\Omega$	$C_{G1}=C_{D1}=15pF^{#2}$	Ta=25°C)

Item	Symbol	Condition	Min.	Тур.	Max.	Unit	*
Oscillation start time	tsta3	VDD=3.3V			10	ms	
		VDD=2.0V			25	ms	

#1 Q22MA306: Crystal resonator made by Seiko Epson

#2 "CG1=CD1=15pF" includes board capacitance.
#### **OSC3** ceramic oscillation

(Unless otherwise specified: Vss=0V, Ta=25°C) Тур. Item Symbol Condition Min. Max. Unit \* Oscillation start time tsta3 10MHz ceramic oscillator 10 ms 1 2 16MHz ceramic oscillator 10 ms 3 20MHz ceramic oscillator 10 ms 25MHz ceramic oscillator 4 5 ms 33MHz ceramic oscillator 5 5 ms

note)	No.	Ceramic	Recomm	nended c	onstants	Power voltage	Remarks
		oscillator	CG2 (pF)	CD2 (pF)	Rf2 (MΩ)	range (V)	(Manufacturer)
	1 CST10.0MTW		30	30	1	1.8 to 2.2	(Murata Mfg. corporation) *1
	2	CST16.00MXW0C1	5	5 5		1.8 to 2.2	(Murata Mfg. corporation)
	3	CST20.00MXW0H1	5	5	1	1.8 to 2.2	(Murata Mfg. corporation)
	4	CST25.00MXW0H1	5 5		1	2.7 to 3.6	(Murata Mfg. corporation)
	5	CST33.00MXZ040	Open	Open Open		2.7 to 3.6	(Murata Mfg. corporation)

\*1 This oscillator has a tendency to rise to the frequency of 0.3%.

### 8.7 PLL Characteristics

#### Setting the PLLS0 and PLLS1 pins (recommended operating condition)

VDD=2.7V to 3.6V

3

PLLS1	PLLS0	Mode	Fin (OSC3 clock)	Fout
1	1	x2	10 to 25MHz	20 to 50MHz
0	1	x4	10 to 12.5MHz	40 to 50MHz
0	0	PLL not used	-	-

 $VDD=2.0V\pm0.2V$ 

PLLS1	PLLS0	Mode	Fin (OSC3 clock)	Fout
1	1	x2	10MHz	20MHz
0	0	PLL not used	-	-

#### **PLL characteristics**

(Unless otherwise specified: VDD=2.7V to 3.6V, Vss=0V, crystal oscillator=Q3204DC<sup>#1</sup>, R1=4.7kΩ, C1=100pF, C2=5pF, Ta=-40°C to +85°C)

Item	Symbol	Condition	Min.	Тур.	Max.	Unit	*
Jitter (peak jitter)	tpj		-1		1	ns	
Lockup time	tpll				1	ms	

#1 Q3204DC: Crystal oscillator made by Seiko Epson

(Unless otherwise specified: VDD=2.0V±0.2V, Vss=0V, crystal oscillator=Q3204DC<sup>#1</sup>, R1=4.7kΩ, C1=100pF, C2=5pF, Ta=-40°C to +85°C)

Item	Symbol	Condition	Min.	Тур.	Max.	Unit	*
Jitter (peak jitter)	tpj		-2		2	ns	
Lockup time	tpll				2	ms	

#1 Q3204DC: Crystal oscillator made by Seiko Epson

## 9 Package

## 9.1 Plastic Package

#### QFP15-100pin



#### Limit of power consumption

The chip temperature of an LSI rises according to power consumption. The chip temperature can be calculated from environment temperature (Ta), thermal resistance ( $\theta$ ) and power consumption (PD).

Chip temperature  $(Tj) = Ta + (PD \times \theta) (^{\circ}C)$ 

As a guide, normally keep the chip temperature (Tj) lower than 85°C. The thermal resistance of the QFP15-100pin package is as follows:

Thermal resistance ( $^{\circ}C/W$ ) = 105 to 115 $^{\circ}C$  (75 to 85 $^{\circ}C$  for Cu lead frame)

This thermal resistance is a value under the condition that the measured device is hanging in the air and has no air-cooling. Thermal resistance greatly varies according to the mounting condition on the board and air-cooling condition.

(Unit: mm)

## **10 Pad Layout**





## 10.2 Pad Coordinate

(Unit: µm)

No.	Pad name	Х	Y
1	Vdd	-1,638	-2,015
2	#WRL/WR/#WE	-1,512	-2,015
3	#WRH/#BSH	-1,386	-2,015
4	#RD	-1,260	-2,015
5	#EMEMRD	-1,134	-2,015
6	#LCAS	-1,008	-2,015
7	#HCAS	-882	-2,015
8	Vss	-756	-2,015
9	D0	-630	-2.015
10	D1	-504	-2.015
11	D2	-378	-2.015
12	D3	-252	-2.015
13	D4	-126	-2.015
14	D5	120	-2 015
15	Von	126	-2 015
16		252	-2 015
17	D7	378	-2 015
18		504	-2.015
10		630	-2 015
20	D10	756	-2 015
20	D11	882	-2.015
21	Vee	1 002	-2,015
22	V35	1 13/	-2,015
23	D12	1,104	2,015
24	D13	1,200	-2,015
25	D15	1,500	-2,015
20	Vee	1,012	-2.015
28	40/#BSI	2 141	-1 512
29	A1	2,141	-1 386
30	Δ2	2,141	-1 260
31	Δ3	2,141	_1 134
32	Von	2,141	-1 008
33		2,141	-882
34	Δ5	2,141	-756
35	Δ6 Δ6	2,141	-630
36	A7	2,171	-504
27		2,141	279
20	V35	2,141	-570
20	A0	2,141	126
40	A9 A10	2,141	-120
40	A10	2,141	126
41	ATT Ver	2,141	250
42	VDD	2,141	202
43	A12	2,141	504
44		2,141	504
45	A14	2,141	030
40	Non	2,141	001
4/	V55	2,141	1 000
48		2,141	1,008
49		2,141	1,134
50		2,141	1,260
51		2,141	1,386
52	A20/P33	2,141	1,512

No.	Pad name	Х	Y
53	Vdd	1,638	2,015
54	A21/P34/#BUSREQ	1,512	2,015
55	A22/P35/#BUSACK	1,386	2,015
56	#CE9/P32	1,260	2,015
57	A23/P07/#SRDY1	1,134	2,015
58	P06/#SCLK1	1,008	2,015
59	P05/SOUT1	882	2,015
60	P04/SIN1	756	2,015
61	Vss	630	2.015
62	OSC1	504	2.015
63	OSC2	378	2.015
64	Vpp	252	2.015
65	#RESET	126	2.015
66	#NMI	0	2.015
67	FA10MD0	-126	2.015
68	FA10MD2	-252	2.015
69	Vss	-378	2,015
70	#CE8/P31/#BUSGET/#GARD	-504	2,015
71	P30/#WAIT	-630	2,015
72	P03/#SBDY0	-756	2,015
73	P02/#SCLK0	-882	2,015
74	P01/SOUT0	-1 008	2,015
75	P00/SIN0	-1 134	2,010
76	#CE5/P16/EXCL5	-1 260	2,010
77	#CE4/P15/EXCL4	-1 386	2,015
78		-1 512	2,010
79	Vss	-1 638	2,010
80	P14/FOSC1/DCLK	-2 141	1 512
81		-2 141	1 386
82	P12/EXCL2/T8LE2/DST2	-2 141	1,000
83	P11/EXCL1/T8UE1/DST1	-2 141	1 1 3 4
84		-2 141	1,104
85		-2 141	1,000
86	PLI S1	-2,141	756
87		-2,141	630
88	Vee	-2 1/1	504
80	#¥22SPD	-2,141	378
00	#X231 D	-2,141	252
01	0503	2,141	126
91		-2,141	120
92		-2,141	126
93	#CE10IN	-2,141	-120
94		-2,141	-252
90		-2,141	-370
90		-2,141	-504
91	#CE7/P21/#DWE/#CAAS	-2,141	-030
98	#CE7/P21/#DWE/#GAAS	-2,141	-/50
100		-2,141	-002
100	A20/ IN/2	-2,141	-1,008
101		-2,141	-1,134
102		-2,141	-1,260
103	A20/11/14	-2,141	-1,386
104	A27/TM5	-2,141	-1,512

## **Appendix A** <Reference> External Device Interface Timings

This section shows setup examples for setting timing conditions of the external system interface as a reference material used when configuring a system with external devices. Pay attention to the following precautions when using this material.

- The described AC characteristic values of external devices are standard values. They may differ from those of the devices actually used, so the actual setup values (number of cycles) should be determined by referring the manual or specification of the device to be used.
- It is necessary to set the timing values allowing ample margin according to the load capacitance of the bus and signal lines, number of devices to be connected, operating temperature range, I/O levels and other conditions. The number of cycles described in this section is an example and the conditions are not considered.
- The values described in "Time" column of the tables are simply calculated by multiplying the number of cycles by the cycle time. Conditions such as the output delay time of the device, delay due to wiring and load capacitance, and input setup time are not considered.
- The described contents are reference data and cannot be guaranteed to work.

## A.1 DRAM (70ns)

DRAW Interface setup examples – 7015											
Operating frequency	RAS precharge RAS cycle CAS cycle F		Refresh RAS pulse width	Refresh RPC delay							
20MHz	2	1	2	2	1						
25MHz	2	1	2	2	1						
33MHz	2	2	3	3	1						

\_\_\_\_\_

#### DRAM interface setup examples - 70ns

#### DRAM interface timing – 70ns

DRAM interface		Unit: ns		33MHz		25MHz		20MHz	
Parameter	Symbol	Min.	Max.	Cycle	Time	Cycle	Time	Cycle	Time
<common parameters=""></common>									
Random read/random write cycle time	trc	130	-	7	210	5	200	5	250
#RAS precharge time	<b>t</b> RP	50	-	2	60	2	80	2	100
#RAS pulse width	tras	70	10000	5	150	3	120	3	150
#CAS pulse width	tcas	20	10000	2.5	75	1.5	60	1.5	75
Row address setup time	<b>t</b> ASR	0	-	0.5	15	0.5	20	0.5	25
Row address hold time	<b>t</b> RAH	10	_	1.5	45	0.5	20	0.5	25
Column address setup time	tasc	0	-	0.5	15	0.5	20	0.5	25
#RAS→#CAS delay time	trcd	20	-	2.0	60	1.0	40	1.0	50
#RAS→column address delay time	<b>t</b> RAD	15	-	1.5	45	0.5	20	0.5	25
<read-cycle parameters=""></read-cycle>									
#RAS access time	<b>t</b> RAC	-	70	4.5	135	2.5	100	2.5	125
#CAS access time	tcac	-	20	2.5	75	1.5	60	1.5	75
Address access time	<b>t</b> AA	-	35	3.0	90	2.0	80	2.0	100
#OE access time	toac	-	20	4.5	135	2.5	100	2.5	125
Output buffer turn-off time	toff	0	20	2	60	2	80	2	100
<pre><write-cycle parameters=""></write-cycle></pre>									
Data input hold time	tdн	15	-	2.5	75	1.5	60	1.5	75
<fast-page mode=""></fast-page>									
Fast-page mode cycle time	tPC	45	-	3.0	90	2.0	80	2.0	100
Fast-page mode #CAS precharge time	tcp	10	-	0.5	15	0.5	20	0.5	25
Access time after #CAS precharge	<b>t</b> ACP	-	40	3.0	90	2.0	80	2.0	100
<refresh cycle=""></refresh>									
#CAS setup time	tcsr	10	-	1.0	30	1.0	40	1.0	50
#CAS hold time	<b>t</b> CHR	10	-	2.5	75	1.5	60	1.5	75
#RAS precharge→#CAS hold time	<b>t</b> PPC	10	-	1.0	30	1.0	40	1.0	50
#RAS pulse width (only in refresh cycle)	tras	70	10000	3.0	90	2.0	80	2.0	100



#### DRAM: 70ns, CPU: 33MHz, random read/write cycle

#### DRAM: 70ns, CPU: 33MHz, page-mode read/write cycle



#### DRAM: 70ns, CPU: 33MHz, CAS-before-RAS refresh cycle





DRAM: 70ns, CPU: 25/20MHz, random read/write cycle

## A.2 DRAM (60ns)

#### DRAM interface setup examples – 60ns

Operating frequency	RAS precharge cycle	RAS cycle CAS cycle Refresh		Refresh RAS pulse width	Refresh RPC delay
20MHz	1	1	2	2	1
25MHz	2	1	2	2	1
33MHz	2	2	2	3	1

#### DRAM interface timing - 60ns

DRAM interface		Unit: ns		33MHz		25MHz		20MHz	
Parameter	Symbol	Min.	Max.	Cycle	Time	Cycle	Time	Cycle	Time
<common parameters=""></common>									
Random read/random write cycle time	trc	110	-	6	180	5	200	4	200
#RAS precharge time	<b>t</b> RP	40	-	2	60	2	80	1	50
#RAS pulse width	tras	60	10000	4	120	3	120	3	150
#CAS pulse width	tcas	15	10000	1.5	45	1.5	60	1.5	75
Row address setup time	<b>t</b> ASR	0	-	0.5	15	0.5	20	0.5	25
Row address hold time	<b>t</b> rah	10		1.5	45	0.5	20	0.5	25
Column address setup time	tasc	0	-	0.5	15	0.5	20	0.5	25
#RAS→#CAS delay time	trcd	20	-	2.0	60	1.0	40	1.0	50
#RAS→column address delay time	<b>t</b> rad	15		1.5	45	0.5	20	0.5	25
<read-cycle parameters=""></read-cycle>									
#RAS access time	<b>t</b> rac	_	60	3.5	105	2.5	100	2.5	125
#CAS access time	tcac	—	15	1.5	45	1.5	60	1.5	75
Address access time	taa	_	30	2.0	60	2.0	80	2.0	100
#OE access time	toac	_	15	3.5	105	2.5	100	2.5	125
Output buffer turn-off time	toff	0	15	2	60	2	80	1	50
<write-cycle parameters=""></write-cycle>									
Data input hold time	tон	10	-	1.5	45	1.5	60	1.5	75
<fast-page mode=""></fast-page>									
Fast-page mode cycle time	tPC	40	-	2.0	60	2.0	80	2.0	100
Fast-page mode #CAS precharge time	tcp	10	-	0.5	15	0.5	20	0.5	25
Access time after #CAS precharge	<b>t</b> ACP	_	35	2.0	60	2.0	80	2.0	100
<refresh cycle=""></refresh>									
#CAS setup time	tcsr	10	-	1.0	30	1.0	40	1.0	50
#CAS hold time	<b>t</b> CHR	10	-	2.5	75	1.5	60	1.5	75
#RAS precharge→#CAS hold time	<b>t</b> PPC	10	-	1.0	30	1.0	40	1.0	50
#RAS pulse width (only in refresh cycle)	tras	60	10000	3.0	90	2.0	80	2.0	100



#### DRAM: 60ns, CPU: 33MHz, random read/write cycle

#### DRAM: 60ns, CPU: 33MHz, page-mode read/write cycle





#### DRAM: 60ns, CPU: 25MHz, random read/write cycle

#### DRAM: 60ns, CPU: 25MHz, page-mode read/write cycle



#### DRAM: 60ns, CPU: 25MHz, CAS-before-RAS refresh cycle





#### DRAM: 60ns, CPU: 20MHz, random read/write cycle

## A.3 ROM and Burst ROM

Operating	Normal r	ead cycle	Burst re	Output disable						
frequency	frequency Wait cycle		Wait cycle	Read cycle	delay cycle					
20MHz	2	3	1	2	1.5					
25MHz	3	4	1	2	1.5					
33MHz	3MHz 4 5		2	3	1.5					

#### Burst ROM and mask ROM interface setup examples

#### Burst ROM and mask ROM interface timing

Burst ROM and mask ROM interface				33MHz		25MHz		20MHz	
Parameter	Symbol	Min.	Max.	Cycle	Time	Cycle	Time	Cycle	Time
Access time	tacc	_	100	5	150	4	160	3	150
#CE output delay time	tce	_	100	5	150	4	160	3	150
#OE output delay time to		_	50	4.5	135	3.5	140	2.5	125
Burst access time	<b>t</b> BAC	-	50	3	90	2	80	2	100
Output disable delay time	tdf	0	40	1.5	45	1.5	60	1.5	75





RD data

RD data

X//

← tDF →

RD data

X///////X X//

#RD

D[15:0] -

#### APPENDIX A <REFERENCE> EXTERNAL DEVICE INTERFACE TIMINGS



## A.4 SRAM (55ns)

#### SRAM interface setup examples – 55ns

Operating	Read	l cycle	Write cycle	Output disable
frequency	Wait cycle	Read cycle		delay time
20MHz	1	2	2	1.5
25MHz	2	3	3	1.5
33MHz	2	3	3	1.5

#### SRAM interface timing – 55ns

SRAM interface			33MHz		25MHz		20MHz		
Parameter	Symbol	Min.	Max.	Cycle	Time	Cycle	Time	Cycle	Time
<read cycle=""></read>									
Read cycle time	trc	55	-	3	90	3	120	2	100
Address access time	tacc	-	55	3	90	3	120	2	100
#CE access time	tacs	-	55	3	90	3	120	2	100
#OE access time	toe	-	30	2.5	75	2.5	100	1.5	75
Output disable delay time	tонz	0	30	1.5	45	1.5	60	1.5	75
<write cycle=""></write>									
Write cycle time	twc	55	-	3	90	3	120	2	100
Address enable time	taw	50	-	2.5	75	2.5	100	1.5	75
Write pulse width	twp	45	-	2	60	2	80	1	50
Input data setup time tow 30 -		_	2	60	2	80	1	50	
Input data hold time	tdн	0	-	0.5	15	0.5	20	0.5	25

#### SRAM: 55ns, CPU: 33/25MHz, read cycle



#### SRAM: 55ns, CPU: 33/25MHz, write cycle





#### SRAM: 55ns, CPU: 20MHz, write cycle



## A.5 SRAM (70ns)

#### SRAM interface setup examples – 70ns

Operating	Read	l cycle	Write cycle	Output disable
frequency	Wait cycle	Read cycle		delay time
20MHz	2	3	3	1.5
25MHz	2	3	3	1.5
33MHz	3	4	4	1.5

#### SRAM interface timing – 70ns

SRAM interface			33MHz		25MHz		20MHz		
Parameter	Symbol	Min.	Max.	Cycle	Time	Cycle	Time	Cycle	Time
<read cycle=""></read>									
Read cycle time	trc	70	-	4	120	3	120	3	150
Address access time	tacc	-	70	4	120	3	120	3	150
#CE access time	tacs	_	70	4	120	3	120	3	150
#OE access time	toe	-	40	3.5	105	2.5	100	2.5	125
Output disable delay time	tонz	0	30	1.5	45	1.5	60	1.5	75
<write cycle=""></write>									
Write cycle time	twc	70	-	4	120	3	120	3	150
Address enable time	taw	60	-	3.5	105	2.5	100	2.5	125
Write pulse width	twp	55	-	3	90	2	80	2	100
Input data setup time tow 30 -		-	3	90	2	80	2	100	
Input data hold time tDH 0 -			-	0.5	15	0.5	20	0.5	25

#### SRAM: 70ns, CPU: 33MHz, read cycle



#### SRAM: 70ns, CPU: 33MHz, write cycle





## A.6 8255A

#### 8255A interface setup examples

Operating	Read	cycle	Write cycle	Output disable
frequency	Wait cycle	Read cycle		delay time
20MHz	9 *1	10	10	3.5
25MHz	11	12	12	3.5
33MHz	14	15	15	3.5 *2

#### 8255A interface timing

SRAM interface			33MHz		25MHz		20MHz		
Parameter	Symbol	Min.	Max.	Cycle	Time	Cycle	Time	Cycle	Time
<read cycle=""></read>									
Read cycle time	trc	300	-	15	450	12	480	10	500
Address access time	tacc	-	250	15	450	12	480	10	500
#CE access time tacs -				15	450	12	480	10	500
#OE access time	toe	-	250	14.5	435	11.5	460	9.5	475
Output disable delay time	tонz	10	150	3.5	105	3.5	140	3.5	175
<write cycle=""></write>									
Write cycle time	twc	430	I	15	450	12	480	10	500
Address enable time	taw	400	-	14.5	435	11.5	460	9.5	475
Write pulse width	twp	400	-	14	420	11	440	9	450
Input data setup time	tow	100	-	14	420	11	440	9	450
Input data hold time tDH 30 -		_	0.5	15	0.5	20	0.5	25	
*3									

- \*1 The S1C33S01 enables up to 7 cycles of wait-cycle insertion. If a number of wait cycles more than 7 cycles needs to be inserted, input the #WAIT signal from external hardware. Note that the interface must be set for SRAM type devices to insert wait cycles using the #WAIT pin. (Refer to "BCU (Bus Control Unit)" in the "S1C33S01 FUNCTION PART", for more information.)
- \*2 This setting cannot satisfy the 150 ns of output-disable delay time specification required for the 8255A. When implementing such a low-speed device in the system, the external bus must be separated by inserting a 3-state bus buffer at the output side (when viewed from the CPU) of the external system bus.
- \*3 If the data hold time that can be set is sufficient for the device, secure it by connecting a bus repeater to the external data bus D[15:0] or by inserting a latch at the output side of the external system interface.

## **Appendix B Pin Characteristics**

Pin No.	Signal name I/O cell Input characteristic Pou				Pull-up/ down	Remarks
1	#WRL/#WR/#WE	XBB1	note 2	Type 1		
2	#WRH/#BSH	XBB1	note 2	Type 1		
3	#RD	XBB1	note 2	Type 1		
4	#EMEMRD	XTB1T		Type 1		
5	#LCAS	XTB1T		Type 1		
6	#HCAS	XTB1T		Type 1		
7	Vss	XVSS				
8	D0	XBB1	CMOS	Type 1		note 1
9	D1	XBB1	CMOS	Type 1		note 1
10	D2	XBB1	CMOS	Type 1		note 1
11	D3	XBB1	CMOS	Type 1		note 1
12	D4	XBB1	CMOS	Type 1		note 1
13	D5	XBB1	CMOS	Type 1		note 1
14	Vdd	XVDD				
15	D6	XBB1	CMOS	Type 1		note 1
16	D7	XBB1	CMOS	Type 1		note 1
17	D8	XBB1	CMOS	Type 1		note 1
18	D9	XBB1	CMOS	Type 1		note 1
19	D10	XBB1	CMOS	Type 1		note 1
20	D11	XBB1	CMOS	Type 1		note 1
21	Vss	XVSS				
22	D12	XBB1	CMOS	Type 1		note 1
23	D13	XBB1	CMOS	Type 1		note 1
24	D14	XBB1	CMOS	Type 1		note 1
25	D15	XBB1	CMOS	Type 1		note 1
26	A0/#BSL	XBB1	note 2	Type 1		
27	A1	XBB1	note 2	Type 1		
28	A2	XBB1	note 2	Type 1		
29	A3	XBB1	note 2	Type 1		
30	Vdd	XVDD				
31	A4	XBB1	note 2	Type 1		
32	A5	XBB1	note 2	Type 1		
33	A6	XBB1	note 2	Type 1		
34	A7	XBB1	note 2	Type 1		
35	Vss	XVSS				
36	A8	XBB1	note 2	Type 1		
37	A9	XBB1	note 2	Type 1		
38	A10	XBB1	note 2	Type 1		
39	A11	XBB1	note 2	Type 1		
40	Vdd	XVDD				
41	A12	XBB1	note 2	Type 1		
42	A13	XBB1	note 2	Type 1		
43	A14	XBB1	note 2	Type 1		
44	A15	XBB1	note 2	Type 1		
45	Vss	XVSS				
46	A16	XBB1	note 2	Type 1		
47	A17	XBB1	note 2	Type 1		
48	A18	XBB1	note 2	Type 1		
49	A19	XBB1	note 2	Type 1		
50	A20/P33	XBG1	CMOS SCHMITT	Type 1		note 1
51	A21/P34/#BUSREQ	XBG1	CMOS SCHMITT	Type 1		note 1
52	A22/P35/#BUSACK	XBG1	CMOS SCHMITT	Type 1		note 1
53	#CE9/P32	XBG1	CMOS SCHMITT	Type 1		note 1
54	A23/P07/#SRDY1	XBG1	CMOS SCHMITT	Type 1		note 1

#### APPENDIX B PIN CHARACTERISTICS

Pin No.	Signal name	I/O cell name	Input characteristic	Power supply	Pull-up/ down	Remarks
55	P06/#SCLK1	XBG1	CMOS SCHMITT	Type 1		note 1
56	P05/SOUT1	XBG1	CMOS SCHMITT	Type 1		note 1
57	P04/SIN1	XBG1	CMOS SCHMITT	Type 1		note 1
58	Vss	XVSS				
59	OSC1	XLIN				
60	OSC2	XLOT				
61	Vdd	XVDD				
62	#RESET	XIBHP2	LVTTL/CMOS SCHMITT		Pull-up	
63	#NMI	XIBHP2	LVTTL/CMOS SCHMITT		Pull-up	
64	EA10MD0	XIBC	LVTTL/CMOS			
65	EA10MD1	XIBCP2	LVTTL/CMOS		Pull-up	
66	Vss	XVSS				
67	#CE8/P31/#BUSGET/#GARD	XBG1	CMOS SCHMITT	Type 1		note 1
68	P30/#WAIT	XBG1	CMOS SCHMITT	Type 1		note 1
69	P03/#SRDY0	XBG1	CMOS SCHMITT	Type 1		note 1
70	P02/#SCLK0	XBG1	CMOS SCHMITT	Type 1		note 1
71	P01/SOUT0	XBG1	CMOS SCHMITT	Type 1		note 1
72	P00/SIN0	XBG1	CMOS SCHMITT	Type 1		note 1
73	#CE5/P16/EXCL5	XBG1	CMOS SCHMITT	Type 1		note 1
74	#CE4/P15/EXCL4	XBG1	CMOS SCHMITT	Type 1		note 1
75	DSIO	XBH2P2T	LVTTL/CMOS SCHMITT	Type 2	Pull-up	
76	P14/FOSC1/DCLK	XBG2	CMOS SCHMITT	Type 2		note 1
77	P13/EXCL3/T8UF3/DPCO	XBG2	CMOS SCHMITT	Type 2		note 1
78	P12/EXCL2/T8UF2/DST2	XBG2	CMOS SCHMITT	Type 2		note 1
79	P11/EXCL1/T8UF1/DST1	XBG2	CMOS SCHMITT	Type 2		note 1
80	P10/EXCL0/T8UF0/DST0	XBG2	CMOS SCHMITT	Type 2		note 1
81	PLLS0	XIBC	CMOS			
82	PLLS1	XIBC	CMOS			
83	PLLC	XLIN				
84	Vss	XVSS				
85	#X2SPD	XIBC	CMOS			
86	OSC3	XLIN				
87	OSC4	XLOT				
88	ICEMD	XITST1			Pull-down	Test pin
89	#CE10EX	XBB1	note 2	Type 1		
90	#CE10IN	XTB1T		Type 1		
91	Vdd	XVDD				
92	BCLK	XTB1T		Type 1		
93	#CE6/P20/#DRD	XBG1	CMOS SCHMITT	Type 1		note 1
94	#CE7/P21/#DWE/#GAAS	XBG1	CMOS SCHMITT	Type 1		note 1
95	P22/TM0	XBG1	CMOS SCHMITT	Type 1		note 1
96	P23/TM1	XBG1	CMOS SCHMITT	Type 1		note 1
97	P24/TM2	XBG1	CMOS SCHMITT	Type 1		note 1
98	P25/TM3	XBG1	CMOS SCHMITT	Type 1		note 1
99	P26/TM4	XBG1	CMOS SCHMITT	Type 1		note 1
100	P27/TM5	XBG1	CMOS SCHMITT	Type 1		note 1

note 1) This pin is 5 V tolerant.

note 2) This pin is set as an input pin during device testing. Normally it is an output pin.

The following table lists output current characteristics.

Output current (IoL/Ioн)

	5.0 V	3.3 V	2.0 V
Type1	3 mA	2 mA	0.6 mA
Type2	-	6 mA	2 mA

## S1C33S01 FUNCTION PART

# I OUTLINE

## **I-1 INTRODUCTION**

The S1C33S01 Function Part gives a detailed description of the various function blocks built into the Seiko Epson original 32-bit microcomputer S1C33S01.

The S1C33S01 employs a RISC type CPU, and has a powerful instruction set capable of compilation into compact code, despite the small CPU core size.

The S1C33S01 has the following features:

• Small CPU core:	25K gates
• Fast and high performance:	DC to 50 MHz operation
• Strong instruction set:	16-bit fixed length, 105 basic instructions
• Execution cycle:	Major instructions are executed in 1 cycle per instruction
• MAC function:	16 bits $\times$ 16 bits + 64 bits, 2 clock per MAC (25 MOPS in 50 MHz)
• Registers:	32 bits $\times$ 16 general registers and 32 bits $\times$ 5 special registers
• Memory space:	256M bytes (28 bits) linear space, code-data-IO shared type
• External bus I/F:	15 configurable memory areas Direct connection to external memory
• Interrupts:	Reset, NMI, up to 128 external interrupts, 4 software interrupts, 2 exceptions
• Reset, boot:	Cold reset, hot reset
• Power down mode:	Sleep, Halt
• Others:	Little endian (partial big endian can be configured) Harvard architecture (fetch, load/store parallel execution)
• User logic interface:	Programmable wait state (up to 7 cycles) #WAIT pin hand shake is possible. Large memory space for the user logic (up to 16M bytes) BCU configuration registers allow internal use of the external areas (Areas 4 to 18). Many interrupt requests from the user logic are acceptable.

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## **I-2 BLOCK DIAGRAM**

S1C33S01 consists of five major blocks: C33 Core Block, C33 Peripheral Block, and C33 Internal Memory Block.

Figure 2.1 shows the configuration of the S1C33 blocks.



#### C33 Core Block

The C33 Core Block consists of a functional block C33\_CORE including CPU, BCU (Bus Control Unit), ITC (Interrupt Controller), CLG (Clock Generator) and DBG (Debug Unit), an I/O pad block for external interface, and an SBUS (Internal Silicon Integration Bus) for interfacing with on-chip Peripheral Macro Cells. The C33 Core Block employs the S1C33000 32-bit RISC type CPU as the core CPU.

#### C33 Peripheral Block

The C33 Peripheral Block consists of a prescaler, four channels of 8-bit programmable timer, six channels of 16-bit programmable timer including watchdog timer function, two channels of serial interface, I/O ports, and a clock timer.

#### C33 Memory Block

8 MB SRAM is provided for the internal memory space.

For details of the blocks, refer to the respective section in this manual.

## I-3 LIST OF PINS

## List of External I/O Pins

The following lists the external I/O pins of the C33 Core Block and Peripheral Block. Note that some pins are listed in two or more tables.

			Table 3.1 List of Pins for Power Supply System
Pin name	I/O	Pull-up	Function
Vdd	-	-	Power supply (+)
Vss	-	-	Power supply (-); GND

Pin name	I/O	Pull-up	Function				
A0	0	-	A0: Address bus (A0) when SBUSST (D3/0x4812E) = "0" (default)				
#BSL			#BSL: Bus strobe (low byte) signal when SBUSST (D3/0x4812E) = "1"				
A[19:1]	0	-	Address bus (A1 to A19)				
A23	I/O	-	A23: Address bus (A23) when CFA23 (D7/0x40300) = "0" (default)				
P07			P07: I/O port when CFA23 (D7/0x40300) = "1" and CFP07 (D7/0x402D0) = "0"				
#SRDY			#SRDY: Serial I/F Ch. 1 ready signal input/output when CFA23 (D7/0x40300) = "1" and CFP07				
			(D7/0x402D0) = "1"				
A22	I/O	-	A22: Address bus (A22) when CFA22 (D6/0x40300) = "0" (default)				
P35			P35: I/O port when CFA22 (D6/0x40300) = "1" and CFP35 (D5/0x02DC) = "0"				
#BUSACK			#BUSACK: Bus acknowledge output when CFA22 (D6/0x40300) = "1" and CFP35 (D5/0x02DC) = "1"				
A21	I/O	-	A21: Address bus (A21) when CFA21 (D5/0x40300) = "0" (default)				
P34			P34: I/O port when CFA21 (D5/0x40300) = "1" and CFP34 (D4/0x402DC) = "0"				
#BUSREQ			#BUSREQ: Bus release requestinput when CFA21 (D5/0x40300) = "1", CFP34 (D4/0x402DC) = "1", and				
#CE6			IOC34 (D4/0x402DE) = "0"				
			#CE6: Area 6 chip enable when CFA21 (D5/0x40300)="1", CFP34 (D4/0x402DC) = "1", and IOC34				
•			(D4/0x402DE) = "1"				
A20	I/O	-	A20: Address bus (A20) when CFA20 (D5/0x40300) = "0" (default)				
P33			P33: I/O port when CFA20 (D5/0x40300) = "1"				
D[15:0]	I/O	-	Data bus (D0 to D15)				
#CE10EX	0	-	Area 10 chip enable for external memory				
			* When CEFUNC[1:0] = "1x", this pin outputs #CE9+#CE10EX signal.				
#CE10IN	0	-	Area 10 chip enable for internal ROM emulation				
#CE9	I/O	-	#CE9: Area 9 chip enable when CFCE9 (D5/0x40301) = "0" (default)				
P32			* Output can be changed to #CE17, #CE9+#CE10 by CEFUNC[1:0] (D[A:9]/0x48130)				
			P32: I/O port when CFCE9 (D5/0x40301) = "1"				
#CE8	I/O	-	#CE8: Area 8 chip enable when CFCE8 (D4/0x40301) = "0" (default)				
P31			* Output can be changed to #RAS1, #CE14, #RAS3 by CEFUNC[1:0] (D[A:9]/0x48130),				
#BUSGET			A8DRA (D8/0x48128), and A14DRA (D8/0x48122)				
#GARD			P31: I/O port when CFCE8 (D4/0x40301) = "1", CFP31 (D1/0x402DC) = "0", and CFEX3				
			(D3/0x402DF) = "0"				
			#BUSGET: Bus status monitor signal output when CFCE8 (D4/0x40301) = "1", CFP31 (D1/0x402DC)				
			= "1", and CFEX3 (D3/0x402DF) = "0"				
			#GARD: Area read signal output for GA when CFCE8 (D4/0x40301) = "1" and CFEX3(D3/0x402DF) = "1"				

#### Table 3.2 List of Pins for External Bus Interface Signals

Pin name	I/O	Pull-up	Function			
#CE7	I/O	_	#CE7:	Area 7 chip enable when CFCE7 (D3/0x40301) = "0" (default)		
P21				* Output can be changed to #RAS0, #CE13, #RAS2 by CEFUNC[1:0] (D[A:9]/0x48130),		
#DWE				A7DRA (D7/0x48128), and A13DRA (D7/0x48122)		
#GAAS			P21:	I/O port when CFCE7 (D3/0x40301) = "1", CFP21 (D1/0x402D8) = "0", and CFEX2 (D2/0x402DF) = "0"		
			#DWE:	DRAM write signal output for successive RAS mode when CFCE7 (D3/0x40301) = "1", CEP21 (D1/0x402D8) = "1", and CEEX2 (D2/0x402DE) = "0"		
			#GAAS'	Area address strobe output for GA when CECE7 (D3/0x40301) – "1" and CEEX2		
				(D2/0x402DF) = "1"		
#CE6	I/O	-	#CE6:	Area 6 chip enable when CFCE6 (D2/0x40301) = "0" (default)		
P20				* Output can be changed to #CE7+#CE8 by CEFUNC[1:0] (D[A:9]/0x48130)		
#DRD			P20:	I/O port when CFCE6 (D2/0x40301) = "1" and CFP20 (D0/0x402D8) = "0"		
			#DRD:	DRAM read signal output for successive RASmode when CFCE6 (D2/0x40301) = "1" and CFP20 (D0/0x402D8) = "1"		
#CE5	I/O	-	#CE5:	Area 5 chip enable when CFCE5 (D1/0x40301) = "0" (default)		
P16				* Output can be changed to #CE15, #CE15+#CE16 by CEFUNC[1:0] (D[A:9]/0x48130)		
EXCL5			P16:	I/O port when CFCE5 (D1/0x40301) = "1" and CFP16 (D6/0x402D4) = "0"		
			EXCL5:	16-bit timer 5 event counter input when CFCE5 (D1/0x40301) = "1", CFP16 (D6/0x402D4) = "1", and IOC16 (D6/0x402D6) = "0"		
#CE4	I/O	_	#CE4:	Area 4 chip enable when CFCE4 (D0/0x40301) = "0" (default)		
P15				* Output can be changed to #CE11, #CE11+#CE12 by CEFUNC[1:0] (D[A:9]/0x48130)		
EXCL4			P15:	I/O port when CFCE4 (D0/0x40301) = "1" and CFP15 (D5/0x402D4) = "0"		
			EXCL4:	16-bit timer 4 event counter input when CFCE4 (D0/0x40301) = "1", CFP15 (D5/0x402D4)		
				= "1", and IOC15 (D5/0x402D6) = "0"		
#RD	0	-	Read signa	al		
#EMEMRD	0	-	Read signa	al for internal ROM emulation memory		
#WRL	0	-	#WRL:	Write (low byte) signal when SBUSST (D3/0x4812E) = "0" (default)		
#WR			#WR:	Write signal when SBUSST (D3/0x4812E) = "1"		
#WE			#WE:	DRAM write signal		
#WRH	0	-	#WRH:	Write (high byte) signal when SBUSST (D3/0x4812E) = "0" (default)		
#BSH			#BSH:	Bus strobe (high byte) signal when SBUSST (D3/0x4812E) = "1"		
#HCAS	0	-	#HCAS:	DRAM column address strobe (high byte) signal		
#LCAS	0	-	#LCAS:	DRAM column address strobe (low byte) signal		
BCLK	0	-	Bus clock of	butput		
P30	I/O	-	P30:	I/O port when CFP30 (D0/0x402DC) = "0" (default)		
#WAIT			#WAIT:	Wait cycle request input when CFP30 (D0/0x402DC) = "1"		
#CE4&5			#CE4&5:	Areas 4&5 chip enable when CFP30 (D0/0x402DC) = "1" and IOC30 (D0/0x403DE) = "1"		
#CE8	I/O	-	#CE8:	Area 8 chip enable when CFCE8 (D4/0x40301) = "0" (default)		
P31				* Output can be changed to #RAS1, #CE14, #RAS3 by CEFUNC[1:0] (D[A:9]/0x48130),		
#BUSGET				A8DRA (D8/0x48128), and A14DRA (D8/0x48122)		
#GARD			P31:	I/O port when CFCE8 (D4/0x40301) = "1", CFP31 (D1/0x402DC) = "0", and CFEX3 (D3/0x402DF) = "0"		
			#BUSGET:	Bus status monitor signal output when CFCE8 (D4/0x40301) = "1", CFP31 (D1/0x402DC) = "1" and CFEX3 (D3/0x402DE) = "0"		
			#GARD:	Area read signal output for GA when CFCE8 (D4/0x40301) = "1" and CFEX3(D3/0x402DF)		
				="1"		
#CE9	I/O	_	#CE9:	Area 9 chip enable when CFCE9 (D5/0x40301) = "0" (default)		
P32				* Output can be changed to #CE17, #CE9+#CE10 by CEFUNC[1:0] (D[A:9]/0x48130)		
			P32:	I/O port when CFCE9 (D5/0x40301) = "1"		
A20	I/O	-	A20:	Address bus (A20) when CFA20 (D5/0x40300) = "0" (default)		
P33			P33:	I/O port when CFA20 (D5/0x40300) = "1"		

Pin name	I/O	Pull-up	Function	
A21	I/O	-	21: Address bus (A21) when CFA21 (D5/0x40300) = "0" (default)	
P34			34: I/O port when CFA21 (D5/0x40300) = "1" and CFP34 (D4/0x402DC) = "0"	
#BUSREQ			BUSREQ: Bus release requestinput when CFA21 (D5/0x40300) = "1", CFP34 (D4/0x402DC)	="1", and
#CE6			IOC34 (D4/0x402DE) = "0"	
			CE6: Area 6 chip enable when CFA21 (D5/0x40300)="1", CFP34 (D4/0x402DC) = "1", a	andIOC34
			(D4/0x402DE) = "1"	
A22	I/O	-	22: Address bus (A22) when CFA22 (D6/0x40300) = "0" (default)	
P35			35: I/O port when CFA22 (D6/0x40300) = "1" and CFP35 (D5/0x02DC) = "0"	
#BUSACK			BUSACK: Bus acknowledge output when CFA22 (D6/0x40300)= "1" and CFP35 (D5/0x02	2DC) = "1"

Table 3.3 List of Pins for Clock Generator									
Pin name	I/O	Pull-up	Function						
OSC1	Ι	-	Low-speed (OSC1) oscillation input (32 kHz crystal oscillator or external clock input)						
OSC2	0	-	Low-speed (OSC1) oscillation output						
OSC3	I	-	High-speed (OSC3) oscillation input (crystal/ceramic oscillator or external clock input)						
OSC4	0	-	High-speed (OSC3) oscillation output						
PLLS[1:0]	Т	-	PLL set-up pin:	S					
			PLLS1	PLLS0	fin (fosc3)	fout (fpscin)			
			1	1	10–25MHz	20–50MHz			
			1	0	-	-			
			0	1	10–12.5MHz	40–50MHz			
			0	0	PLL is not used	_			
PLLC	I/O	_	Capacitor connecting pin for PLL						

#### Table 3.3 List of Pins for Clock Generator

#### Table 3.4 List of Other Pins

Pin name	I/O	Pull-up	Function						
ICEMD	Ι	Pull-down	High-impedance control input pin						
			When this pin is setto High, all the outputpins go to the high-impedance state. This enables the S1C33						
			chip on the board to be isolated from the system.						
DSIO	I/O	Pull-up	Serial I/O pin for debugging						
			This pin is used to communicate with the debugging tool S5U1C33000H.						
#X2SPD	1	-	Clock doubling mode set-up pin						
			1: CPU clock =	: CPU clock = bus clock x 1, 0: CPU clock = bus clock x 2					
#NMI	1	Pull-up	NMI request inp	NMI request input pin					
#RESET	Ι	Pull-up	initial reset input pin						
EA10MD1	Ι	Pull-up	Area 10 boot m	Area 10 boot mode selection					
EA10MD0	Т	-	EA10MD1	EA10MD0	Mode				
			1	1	External ROM mode				
			1	0	Internal ROM mode				
			0	1	_				
			0	0	Internal ROM emulation mode				

**Note:** "#" in the pin names indicates that the signal is low active.

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# S1C33S01 FUNCTION PART
# **II-1 INTRODUCTION**

The core block consists of a functional block C33\_CORE including CPU, BCU (Bus Control Unit), ITC (Interrupt Controller), CLG (Clock Generator) and DBG (Debug Unit), an I/O pad block for external interface, and an SBUS (Internal Silicon Integration Bus) for interfacing with on-chip Peripheral Macro Cells.



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# **II-2 CPU AND OPERATING MODE**

# CPU

The C33 Core Block employs the S1C33000 32-bit RISC type CPU as the core CPU. Since it has a built-in multiplier, all instructions (105 instructions) in the S1C33000 instruction set including the MAC (multiplication and accumulation) instruction and the multiplication/division instructions are available.

All the internal registers of the S1C33000 can be used. The CPU registers and CPU address bus can handle 28-bit addresses. However, the core block has a 24-bit external address bus (A[0:23]), so the low-order 24 bits of address data can only be delivered to the external address bus and the internal address bus which is connected to the User Logic Block.

Refer to the "S1C33000 Core CPU Manual" for details of the S1C33000.

# Standby Mode

The CPU supports three standby modes: two HALT modes and a SLEEP mode. By setting the CPU in the standby mode, power consumption can greatly be reduced.

## HALT Mode

When the CPU executes the halt instruction, it suspends the program execution and enters the HALT mode. The CPU supports two types of HALT modes (basic HALT mode and HALT2 mode) and either can be selected using the HLT2OP (D3) / Clock option register (0x40190).

The CPU stops operating in basic HALT mode, so the amount of current consumption can be reduced. The internal peripheral circuits including the oscillation circuit keep operating in basic HALT mode.

HALT2 mode stops the external bus control functions and the bus clock as well as the CPU similar to basic HALT mode. Consequently, HALT2 mode realizes more power saving than the basic HALT mode.

The HALT mode is canceled by an initial reset or an interrupt including NMI. This mode is useful for saving power when waiting for an external input or completion of the peripheral circuit operations that do not need to execute the CPU.

The CPU transits to program execution status through trap processing when the HALT mode is canceled by an interrupt and executes the interrupt processing routine. The trap processing of the CPU saves the address of the instruction that follows the executed halt instruction into the stack. Therefore, when the interrupt processing routine is terminated by the reti instruction, the program flow returns to the instruction that follows the halt instruction. Note that the HALT mode cannot be canceled with an interrupt factor except for reset and NMI if the PSR is set into interrupt disabled status.

# SLEEP Mode

When the CPU executes the slp instruction, it suspends the program execution and enters SLEEP mode.

In SLEEP mode, the CPU and the internal peripheral circuits including the high-speed (OSC3) oscillation circuit stop operating. Thus SLEEP mode can greatly reduce current consumption in comparison to HALT mode. Moreover, the low-speed (OSC1) oscillation circuit and clock timer do not stop operating. The clock function keeps operating in SLEEP mode.

SLEEP mode is canceled by an initial reset or an interrupt (NMI, clock timer interrupt, external interrupt such as a key entry). Note that other interrupts by the internal peripheral circuits that use the OSC3 clock cannot be used for canceling SLEEP mode.

The CPU transits to program execution status through trap processing when the SLEEP mode is canceled by an interrupt and executes the interrupt processing routine. The trap processing of the CPU saves the address of the instruction that follows the executed slp instruction into the stack. Therefore, when the interrupt processing routine is terminated by the reti instruction, the program flow returns to the instruction that follows the slp instruction. Note that SLEEP mode cannot be canceled with an interrupt factor except for reset and NMI if the PSR is set into interrupt disabled status.

# Notes on Standby Mode

### Interrupts

The standby mode can be canceled by an interrupt. Therefore, it is necessary to enable the interrupt to be used for canceling the standby mode before setting the CPU in the standby mode. It is also necessary to set the IE (interrupt enable) and IL (interrupt level) bits in the PSR to a condition that can accept the interrupt. Otherwise, the standby mode cannot be canceled even when an interrupt occurs. Refer to "ITC (Interrupt Controller)", for interrupt settings.

### **Oscillation circuit**

The high-speed (OSC3) oscillation circuit stops in SLEEP mode and restarts oscillating when SLEEP mode is canceled. If the CPU had operated with the OSC3 clock before entering SLEEP mode, the CPU restarts operating with the OSC3 clock immediately after canceling SLEEP mode. However, the OSC3 oscillation needs appropriate stabilization time (10 ms max. under the standard condition in 3.3 V). To restart the CPU after the oscillation stabilizes, a programmable interval can be inserted between cancellation of SLEEP mode and starting the CPU operation. Refer to "CLG (Clock Generator)", for details.

The oscillation start time of the high-speed (OSC3) oscillation circuit varies according to the components to be used, board pattern and operating environment. The interval must be set to allow enough margin.

### BCU

When the CPU enters the standby mode, the BCU (bus control unit) stops after the current bus cycle has completed. All the chip enable signals are negated.

In basic HALT mode, the BCLK (bus clock) signal is output and DRAM refresh cycles are generated. In HALT2 or SLEEP mode, the BCLK signal stops, therefore DRAM refresh cycles cannot be generated.

### Additional

The contents of the CPU registers and input/output port status are retained in the standby mode. Almost all control and data registers of the internal peripheral circuits are also retained, note, however, some registers may be changed at the transition to SLEEP mode. Refer to the section of each peripheral circuit for other precautions.

# Test Mode

The C33 Core Block has the ICEMD pin for testing the chip. When this pin is set to High, the IC enters the following state:

- All output pins go into high-impedance state except for the clock output pins (OSC2: H, OSC4 H, PLLC: L).
- Clock inputs are disabled. OSC1, OSC3 and PLL stop operating. OSC2: H, OSC4 H, PLLC: L
- All the pull-up and pull-down resistors enter an inactive state.

Leave this pin open or connect to Vss for normal operation. The ICEMD pin has a built-in pull-down resistor.

# **Debug Mode**

The C33 Core Block supports the debug mode.

The debug mode is a CPU function, and realizes single step operation and break functions in the chip itself. Refer to the "S1C33000 Core CPU Manual" for details of the debug mode and the functions.

Area 2 in the memory map can only be accessed in the debug mode.

In the debug mode, the OSC3 clock is used as the CPU operating clock. Therefore, do not stop the high-speed (OSC3) oscillation circuit when using the debugging functions. Furthermore, only the C33 Core Block operates in the debug mode and other internal peripheral circuits stop operating.

# Trap Table

Table 2.1 shows the trap table in the C33 Core. Refer to the "S1C33000 Core CPU Manual" for details of exceptions and Section II-5 in this manual, "ITC (Interrupt Controller)", for interrupts.

HEX No	Vector number	Exception/interrupt name	Exception/interrupt factor	Priority
NO.		Posot	Low input to the reset pin	High
	1_3	reserved		riigii ↑
4	4(Base+10)	Zero division	Division instruction	. I
5	5	reserved		
6	6(Base+18)	Address error exception	Memory access instruction	
7	$0 \times 0 \text{ or } 0 \times 60000$		hrk instruction etc	
8	8(Base+1C)	NMI	Low input to the NMI pin	
	9–11	reserved	-	
С	12(Base+30)	Software exception 0	int instruction	
D	13(Base+34)	Software exception 1	intinstruction	
E	14(Base+38)	Software exception 2	int instruction	
F	15(Base+3C)	Software exception 3	int instruction	
10	16(Base+40)	Port input interrupt 0	Edge (rising or falling) or level (High or Low)	1
11	17(Base+44)	Port input interrupt 1	Edge (rising or falling) or level (High or Low)	
12	18(Base+48)	Port input interrupt 2	Edge (rising or falling) or level (High or Low)	
13	19(Base+4C)	Port input interrupt 3	Edge (rising or falling) or level (High or Low)	
14	20(Base+50)	Key input interrupt 0	Rising or falling edge	
15	21(Base+54)	Key input interrupt 1	Rising or falling edge	
	22–29	reserved	-	
1E	30(Base+78)	16-bit programmable timer 0	Timer 0 comparison B	
1F	31(Base+7C)		Timer 0 comparison A	
	32–33	reserved	-	
22	34(Base+88)	16-bit programmable timer 1	Timer 1 comparison B	
23	35(Base+8C)		Timer 1 comparison A	
	36–37	reserved	-	
26	38(Base+98)	16-bit programmable timer 2	Timer 2 comparison B	
27	39(Base+9C)		Timer 2 comparison A	
	40-41	reserved		
_2A	42(Base+A8)	16-bit programmable timer 3	Timer 3 comparison B	
_2B	43(Base+AC)		Timer 3 comparison A	
	44-45	reserved		
2E	46(Base+B8)	16-bit programmable timer 4	Timer 4 comparison B	
2F	47(Base+BC)		Timer 4 comparison A	
- 22	48-49	reserved	– Timer 5 comparison D	
32	50(Base+C8)	16-bit programmable timer 5	Timer 5 comparison B	
24	51(Base+CC)	9 hit programmable timer	Timer 5 companison A	
25	52(Base+D0)	8-bit programmable timer	Timer 0 underflow	
30	53(Base+D4)		Timer 1 underflow	
27	55(Base+DC)		Timer 2 underflow	
38	56(Base+E0)	Serial interface Ch 0	Receive error	
30	57(Base+E4)	Senai internace Ch.0	Receive buffer full	
34	58(Base+E8)		Transmit buffer empty	
	50(Dase+L0)	reserved		
30	60(Base+E0)	Serial interface Ch 1	Receive error	
3D	61(Base+F4)		Receive buffer full	
3E	62(Base+F8)		Transmit buffer empty	1
	63–64	reserved	-	
41	65(Base+104)	Clock timer	Falling edge of 32 Hz, 8 Hz, 2 Hz or 1 Hz signal	
			1-minuet, 1-hour or specified time count up	
	66–67	reserved	_	
44	68(Base+110)	Port input interrupt 4	Edge (rising or falling) or level (High or Low)	1
45	69(Base+114)	Port input interrupt 5	Edge (rising or falling) or level (High or Low)	1
46	70(Base+118)	Port input interrupt 6	Edge (rising or falling) or level (High or Low)	Ļ
47	71(Base+11C)	Port input interrupt 7	Edge (rising or falling) or level (High or Low)	Low

Table 2.1 Trap Table

\* Base = Set value in the TTBR register (0x48134 to 0x48137); 0xC00000 by default.

# **II-3 INITIAL RESET**

# Pins for Initial Reset

Table 3.1 shows the pins used for initial reset.

Table 3.1 Pins for Initial Reset						
Pin name	I/O	Function				
#RESET	Ι	nitial reset input pin (Low active)				
		ow: Resets the CPU.				
#MNI	I	NMI request input pin				
		his pin is also used for selecting a reset method.				
		ligh: Cold start				
		Low: Hot start				

The chip is reset when the #RESET pin goes low and starts operating at the rising edge of the reset signal. The CPU and internal peripheral circuits are initialized while the #RESET pin is low.

# Cold Start and Hot Start

The CPU supports two initial reset methods: cold start and hot start. The #MNI pin is used with the #RESET pin to set this condition.

The differences between cold start and hot start are shown in Table 3.2.

Table 3.2				
Setup contents	Cold start	Hot start		
Reset condition	#RESET = low & #MNI = high	#RESET = low & #MNI = low		
CPU: PC	The vector at the boot ad	The vector at the boot address is loaded to the PC.		
CPU: PSR	All the PSR bits	s are reset to 0.		
CPU: Other registers	Undefined			
CPU: Operating clock	The CPU operates with the OSC3 clock.			
External bus status (0x48120–0x4813F)	Initialized	Status is retained.		
Oscillation circuit	Both the OSC1 and OSC3 circuits start oscillating.			
I/O pin status (0x402C0–0x402DF)	Initialized	Status is retained.		
Other peripheral circuit	Initialized or undefined			

Table 3.2 Differences between Cold Start and Hot Start

Since cold start initializes all the internal peripheral circuits as well as the CPU, it is useful as a power-on reset. Hot start initializes the CPU and peripheral circuits, but does not reset the bus control unit and the input, output and I/O port status. It is useful as a reset that maintains the external memory, external I/O and the port status.

The #NMI pin that specifies the reset method should be set following the timing chart shown in Figure 3.1.

Cold start is generated	Hot start is generated
$\downarrow$ (#RESET = low & #NMI = h	high) $\downarrow$ (#RESET = low & #NMI = low)
#NMI _/	#NMI/
#RESET	#RESET/
#NMI must be set to high longer than the reset pulse width.	#NMI must be set to low longer than the reset pulse width.
(1) Cold start	(2) Hot start

Figure 3.1 Setup of pad\_rset\_x and #MNI Pins

# Power-on Reset

Be sure to reset (cold start) the chip after turning on the power to start operating.

Since the #RESET pin is directly connected to an input gate, a power-on reset circuit should be configured outside the chip.

An initial reset (#RESET = low) turns the high-speed (OSC3) oscillation circuit on. The CPU starts operating with the OSC3 clock at the rising edge of the reset signal. The high-speed (OSC3) oscillation circuit takes time (10 ms max. under the standard condition in 3.3 V) for the oscillation to stabilize, therefore initial reset must be released after an appropriate oscillation-stabilization time has passed in order to start up the CPU without fault. The initial reset pulse width must be exceeded the oscillation-stabilization time.

Figure 3.2 shows a power-on reset timing chart.



Figure 3.2 Power-on Reset Timing

Maintain the #RESET pin at 0.1•VDD or less (low level) after turning the power on until the supply voltage rises at least to the oscillation start voltage (3.0 V). Furthermore, maintain the #RESET pin at 0.5•VDD or less until the high-speed (OSC3) oscillation circuit stabilizes oscillating.

**Note:** The OSC3 oscillation start time varies due to the elements used, board pattern and operating environment, therefore allow enough margin for the reset-release time. Refer to "Oscillation Characteristics", in which an example of oscillation start time is provided.

# Reset Pulse

A low pulse can be input to the #RESET pin for resetting the chip being operated.

The minimum reset pulse width is provided in "AC Characteristics". Be sure to input a pulse that has a pulse width longer than the minimum value.

To reset the chip when the high-speed (OSC3) oscillation circuit is in off status, the pulse width must be extended until the oscillation stabilizes similarly to the power-on reset. Be aware that a short reset pulse may cause an operation error.

# **Boot Address**

When the core CPU is initially reset, it reads the reset vector (program start address) from the boot address (0x0C00000) and loads the vector to the PC (program counter). Then the CPU starts executing the program from the address when the #RESET pin goes high.

The trap table in which trap vectors for interrupts and other trap factors are written also begins from the boot address by the default setting. (Refer to the "S1C33000 Core CPU Manual" for details of the trap table.) The trap table base address can also be changed to a 1KB boundary address using the TTBR register (0x48134 to 0x48137).

# Notes Related to Initial Reset

#### Core CPU

Since the all registers except for the PC and PSR are indeterminate at initial reset, they should be initialized by a program. In particular, the SP (stack pointer) must be initialized before accessing the stack area. NMI requests are disabled until any value is written to the SP. The initialization is necessary when the CPU is cold-started.

#### Internal RAM

The contents of the internal RAM are indeterminate at initial reset. Initialize the area to be used if necessary.

#### High-speed (OSC3) oscillation circuit

An initial reset activates the high-speed (OSC3) oscillation circuit and the CPU starts operating with the OSC3 clock after the initial reset is released. In order to prevent a malfunction of the CPU due to an unstabilized clock, the #RESET pin must be maintained at low until the OSC3 oscillation stabilizes when performing a power-on reset or resetting while the high-speed (OSC3) oscillation circuit is stopped.

### Low-speed (OSC1) oscillation circuit

A power-on reset or an initial reset when the low-speed (OSC1) oscillation circuit is off starts the OSC1 oscillation. The low-speed (OSC1) oscillation circuit takes a longer stabilization time (3 sec max. under the standard condition) than the high-speed (OSC3) oscillation circuit. In order to prevent a malfunction due to an unstabilized clock, do not use the OSC1 clock until the stabilization time has passed.

#### **BCU (Bus Control Unit)**

Cold-start initializes the control registers for the BCU (bus control unit). Therefore, it is necessary to set up all the bus conditions.

Hot-start retains the previous bus conditions before an initial reset.

#### Input/output ports and input/output pins

Cold start initializes the control and data registers for the I/O ports.

Hot start retains the contents of the control registers and input/output pin status before an initial reset. However, when the pins are used for the internal peripheral circuits, it is necessary to set up the control registers of the peripheral circuit because they are initialized by an initial reset.

#### Other internal peripheral circuits

The control and data registers of peripheral circuits other than those listed above are initialized with the predefined values or become indeterminate regardless of the reset method (cold start or hot start). Therefore, it is necessary to set up the peripheral circuit conditions.

Refer to the I/O maps or explanation of each peripheral circuit section for initial settings of the peripheral circuits.

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# II-4 BCU (Bus Control Unit)

The BCU (Bus Control Unit) provides an interface for external devices and on-chip user logic block. The types and sizes of memory and peripheral I/O devices can be set for each area of the memory map and can be controlled directly by the BCU. This unit also supports a direct interface for DRAM and burst ROM. This chapter describes how to control the external and internal system interface, and how it operates.

**Note:** The control registers of the external system interface shown in this chapter are mapped to the internal 16-bit I/O area. Therefore, the addresses of these control registers are indicated by halfword (16-bit) addresses unless otherwise specified. Note that the control registers can be accessed in bytes, half-words, or words.

# Pin Assignment for External System Interface

# I/O Pin List

### External I/O pins

Table 4.1 lists the pins used for the external system interface.

Pin name	I/O	Function
A[0]/#BSL	0	Address bus (A0) / Bus strobe (Low-byte)
A[23:1]	0	Address bus (A1–A23)
D[15:0]	I/O	Data bus (D0–D15)
#CE10EX	0	Area 10 external memory chip enable
#CE10IN	0	Area 10 chip enable for internal ROM emulation mode
#CE9/#CE17	0	Area 9/17 chip enable
#CE8/#RAS1/#CE14/#RAS3	0	Area 8/14 chip enable / DRAM Row strobe
#CE7/#RAS0/#CE13/#RAS2	0	Area 7/13 chip enable / DRAM Row strobe
#CE6	0	Area 6 chip enable
#CE5/#CE15	0	Area 5/15 chip enable
#CE4/#CE11	0	Area 4/11 chip enable
#CE3	0	Area 3 chip enable for ROM emulation mode
#RD	0	Read signal
#EMEMRD	0	Read signal for area 3/10 emulation mode
#WRL/#WR/#WE	0	Write (Low-byte) / Write / DRAM write
#WRH/#BSH	0	Write (High-byte) / Bus strobe (High-byte)
#HCAS	0	DRAM column address strobe (High-byte)
#LCAS	0	DRAM column address strobe (Low-byte)
BCLK	0	Bus clock output
#BUSREQ/#CE6/P34	I/O	Bus release request / Area 6 chip enable / I/O port
#BUSACK/P35	0	Bus request acknowledge / I/O port
#WAIT/#CE4&5/P30	I/O	Wait cycle request / Areas 4&5 chip enable / I/O port
#DRD/P20	0	DRAM read signal / I/O port
#DWE/P21	0	DRAM write (Low-byte) / I/O port
#X2SPD I CPU - BCLK clock ratio		CPU - BCLK clock ratio
		1: CPU clock = Bus clock, 0: CPU clock = Bus clock x 2
EA10MD[1:0]		Area 10 boot mode selection
		11: External ROM, 10: Internal ROM, 01: OTP, 00: Internal ROM emulation

Table 4.1 I/O Pin List

### User interface signals

Signal name	I/O	Function
Internal_addr0	0	<ul> <li>Address bus (a0) when SBUSST(D3/0x4812E) = "0" (default)</li> <li>Bus strobe (low byte) signal (#BSL) when SBUSST(D3/0x4812E) = "1"</li> </ul>
Internal_addr[23:1]	0	Address bus (a1 to a23)
Internal_dout[15:0]	0	Output data bus (dout0 to dout15) This data bus is used when the CPU writes data to the on-chip user logic.
Internal_din[15:0]	Ι	Input data bus (din0 to din15) This data bus is used when the CPU reads data from the on-chip user logic.
Internal_ce4_x Internal_ce5_x Internal_ce6_x	0	Areas 6–4 chip enable signals These signals go low when the CPU accesses the user logic circuits that are mapped to Areas 6–4.
Internal_rd_x	0	Read signal This signal goes low when the CPU reads data from the user logic.
Internal_wrl_x	0	<ul> <li>Write (low byte) signal (#WRL) when SBUSST(D3/0x4812E) = "0" (default)</li> <li>Write signal (#WR) when SBUSST(D3/0x4812E) = "1"</li> <li>This signal goes low when the CPU write 8 low-order bit data to the user logic.</li> </ul>
Internal_wrh_x	0	<ul> <li>Write (high byte) signal (#WRH) when SBUSST(D3/0x4812E) = "0" (default)</li> <li>Bus strobe (high byte) signal (#BSH) when SBUSST(D3/0x4812E) = "1"</li> <li>This signal goes low when the CPU write 8 high-order bit data to the user logic.</li> </ul>
Internal_osc3_clk	0	High-speed (OSC3) oscillation clock output This can be used as a source clock for the user logic.
Internal_pll_clk	0	PLL output clock This can be used as a source clock for the user logic.
Internal_wait_x	Ι	Wait cycle request input The user logic can request to insert wait cycles by setting this signal to low.
Internal_irrd_x	0	Instruction fetch indicator signal This signal goes low when the CPU is in an instruction fetch cycle.

Table 4.2 List of User Interface Signals

The internal bus signals are available when an internal access area is set using the BCU register. The bus conditions can be programmed using the BCU registers similar to the external bus.

## Combination of System Bus Control Signals

The bus control signal pins that have two or more functions have their functionality determined when an interface method is selected by a program. The BCU contains an ordinary external system interface (two interface method are supported) and a DRAM interface.

Table 4.3 Interface Selection				
Interface type	Interface method	Control bit		
External system interface	A0 system (default)	SBUSST(D3/0x4812E) = "0"		
	#BSL system	SBUSST(D3/0x4812E) = "1"		
DRAM interface	2CAS system (fixed)	None		

SBUSST is initialized to "0" at cold start.

When the IC is hot-started, these bits retain their status before the chip was reset.

Table 4.4 shows combinations of control signals classified by each interface method.

Table 4.4 Combinations of Bus Control Signals				
External sys	DRAM interface			
A0 system	A0 system #BSL system			
A0	#BSL (little endian) /	-		
	#BSH (big endian) *1			
#WRL	#WR	#WE		
#WRH	#BSL (little endian) /	-		
	#BSH (big endian) *1			
_	_	#HCAS		
_	_	#LCAS		
#CEx	#CEx	<b>#RASx</b> *2		

#### Table 4.4 Combinations of Bus Control Signals

- \*1 In the #BSL system, the A0 and #WRH pin functions change according to the endian selected (little endian or big endian).
- \*2 When using DRAM, the #CE output pins in areas 7–8 (areas 13–14) function as the #RAS1–2 (#RAS3–4) pins.

0x0000000

# Memory Area

# Memory Map

Figure 4.1 shows the memory map supported by the BCU.

Area	Address		Area	Address	
Area 9	0x0BFFFFF		Area 18	0xfffffff	
SRAM type		External memory (4MB)	SRAM type	0xD000000	
Burst ROM type			8 or 16 bits	0xCFFFFFF	External memory (16MB)
8 or 16 bits	0x0800000		A	0xC000000	
Area 8	0X0/FFFFF		Area 17	OXBEFFFFFF	
SRAM type		External memory (2MB)	SRAM type	0x9000000	
DRAW type	00600000		8 OF 16 DILS	0x8FFFFFF	External memory (16MB)
Area 7	0x0600000		Aroa 16	0x8000000	
SPAM time	UXUSFFFFF		SPAM turo	0x7FFFFFF	
DRAW type		External memory (2MB)	SRAW type	0x/000000	
DRAW type	00400000		O UI TO DILS	0	External memory (16MB)
Area 6	0x0400000		Aroa 15	0x6000000	
SPAM time	0x03FFFFF	External I/O (16-bit device)	SPAM turo	0x5FFFFFF	
SRAW type	0x0360000		SRAW type	0x5000000	
	0x037FFFF	External I/O (8-bit device)	O UI TO DILS	0x4FFFFFF	External memory (16MB)
Area 5	0x0300000		Area 1/	0x2000000	
SPAM type	UXUZFFFFF		SPAM type	UXSFFFFFF	
SICAW type		External memory (1MB)	DRAM type		External memory (16MB)
001100115	0*0200000		8 or 16 bits	0*2000000	
Area /	0x0100000		Area 13	0x3000000	
SPAM type	UXUIFFFFF		SPAM type	UXZFFFFFF	
8 or 16 bits		External memory (1MB)	DRAM type		External memory (16MB)
00110013	0~010000		8 or 16 bits	0~2000000	
Area 3	0x0077777		Area 12	33333332 <u>x3</u> 77777771x0	
16 hits	0110011111	(Reserved)	SRAM type	0	
Fixed at 1 cycle		For middleware use	8 or 16 hits		External memory (8MB)
T INOU UL T OYOIO	0x0080000			0v1800000	
Area 2	0x007FFFF		Area 11	0x17FFFFF	
16 bits	01100/1111	(Reserved)	SRAM type	0112/11/11	
Fixed at 3 cycles		For CPU core or debug mode	8 or 16 bits		External memory (8MB)
	0x0060000			0x1000000	
Area 1	0x005FFFF	(Mirror of internal I/C)	Area 10	0x0FFFFFF	
8, 16 bits	0x0050000	(Wirror of Internal I/O)	SRAM type		
2 or 4 cvcles	0x004FFFF	latana al 140	Burst ROM type		External memory (4MB)
,	0x0040000	Internal I/O	8 or 16 bits	0x0C00000	
	0x003FFFF	(Mirror of internal I/O)			
	0x0030000	(wintor or internal i/O)			
Area 0	0x002FFFF				
32 bits		Internal DAM			
Fixed at 1 cycle		Internal RAM			

Figure 4.1 Memory Map

Basically, Areas 0 to 3 are internal memory areas and Areas 4 to 18 are external memory areas.

Area 0 is normally used for a built-in RAM. The built-in memory is mapped from the beginning of the area. Area 1 is reserved for the I/O memory of the on-chip functional blocks. Address 0x0040000 to address 0x004FFFF

are used as the control registers and address 0x0050000 to 0x005FFFF are used as the mirror area.

Area 2 is used in debug mode only and it cannot be accessed in user mode (normal program execution status). Area 3 is reserved for S1C33 middlewares.

Area 4 to 18 can also be configured as internal memory areas using the control register and they can be used for user logic circuits.

## External Memory Map and Chip Enable

The BCU has a 24-bit external address bus (A[23:0]) and a 16-bit external data bus (D[15:0]), allowing an address space of up to 16MB to be accessed with one chip enable signal. By default, the address space is divided into 11 areas (areas 0 to 10) for management purposes. Of these, areas 4 to 10 are open to an external system, each provided with an independent chip-enable pin (#CE[10:4]).

The C33 Core Block is limited to 24 available pins for the address bus and 7 pins for the #CE output due to its package structure. However, the #CE[4:10] output pins can be switched to the high-order area chip enable output pins as shown in Table 4.5 using software. CEFUNC[1:0] (D[A:9]) / DRAM timing set-up register (0x48130) is used for this switching.

Table 4.5 Switching of #CE Output				
Pin	CEFUNC = "00"	CEFUNC = "01"	CEFUNC = "1x"	
#CE4	#CE4	#CE11	#CE11+#CE12	
#CE5	#CE5	#CE15	#CE15+#CE16	
#CE6	#CE6	#CE6	#CE7+#CE8	
#CE7/#RAS0	#CE7/#RAS0	#CE13/#RAS2	#CE13/#RAS2	
#CE8/#RAS1	#CE8/#RAS1	#CE14/#RAS3	#CE14/#RAS3	
#CE9	#CE9	#CE17	#CE17+#CE18	
#CE10EX	#CE10EX	#CE10EX	#CE9+#CE10EX	
#CE9 #CE10EX	#CE9 #CE10EX	#CE17 #CE10EX	#CE9+#CE10EX	

(Default: CEFUNC = "00")

The high-order areas that are made available for use by writing "01" to CEFUNC can be larger in size than the default low-order areas. For example, when using DRAM in default settings, the available space is 4MB in areas 7 and 8. However, if areas 13 and 14 are used, up to 32MB of DRAM can be used. The same applies to the other areas. Furthermore, when CEFUNC is set to "10" or "11", five chip enable signals are expanded into two area size. Although the C33 Core Block has only 24 address output pins, it features 28-bit internal address processing. Figure 4.2 shows a memory map for an external system.

Area	Address		Area	Address	
Area 10 (#CE10)	0x0FFFFFF		Area 17 (#CE17)	0xBFFFFFF	(Mirror of External memory 6)
SRAM type		External memory 6 (4MB)	SRAM type	0x9000000	
Burst ROM type		External memory 0 (4MD)	8 or 16 bits	0x8FFFFFF	External memory 6 (16MB)
8 or 16 bits	0x0C00000			0x8000000	
Area 9 (#CE9)	0x0BFFFFF		Area 15 (#CE15)	0x5FFFFFF	(Mirror of External memory 5)
SRAM type		External memory 5 (4MB)	SRAM type	0x5000000	(
Burst ROM type		External memory 5 (4MD)	8 or 16 bits	0x4FFFFFF	External memory 5 (16MB)
8 or 16 bits	0x080000			0x4000000	
Area 8 (#CE8/#RAS1)	0x07FFFFF		Area 14 (#CE14/#RAS3)	0x3FFFFFF	
SRAM type		External memory 4 (2MB)	SRAM type		External memory 4 (16MB)
DRAM type		External memory 4 (200D)	DRAM type		External memory 4 (TOMB)
8 or 16 bits	0x0600000		8 or 16 bits	0x3000000	
Area 7 (#CE7/#RAS0)	0x05FFFFF		Area 13 (#CE13/#RAS2)	0x2FFFFFF	
SRAM type		External memory 2 (2MD)	SRAM type		
DRAM type		External memory 3 (2MB)	DRAM type		External memory 3 (TOMB)
8 or 16 bits	0x0400000		8 or 16 bits	0x2000000	
Area 6 (#CE6)	0x03FFFFF	Extornal I/O (16 bit dovice)	Area 11 (#CE11)	0x17FFFFF	
SRAM type	0x0380000	External I/O (10-bit device)	SRAM type		External mamon (2 (0MD)
	0x037FFFF	External I/O (8 bit device)	8 or 16 bits		External memory 2 (81VIB)
	0x0300000	External I/O (8-bit device)		0x1000000	
Area 5 (#CE5)	0x02FFFFF		Area 10 (#CE10)	0x0FFFFFF	
SRAM type		External memory 2 (1MD)	SRAM type		External manage (1 (1MD)
8 or 16 bits		External memory 2 (TMB)	Burst ROM type		External memory 1 (4MB)
	0x0200000		8 or 16 bits	0x0C00000	
Area 4 (#CE4)	0x01FFFFF		Area 6 (#CE6)	0x03FFFFF	Extornal I/O (16 bit dovice)
SRAM type		External memory 4 (1MD)	SRAM type	0x0380000	External I/O (10-bit device)
8 or 16 bits		External memory 1 (TMB)		0x037FFFF	External I/O (8 bit dovice)
	0x0100000			0x0300000	External I/O (8-bit device)
	CEFUNC	= "00"		CEFUN	C = "01"

Area	Address	
Area 17+18 (#CE17+18)	Oxfffffff	(Mirror of External memory 7')
SRAM type	0xD000000	(WIND OF External memory 7)
8 or 16 bits	0xCFFFFFF	External memory 7' (16MB)
	0xC000000	
	0xBFFFFFF	(Mirror of External memory 7)
	0x9000000	
	0x8FFFFFF	External memory 7 (16MB)
Aroos 15 16 (#0545:40)	0x8000000	
Aleas 15-16 (#CE15+16)	0x7FFFFFF	(Mirror of External memory 6')
SRAM type	0x7000000	
8 of 16 bits	0x6FFFFFF	External memory 6' (16MB)
	0x6000000	
	0x5FFFFFF	(Mirror of External memory 6)
	0x5000000	
	0x4FFFFFF	External memory 6 (16MB)
	0x4000000	
Area 14 (#CE14/#RAS3)	0x3FFFFFF	
SRAM type		External memory 5 (16MB)
DRAM type		
8 or 16 bits	0x3000000	
Area 13 (#CE13/#RAS2)	0x2FFFFFF	
SRAM type		External memory 4 (16MB)
DRAM type		
8 or 16 bits	0x2000000	
Areas 11–12 (#CE11+12)	0x1FFFFFF	
SRAM type		External memory 3 (16MB)
8 or 16 bits		
	0x1000000	
Areas 9–10 (#CE9+10EX)	0x0FFFFFF	
SRAM type		External memory 2 (8MB)
Burst ROM type		
8 or 16 bits	0x0800000	
Areas 7–8 (#CE7+8)	0x07FFFFF	
SRAM type		External memory 1 (4MB)
8 or 16 bits		
	0x0400000	

CEFUNC = "10" or "11"

Figure 4.2	External System Memory	y Map
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Furthermore, the #CE4+#CE5 and #CE6 signals can be output from the P30 and P34 terminals, respectively. This function expands the accessible area when CEFUNC is set to "01, "10" or "11".

To output the #CE4+#CE5 signal from the P30 terminal:

CFP30 (D0)/P3 function select register (0x402DC) = "1"IOC30 (D0)/P3 I/O control register (0x402DE) = "1"

To output the #CE6 signal from the P34 terminal:

CFP34 (D4)/P3 function select register (0x402DC) = "1"

IOC34 (D4)/P3 I/O control register (0x402DE) = "1"

The P30 and P34 terminals are set for the general I/O ports at initial reset.

The P30 and P34 terminals are shared with the #WAIT input and the #BUSREQ input, respectively. Therefore, when using the #WAIT and #BUSREQ signals, there terminal cannot be used for #CE4+#CE5 and #CE6 outputs.

## Using Internal Memory on External Memory Area

The BCU allows using of an internal memory in the external memory areas.

The AxxIO bit in the access control register (0x48132) is used to select either internal access or external access.

When "1" is written, the internal device will be accessed and when "0" is written, the external device is accessed (external access by default). The bit names and the corresponding areas are as follows:

 A18IO (DF):
 Areas 17 and 18

 A16IO (DE):
 Areas 15 and 16

 A14IO (DD):
 Areas 13 and 14

 A12IO (DC):
 Areas 11 and 12

 A8IO (DA):
 Areas 7 and 8

 A6IO (D9):
 Areas 4 and 5

## **Exclusive Signals for Areas**

Areas can be accessed using the exclusive signals (address strobe and read signals) as well as the common control signals.

To use these exclusive signals, they should be configured using G/A read signal control register (0x48138). The AxxAS bit is used to enable/disable the address strobe signal, and the AxxRD bit is used to enable/disable the read signal. When "1" is written to the bit, the exclusive signal for the corresponding area(s) is enabled and when "0" is written, it is disabled (disabled by default). The bit names and the corresponding areas are as follows:

A18AS (DF), A18RD (D7):	Areas 17 and 18
A16AS (DE), A16RD (D6):	Areas 15 and 16
A14AS (DD), A14RD (D5):	Areas 13 and 14
A12AS (DC), A12RD (D4):	Areas 11 and 12
A8AS (DA), A8RD (D2):	Areas 7 and 8
A6AS (D9), A6RD (D1):	Area 6
A5AS (D8), A5RD (D0):	Areas 4 and 5
#CE selec	ted with AxxAS (ORed) #WRH #WRL #PD
#CE selec	ted with AxxRD (ORed) → #GAAS → P31

Figure 4.3 #GAAS and #GARD Signals

The address strobe signal and the read signal are output from the P21 pin and P31 pin, respectively. Therefore, when using these signals, the pin(s) must be configured for exclusive signal output using the port function select register and port function extension register.

To output the exclusive address strobe signal #GAAS:

CFEX2 (D2)/Port function extension register (0x402DF) = "1"

To output the exclusive address strobe signal #GARD:

CFEX3 (D3)/Port function extension register (0x402DF) = "1"

These signals are common used to all the above areas, so when two or more areas are selected to output the exclusive signal, OR condition is applied.

## Area 10

Area 10 is an external memory area that includes the boot address (0xC00000). This area supports three boot mode and a high-speed internal ROM can also be mapped.

### Area 10 boot mode

The boot mode can be configured using the external pins EA10MD[1:0].

Table 4.6	6 Area 10 Boot Mode Selection
EA10MD[1:0] pins	Area 10 boot mode
00	Internal ROM emulation mode
01	-
10	Internal ROM boot mode
11	External ROM boot mode

#### Internal ROM boot mode

The CPU boots by the internal ROM mapped to area 10. The internal ROM size should be selected from among eight types (min. 16KB, max. 2MB) using the A10IR[2:0] (D[E:C])/Areas 10-9 set-up register (0x48126). This ROM begines with address 0xC00000 and can be read in one cysle the same as that of area 3. For the remained area within area 10, the external memory will be accessed if it is available.

### Internal ROM emulation mode

The CPU boots by the external memory that emulates an internal ROM. This mode accesses the ROM emulation area set by the A10IR[2:0] (D[E:C])/Areas 10-9 set-up register (0x48126) using the same condition as internal ROM boot mode. The emulation memory is accessed using the #CE10IN chip enable signal.

\* Internal ROM emulation mode can only be used for debugging, and cannot be used in mass production.

### External ROM boot mode

The CPU boots by the external ROM (ROM, Flash, SRAM, etc.). This mode uses the bus condition set by the BCU registers for area 10.

### Setting the internal ROM size

When a boot mode other than external ROM boot mode is used, the internal ROM or emulation memory size should be set using A10IR[2:0] (D[E:C)/Areas 10-9 set-up register (0x48126).

A10IR2	A10IR1	A10IR0	ROM size
0	0	0	16KB
0	0	1	32KB
0	1	0	64KB
0	1	1	128KB
1	0	0	256KB
1	0	1	512KB
1	1	0	1MB
1	1	1	2MB (default)

Table 4.7	Area	10 Internal	ROM Size
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### Area 10 memory map

Figure 4.4 shows the memory map of area 10.



Figure 4.4 Area 10 Memory Map

## Area 3

Area 3 is an internal memory area and reserved for S1C33 middlewares.

# Setting External Bus Conditions

The type, size, and wait conditions of a device connected to the external bus can be individually set for each area using the control register (0x48120 to 0x48130). The following explains the available setup conditions individually for each area. For details on how to set the DRAM interface conditions, refer to "DRAM Direct Interface".

The control register used to set bus conditions is initialized at cold start. Therefore, please set up these registers again using software according to the external device configuration and specifications.

When the IC is hot-started, the setup contents and pins retain their previous status before a reset.

## Setting Device Type and Size

Table 4.8 shows the types of devices that can be connected directly to each area.

			Table 4.8	Device Type
Area	SRAM type	DRAM type	Burst ROM type	Control bit
18–15	0	Х	Х	None
14	0	0	Х	A14DRA(D8)/Areas 14–13 set-up register(0x48122)
13	0	0	Х	A13DRA(D7)/Areas 14–13 set-up register(0x48122)
12,11	0	Х	Х	None
10	0	Х	0	A10DRA(D8)/Areas 10–9 set-up register(0x48126)
9	0	Х	0	A9DRA(D7)/Areas 10–9 set-up register(0x48126)
8	0	0	Х	A8DRA(D8)/Areas 8–7 set-up register(0x48128)
7	0	0	Х	A7DRA(D7)/Areas 8–7 set-up register(0x48128)
6-4	0	Х	Х	None
				O: Can be connected X: Cannot be connected

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When connecting burst ROM or DRAM, write "1" to each corresponding control bit. These control bits are reset to "0" (SRAM type) at cold start.

The device size can be set to 8 or 16 bits once every two areas except for area 6. Area 6 alone has its first half (0x300000–0x37FFFF) fixed to an 8-bit device and the second half (0x380000–0x3FFFFF) fixed to a 16-bit device.

	Table 4.9 Device Size Control Bits
Area	Control bit
18, 17	A18SZ(DE)/Areas 18–15 set-up register(0x48120)
16, 15	A16SZ(D6)/Areas 18–15 set-up register(0x48120)
14, 13	A14SZ(D6)/Areas 14–13 set-up register(0x48122)
12, 11	A12SZ(D6)/Areas 12–11 set-up register(0x48124)
10, 9	A10SZ(D6)/Areas 10–9 set-up register(0x48126)
8, 7	A8SZ(D6)/Areas 8–7 set-up register(0x48128)
5, 4	A5SZ(D6)/Areas 6-4 set-up register(0x4812A)

At cold start, each area by default is set to 16 bits.

When using an 8-bit device, write "1" to the control bit.

Note: The BCU supports 16-bit burst ROM. Therefore, when connecting burst ROM to area 10 or area 9, do not set the device size to 8 bits (A10SZ = "1").

For differences in bus operation due to the device size and access data size, refer to "Bus Operation of External Memory".

## Setting SRAM Timing Conditions

The areas set for the SRAM allow wait cycles and output disable delay time to be set.

Number of wait cycles:0 to 7 (incremented in units of one cycle)Output disable delay time:0.5, 1.5, 2.5, 3.5 cycles

This selection can be made once every two areas except for area 6.

Area	Number of wait cycles	Output disable delay time	Control register
18, 17	A18WT[2:0](D[A:8])	A18DF[1:0](D[D:C])	Areas 18–15 set-up register(0x48120)
16, 15	A16WT[2:0](D[2:0])	A16DF[1:0](D5:4])	Areas 18–15 set-up register(0x48120)
14, 13	A14WT[2:0](D[2:0])	A14DF[1:0](D5:4])	Areas 14–13 set-up register(0x48122)
12, 11	A12WT[2:0](D[2:0])	A12DF[1:0](D5:4])	Areas 12–11 set-up register(0x48124)
10, 9	A10WT[2:0](D[2:0])	A10DF[1:0](D5:4])	Areas 10–9 set-up register(0x48126)
8, 7	A8WT[2:0](D[2:0])	A8DF[1:0](D[5:4])	Areas 8–7 set-up register(0x48128)
6	A6WT[2:0](D[A:8])	A6DF[1:0](D[D:C])	Areas 6–4 set-up register(0x4812A)
5, 4	A5WT[2:0](D[2:0])	A5DF[1:0](D[5:4])	Areas 6-4 set-up register(0x4812A)

	Table 4.10 Timin	g Condition Setting	) Bits	(for SRAM type)
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At cold start, the number of wait cycles is set to 7 and the output disable delay time is set to 3.5 cycles. Reset up these parameters as necessary using software according to specifications of the connected device. At hot start, these parameters retain their previous settings before a reset.

### Wait cycles

When the number of wait cycles is set for an area using the control bit, the BCU extends the bus cycle for a duration equivalent to the wait cycles set when it accesses the area. Set the desired wait cycles according to the bus clock frequency and the external device's access time. Separately from the wait cycles set here, a wait request from an external device can also be accepted using the #WAIT pin. Since the settings of wait cycles using software are made once every two areas, use this external wait request function if you want the wait cycles to be controlled individually in each area or if you need 7 or more wait cycles. The #WAIT pin is shared with the P30 I/O port. For an external wait request to be accepted, write "1" to CFP30 (D0) / P3 function select register (0x402DC [Byte]) and write "1" (default = "0") to SWAIT (D0) / Bus control register (0x4812E) to enable the #WAIT pin.

For timing charts for bus cycles and when wait cycles are inserted, refer to "Bus Cycles in External System Interface".

If the number of wait cycles is set to 0 and no external wait is requested, the basic read cycle (read in byte or half-word) for the SRAM external device consists of one cycle. If wait cycles are set, because these cycles are added, the bus read cycle consists of [number of wait cycles + 1] (providing that there is no external wait). On the other hand, the basic write cycle consists of at least two cycles. This does not change regardless of whether zero or one wait cycle is set. If the number of wait cycles set is 2 or more, the bus cycle is actually extended. In this case, the bus write cycle consists of [number of wait cycles + 1], as in the case of read cycles (providing that there is no external wait).

### Output disable delay time

In cases when a device having a long output disable time is connected, if a read cycle for that device is followed by the next access, contention for the data bus may occur. (Due to the fact the read device's data bus is not placed in the high-impedance state.) The output disable delay time is provided to prevent such data bus contention. This is accomplished by inserting a specified number of cycles between a read cycle and the next bus operation.

Check the specifications of the device to be connected before setting the output disable delay time. By default, the output disable delay time is inserted only in the following cases:

- when a read cycle from the external device that has had an output disable delay time set is followed by a write cycle performed by the CPU; and
- when a read cycle from the external device that has had an output disable delay time set is followed by a read cycle for a different area (including the internal device).

Conversely, no output disable delay time is inserted in the following conditions:

- immediately after a write cycle, and
- during a successive read from the same external device.

# Setting Timing Conditions of Burst ROM

#### Wait cycles

If burst ROM is selected for area 10 or 9, the wait cycles to be inserted in the burst read cycle can be selected in a range from 0 to 3 cycles. A10BW[1:0] (D[A:9]) / Areas 10–9 set-up register (0x48126) is used for this selection. This selection is applied simultaneously to areas 10 and 9, so wait cycles can not be chosen individually for each area. The wait cycles set at cold start is 0.

Even for a burst read, the SRAM settings of wait cycles in the first bus operation are valid. (Refer to A10WT[2:0] in the foregoing section.)

The wait cycles set by A10BW[1:0] are inserted into the burst cycles after the first bus operation.

In addition, when burst ROM is selected, no wait cycles can be inserted into the read cycle via the #WAIT pin. For writing to an area that has had burst ROM selected, an SRAM write cycle is executed. In this case, both the SRAM settings of wait cycles and those input via the #WAIT pin are valid.

### Burst mode

The burst mode can be selected between an eight-consecutive-burst and a four-consecutive-burst mode. RBST8 (DD) / Bus control register (0x4812E) is used for this selection. The eight-consecutive-burst mode is selected by writing "1" to RBST8 and the four-consecutive-burst mode is selected by setting the bit to "0". At cold start, the four-consecutive-burst mode is set by default.

# Bus Operation

### Data Arrangement in Memory

The S1C33 Family of devices handle data in bytes (8 bits), half-words (16 bits), and words (32 bits). When accessing data in memory, it is necessary to specify a boundary address that conforms to the data size involved. Specification of an invalid address causes an address error exception. For instructions (e.g., stack manipulation or branch instructions) that rewrite the SP (stack pointer) or PC (program counter), the specified addresses are forcibly modified to appropriate boundary addresses. Therefore, no address error exception occurs in this type of instruction. For details about the address error exception, refer to the "S1C33000 Core CPU Manual".

Table 4.11 shows the data arrangement in memory, classified by data type.

Table 4	4.11 Data Arrangement in Memory
Data type	Arranged location
Byte data	Byte boundary address (all addresses)
Half-word data	Half-word boundary address (A[0]="0")
Word data	Word boundary address (A[1:0]="00")

The half-word and word data in memory area accessed in little-endian format by default. It can be changed to bigendian format using AxxEC (D[7:0])/Access control register (0x48132). When "1" is written to AxxEC, the corresponding area is accessed in big-endian method. The bit names and the corresponding areas are as follows: A18EC (D7): Areas 17 and 18

A18EC (D7): Areas 17 and 18 A16EC (D6): Areas 15 and 16 A14EC (D5): Areas 13 and 14 A12EC (D4): Areas 11 and 12 A10EC (D3): Areas 9 and 10 ... Fixed at "0" (little-endian) for booting. A8EC (D2): Areas 7 and 8 A6EC (D1): Area 6 A5EC (D0): Areas 4 and 5

To increase memory efficiency, try to locate the same type of data at continuous locations on exact boundary addresses in order to minimize invalid areas.

## **Bus Operation of External Memory**

The external data bus is 16-bits wide. For this reason, more than one bus operation occurs depending on the device size and the data size of the instruction executed, as shown in Table 4.12.

Data size to be accessed	Devise size	Number of bus operation cycles	Remarks
32 bits	16 bits	2	
16 bits	16 bits	1	
8 bits	16 bits	1	In little-endian method, the low-order byte is accessed when the LSB of the address (A[0]) is "0" or the #BSL signal is L. The high-order byte is accessed when the LSB of the address (A[0]) is "1" or the #BSH signal is H. In big-endian method, the high-order byte is accessed when the LSB of the address (A[0]) is "0" or the #BSL signal is L. The low-order byte is accessed when the LSB of the address (A[0]) is "1" or the #BSH signal is H.
32 bits	8 bits	4	In little-endian method, the 8-bit device must be connected to the low- order 8 bits of the data bus. In big-endian method, the 8-bit device must be connected to the high-order 8 bits of the data bus.
16 bits	8 bits	2	In little-endian method, the 8-bit device must be connected to the low- order 8 bits of the data bus. In big-endian method, the 8-bit device must be connected to the high-order 8 bits of the data bus.
8 bits	8 bits	1	In little-endian method, the 8-bit device must be connected to the low- order 8 bits of the data bus. In big-endian method, the 8-bit device must be connected to the high-order 8 bits of the data bus.

able 4.12 Number of Bus Operation Cycle	able 4.12	Number of Bus Operation C	ycles
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These bus operations are shown in the figure below, taking the example of the A0 method.

With the BSL method, the following adjustments should be made when reading the figure.

- (1) For data reads, the operation is as shown in the figure below.
- (2) For little-endian data writes, read A0 as #BSC, and #WRH as #BSH.
- (3) For big-endian data writes, read A0 as #BSL, and #WRL as #BSH.

For information on memory connection, see Figure 4.20.

#### Little-endian

_														
31	So	urce (general-	purpose regis	ter) 0					Bus o	pera	ition			
	Byte 3	Byte 2	Byte 1	Byte 0	No.	A1	A0	#WRH	#WRL	15	Dat	a bus	0	
15		2 0	15	<b>↓</b> 1 0	1	0	0	0	0		Byte 1	Byte 0		
Ē	A[1:0	)]=10	A[1:	0]=00	2	1	0	0	0		Byte 3	Byte 2		
		Destination (	16-bit device)											
Big	g-endian													
21	So	urce (general-	purpose regis	ter) o					Bus o	nera	ition			
<u> </u>	Byte 3	Byte 2	Byte 1	Byte 0	No	Δ1	۸0	#\\/PH	Dat	Data bus				
45		1	45	2	1	0	0	0	0		Byte 3	Byte 2	٦	
15	A[1:0	0	A[1:	0]=10	2	1	0	0	0		Byte 1	Byte 0		
		Destination (	16-bit device)	-1										
		(	Figure 4	5 Word Data	Writing	n to s	16.	hit Dev	ico					
			r igure 4		vviitiitų	<i>y</i> 10 c	110	Dit Dev						
Lit	tle-endian													
31	Dest	nation (gener	al-purpose reg	gister) 0					Bus o	pera	ition			
	Byte 3	Byte 2	Byte 1	Byte 0	No.	A1	A0	#WRH	#WRL	15	Dat	a bus	0	
15	-	<b>↑</b> 1 0	1	0	0	1	1		Byte 1	Byte 0				
	A[1:0	)=10	A[1:	0]=00	2	1	0	1	1		Byte 3	Byte 2		
		Source (16	bit device)											
Big	g-endian													
31	Dest	nation (gener	al-purpose rec	pister) 0					Bus o	pera	ition			
<u> </u>	Byte 3	Byte 2	Byte 1	Byte 0	No.	A1	A0	#WRH	#WRL	15	Dat	a bus	0	
15	4	1 0	15	<b>≜</b> 2 0	1	0	0	1	1		Byte 3	Byte 2		
	A[1:0	01=00	A[1:	01=10	2	1	0	1	1		Byte 1	Byte 0		
	•	Source (16	bit device)											
			Figure 4.6	Word Data Re	eading	fron	n a 1	6-bit D	evice					
			r iguro no	mora Data ra	buunig	non		0 51 2	51100					
Lit	tle-endian													
31	So	urce (general-	purpose regis	ter) 0					Bus o	pera	ition			
	Byte 3	Byte 2	Byte 1	Byte 0	No.	A1	A0	#WRH	#WRL	15	Dat	a bus	0	
			15	<b>↓</b> 1 0	1	*	0	0	0		Byte 1	Byte 0		
			A[1:	0]=*0										
			Destination (	16-bit device)										
Bio	g-endian													
21	So	urce (general-	purpose regis	ter) o					Bus o	pera	ition			
	Bvte 3	Bvte 2	Bvte 1	Bvte 0	No	۸1	۸0	#\\/DU	#\//DI	15	Dat	a hue	0	
	,	,	45	<b>↓</b> 1 0	1	*	0	0	0	15	Bvte 1	Bvte 0		
			ιο Δ[1-	▼ 0 01=*0			2	5	-	L	,			
			Destination (	(16-bit device)	L									
			Eiguro 47		~ \//ri+i	na +/	1		ovico					
			Figure 4.7	nall-word Dat	a vviiti	ng to	Jai	o-bit Di	evice					

31 Destination (gener	al-purpose re	gister) 0					Bus o	peration	
Sign or Zero extension	Byte 1	Byte 0	No.	A1	A0	#WRH #	#WRL	15 Data	a bus 0
	15	<b>↑</b> 1 0	1	*	0	1	1	Byte 1	Byte 0
	A[1	:0]=*0							
	Source (1	6-bit device)							
Big-endian									
31 Destination (gener	al-purpose re	gister) 0					Bus o	peration	
Sign or Zero extension	Byte 1	Byte 0	No.	A1	A0	#WRH #	#WRL	15 Dat	a bus 0
	15	<u>↑1 0</u>	1	*	0	1	1	Byte 1	Byte 0
	A[1	:0]=*0							
	Source (1	6-bit device)							
Little endion	Figure 4.8	Half-word Data	Readir	ng fro	om a	a 16-bit E	Device	<b>;</b>	
Little-endian									
31 Source (general	-purpose regis	Byte 0					Bus o	peration	
Dyte 5 Dyte 2	Dyter	$\checkmark 1 \perp 1'$	<u>NO.</u>	A1 *	A0 1	#WRH #	1 WRL	15 Data	a bus 0 Data retained
	15 [	0 · ▼ · ▲	1'	*	0	1	0	Data retained	Byte 0
	Destination	(16-bit device)							
Big-endian	Dootindiion	(10 21 00 100)							
Source (general	-purpose regis	ster) o					Bus o	peration	
Byte 3 Byte 2	Byte 1	Byte 0	No	Δ1	AO	#WRH #	±WRI	15 Dat	a bus 0
L	15	<b>▲</b> 1 <b>↓</b> 1' 0	1	*	0	0	1	Byte 0	Data retained
	A[1:0]=*0	A[1:0]=*1	1'	*	1	1	0	Data retained	Byte 0
	Destination	(16-bit device)							
	Figure 4	4.9 Byte Data \	Nriting	to a	16-	bit Devic	e		
Little-endian									
Destination (gener	al-purpose re	aister) o					Bus o	peration	
Sign or Zero exter	nsion	RD byte	No	Δ1	۵0	#\//RH #		15 Date	a bus 0
	15	<b>▼</b> 1 <b>↑</b> 1' 0	1	*	1	1	1	RD byte	Ignored
	A[1:0]=*1	A[1:0]=*0	1'	*	0	1	1	Ignored	RD byte
	Source (1	6-bit device)							
Big-endian	Source (1	6-bit device)							
Big-endian 31 Destination (gener	Source (1)	6-bit device) gister) 0					Bus o	peration	
Big-endian <sub>31</sub> Destination (gener Sign or Zero exter	Source (1 ral-purpose repose	6-bit device) gister) 0 RD byte	No.	A1	A0	#WRH #	Bus o #WRL	peration 15 Data	a bus 0
Big-endian <sub>31</sub> Destination (gener Sign or Zero exter	Source (1) ral-purpose reg nsion 15	6-bit device) gister) 0 RD byte // 1 ↑1'0	No.	A1 *	A0 0	#WRH #	Bus o #WRL 1	peration 15 Data RD byte	a bus 0 Ignored
Big-endian <sub>31</sub> Destination (gener Sign or Zero exter	Source (1) ral-purpose rep nsion 15 [A[1:0]=*0	6-bit device) gister) 0 RD byte ✓ 1 ↑1' 0 A[1:0]=*1	No. 1 1'	A1 *	A0 0 1	#WRH # 1 1	Bus o #WRL 1 1	peration 15 Data RD byte Ignored	a bus 0 Ignored RD byte
Big-endian <sub>31</sub> Destination (gener Sign or Zero exter	Source (1) ral-purpose reansion 15 [A[1:0]=*0 Source (1)	6-bit device) gister) 0 ▼ 1 ↑1' 0 ▲ [1:0]=*1 6-bit device)	No. 1 1'	A1 * *	A0 0 1	#WRH # 1 1	Bus o #WRL 1 1	peration 15 Data RD byte Ignored	a bus 0 Ignored RD byte
Big-endian <sub>31</sub> Destination (gener Sign or Zero exter	Source (1) ral-purpose reansion 15 [A[1:0]=*0 Source (1) Figure 4.1	6-bit device) gister) 0 RD byte ✓ 1 ↑1' 0 A[1:0]=*1 6-bit device) 0 Byte Data R	No. 1 1' eading	A1 * *	A0 0 1 n a 1	#WRH # 1 1 16-bit De	Bus o #WRL 1 1	peration 15 Data RD byte Ignored	a bus 0 Ignored RD byte
Big-endian <sub>31</sub> Destination (gener Sign or Zero exter Little-endian	Source (1) ral-purpose reprision 15 [A[1:0]=*0 Source (1) Figure 4.1	6-bit device) gister) 0 RD byte ✓ 1 ↑1' 0 A[1:0]=*1 6-bit device) 0 Byte Data R	No. 1 1' eading	A1 * *	A0 0 1 n a 1	#WRH # 1 1 16-bit De	Bus o #WRL 1 1 evice	peration 15 Data RD byte Ignored	a bus 0 Ignored RD byte
Big-endian <sup>31</sup> Destination (gener Sign or Zero exter <u>Little-endian</u> 31 Source (general-	Source (1) al-purpose register 15 [A[1:0]=*0 Source (1) Figure 4.1 -purpose register	6-bit device) gister) 0	No. 1 1' eading	A1 * *	A0 0 1 n a 1	#WRH # 1 1 16-bit De	Bus o #WRL 1 1 evice Bus o	peration 15 Data RD byte Ignored	a bus 0 Ignored RD byte
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Big-endian 31 Destination (gener Sign or Zero exter Little-endian 31 Source (general- Byte 3 Byte 2 8 ↓ 4 0 8 ↓ 3 0	Source (1) source (1) al-purpose regision 15 A[1:0]= $*0$ Source (1) Figure 4.1 -purpose regision Byte 1 $0.8 \neq 2$	6-bit device) gister) 0 ▼ 1 ↑1' 0 ↓ A[1:0]=*1 6-bit device) 0 Byte Data R ster) 0 ↓ Byte 0 0 8 ↓ 1 0	No. 1 1 2 eading	A1 * + + + + + + + + + + + + + + + + + +	A0 0 1 n a 1 <u>A0</u> 0	#WRH # 1 16-bit De #WRH #	Bus o #WRL 1 2 evice Bus o #WRL 0	peration          15       Data         IS       Dyte         Ignored       Ignored         peration       15         Data retained       Data	a bus 0 Ignored RD byte a bus 0 Byte 0
Big-endian $31$ Destination (gener         Sign or Zero exter         Little-endian $31$ Source (general-         Byte 3       Byte 2         8 $4$ 0.8 $4$ A[1:0]=11       A[1:0]=10	Source (1) source (1) 15 A[1:0]= $*0$ Source (1) Figure 4.1 -purpose regis Byte 1 $0 \ge 4 + 2$ A[1:0]= $01$	6-bit device) gister) 0 RD byte $1 \uparrow 1' 0$ A[1:0]=*1 6-bit device) 0 Byte Data R ster) 0 Byte 0 0 8 $\downarrow 1 0$ A[1:0]=00	No. 1' eading	A1 * *   fror A1 0	A0 0 1 m a 1 A0 0 1	#WRH ; 1 16-bit De #WRH ; X X	Bus o #WRL 1 2 evice Bus o #WRL 0 0	peration 15 Data RD byte Ignored peration 15 Data Data retained Data retained Data retained	a bus 0 Ignored RD byte a bus 0 Byte 0 Byte 1 Pyte 2
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Big-endian $31$ Destination (gener         Sign or Zero exter         Little-endian $31$ Source (general- $31$ Source (general-         Byte 3       Byte 2         8 $4$ $0.8$ $4$ A[1:0]=11       A[1:0]=10       Destination	Source (1) ral-purpose register 15 A[1:0]=*0 Source (1) Figure 4.1 -purpose register Byte 1 $0.8 \neq 2$ A[1:0]=01 (8-bit device)	6-bit device) gister) 0	No. 1 1' eading No. 1 2 3 4	A1 * + + + + + + + + + + + + + + + + + +	A0 0 1 n a 1 A0 0 1 0 1	#WRH # 1 16-bit De #WRH # X X X X X	Bus o #WRL 1 2 2 2 2 2 2 2 2 2 2 2 2 2	peration 15 Data RD byte Ignored peration 15 Data Data retained Data retained Data retained Data retained (X: Not conner	a bus 0 Ignored RD byte a bus 0 Byte 0 Byte 1 Byte 2 Byte 3 ected/Unused)
Big-endian $31$ Destination (gener         Sign or Zero exter         Little-endian $31$ Source (general-         Byte 3       Byte 2         8 $4$ $0.8$ $3.0$ A[1:0]=11       A[1:0]=10       Destination         Big-endian $2.0$ $2.0$	Source (1) al-purpose register 15 A[1:0]=*0 Source (1) Figure 4.1 -purpose register Byte 1 $0.8 \downarrow 2$ A[1:0]=01 (8-bit device)	6-bit device) gister) 0 RD byte $1 \uparrow 1' 0$ A[1:0]=*1 6-bit device) 0 Byte Data R ster) 0 Byte 0 0 8 $\downarrow 1$ 0 A[1:0]=00	No. 1 1' eading No. 1 2 3 4	A1 * fror A1 0 1 1	A0 0 1 m a 7 A0 0 1 0 1	#WRH # 1 16-bit De #WRH # X X X X X X	Bus o #WRL 1 1 evice Bus o #WRL 0 0 0 0	peration 15 Data RD byte Ignored peration 15 Data Data retained Data retained Data retained Data retained Data retained (X: Not conne	a bus 0 Ignored RD byte a bus 0 Byte 0 Byte 1 Byte 2 Byte 3 ected/Unused)
Big-endian $31$ Destination (generalisity of the second secon	Source (1) Source (1) al-purpose regision 15 A[1:0]=*0 Source (1) Figure 4.1 -purpose regision Byte 1 ) 8 $\downarrow$ 2 A[1:0]=01 (8-bit device) -purpose regision A[1:0]=01	6-bit device) gister) 0 RD byte 1 ↑1' 0 A[1:0]=*1 6-bit device) 0 Byte Data R ster) 0 0 8 ↓1 0 A[1:0]=00 0 8 ↓1 0 A[1:0]=00 0 8 ↓1 0 0 A[1:0]=00	No. 1 1 eading	A1 * * I fror 0 1 1	A0 0 1 m a 1 A0 0 1 0 1	#WRH 1 1 16-bit De #WRH 1 X X X X X X	Bus o #WRL 1 1 evice Bus o #WRL 0 0 0 0 0 0 0 0 0	peration 15 Data RD byte Ignored peration 15 Data Data retained Data retained Data retained Data retained (X: Not conner peration	a bus 0 Ignored RD byte a bus 0 Byte 0 Byte 1 Byte 2 Byte 2 Byte 3 ected/Unused)
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Big-endian         31       Destination (generalisity of the second	Source (1) Source (1) al-purpose regision 15 A[1:0]= $*0$ Source (1) Figure 4.1 -purpose regision Byte 1 0 8 $\downarrow$ 2 A[1:0]=01 (8-bit device) -purpose regision Byte 1 0 8 $\downarrow$ 3 (0 8 $\downarrow$ 3 (1) 0 8 $\downarrow$ 3	6-bit device) gister) 0 RD byte $1 \uparrow 1'$ 0 A[1:0]=*1 6-bit device) 0 Byte Data R ster) 0 Byte 0 0 A[1:0]=00 0 A[1:0]=00 ster) 0 A[1:0]=00 0 A[1:0]=00 0 A[1:0]=00	No. 1 1 eading No. 1 2 3 4 No. 1 2 3 4	A1 * * fror 0 1 1 1	A0 0 1 n a 1 A0 0 1 0 1 0 1	#WRH ; 1 16-bit De #WRH ; X X X X #WRH ; 0	Bus o #WRL 1 1 2 2 2 2 2 2 2 2 2 2 2 2 2	peration 15 Data RD byte Ignored peration 15 Data Data retained Data retained Data retained Data retained (X: Not conne peration 15 Data Byte 3 Byte 2	a bus 0 Ignored RD byte a bus 0 Byte 0 Byte 1 Byte 2 Byte 3 ected/Unused) a bus 0 Data retained Data retained
Big-endian         31       Destination (gener         31       Destination (gener         Sign or Zero exter         Little-endian         31       Source (general-         Byte 3       Byte 2         8 $4$ 0.8 $4$ A[1:0]=11       A[1:0]=10       Destination         Big-endian       31       Source (general-         31       Source (general-       Byte 3         Byte 3       Byte 2       8         8 $4$ 0.8 $4$ 0.8 $4$ 2.0         A[1:0]=00       A[1:0]=01	Source (1) source (1) 15 A[1:0]=*0 Source (1) Figure 4.1 -purpose regis Byte 1 0.8 $\downarrow$ 2 A[1:0]=01 (8-bit device) -purpose regis Byte 1 0.8 $\downarrow$ 3 (8-bit device) (9.6 bit device)	6-bit device) gister) 0 RD byte $1 \uparrow 1' 0$ A[1:0]=*1 6-bit device) 0 Byte Data R ster) 0 Byte 0 0 8 $\downarrow 1 0$ A[1:0]=00 a $\downarrow 1 0$ b $\downarrow 0 0$ b $\downarrow 0 0$ b $\downarrow 0 0$ b $\downarrow 0 0$ c $\downarrow 0 0$ b $\downarrow 0 0$ c $\downarrow 0 0$ b $\downarrow 0 0$ c $\downarrow 0 0$ c $\downarrow 0 0$ b $\downarrow 0 0$ c	No. 1 1 eading No. 1 2 3 4 No. 1 2 3 4	A1 * + + + + + + + + + + + + + + + + + +	A0 0 1 m a 1 A0 0 1 0 1 0 1 0 1 0	#WRH # 1 16-bit De #WRH # X X X X X #WRH # 0 0 0 0	Bus o #WRL 1 Bus o #WRL 0 0 0 Bus o #WRL 1 1 1 1	peration 15 Data RD byte Ignored peration 15 Data Data retained Data retained Data retained Data retained (X: Not conner peration 15 Data Byte 3 Byte 2 Byte 1	a bus 0 Ignored RD byte a bus 0 Byte 0 Byte 1 Byte 2 Byte 3 ected/Unused) a bus 0 Data retained Data retained Data retained
Big-endian31Destination (gener31Sign or Zero exterLittle-endian31Source (general-Byte 3Byte 28 $4$ 0.8 $4$ 0.8 $3$ 0A[1:0]=11A[1:0]=10DestinationBig-endian31Source (general-Byte 3Byte 28 $4$ 0.8 $4$ 0.8 $4$ 0.8 $4$ 0.8 $4$ 0.8 $4$ 0.8 $4$ 0.0 $4$ 0.8 $4$ 0.0 $4$ 0.8 $4$ 0.0 $4$ 0.8 $4$ 0.0 $4$ 0.8 $4$ 0.0 $4$ 0.8 $4$ 0.0 $4$ 0.8 $4$ 0.0 $4$ 0.8 $4$ 0.0 $4$ 0.8 $4$ 0.0 $4$ 0.8 $4$ 0.0 $4$ 0.8 $4$ 0.0 $4$ 0.8 $4$ 0.0 $4$ 0.9 $4$ 0.0 $4$ 0.9 $4$ 0.0 $4$ 0.9 $4$ 0.0 $4$ 0	Source (1) source (1) al-purpose regision 15 A[1:0]=*0 Source (1) Figure 4.1 -purpose regision Byte 1 $0.8 \neq 2$ A[1:0]=01 (8-bit device) Byte 1 $0.8 \neq 3$ A[1:0]=10 (8-bit device)	6-bit device) gister) 0	No. 1 1' eading No. 1 2 3 4 No. 1 2 3 4	A1 * * I from 0 1 1 0 0 1 1 1	A0 0 1 m a 1 0 1 0 1 0 1 0 1 0 1	#WRH # 1 16-bit De #WRH # X X X X X X X X 0 0 0 0 0	Bus o #WRL 1 2 2 2 2 2 3 3 4 3 4 3 4 3 3 3 3 4 3 4 3	peration 15 Data RD byte Ignored Ignored peration 15 Data Data retained Data retained Data retained Data retained (X: Not conner peration 15 Data Byte 3 Byte 1 Byte 0	a bus 0 Ignored RD byte a bus 0 Byte 0 Byte 1 Byte 2 Byte 3 ected/Unused) a bus 0 Data retained Data retained Data retained
Big-endian31Destination (gener31Sign or Zero exter31Source (general-31Source (general-Byte 3Byte 28 $4$ 0 8 $4$ 3 cA[1:0]=11A[1:0]=10DestinationBig-endian31Source (general-Byte 3Byte 28 $4$ 0 8 $2$ Byte 3Byte 3Byte 28 $4$ 0 8 $4$ 1 0 8 $4$ 2 cA[1:0]=00A[1:0]=01Destination	Source (1) Source (1) 15 A[1:0]=*0 Source (1) Figure 4.1 -purpose regis Byte 1 0.8 $\downarrow$ 2 A[1:0]=01 (8-bit device) Figure 4.1 -purpose regis Byte 1 0.8 $\downarrow$ 3 A[1:0]=10 (8-bit device) Figure 4.1	6-bit device) gister) 0 RD byte $1 \uparrow 1'$ 0 A[1:0]=*1 6-bit device) 0 Byte Data R ster) 0 Byte 0 0 Byte 0 0 A[1:0]=00 0 Byte 0 0 Byte 0 0 A[1:0]=11 11 Word Data	No. 1 1 1 eading No. 1 2 3 4 Writin	A1 * * I fror 0 1 1 0 0 1 1 0 0 1 1 0 0 1 1 0 0 1 1 0 0 1 1 0 0 1 1 0 0 1 1 0 0 1 1 0 0 0 1 1 0 0 0 1 1 0 0 0 0 1 0	A0 0 1 m a 1 0 1 0 1 0 1 0 1 0 1 0 1 0 1 0 1 0 1 0	#WRH ; 1 16-bit De #WRH ; X X X X X X X X X 0 0 0 0 0 0	Bus o #WRL 1 2vice Bus o #WRL 0 0 0 0 0 0 0 0 0 0 0 0 0 0 0 0 0 0 0	peration 15 Data RD byte Ignored Ignored peration 15 Data Data retained Data retained Data retained Data retained (X: Not conner peration 15 Data Ryte 3 Byte 3 Byte 1 Byte 0	a bus 0 Ignored RD byte a bus 0 Byte 0 Byte 1 Byte 2 Byte 3 ected/Unused) a bus 0 Data retained Data retained Data retained

Little-endian Destination (general-purpose register) Bus operation 31 0 Byte 1 Byte 3 Byte 2 Byte 0 No. A1 A0 #WRH #WRL 15 Data bus 0 0 Ignored Byte 0 **4 A**3 **1**2 **†** 1 1 0 Х 1 08 08 0.8 2 0 1 Х 1 Ignored Byte 1 A[1:0]=10 A[1:0]=01 A[1:0]=00 A[1:0]=11 Byte 2 3 Х 0 1 Ignored 1 Source (8-bit device) Ignored 4 1 1 х 1 Byte 3 (X: Not connected/Unused) **Big-endian** Destination (general-purpose register) 31 Bus operation 0 Byte 2 Byte 1 Bvte 0 Byte 3 No. A1 A0 #WRH #WRL 15 Data bus 0 **†**2 **†**З **†**4 1 0 0 Byte 3 Ignored **†**1 1 08 08 08 8 0 2 0 1 Byte 2 Ignored 1 1 A[1:0]=01 A[1:0]=10 A[1:0]=11 A[1:0]=00 3 Byte 1 Ignored 1 1 0 1 Source (8-bit device) Ignored 4 1 1 1 Byte 0 1 Figure 4.12 Word Data Reading from an 8-bit Device Little-endian Source (general-purpose register) Bus operation 31 Byte 2 Byte 1 Byte 0 Byte 3 #WRH #WRL No. A0 15 Data bus A1 Data retained ₹2 1 0 Х 0 Byte 0 ↓1 08 0 Х 2 1 0 Data retained Byte 1 A[1:0]=\*1 A[1:0]=\*0 (X: Not connected/Unused) Destination (8-bit device) **Big-endian** Source (general-purpose register) Bus operation 31 Byte 3 Byte 2 Byte 1 Byte 0 #WRH #WRL No. A1 A0 15 Data bus 0 Byte 1 Data retained 1 ₩2 0 0 0 **↓**1 \* 08 0 2 \* 1 0 0 Byte 0 Data retained A[1:0]=\*0 A[1:0]=\*1 (\*: Uniformly 1 or 0) Destination (8-bit device) Figure 4.13 Half-word Data Writing to an 8-bit Device Little-endian Destination (general-purpose register) Bus operation 31 0 Sign or Zero extension Byte 1 Byte 0 #WRH #WRL No. A1 A0 15 Data bus 0 Ignored Byte 0 **1**2 **†**1 1 \* Х 1 08 2 Х 1 1 Ignored Byte 1 A[1:0]=\*1 A[1:0]=\*0 (X: Not connected/Unused) Source (8-bit device) **Big-endian** Destination (general-purpose register) Bus operation 31 Sign or Zero extension Byte 1 Byte 0 #WRH #WRL No. A1 A0 15 Data bus 0 Byte 1 **↑**0 0 Ignored **1** 1 1 08 8 0 2 \* 1 1 1 Byte 0 Ignored A[1:0]=\*0 A[1:0]=\*1 (\*: Uniformly 1 or 0) Source (8-bit device) Figure 4.14 Half-word Data Reading from an 8-bit Device Little-endian Source (general-purpose register) Bus operation 31 0 Byte 3 Byte 2 Byte 1 Byte 0 No. A0 #WRH #WRL Data bus A1 0 15 Data retained Byte 0 ↓1 1 Х 0 8 Λ A[1:0]=\*\*

Destination (8-bit device)

(X: Not connected/Unused)

n

0

**Big-endian** Source (general-purpose register) Bus operation 31 0 Byte 3 Byte 2 Byte 1 Byte 0 #WRH #WRL 15 Data bus No. A1 A0 0 ↓1 Byte 0 Data retained 1 0 1 8 0 A[1:0]=\*\* Destination (8-bit device)

Figure 4.15 Byte Data Writing to an 8-bit Device

Little-endian

31	Destination (general-purpose	e register) 0	Bus operation													
	Sign or Zero extension	Byte 0	No.	A1	A0	#WRH #	WRL	15 Dat	a bus	0						
		8 <b>1</b> 0	1	*	*	Х	1	Ignored	Byte 0							
		A[1:0]=**														
		Source (8-bit devic	ce)					(X: Not conne	ected/Unused	(k						
Big-er	ndian															
31	Destination (general-purpose	e register) 0	Bus operation													
	Sign or Zero extension	Byte 0	No.	A1	A0	#WRH #	WRL	15 Dat	a bus	0						
		8 1 0	1	*	*	1	1	Byte 0	Ignored							
		A[1:0]=**														

Source (8-bit device)

Figure 4.16 Byte Data Reading from an 8-bit Device

# **Bus Clock**

The bus clock is generated by the BCU using the CPU system clock output from the clock generator. Figure 4.17 shows the clock system.



Figure 4.17 Clock System

Since the bus clock is generated from the CPU system clock (CPU\_CLK), the following settings affect the bus clock:

1. Selection of an oscillation circuit (OSC3 or OSC1)

- 2. PLL configuration (OSC3\_CLK x 1, x2 or x4)
- 3. CPU clock division ratio for power saving

Items 2 and 3 apply when the high-speed (OSC3) oscillation circuit is selected as the CPU clock source. For details about the settings of the system clock, refer to "CLG (Clock Generator)".

Bus clock operation during standby is as follows:

Basic HALT mode: the BCU and bus clock continue operating. DRAM can be refreshed. HALT2 mode: the BCU and bus clock are stopped.

SLEEP mode: the BCU and bus clock are stopped.

## **Bus Speed Mode**

The CPU - bus clock ratio can be set using the #X2SPD pin as follows:

When #X2SPD = High, x1 speed mode (CPU - bus clock ratio is 1 : 1) is set. The bus clock and the CPU system clock will be the same.

When #X2SPD = Low, x2 speed mode (CPU - bus clock ratio is 2 : 1) is set. In x2 speed mode, the bus clock will be dynamically varied according to the memory to be accessed.

- When an external memory area is accessed, the bus clock frequency becomes half of the CPU system clock.
- When the internal RAM/ROM area is accessed, the bus clock frequency becomes equal to the CPU system clock.

In x1 speed mode, area 1 (internal I/O area) is accessed in 4 cycles of the CPU system clock, while in x2 speed mode, the number of access cycles can be selected using A1X1MD (D3) / BCLK select register (0x4813A).

When A1X1MD = "1", area 1 is accessed in 2 cycles of the CPU system clock.

When A1X1MD = "0", area 1 is accessed in 4 cycles of the CPU system clock. (default)

# **Bus Clock Output**

The bus clock is also output from the BCLK pin to an external device. The BCLK output clock can be selected from among four types using BCLKSEL[1:0] (D[1:0]) / BCLK select register (0x4813A).

BCLKSEL1	BCLKSEL0	Output clock
1	1	PLL_CLK (PLL output clock)
1	0	OSC3_CLK (OSC3 oscillation clock)
0	1	BCU_CLK (BCU operating clock)
0	0	CPU_CLK (CPU operating clock)

Table 4.13 Selection of BCLK Output Clock

# Bus Cycles in External System Interface

The following shows a sample SRAM connection the basic bus cycles.







(1) A0 system (little endian/big endian)

(2) #BSL system (little endian)

Figure 4.18 Sample DRAM Connection



## SRAM Read Cycles

#### Basic read cycle with no wait mode



Figure 4.19 Basic Read Cycle with No Wait

#### Read cycle with wait mode

Example: When the BCU has no internal wait mode and 2 wait cycles via #WAIT pin are inserted



Figure 4.20 Read Cycle with Wait

The #WAIT signal is sampled at the falling edge of the transition of BCLK (bus clock) and when it is sampled on an inactive (high level), the read cycle is terminated.

**Note:** Insertion of wait cycles via the #WAIT pin is possible only when the device for bus conditions is set for SRAM, and SWAIT (D0) / Bus control register (0x4812E) is enabled for waiting.

The above example shows a read cycle when a wait mode is inserted via the #WAIT signal. A wait mode consisting of 0 to 7 cycles can also be inserted using the wait control bits. The settings of these bits can also be used in combination with the #WAIT signal. In this case as well, the #WAIT signal is sampled at the falling edge of the transition of BCLK. However, even when the #WAIT signal is inactive before the wait cycles set by the wait control bits are terminated, the read cycle is not terminated at that time.

### Precaution

### #CE and address hold times at the rising edge of the #RD signal

In read cycles of this BCU, negating the #RD signal, negating the chip enable (#CExx) signal and changing the address (A[23:0]) occur simultaneously at the same clock edge. No hold time is inserted to the chip enable and address signals. The same applies even when an output disable delay time is inserted.

Therefore when connecting a peripheral circuit, which changes its internal state by reading, to the bus, take a measure to insert a delay to the address and chip enable signals.



Figure 4.21 Trouble Case

### Output disable cycle

When an output disable cycle (set with output disable delay time parameter) is inserted, the chip enable (#CExx) signal temporarily goes high. This makes an interval between the next read cycle. Note, however, that no output disable cycle is inserted when reading is continuously performed to the area that is accessed with the same chip enable signal.

## **SRAM Write Cycles**

### Basic write cycle with no wait mode









Figure 4.24 Byte Write Cycle with No Wait (#BSL system, little endian)

### Write cycle with wait mode

Example: When the BCU has no internal wait mode, and 1 wait cycle is inserted via the #WAIT pin



Figure 4.25 Half-word Write Cycle with Wait

The #WAIT signal is sampled at the falling edge of the transition of BCLK (bus clock), and the write cycle is terminated in the cycle immediately following the cycle in which the #WAIT signal was sampled in an inactive (high level).

**Note:** Insertion of wait cycles via the #WAIT pin is possible only when the device for bus conditions is set to SRAM and SWAIT (D0) / Bus control register (0x4812E) is enabled for waiting.

The above example shows a write cycle when a wait mode is inserted via the #WAIT signal. A wait mode consisting of 2 to 7 cycles can also be inserted using the wait control bits. The settings of these bits also can be used in combination with the #WAIT signal. In this case as well, the #WAIT signal is sampled at the falling edge of the transition of BCLK. However, even when the #WAIT signal is inactive before the wait cycles set by the wait control bits are terminated, the write cycle is not terminated at that time.

**Note:** The basic write cycle consists of at least two cycles. This does not change regardless of whether zero or one wait cycle is set by the wait control bits. If the number of wait cycles set is 2 or more, the bus cycle is actually extended. In this case, the bus write cycle consists of [number of wait cycles + 1], as in the case of read cycles (providing that there is no external wait).

## Burst ROM Read Cycles

### Burst read cycle

Example: When 4-consecutive-burst and 2-wait cycles are set during the first access





A burst read cycle occurs when area 10 or 9 is set for burst ROM and one of those areas is accessed for the following reasons:

#### 1) Instruction fetch

- The burst read cycle is executed as long as a instruction fetch from contiguous addresses continues until A[2:1] = "11" (for 4-consecutive bursts); or
  - A[3:1] = "111" (for 8-consecutive bursts)
- 2) Word (32-bit) data readout

Note: A 16-bit output is supported for the burst ROM. Set the device size to 16 bits.

#### Wait cycles during burst read

In the first bus operation, 0 to 7 wait cycles can be inserted using the wait control bits A10WT[2:0] (D[2:0]) /Areas 10–9 set-up register (0x48126) in the same way as for ordinary SRAM. For the wait cycles to be inserted in the burst cycle that follows, use a dedicated wait control bits, A10BW[1:0], which is only used for reading bursts. The wait cycles can be set in the range from 0 to 3 using these bits. Note that no wait cycle via the #WAIT pin can be inserted into the burst-read cycle.

#### Write cycle to burst ROM area

If area 10 or 9 is set for burst ROM, a SRAM write cycle is executed when a write to that area is attempted. In this case, wait cycles via the #WAIT pin can be inserted.

# DRAM Direct Interface

## **Outline of DRAM Interface**

The BCU incorporates a DRAM direct interface that allows DRAM to be connected directly to areas 8 and 7 or areas 14 and 13. This interface supports the 2CAS method, so that column addresses can be set at between 8 and 11 bits. In addition, this interface supports a fast-page or an EDO-page mode (EDO DRAM directly connectable to areas) as well as random cycles. The refresh method (CAS-before-RAS refresh or self-refresh) and timing conditions (e.g., number of RAS/CAS cycles and number of precharge cycles) can be programmed using a control bit.

When selecting areas 8 and 7 or areas 14 and 13 to be used for DRAM, it depends on chip-enable settings using CEFUNC (D9) / DRAM timing set-up register (0x48130).

CEFUNC = "00": DRAM can be connected to areas 8 and 7 (default)

#CE8 and #CE7 function as #RAS0 and #RAS1, respectively.

CEFUNC  $\neq$  "00": DRAM can be connected to areas 14 and 13.

#CE14 and #CE13 function as #RAS2 and #RAS3, respectively.

Figure 4.27 shows a sample DRAM connection. Table 4.14 and Table 4.15 show examples of connectable DRAMs and typical configurations.



\* x: 14, 13, 8 or 7

Figure 4.27 Sample DRAM Connection

\_ \_ . . . \_

DRAM	Number of devices	Number of Row bits	Number of Column bits	Memory size			
1M (64K x 16)	1	8	8	128K bytes			
4M (256K x 16)	1	9	9	512K bytes			
16M (1M x 16)	1	12	8	2M bytes			

Table 4.15	DRAM Configuration	Example	(areas 7	and 8	only)
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	Area 7	Area 8	Total r	nemory size
1	I/O	DRAM (1M)	1M bits	(128K bytes)
2	I/O	DRAM (4M)	4M bits	(512K bytes)
3	I/O	DRAM (16M)	16M bits	(2M bytes)
4	DRAM (1M)	DRAM (1M)	2M bits	(256K bytes)
5	DRAM (4M)	DRAM (4M)	8M bits	(1M bytes)
6	DRAM (16M)	DRAM (16M)	32M bits	(4M bytes)

## **DRAM Setting Conditions**

The DRAM interface allows the following conditions to be selected. Although DRAM can be used in areas 8 and 7 or areas 14 and 13, these condition are applied to all four areas and cannot be set individually for each area.

r	Table 4.16 DRAM Interface Parameters													
Parameter	Selectable condition	Initial setting	Control bits											
Page mode	EDO page mode	Fast page mode	REDO(DC)/Bus control register(0x4812E)											
	or Fast page mode													
RAS mode	Successive RAS mode	Normal mode	CRAS(D8)/DRAM timing set-up register(0x48130)											
	or Normal mode													
Column address size	8, 9, 10 or 11 bits	8 bits	RCA[1:0](D[B:A])/Bus control register(0x4812E)											
Refresh enable	Enabled or Disabled	Disabled	RPC2(D9)/Bus control register(0x4812E)											
Refresh method	Self-refresh	CBR refresh	RPC1(D8)/Bus control register(0x4812E)											
	or CBR refresh													
Refresh RPC delay	2.0 or 1.0	1.0	RPC0(D7)/Bus control register(0x4812E)											
Refresh RAS pulse width	2, 3, 4 or 5 cycles	2 cycles	RRA[1:0](D[6:5])/Bus control register(0x4812E)											
Number of RAS precharge cycles	1, 2, 3 or 4 cycles	1 cycle	RPRC[1:0](D[7:6])/DRAM timing set-up register(0x48130)											
CAS cycle control	1, 2, 3 or 4 cycles	1 cycle	CASC[1:0](D[4:3])/DRAM timing set-up register(0x48130)											
RAS cycle control	1, 2, 3 or 4 cycles	1 cycle	RASC[1:0](D[1:0])/DRAM timing set-up register(0x48130)											

### Page mode

The DRAM interface allows EDO DRAM to be connected directly. Therefore, the EDO-page mode is supported along with the fast-page mode.

Use REDO to choose the desired page mode that suits the DRAM to be used.

REDO = "1": EDO page mode

REDO = "0": Fast page mode (default)

#### Successive RAS mode

For applications that require high-speed DRAM access, the DRAM interface supports a successive RAS mode. In this mode, even when successive accesses to the DRAM are not requested by the CPU, the #RAS signal is kept low and operation is continued without inserting any precharge cycle. Therefore, when accessing the same page (row address) of the DRAM that has been accessed previously, the page mode remains active, allowing read/write to be performed at high speeds.

However, to maintain the rated AC characteristics, one idle cycle is inserted when access in the page mode is begun and when finished.

CRAS is used to set the successive RAS mode.

CRAS = "1": Successive RAS mode

CRAS = "0": Normal mode (default)

The successive RAS mode is suspended by one of the following causes:

- a refresh cycle has occurred;
- bus control is requested by an external bus master;
- the requested device and page are not compatible with DRAM memory; and
- the slp or halt instruction is executed.
- If the successive RAS mode is suspended, a precharge cycle is inserted before the next bus cycle begins.
- **Note:** When using the successive RAS mode, always be sure to use #DRD for the read signal and #DWE for the low-byte write signal.

#### Column address size

When accessing DRAM, addresses are divided into a row address and a column address as they are output. Choose the size of this column address using RCA, as shown below.

Table 4.17 Column Address Size											
RCA1	RCA0	Column address size									
1	1	11									
1	0	10									
0	1	9									
0	0	8									

The initial default size is 8 bits. Choose the desired size according to the address input pins of the DRAM to be used.

The row addresses output synchronously with falling edges of the #RAS signal are derived from the CPU's internal 28-bit addresses by logically shifting them to the right by an amount equal to the column address size. The MSB contains a 1. The column addresses are output to the address bus along with the falling edges of the #CAS signal. These addresses are derived directly from the CPU's internal 28-bit addresses.

Figure 4.28 shows the contents of the row addresses thus output.

#### 28-bit CPU internal address

27	26	25	24	23	22	21	20	19	18	17	16	15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0
	-	-		-			-	-	-		-	-		-			-	-	-		-	-		-			

(1) Row address when column address is set to 8 bits

T T T T T T T T T T T 27 26 25 24 23 22 21 20 19 18 17 16 15 14 13 12 11 10 9 8

(2) Row address when column address is set to 9 bits

 T
 T
 T
 T
 T
 27
 26
 25
 24
 23
 22
 21
 20
 19
 18
 17
 16
 15
 14
 13
 12
 11
 10
 9

(3) Row address when column address is set to 10 bits

T T T T T T T T T T T T T T T 7 27 26 25 24 23 22 21 20 19 18 17 16 15 14 13 12 11 10

(4) Row address when column address is set to 11 bits

T T T T T T T T T T T T T T T T 727 26 25 24 23 22 21 20 19 18 17 16 15 14 13 12 11

T = "1", 0–27: Bit number of CPU internal address

Figure 4.28 Example of Row/Column Address Mapping

#### Refresh enable

Use RPC2 to enable or disable the internal refresh function.

RPC2 = "1": Enabled

RPC2 = "0": Disabled (default)

After choosing the desired refresh method using RPC1, write "1" to RPC2.

#### **Refresh method**

The DRAM interface supports both a CAS-before-RAS refresh cycle and a self-refresh cycle. Choose the desired method using RPC1.

RPC1 = "1": Self-refresh

RPC1 = "0": CAS-before-RAS refresh

The generation interval of the CAS-before-RAS refresh is determined by the underflow signal of an 8-bit programmable timer 0. Consequently, before the CAS-before-RAS refresh can be executed, the 8-bit programmable timer 0 must be set to obtain the necessary underflow timing. When this method is selected and RPC2 is enabled, the refresh cycle is generated each time the 8-bit programmable timer 0 underflows. The self-refresh is started by writing "1" to RPC2 while RPC1 = "1" and is terminated by clearing RPC1 or

RPC2 to "0".

If RPC1 is switched over when RPC2 = "1" (refresh enabled), an undesirable self-refresh cycle is generated. So be sure to clear RPC2 to "0" (refresh disabled) before selecting the refresh method.
#### **Refresh RPC delay**

Use RPC0 to set the RPC delay value of a refresh cycle (a delay time from the immediately preceding precharge to the fall of #CAS). RPC0 = "1": 2 cycles

RPC0 = "0": 1 cycle

#### **Refresh RAS pulse width**

Use RRA to set the #RAS pulse width of a CAS-before-RAS refresh cycle.

Table 4.1	Table 4.18 Refresh RAS Pulse Width							
RRA1	RRA0	Pulse width						
1	1	5 cycles						
1	0	4 cycles						
0	1	3 cycles						
0	0	2 cycles						

The initial default value is 2 cycles.

#### Number of RAS precharge cycles

Use RPRC to choose the number of RAS precharge cycles.

RPRC1	RPRC0	Number of cycles						
1	1	4 cycles						
1	0	3 cycles						
0	1	2 cycles						
0	0	1 cycle						

Table 4.19 Number of RAS Precharge Cycles

The initial default value is 1 cycle.

#### **CAS cycle control**

Use CASC to choose the number of CAS cycles when accessing DRAM.

Table 4.20 Number of CAS Cycles								
CASC1	CASC0	Number of cycles						
1	1	4 cycles						
1	0	3 cycles						
0	1	2 cycles						
0	0	1 cycle						

The initial default value is 1 cycle.

#### **RAS cycle control**

Use RASC to choose the number of RAS cycles when accessing DRAM.

Table 4.21 Number of RAS Cycles								
RASC1	RASC0	Number of cycles						
1	1	4 cycles						
1	0	3 cycles						
0	1	2 cycles						
0	0	1 cycle						

The initial default value is 1 cycle.

### DRAM Read/Write Cycles

The following shows the basic bus cycles of DRAM. The DRAM interface does not accept wait cycles inserted via the #WAIT pin.

#### **DRAM random read cycle**

Example: RAS: 1 cycle; CAS: 2 cycles; Precharge: 1 cycle



Figure 4.29 DRAM Random Read Cycle

#### DRAM read cycle (fast page mode)

Example: RAS: 1 cycle; CAS: 2 cycles; Precharge: 1 cycle



Figure 4.30 DRAM Read Cycle (fast page mode)

#### DRAM read cycle (EDO page mode)

Example: RAS: 1 cycle; CAS: 2 cycles; Precharge: 1 cycle





The read timing in EDO page-mode lags 0.5 cycles behind that in fast page mode.

#### DRAM random write cycle

Example: RAS: 1 cycle; CAS: 2 cycles; Precharge: 1 cycle



Figure 4.32 2CAS Type DRAM Random Write Cycle

#### DRAM write cycle (fast page or EDO page mode)

Example: RAS: 1 cycle; CAS: 2 cycles; Precharge: 1 cycle; word-write sample







Example: RAS: 1 cycle; CAS: 2 cycles; Precharge: 1 cycle; byte-write sample (little endian)



#### **Operation in successive RAS mode**

Example: RAS: 2 cycles; CAS: 1 cycle; Precharge: 2 cycles



Figure 4.35 Operation in Successive RAS Mode

- (1) When accessing the DRAM area, an ordinary RAS cycle is executed first.
- (2) If access to the same DRAM is suspended during a page mode, #RASx remains asserted while some other device is accessed. In this case, a cycle to temporarily deassert #DRD/#DWE is inserted before accessing the other device.
- (3) If access to the same page in the same DRAM area as in (1) is requested after (2), #DRD/#DWE is asserted back again to restart the page mode.
- (4) A precharge cycle is executed when one of the following conditions that cause the page mode to suspend is encountered:
  - access to different DRAM is requested;
  - access to a different page in the same DRAM area is requested;
  - access to some other device than DRAM is requested;
  - CAS-before-RAS refresh is requested; and
  - relinquishing of bus control is requested by an external bus master.
- **Note:** When using the successive RAS mode, always be sure to use #DRD for the read signal and #DWE for the low-byte write signal.

### DRAM Refresh Cycles

The DRAM interface supports a CAS-before-RAS refresh cycle and a self-refresh cycle.

#### CAS-before-RAS refresh cycle

Before performing a CAS-before-RAS refresh, set RPC2 to "1" while RPC1 = "0" in order to enable the DRAM refresh function. Once this is done, the BCU executes a CAS-before-RAS refresh by using the underflow signal that is output by the 8-bit programmable timer 0 as a trigger. Therefore, refresh generation timing can be programmed using the internal prescaler and 8-bit programmable timer 0. For details on how to control the prescaler and 8-bit programmable timer 0, refer to "Prescaler and Operating Clock for Peripheral Circuits", and "8-bit Programmable Timers".

Example: RPC delay: 1 cycle; Refresh RAS pulse width: 2 cycles; Precharge: 1 cycle



Figure 4.36 CAS-Before-RAS Refresh

When the refresh cycle is terminated, the #HCAS/#LCAS signal boot timing is 0.5 cycles before that of #RAS. Consequently, the pulse width of #HCAS/#LCAS is determined by the refresh RAS pulse width that was set using RRA. The number of precharge cycles after the refresh cycle is defined by the value that was set using RPRC, the same value that is used for both random cycles and page mode accesses.

#### Self-refresh

To support DRAM chips equipped with a self-refresh function, the BCU has a function to generate a self-refresh cycle.

To start a self-refresh cycle, set RPC2 to "1" after setting RPC1 to "1". To deactivate a self-refresh cycle, write "0" to RPC1 or RPC2.



Example: RPC delay: 1 cycle

For a self-refresh function as well, the RPC delay is determined by setting RPC0 in the same way as for a CAS-before-RAS refresh.

The refresh RAS pulse width is determined by the timing at which the refresh is deactivated in software and is unaffected by settings of RRA.

#RAS and #HCAS/#LCAS are booted up simultaneously upon completion of a self-refresh and the precharge duration that follows is fixed at 6 cycles.

Normally, DRAM specifications require that the contents of all row addresses be refreshed within a certain time before and after a self-refresh. To meet this requirement, make sure a CAS-before-RAS refresh is executed by a program. In this case, set the 8-bit programmable timer 0 so that the contents of all row addresses are refreshed within a predetermined time.

**Note:** If read from or write to the DRAM under a self-refresh is attempted, the BCU keeps #RAS and #HCAS/#LCAS low as it executes a read/write cycle. Other bus signals than #RAS and #HCAS/#LCAS (e.g., address, data, and control signals) change their state according to the specified conditions. Since said attempt initiates an invalid access to the DRAM, do not read from or write to the DRAM during a self-refresh.

## **Releasing External Bus**

The external bus is normally controlled by the CPU, but the BCU is designed to release control of the bus ownership to an external device. This function is enabled by writing "1" to SEMAS (D2) / Bus control register (0x4812E) (disabled by default). The #BUSREQ (P34) and #BUSACK (P35) pins are used for control of the bus ownership. To direct the P34 and P35 pins for input/output of the #BUSREQ and #BUSACK signals, write "1" to CFP34 (D4) and CFP35 (D5) / P3 function select register (0x402DC [Byte]).

#### Sequence in which control of the bus is released

This sequence is described below.

- 1. The external bus master device requesting control of the bus ownership lowers the #BUSREQ pin.
- 2. The CPU keeps monitoring the status of the #BUSREQ pin, so that when this pin is lower, the CPU terminates the bus cycle being executed and places the signals listed below in high-impedance state one cycle later:

A[23:0], D[15:0], #RD, #WRL, #WRH, #HCAS, #LCAS, #CExx

Then the CPU lowers the #BUSACK pin to inform the external device that control of the bus ownership has been released.

- 3. One cycle later, the external bus starts its own bus cycle. The external bus master must hold the #BUSREQ pin low until the bus cycle is completed.
- 4. After completing the necessary bus cycles, the external bus master places the bus in high-impedance state and releases the **#BUSREQ** pin back high.
- 5. After confirming that the #BUSREQ pin is raised again, the CPU raises the #BUSACK pin one cycle later and resumes the processing that has been suspended.



Figure 4.38 External Bus Release Timing

#### DRAM refresh when bus ownership control is released

In systems where DRAM is connected directly, a refresh request could arise while control of the bus ownership is released from the CPU. In such a case, take one of the corrective measures described below.

#### • Monitoring the output signal of the 8-bit programmable timer 0

The underflow signal (DRAM refresh request) of the 8-bit programmable timer 0 can be output from the P10 I/O port pin.

If a refresh request arises while the external bus master is monitoring this output, release #BUSREQ back high to drop the request for bus ownership control.

Start a DRAM refresh cycle when control of the bus ownership is returned to the CPU.

To direct the P10 pin in order to output the underflow signal of the 8-bit programmable timer 0, write "1" to CFP10 (D0) / P1 function select register (0x402D4 [Byte]) and IOC10 (D0) / P1 I/O control register (0x402D6 [Byte]). Also, to output the underflow signal to an external device, write "1" to PTOUT0 (D2) / 8-bit Timer 0 control register (0x40160 [Byte]). For details about output control, refer to "8-Bit Programmable Timers".

#### Monitoring the #BUSGET signal

The #BUSGET signal can be output from the P31 I/O port pin.

- The #BUSGET signal is derived from logical sum of the following signals:
- 1. DRAM refresh request signal (output from the 8-bit programmable timer 0)
- 2. Interrupt request signal from the interrupt controller to the CPU

If the #BUSGET signal is found to be active when the external bus master is monitoring it, release #BUSREQ back high to drop the request for bus ownership control.

When using the #BUSGET signal to only monitor a refresh request, set the interrupt controller in such a way that no interrupt request will be generated.

To direct the P31 pin for output of the #BUSGET signal, write "1" to CFP31 (D1) / P3 function select register (0x402DC [Byte]) and CFEX3 (D3) / Port function extension register (0x402DF [Byte]).

## Power-down Control by External Device

In addition to requesting the releasing of bus ownership control described above, it is possible to place the CPU in a HALT state by using the #BUSREQ signal. This allows the CPU to be stopped during bus operation by an external bus master in order to conserve power.

This function is enabled by writing "1" to SEPD (D1) / Bus control register (0x4812E).

If SEPD = "1", the CPU and the BCU stop operating when the #BUSREQ pin is lowered, thus entering a HALT state. This HALT state is not cleared by an interrupt from the internal peripheral circuits and remains set until the #BUSREQ pin is released back high. Unlike in the case of ordinary releasing of the bus by #BUSREQ, the address bus and bus control signals are not placed in high-impedance state.

For a DRAM refresh request that may arise in this HALT state, take one of the corrective measures described above.

## I/O Memory of BCU

Table 4.22 shows the control bits of the BCU. These I/O memories are mapped into the area (0x48000 and following addresses) used for the internal 16-bit peripheral circuits. However, these I/O memories can be accessed in bytes or words, as well as in half-words.

For the control bits of the external system interface pins assigned to the I/O ports, and for details on how to control the 8-bit programmable timer 0 in order to generate a DRAM refresh cycle, refer to each corresponding section in this manual.

Register name	Address	Bit	Name	Function Setting I		Init.	R/W	Remarks		
Areas 18-15	0048120	DF	-	reserved			-	-	-	0 when being read.
set-up register	(HW)	DE	A18SZ	Areas 18–17 device size selection	1 8	bits	0 16 bits	0	R/W	
		DD	A18DF1	Areas 18–17	A180	DF[1:0]	Number of cycles	1	R/W	
		DC	A18DF0	output disable delay time	1	1	3.5	1		
					1	0	2.5			
					0	1	1.5			
					0	0	0.5			
		DB	-	reserved			-	-	-	0 when being read.
		DA	A18WT2	Areas 18–17 wait control	A18V	VT[2:0]	Wait cycles	1	R/W	
		D9	A18WT1		1	1 1	7	1		
		D8	A18WT0		1	1 0	6	1		
					1	0 1	5			
					1	0 0	4			
					0	1 1	3			
					0	1 0	2			
					0	0 1	1			
					0	υΙΟ	0			
		D7	-	reserved	1 0	hito	-	_	-	U when being read.
		D6	A165Z	Areas 16–15 device size selection	1 8		U 16 Dits	0	R/W	
		D5	AIODEI	Aleas 10-15	4161		Number of cycles	1	R/VV	
		D4	ATODFU	output disable delay time			3.5			
						1	2.5			
					0	0	0.5			
		D3	_	reserved	-	Ŭ	-	_	-	0 when being read.
		D2	A16WT2	Areas 16–15 wait control	A16WT[2:0] Wait cycles		1	R/W		
		D1	A16WT1		1	1 1	7	1		
		D0	A16WT0		1	1 0	6	1		
					1	0 1	5			
					1	0 0	4			
					0	1 1	3			
					0	1 0	2			
					0 0 1 1					
					0	0 0	0			
Areas 14-13	0048122	DF-9	-	reserved			_	-	0 when being read.	
set-up register	(HW)	D8	A14DRA	Area 14 DRAM selection	1 Us	sed	0 Not used	0	R/W	
		D7	A13DRA	Area 13 DRAM selection	1 U:	sed	0 Not used	0	R/W	
		D6	A14SZ	Areas 14–13 device size selection	1 8	bits	0 16 bits	0	R/W	
		D5	A14DF1	Areas 14–13	A14L	JF[1:0]	Number of cycles	1	R/W	
		D4	A14DF0	output disable delay time	able delay time 1 1 3.5		1			
						2.5				
							1.5			
		D3	_	reserved		0	0.5			0 when being read
		D3 D2	_ Δ14WT2	Areas 14–13 wait control				1		o when being read.
		D1	A14WT1			1 1	7	1	1011	
		D0	A14WT0			1 0	6	1		
		20				0 1	5			
					1	0 0	4			
					0	1 1	3			
					0	1 0	2			
					0	0 1	1			
					0	0 0	0			

Table 4.22 Control Bits of External System Interface

Register name	Address	Bit	Name	Function	Setting		Init.	R/W	Remarks		
Areas 12–11	0048124	DF-7	-	reserved				_	_	_	0 when being read
set-up register	(HW)	D6	A12SZ	Areas 12–11 device size selection	1 8	3 bit	s	0 16 bits	0	R/W	o mon boing road.
oot up rogiotoi	(,	D5	A12DF1	Areas 12–11	A18	BDF	[1:0]	Number of cycles	1	R/W	
		D4	A12DF0	output disable delay time	1	1 1 35		35	1		
		54					0	2.5			
					0		1	1.5			
					0		0	0.5			
		D3	-	reserved				-	-	-	0 when being read.
		D2	A12WT2	Areas 12–11 wait control	A18	WT	[2:0]	Wait cycles	1	R/W	
		D1	A12WT1		1	1	1	7	1		
		D0	A12WT0		1	1	0	6	1		
					1	0	1	5			
					1	0	0	4			
					0	1	1	3			
					0	1	0	2			
					0	0	1	1			
					0	0	0	0			
Areas 10-9	0048126	DF	-	reserved				-	-	-	0 when being read.
set-up register	(HW)	DE	A10IR2	Area 10 internal ROM wait control	A10	)IR[	[2:0]	ROM size	1	R/W	
		DD	A10IR1	Area 10 internal ROM size	1	1	1	2MB	1		
		DC	A10IR0	selection	1	1	0	1MB	1		
					1	0	1	512KB			
					1	0	0	256KB			
					0	1	1	128KB			
					0	1	0	64KB			
					0	0	1	32KB			
					0 0 0 16KB						
		DB	-	reserved	eserved			-	-	-	0 when being read.
		DA	A10BW1	Areas 10–9	A10	BW	/[1:0]	Wait cycles	0	R/W	
		D9	A10BW0	burst ROM			1	3	0		
				burst read cycle wait control	1		0	2			
					0		1	1			
		D0		Area 10 burst BOM selection			4		0	D/\/	
				Area 9 burst ROM selection		Jse	u d		0		
			A9DKA	Areas 10–9 device size selection	1 9	2 bit	u c		0		
		D5	A10DF1	Areas 10–9	A10DE[1:0] Number of cycles		1	R/W			
		D4	A10DF0	output disable delay time	1	<u> </u>	1	3.5	1		
					1		0	2.5			
					0		1	1.5			
					0 0 0.5						
		D3	-	reserved					-	-	0 when being read.
		D2	A10WT2	Areas 10–9 wait control	A10	WT	[2:0]	Wait cycles	1	R/W	
		D1	A10WT1		1	1	1	7	1		
		D0	A10WT0		1	1	0	6	1		
					1	0	1	5			
					1	0	0	4			
					0	1	1	3			
					0	1	0	2			
								1			
Aroas 9 7	0040400			reconved		0	10				0 when heing read
set-up register	(HIV)	DE-8		Area 8 DRAM selection	11	lec	d	-	_	= R/\\/	o when being read.
set-up register	(ПVV)	D0 D7		Area 7 DRAM selection		JSe	u d		0	R/W	
		D6	A8S7	Areas 8–7 device size selection	1 8	3 bit	s	0 16 bits	0	R/W	
		D5	A8DF1	F1 Areas 8–7		DFI	1:01	Number of cycles	1	R/W	
		D4	A8DF0	output disable delay time		Т	1	3.5	1		
					1		0	2.5			
					0		1	1.5			
					0		0	0.5			
		D3	-	reserved				-	-	-	0 when being read.
		D2	A8WT2	Areas 8–7 wait control	A8\	WT	[2:0]	Wait cycles	1	R/W	
		D1	A8WT1			1		7	1		
		00	A8W10			1	0	6	1		
						0		D A			
						1		4			
						1		2			
						0	1	1			
					0	0	0	o			

### II CORE BLOCK: BCU (Bus Control Unit)

Register name	Address	Bit	Name	Function	Setting		R/W	Remarks
Areas 6-4	004812A	DF-F	-	reserved	_	-	-	0 when being read
set-up register	(HW)		A6DF1	Area 6	A6DF[1:0] Number of cycle	s 1	R/W	o mion boing roadi
oot up rogioto.	(,	DC	A6DF0	output disable delay time				
		20				·		
		DB	_	reserved	-	-	-	0 when being read.
		DA	A6WT2	Area 6 wait control	A6WT[2:0] Wait cycles	1	R/W	
		D9	A6WT1					
		D8	A6WT0			1		
		20				·		
		D7	-	reserved	_	-	-	0 when being read.
		D6	A5SZ	Areas 5–4 device size selection	1 8 bits 0 16 bits	0	R/W	, , , , , , , , , , , , , , , , , , ,
		D5	A5DF1	Areas 5–4	A5DF[1:0] Number of cycle	s 1	R/W	
		D4	A5DF0	output disable delay time	1 1 3.5	1		
					1 0 2.5			
					0 1 1.5			
					0 0 0.5			
		D3	-	reserved		-	-	0 when being read.
		D2	A5WT2	Areas 5-4 wait control	A5WT[2:0] Wait cycles	1	R/W	
		D1	A5WT1		1 1 1 7	1		
		D0	A5WT0		1 1 0 6	1		
					1 0 1 5			
					1 0 0 4			
					0 1 1 3			
					0 1 0 2			
					0 0 1 1			
					0 0 0 0			
Bus control	004812E	DF	RBCLK	BCLK output control	1 Fixed at H 0 Enabled	0	R/W	
register	(HW)	DE	-	reserved	-		-	Writing 1 not allowed.
		DD	RBST8	Burst ROM burst mode selection	1 8-successive 0 4-successiv	e 0	R/W	
		DC	REDO	DRAM page mode selection	1 EDO 0 Fast page	0	R/W	
		DB	RCA1	Column address size selection	RCA[1:0] Size		R/W	
		DA	RCAU			0		
			RPC2	Refresh enable		0	R/M	
		D3	RPC1	Refresh method selection	1 Self-refresh 0 CBR-refre	h 0	R/W	
		D7	RPC0	Refresh RPC delay setup		0	R/W	
		D6	RRA1	Refresh RAS pulse width	RRA[1:0] Number of cycle	s 0	R/W	
		D5	RRA0	selection	1 1 5	0		
					1 0 4			
					0 1 3			
					0 0 2			
		D4	-	reserved	-	0	-	Writing 1 not allowed.
		D3	SBUSST	External interface method selection	1 #BSL 0 A0	0	R/W	
		D2	SEMAS	External bus master setup	1 Existing 0 Nonexiste	nt O	R/W	
		D1	SEPD	External power-down control	1 Enabled 0 Disabled	0	R/W	
		D0	SWAITE	#WAIT enable	1 Enabled 0 Disabled	0	R/W	

Register name	Address	Bit	Name	Function	Function Setting		Init.	R/W	Remarks			
DRAM timing	0048130	DF-C	-	reserved				_		_	-	0 when being read.
set-up register	(HW)	DB	A3EEN	Area 3 emulation	1	Inte	ernal RO	M 0	Emulation	1	R/W	Ŭ
	. ,	DA	CEFUNC1	#CE pin function selection	CFFUNC[1:0] #CE output		0	R/W				
		D9	CEFUNC0			1	x	#CE7	/8#CE17/18	0		
					(	0	1	#Cl	E6#CE17			
					(	0	0	#Cl	E4#CE10			
		D8	CRAS	Successive RAS mode setup	1	Su	Iccessive	e 0	Normal	0	R/W	
		D7	RPRC1	DRAM	R	PR	C[1:0]	Num	ber of cycles	0	R/W	
		D6	RPRC0	RAS precharge cycles selection		1	1		4	0		
						1	0		3			
						0	1		2			
		D5	_	reserved		0	0	_	1	_	_	0 when being read
		D4	CASC1	DRAM	С	AS	C[1·0]	Num	her of cycles	0	R/W	o when being read.
		D3	CASCO	CAS cycles selection		1	1	- turn	4	0		
						1	0		3	-		
					(	0	1		2			
					(	0	0		1			
		D2	-	reserved				-		-	-	0 when being read.
		D1	RASC1	DRAM	R	AS	C[1:0]	Numl	ber of cycles	0	R/W	
		D0	RASC0	RAS cycles selection		1	1		4	0		
						1	0		3			
					(	0	1		2			
					(	0	0		1			
Access control	0048132	DF	A18IO	Area 18, 17 internal/external access	1	Int	ernal	0	External	0	R/W	
register	(HW)	DE	A16IO	Area 16, 15 internal/external access		ac	cess		access	0	R/W	
			A14IO	Area 14, 13 internal/external access						0	R/W	
		DB	A12IU	Area 12, 11 Internal/external access						0	R/ VV	0 when being read
			- 4810	Area 8 7 internal/external access	1	Int	ernal	10	External	0	= R/W	o when being read.
		D9	A6IO	Area 6 internal/external access		ac	cess	ľ	access	0	R/W	
		D8	ASIO	Area 5, 4 internal/external access			0000		400000	0	R/W	
		D7	A18EC	Area 18, 17 endian control	1	Bic	g endian	0	Little endian	0	R/W	
		D6	A16EC	Area 16, 15 endian control			-			0	R/W	
		D5	A14EC	Area 14, 13 endian control						0	R/W	
		D4	A12EC	Area 12, 11 endian control						0	R/W	
		D3	A10EC	Area 10, 9 endian control			0	R/W				
		D2	A8EC	Area 8, 7 endian control			0	R/W				
		D1	A6EC	Area 6 endian control						0	R/W	
		D0	ASEC	Area 5, 4 endian control						0	R/W	
G/A read signal	0048138	DF	A18AS	Area 18, 17 address strobe signal	1	En	abled	0	Disabled	0	R/W	
control register	(HW)	DE	A16AS	Area 16, 15 address strobe signal						0	R/W	
			A14A5	Area 12, 11 address strobe signal						0		
		DB	-	reserved	-	L		_		0	_	0 when being read
		DA	A8AS	Area 8, 7 address strobe signal	1	En	abled	0	Disabled	0	R/W	
		D9	A6AS	Area 6 address strobe signal						0	R/W	1
		D8	A5AS	Area 5, 4 address strobe signal						0	R/W	1
		D7	A18RD	Area 18, 17 read signal	1	En	abled	0	Disabled	0	R/W	
		D6	A16RD	Area 16, 15 read signal						0	R/W	
		D5	A14RD	Area 14, 13 read signal						0	R/W	
		D4	A12RD	Area 12, 11 read signal						0	R/W	
		D3	-	reserved	4	<b>_</b>	al-la d	-	Dischlad	0	-	0 when being read.
			ASRD	Area 8, 7 read signal	1	En	abled	0	Disabled	0	R/W	
			ASRD	Area 5, 4 read signal					0	R/W		
BCI K soloot	0048134	D7_4		reserved					L	0		0 when being road
register	(R)	D3		Area 1 access-speed	1	20	voles		4 cycles	0	R/W	x2 speed mode only
910101	(3)	D2	-	reserved		<u> </u>	570100		. 090100	0	-	0 when being read.
			BCLKSEL1	BCLK output clock selection	вс	LKS	SEL[1:0]		BCLK	0	R/W	
		D0	BCLKSEL0			1	1	P	LL_CLK	0		
						1	0	0	SC3_CLK			
						0	1	В	CU_CLK			
						0	0	С	PU_CLK			

A18SZ: Areas 18–17 device size selection (DE) / Areas 18–15 set-up register (0x48120) A16SZ: Areas 16–15 device size selection (D6) / Areas 18–15 set-up register (0x48120) A14SZ: Areas 14–13 device size selection (D6) / Areas 14–13 set-up register (0x48122) A12SZ: Areas 12–11 device size selection (D6) / Areas 12–11 set-up register (0x48124) A10SZ: Areas 10–9 device size selection (D6) / Areas 10–9 set-up register (0x48126) A8SZ: Areas 8–7 device size selection (D6) / Areas 8–7 set-up register (0x48128) A5SZ: Areas 5–4 device size selection (D6) / Areas 6–4 set-up register (0x4812A)

Select the size of the device connected to each area.

Write "1": 8 bits Write "0": 16 bits Read: Valid

A device size can be selected for every two areas.

An 8-bit size is selected by writing "1" to AxxSZ and a 16-bit size is selected by writing "0" to AxxSZ. Area 6 has its first half (0x300000 through 0x37FFF) fixed to an 8-bit device and the last half (0x380000 through 0x3FFFF) fixed to a 16-bit device.

At cold start, these bits are set to "0" (16 bits). At hot start, these bits retain their status before being initialized.

A18DF1-A18DF0: Areas 18-17 output disable delay time (D[D:C]) / Areas 18-15 set-up register (0x48120) A16DF1-A16DF0: Areas 16-15 output disable delay time (D[5:4]) / Areas 18-15 set-up register (0x48120) A14DF1-A14DF0: Areas 14-13 output disable delay time (D[5:4]) / Areas 14-13 set-up register (0x48122) A12DF1-A12DF0: Areas 12-11 output disable delay time (D[5:4]) / Areas 12-11 set-up register (0x48124) A10DF1-A10DF0: Areas 10-9 output disable delay time (D[5:4]) / Areas 10-9 set-up register (0x48126) A8DF1-A8DF0: Areas 8-7 output disable delay time (D[5:4]) / Areas 8-7 set-up register (0x48128) A6DF1-A6DF0: Area 6 output disable delay time (D[D:C]) / Areas 6-4 set-up register (0x4812A) Area 5-4 output disable delay time (D[5:4]) / Areas 6-4 set-up register (0x4812A)

Set the output-disable delay time.

Table 4.23	Output Dis	sable Delay Time			
AxxDF1	AxxDF0	Delay time			
1	1	3.5 cycles			
1	0	2.5 cycles			
0	1	1.5 cycles			
0	0	0.5 cycles			

When using a device that has a long output-disable time, set a delay time to ensure that no contention for the data bus occurs during the bus operation immediately after a device is read.

At cold start, these bits are set to "11" (3.5 cycles). At hot start, the bits retain their status before being initialized.

A18WT2-A18WT0	: Areas 18–17 wait control (D[A:8]) / Areas 18–15 set-up register (0x48120)
A16WT2-A16WT0	: Areas 16–15 wait control (D[2:0]) / Areas 18–15 set-up register (0x48120)
A14WT2-A14WT0	: Areas 14–13 wait control (D[2:0]) / Areas 14–13 set-up register (0x48122)
A12WT2-A12WT0	: Areas 12–11 wait control (D[2:0]) / Areas 12–11 set-up register (0x48124)
A10WT2-A10WT0	: Areas 10–9 wait control (D[2:0]) / Areas 10–9 set-up register (0x48126)
A8WT2–A8WT0:	Areas 8–7 wait control (D[2:0]) / Areas 8–7 set-up register (0x48128)
A6WT2–A6WT0:	Area 6 wait control (D[A:8]) / Areas 6–4 set-up register (0x4812A)
A5WT2–A5WT0:	Areas 5–4 wait control (D[2:0]) / Areas 6–4 set-up register (0x4812A)

Set the number of wait cycles to be inserted when accessing an SRAM device.

The values 0 through 7 written to the control bits equal the number of wait cycles inserted.

Note that the write cycle consists of a minimum of two cycles, so that a writing 0 or 1 is invalid.

When an SRAM device is connected, wait cycles derived via the #WAIT pin can also be inserted. In this case too, the wait cycles set by AxxWT are valid.

The DRAM read/write cycles do not have wait cycles inserted that are set by AxxWT or derived from the #WAIT pin.

The burst read cycle of a burst ROM (except for the first access) also does not have any wait cycle inserted. The first read cycle of a burst ROM and the write cycle to the burst ROM area have wait cycles inserted that are set by AxxWT. Wait cycles derived from the #WAIT pin also can be inserted in the cycle for writing to the burst ROM area.

At cold start, these bits are set to "111" (7 cycles). At hot start, the bits retain their status before being initialized.

A14DRA: Area 14 DRAM selection (D8) / Areas 14-13 set-up register (0x48122) A13DRA: Area 13 DRAM selection (D7) / Areas 14-13 set-up register (0x48122) A8DRA: Area 8 DRAM selection (D8) / Areas 8-7 set-up register (0x48128) A7DRA: Area 7 DRAM selection (D7) / Areas 8-7 set-up register (0x48128)

Select the DRAM direct interface.

Write "1": DRAM is used Write "0": DRAM is not used Read: Valid

When DRAM is used by connecting it directly to the BCU, write "1" to this bit. The ordinary SRAM interface is selected by writing "0" to the control bit.

The areas to which DRAM can be connected are areas 8 and 7 when the CEFUNC = "0", or areas 14 and 13 when the bit = "1".

At cold start, these bits are set to "0" (DRAM not used). At hot start, the bits retain their status before being initialized.

#### A10IR2-A10IR0: Area 10 internal ROM size selection (D[D:B]) / Areas 10-9 set-up register (0x48126)

Select an area 10 internal/emulation memory size.

Tab	Table 4.24 Area 10 Internal ROM Size									
A10IR2	A10IR1	A10IR0	ROM size							
0	0	0	16KB							
0	0	1	32KB							
0	1	0	64KB							
0	1	1	128KB							
1	0	0	256KB							
1	0	1	512KB							
1	1	0	1MB							
1	1	1	2MB							

At cold start, A10IR is set to "111" (2MB). At hot start, A10IR retains its status before being initialized.

A10BW1-A10BW0: Burst read cycle wait control (D[A:9]) / Areas 10-9 set-up register (0x48126)

Set the number of wait cycles inserted during a burst read.

The values 0 to 3 written to the bits constitute the number of wait cycles inserted. The contents set here are applied to both areas 10 and 9. The wait cycles set by AxxWT are inserted in the first read cycle of burst ROM and in the burst ROM write cycle. For the burst ROM write cycle, the wait cycles set via the #WAIT pin can also be used. At cold start, A10BW is set to "0" (no wait cycle). At hot start, A10BW retains its status before being initialized.

**A10DRA**: Area 10 burst ROM selection (D8) / Areas 10–9 set-up register (0x48126) **A9DRA**: Area 9 burst ROM selection (D7) / Areas 10–9 set-up register (0x48126)

Set areas 10 and 9 for use of burst ROM.

Write "1": Burst ROM is used Write "0": Burst ROM is not used Read: Valid

When using burst ROM, write "1" to the control bit. The ordinary SRAM interface is selected by writing "0" to the bit.

Area 9 can only be used when the CEFUNC = "00".

At cold start, these bits are set to "0" (burst ROM not used). At hot start, the bits retain their status before being initialized.

#### **RBCLK**: BCLK output control (DF) / Bus control register (0x4812E)

Control the bus clock BCLK to enable or disable external output.

Write "1": Fixed at high level Write "0": Output enabled Read: Valid

To stop outputting the bus clock from the BCLK pin, write "1" to RBCLK. When the clock output is stopped, the BCLK pin is fixed at high level. The bus clock output from the BCLK pin is enabled by writing "0" to RBCLK. The bus clock output from the BCLK pin also is stopped in the HALT2 and the SLEEP modes. At cold start, the RBCLK is set to "0" (output enabled). At hot start, RBCLK retains its status before being initialized.

**RBST8**: Burst mode selection (DD) / Bus control register (0x4812E)

Set the operation mode during a burst read.

Write "1": 8-successive-burst modeWrite "0": 4-successive-burst modeRead: Valid

The 8-successive-burst mode is selected by writing "1" to RBST8 and the 4-successive-burst mode is selected by writing "0" to RBST8. This setting is valid when areas 10 and 9 are set for burst ROM, and the setting is applied to both areas simultaneously.

At cold start, RBST8 is set to "0" (4-successive-burst mode). At hot start, RBST8 retains its status before being initialized.

#### REDO: Page mode selection (DC) / Bus control register (0x4812E)

Select the page mode of DRAM.

Write "1": EDO-page mode Write "0": Fast-page mode Read: Valid

When using EDO DRAM, write "1" to REDO to select the EDO-page mode.

The contents set here are applied to all of areas 14, 13, 8, and 7 that are set for DRAM.

At cold start, REDO is set to "0" (fast-page mode). At hot start, REDO retains its status before being initialized.

RCA1-RCA0: Column address size selection (D[B:A]) / Bus control register (0x4812E)

Select the column address size of DRAM.

RCA1	RCA0	Column address size
1	1	11
1	0	10
0	1	9
0	0	8

Table 4.25 Column Address Size

The contents set here are applied to all of areas 14, 13, 8, and 7 that are set for DRAM. RCA can be read to obtain its set value.

At cold start, RCA is set to "0" (8 bits). At hot start, RCA retain its status before being initialized.

#### RPC2: Refresh enable (D9) / Bus control register (0x4812E)

Control the DRAM refresh function.

Write "1": Enabled Write "0": Disabled Read: Valid

When DRAM is connected directly, a refresh cycle is generated by writing "1" to RPC2. The internal refresh function is disabled by writing "0" to RPC2.

Since the BCU stops operating in the HALT2 and the SLEEP modes, no refresh cycle is generated regardless of how this bit is set.

The contents set here are applied to all of areas 14, 13, 8, and 7 that are set for DRAM.

At cold start, RPC2 is set to "0" (disabled). At hot start, RPC2 retains its status before being initialized.

RPC1: Refresh method selection (D8) / Bus control register (0x4812E)

Select the DRAM refresh method.

Write "1": Self-refresh Write "0": CAS-before-RAS refresh Read: Valid

To perform a CAS-before-RAS refresh, set RPC1 to "0" and then RPC2 to "1". This causes the underflow output signal of the 8-bit programmable timer 0 is fed to the DRAM interface, at which timing a refresh cycle is generated. To start a self-refresh, set RPC1 to "1" and then RPC2 to "1". The self-refresh is disabled by writing "0" to RPC2. The contents set here are applied to all of areas 14, 13, 8, and 7 that are set for DRAM.

At cold start, RPC1 is set to "0" (CAS-before-RAS refresh). At hot start, RPC1 retains its status before being initialized.

#### RPC0: Refresh RPC delay (D7) / Bus control register (0x4812E)

Set a RPC delay when at start of refresh.

Write "1": 2 cycles Write "0": 1 cycle Read: Valid

Set a time from the immediately preceding precharge to the falling transition of #LCAS necessary in order to perform a refresh. This time is 2 cycles when RPC0 = "1" or 1 cycle when RPC0 = "0".

The contents set here are applied to all of areas 14, 13, 8, and 7 that are set for DRAM.

At cold start, RPC0 is set to "0" (1 cycle). At hot start, RPC0 retains its status before being initialized.

RRA1-RRA0: Refresh RAS pulse width selection (D[6:5]) / Bus control register (0x4812E)

Select the RAS pulse width of a CAS-before-RAS refresh.

Table 4.20 Reflesh RAS Fulse W						
RRA1	RRA0	Pulse width				
1	1	5 cycles				
1	0	4 cycles				
0	1	3 cycles				
0	0	2 cycles				

### Table 4.26 Refresh RAS Pulse Width

The contents set here are applied to all of areas 14, 13, 8, and 7 that are set for DRAM. The RRA can be read to obtain their set value.

At cold start, RRA is set to "0" (2 cycles). At hot start, RRA retains its status before being initialized.

SBUSST: External interface method select register (D3) / Bus control register (0x4812E)

Select the interface method of an SRAM device.

Write "1": #BSL system Write "0": A0 system Read: Valid

When using the #BSL system, write "1" to SBUSST.

The contents set here are applied to all areas that are set for the SRAM type. At cold start, SBUSST is set to "0" (A0 system). At hot start, SBUSST retains its status before being initialized.

SEMAS: External bus master setup (D2) / Bus control register (0x4812E)

Specify whether an external bus master exists.

Write "1": Existing Write "0": Nonexistent Read: Valid

A request for bus ownership control via the #BUSREQ pin is made acceptable by writing "1" to SEMAS. If the system does not have any external bus master, fix this register at "0".

At cold start, SEMAS is set to "0" (nonexistent). At hot start, SEMAS retains its status before being initialized.

SEPD: External power-down control (D1) / Bus control register (0x4812E)

Enable or disable the CPU's power-down control by an external bus master.

Write "1": Enabled Write "0": Disabled Read: Valid

Power-down control via an external pin (#BUSREQ) is enabled by writing "1" to SEPD. If the #BUSREQ pin is lowered when external power-down control is thus enabled, the CPU is placed in a HALT state, allowing for reduction in power consumption.

At cold start, SEPD is set to "0" (disabled). At hot start, SEPD retains its status before being initialized.

#### **SWAITE**: #WAIT enable (D0) / Bus control register (0x4812E)

Enable or disable wait cycle control via the #WAIT pin.

Write "1": Enabled Write "0": Disabled Read: Valid

A wait request from an SRAM device is made acceptable by writing "1" to SWAITE. The wait request signal input from the #WAIT pin is sampled at each falling edge of the bus clock when executing an SRAM read/write cycle. Wait cycles are inserted until the wait request signal is sampled and detected as high (inactive).

Wait control for 0 to 7 cycles can be accomplished by AxxWT without using the #WAIT pin. However, since the setting via AxxWT is applied to every two areas, the number of wait cycles may be controlled individually in each area or more than 7 wait cycles may be set. In such a case, use an external wait request via the #WAIT pin. Wait requests from the #WAIT pin are ignored when SWAITE = "0".

The contents set here are applied to all areas that are set for SRAM, and are also effective for write cycles in the areas that are set for burst ROM.

At cold start, SWAITE is set to "0" (disabled). At hot start, SWAITE retains its status before being initialized.

#### **A3EEN**: Area 3 emulation (DB) / DRAM timing set-up register (0x48130)

Select area 3 emulation mode.

Write "1": Internal ROM mode Write "0": Emulation mode Read: Valid

When "0" is written to A3EEN, internal ROM emulation mode is selected and the external device will be accessed with the same condition as the internal ROM. When "1" is written, the internal ROM will be used for accessing area 3. The bit status and the pin status are logically ORed.

At cold start, A3EEN is set to "1" (internal ROM mode). At hot start, A3EEN retains its status before being initialized.

CEFUNC1-CEFUNC0: #CE pin function selection (D[A:9]) / DRAM timing set-up register (0x48130)

Change the #CE pin-assigned area.

Pin	CEFUNC = "00"	CEFUNC = "01"	CEFUNC = "1x"						
#CE4	#CE4	#CE11	#CE11+#CE12						
#CE5	#CE5	#CE15	#CE15+#CE16						
#CE6	#CE6	#CE6	#CE7+#CE8						
#CE7/#RAS0	#CE7/#RAS0	#CE13/#RAS2	#CE13/#RAS2						
#CE8/#RAS1	#CE8/#RAS1	#CE14/#RAS3	#CE14/#RAS3						
#CE9	#CE9	#CE17	#CE17+#CE18						
#CE10EX	#CE10EX	#CE10EX	#CE9+#CE10EX						
	•	(Defa	ult: CEFUNC = "00")						

Table 4.27 #CE Output Assignment

The high-order areas that are made available for use by writing "01" to CEFUNC can be larger in size than the default low-order areas. For example, when using DRAM in default settings, the available space is 4MB in areas 7 and 8. However, if areas 13 and 14 are used, up to 32MB of DRAM can be used. The same applies to the other areas. Furthermore, when CEFUNC is set to "10" or "11", four chip enable signal is expanded into two area size. At cold start, CEFUNC is set to "00". At hot start, CEFUNC retains its status before being initialized.

#### CRAS: Successive RAS mode (D8) / DRAM timing set-up register (0x48130)

Set the successive RAS mode.

Write "1": Successive RAS mode Write "0": Normal mode Read: Valid

In systems using DRAM, the successive RAS mode is entered by writing "1" to CRAS. In this mode, read/write operations can be performed in page mode even when DRAM accesses do not occur back-to-back.

When using the successive RAS mode, be sure to use #DRD for the read signal and #DWE for the write signal for low-byte.

When CRAS = "0", random read/write cycles are used for non-successive DRAM accesses.

The contents set here are applied to all of areas 14, 13, 8, and 7 that are set for DRAM.

At cold start, CRAS is set to "0" (normal mode). At hot start, CRAS retains its status before being initialized.

#### RPRC1-RPRC0: Number of RAS precharge cycles (D[7:6]) / DRAM timing set-up register (0x48130)

Select the number of precharge cycles during a DRAM access.

RPRC1	RPRC0	Number of cycles					
1	1	4 cycles					
1	0	3 cycles					
0	1	2 cycles					
0	0	1 cycle					

#### Table 4.28 Number of RAS Precharge Cycles

The contents set here are applied to all of areas 14, 13, 8, and 7 that are set for DRAM. At cold start, RPRC is set to "0" (1 cycle). At hot start, RPRC retains its status before being initialized.

#### CASC1-CASC0: Number of CAS cycles (D[4:3]) / DRAM timing set-up register (0x48130)

Select the number of CAS cycles during a DRAM access.

Table 4.29 Number of CAS Cycles								
CASC1	CASC0	Number of cycles						
1	1	4 cycles						
1	0	3 cycles						
0	1	2 cycles						
0	0	1 cycle						

The contents set here are applied to all of areas 14, 13, 8, and 7 that are set for DRAM. At cold start, CASC is set to "0" (1 cycle). At hot start, CASC retains its status before being initialized.

RASC1-RASC0: Number of RAS cycles (D[1:0]) / DRAM timing set-up register (0x48130)

Select the number of RAS cycles during a DRAM access.

Table 4.30 Number of RAS Cycles								
RASC1	RASC0	Number of cycles						
1	1	4 cycles						
1	0	3 cycles						
0	1	2 cycles						
0	0	1 cycle						

The contents set here are applied to all of areas 14, 13, 8, and 7 that are set for DRAM. At cold start, RASC is set to "0" (1 cycle). At hot start, RASC retains its status before being initialized. A18IO: Areas 18–17 internal/external access selection (DF) / Access control register (0x48132)
A16IO: Areas 16–15 internal/external access selection (DE) / Access control register (0x48132)
A14IO: Areas 14–13 internal/external access selection (DD) / Access control register (0x48132)
A12IO: Areas 12–11 internal/external access selection (DC) / Access control register (0x48132)
A8IO: Areas 8–7 internal/external access selection (DA) / Access control register (0x48132)
A6IO: Area 6 internal/external access selection (D9) / Access control register (0x48132)
A6IO: Area 5–4 internal/external access selection (D8) / Access control register (0x48132)

Select either internal access or external access for each area.

Write "1": Internal access Write "0": External access Read: Valid

When AxxIO is set to "1", the internal device that mapped to the corresponding area is accessed. When AxxIO is set to "0", the external device is accessed.

At cold start, these bits are set to "0" (external access). At hot start, these bits retain their status before being initialized.

A18EC: Areas 18–17 little/big endian method selection (D7) / Access control register (0x48132) A16EC: Areas 16–15 little/big endian method selection (D6) / Access control register (0x48132) A14EC: Areas 14–13 little/big endian method selection (D5) / Access control register (0x48132) A12EC: Areas 12–11 little/big endian method selection (D4) / Access control register (0x48132) A10EC: Areas 10–9 little/big endian method selection (D3) / Access control register (0x48132) A8EC: Areas 8–7 little/big endian method selection (D2) / Access control register (0x48132) A6EC: Area 6 little/big endian method selection (D1) / Access control register (0x48132) A5EC: Areas 5–4 little/big endian method selection (D0) / Access control register (0x48132)

Select either little endian or big-endian method for accessing each area.

Write "1": Big-endian Write "0": Little-endian Read: Valid

When AxxEC is set to "1", the corresponding area is accessed in big-endian method. When AxxEC is set to "0", the area is accessed in little-endian method. When using area 10 as the boot area, fix A10EC at "0" (little-endian). At cold start, these bits are set to "0" (little-endian). At hot start, these bits retain their status before being initialized.

```
A18AS: Areas 18–17 address strobe signal (DF) / G/A read signal control register (0x48138)
A16AS: Areas 16–15 address strobe signal (DE) / G/A read signal control register (0x48138)
A14AS: Areas 14–13 address strobe signal (DD) / G/A read signal control register (0x48138)
A12AS: Areas 12–11 address strobe signal (DC) / G/A read signal control register (0x48138)
A8AS: Areas 8–7 address strobe signal (DA) / G/A read signal control register (0x48138)
A6AS: Area 6 address strobe signal (D9) / G/A read signal control register (0x48138)
A5AS: Areas 5–4 address strobe signal (D8) / G/A read signal control register (0x48138)
```

Enable/disable the exclusive address strobe signal output.

Write "1": Enabled Write "0": Disabled Read: Valid

If AxxAS is set to "1", the exclusive address strobe signal is output from #GAAS (P21) pin when the corresponding area is accessed. If AxxAS is set to "0", the signal output is disabled.

At cold start, these bits are set to "0" (disabled). At hot start, these bits retain their status before being initialized.

A18RD: Areas 18–17 read signal (D7) / G/A read signal control register (0x48138)
A16RD: Areas 16–15 read signal (D6) / G/A read signal control register (0x48138)
A14RD: Areas 14–13 read signal (D5) / G/A read signal control register (0x48138)
A12RD: Areas 12–11 read signal (D4) / G/A read signal control register (0x48138)
A8RD: Areas 8–7 read signal (D2) / G/A read signal control register (0x48138)
A6RD: Area 6 read signal (D1) / G/A read signal control register (0x48138)
A5RD: Areas 5–4 read signal (D0) / G/A read signal control register (0x48138)

Enable/disable the exclusive read signal output.

Write "1": Enabled Write "0": Disabled Read: Valid

If AxxRD is set to "1", the exclusive read signal is output from #GARD (P31) pin when the corresponding area is read. If AxxRD is set to "0", the signal output is disabled.

At cold start, these bits are set to "0" (disabled). At hot start, these bits retain their status before being initialized.

#### BCLKSEL1-BCLKSEL0: BCLK output clock selection (D[1:0]) / BCLK select register (0x4813A)

Select a clock to be output from the BCLK pin.

Table 4.31 Selection of BCLK Output Clock								
BCLKSEL1	BCLKSEL0	Output clock						
1	1	PLL_CLK (PLL output clock)						
1	0	OSC3_CLK (OSC3 oscillation clock)						
0	1	BCU_CLK (BCU operating clock)						
0	0	CPU_CLK (CPU operating clock)						

PLL\_CLK: PLL output clock. This clock is stable and kept as output except in the following cases:

- 1. When the PLL is off by setting the PLLS[1:0] pins.
- 2. When the OSC3 (high-speed) oscillation is stopped by executing the SLP instruction.

3. When the OSC3 (high-speed) oscillation is stopped using the CLG register. Note that the PLL\_CLK clock is out of phase with the CPU operating clock.

# OSC3\_CLK: OSC3 (high-speed) oscillation circuit output clock. This clock is stable and kept as output except in the following cases:

1. When the OSC3 (high-speed) oscillation is stopped by executing the SLP instruction.

2. When the OSC3 (high-speed) oscillation is stopped using the CLG register.

Note that the OSC3\_CLK clock is out of phase with the CPU operating clock.

BCU\_CLK: Bus clock in the bus controller. This clock varies according to the bus cycle speed. Furthermore, the clock frequency changes dynamically in x2 speed mode as follows:

1. When the internal RAM/ROM is accessed, x2 clock (e.g., 50 MHz same as the CPU operating clock) is output.

2. When an external device is accessed via the external bus, x1 clock (e.g., 25 MHz) is output. This dynamic change (e.g., between 50 MHz and 25 MHz) does not affect the external memory access timing, such as position relationship between the rising or falling edge of the 25 MHz clock and the falling edge of the #WR signal. (It is the same as that in the x1 speed mode with 25 MHz clock.)

#### CPU\_CLK: The CPU operating clock. The clock frequency is as follows:

- 1. Equals to the PLL output clock frequency when the PLL is on.
- 2. Equals to the OSC3 (high-speed) oscillation circuit output clock frequency when the PLL is off.
- 3. However, it equals to the divided frequency when the CLG is set to generate the CPU operating clock by dividing the source clock.
- 4. When the CPU stops by the HALT or SLP instruction, this clock is also stopped.
- This clock is almost in phase with the bus clock.

At initial reset, BCLKSEL is set to "0" (CPU\_CLK).

#### A1X1MD: Area 1 access speed (D3) / BCLK select register (0x4813A)

Select a number of access cycles for area 1 in x2 speed mode.

Write "1": 2 cycles Write "0": 4 cycles Read: Valid

When x2 speed mode is set (#X2SPD pin = L) and A1X1MD = "1", area 1 is read/written in 2 cycles of the CPU system clock.

When A1X1MD = "0", area 1 is read/written in 4 cycles.

When x1 speed mode is set (#X2SPD pin = H), area 1 is always accessed in 2 cycles regardless of the A1X1MD value.

At cold start, A1X1MD is set to "0" (4 cycles). At hot start, A1X1MD retains its status before being initialized.

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# **II-5 ITC (Interrupt Controller)**

The C33 Core Block contains an interrupt controller, making it possible to control all interrupts generated by the internal peripheral circuits. This section explains the functions of this interrupt controller centering around the method for controlling maskable interrupts. For details about the various factors and conditions under which interrupts are generated, refer to the description of each peripheral circuit in this manual.

## **Outline of Interrupt Functions**

## Maskable Interrupts

The ITC can handle 39 kinds of maskable interrupts as shown in the table below.

	HEY	Vector number	Interrunt system		T
No.	No	(Hey address)	(Perinheral circuit)	Interrupt factor	Priority
1	10	(flex address)	Port input interrupt 0	Edge (rising or falling) or lovel (High or Low)	High
2	11	17(Base+40)	Port input interrupt 1	Edge (rising or falling) or level (High or Low)	. riigii ↑
2	12	17(Dase+44)	Port input interrupt 2	Edge (rising or falling) or level (High or Low)	. '
1	12	10(Base+40)	Port input interrupt 2	Edge (rising or falling) or level (High or Low)	
5	14	19(Dase+4C)	Kow input interrupt 0	Dising or folling odgo	-
6	14	20(Dase+30)	Key input interrupt 0	Rising of falling edge	-
0	15	21(DaSe+34)	received		
12	10	22-29 20/Roca (79)	16 bit programmable timer 0	- Timer O comparison P	
12	10	21(Base+70)	To-bit programmable timer o		
13		22 22	recerved		
11	22	34/Base+88)	16 bit programmable timer 1	- Timor 1 comparison B	
14	22	25(Base+00)	To-bit programmable timer 1		
15	23	36 37	recerved		
16	26	38/Bacou08)	16 bit programmable timer 2	- Timor 2 comparison B	
17	20	30(Base+90)	To-bit programmable timer 2	Timer 2 comparison A	
17	21	39(Dase+9C)	record		
10	24	40-41 42/Roca ( A 9)	16 bit programmable timer 2	- Timer 2 comparison P	
10	28	42(Dase+A0)	To-bit programmable timer 3	Timer 2 comparison A	
19	20	43(Dase+AC)	record		
	25	44-40 46/Roco ( P9)	16 bit programmable timer 4	- Timer 4 comparison P	
20	20	40(DaSe+Do)	To-bit programmable timer 4	Timer 4 comparison A	
21	21	47(Dase+DC)	recerved		
22	22	50/Baca+C8)	16 bit programmable timer 5	- Timor 5 comparison B	
22	32	50(Base+Co)	ro-bit programmable timer 5		
23	24	51(Base+CC)	9 hit programmable timer	Timer 0 underflow	
24	25	52(Base+D0)		Timer 0 underflow	
20	36	53(Base+D4)		Timer 2 underflow	
20	27	55(Base+DC)		Timer 2 underflow	
20	20	56(Base+DC)	Sorial interface Ch 0	Possive error	
20	20	57(Base+E4)	Senai Interface Ch.0	Receive endi	
29	20	58(Base+E4)			
- 50	JA	50(Dase+L0)	recerved		
21	20	59 60(Base+E0)	Sorial interface Ch 1	- Pocoivo orror	
22	30	61(Base+F4)	Senai Interface Ch. I	Receive endi	·
22	30	62(Base+F9)			
- 33	3L	62 64	recerved		
25	11	65/Base+104)	Clock timer	Ealling adda of 32 Hz 8 Hz 2 Hz or 1 Hz signal	
35	41	03(Dase+104)	Clock limer	1 minuet 1 hour or specified time count up	
<u> </u>	l	66 67			1
-		00-07	Port input interrupt 4	-	1
30	44	60(Base+110)	Port input Interrupt 4	Edge (fising of falling) of level (High of Low)	1
31	45	09(Base+114)	Port input interrupt 5	Edge (fising of falling) of level (High of Low)	1
38	46	70(Base+118)	Port input interrupt 6	Eage (rising or failing) or level (High or Low)	. ↓
39	47	71(Base+11C)	Port input interrupt 7	Eage (rising or failing) or level (High or Low)	LOW

Table 5.1 List of Maskable Interrupts

#### **Contents of table**

"Hex No." indicates an interrupt number in hexadecimal value.

"Vector number (Address)" indicates the trap table's vector number. The numerals in parentheses show an offset (in bytes) from the starting address (Base) of the trap table. The starting address (Base) of the trap table by default is the boot address, 0xC00000 set at an initial reset. This address can be changed using the TTBR register (0x48134 to 0x48137).

For details about the trap table contents including exception factors, etc., refer to the "S1C33000 Core CPU Manual".

"Interrupt system (Peripheral circuit)" indicates that interrupt levels can be programmed for each peripheral circuit written.

"Interrupt factor" indicates the factor of the interrupt occurring in each interrupt system.

"Priority" indicates the priority of interrupts in cases when all interrupt systems are set to the same interrupt level. If two or more interrupt factors occur simultaneously, interrupt requests are accepted in order of highest priority. Interrupt priority varies depending on the interrupt levels set in each interrupt system. However, the priorities of interrupt factors in the same interrupt system are fixed in the order that they are written here.

#### Maskable interrupt generating conditions

A maskable interrupt to the CPU occurs when all of the conditions described below are met.

- The interrupt enable register for the interrupt factor that has occurred is set to "1".
- The IE (Interrupt Enable) bit of the Processor Status Register (PSR) in the CPU is set to "1".
- The interrupt factor that has occurred has a higher priority level than the value that is set in the PSR's Interrupt Level (IL). (The interrupt levels can be set using the interrupt priority register in each interrupt system.)
- No other trap factor having higher priority, such as NMI, has occurred.

When an interrupt factor occurs, the corresponding interrupt factor flag is set to "1" and the flag remains set until it is reset in the software program. Therefore, in no cases can the generated interrupt factor be inadvertently cleared even if the above conditions are not met when the interrupt factor has occurred. The interrupt will occur when the above conditions are met.

If two or more maskable interrupt factors occur simultaneously, the interrupt factor that has the highest priority is allowed to signal an interrupt request to the CPU. The other interrupts with lower priorities are kept pending until the above conditions are met.

The PSR and interrupt control register will be detailed later.

For details about interrupt factor generating conditions, refer to the description of each peripheral circuit in this manual.

## Nonmaskable Interrupt (NMI)

The nonmaskable interrupt (NMI) can be generated by pulling the #NMI pin low or using the internal watchdog timer. The vector number of NMI is 7, with the vector address set to the trap table's starting address + 28 bytes.

This interrupt is prioritized over other interrupts and is unconditionally accepted by the CPU.

However, since this interrupt may operate erratically if it occurs before the stack pointer (SP) is set up, it is masked in hardware until a write to the SP is completed after an initial reset.

## Interrupt Processing by the CPU

The CPU keeps sampling interrupt requests every cycle. When the CPU accepts an interrupt request, it enters trap processing after completing execution of the instruction that was being executed.

The following lists the contents executed in trap processing.

- (1) The PSR and the current program counter (PC) value are saved to the stack.
- (2) The IE bit of the PSR is reset to "0" (following maskable interrupts are disabled).
- (3) The IL of the PSR is set to the priority level of the accepted interrupt (NMI does not have its interrupt level changed).
- (4) The vector of the generated interrupt factor is loaded into the PC, thus executing the interrupt processing routine.

Thus, once an interrupt is accepted, all maskable interrupts that may follow are disabled in (2). Multiple interrupts can also be handled by setting the IE bit to "1" in the interrupt processing routine. In this case, since the IL has been changed in (3), only an interrupt that has a higher priority than that of the currently processed interrupt is accepted. When the interrupt processing routine is terminated by the reti instruction, the PSR is restored to its previous status before the interrupt has occurred. The program restarts processing after branching to the instruction next to the one that was being executed when the interrupt occurred.

## Clearing Standby Mode by Interrupts

The standby modes (HALT and SLEEP) are cleared by an NMI or a maskable interrupt.

All maskable interrupts can be used to clear HALT mode.

In SLEEP mode, since the high-speed (OSC3) oscillation circuit is deactivated, interrupts from the peripheral circuits that operate with the OSC3 clock cannot be used.

Interrupts that can be used to clear basic HALT mode: NMI and all maskable interruptsInterrupts that can be used to clear HALT2 mode:NMI and all maskable interruptsInterrupts that can be used to clear SLEEP mode:NMI, input port interrupts, and clock timer interrupts

Clearing of the standby modes is accomplished by an interrupt request to the CPU. Therefore, this requires that the PSR be set in such a way that the requested interrupt will be accepted, and that the interrupt enable register for the interrupt factor be set to accept the interrupt.

When standby mode is cleared and the CPU has accepted the interrupt, it returns to the instruction next to the halt or slp instruction after executing the interrupt processing routine.

## Trap Table

The C33 Core Block allows the base (starting) address of the trap table to be set by the TTBR register. TTBR0 (D[9:0]) / TTBR low-order register (0x48134): Trap table base address [9:0] (fixed at "0") TTBR1 (D[F:A]) / TTBR low-order register (0x48134): Trap table base address [15:10] TTBR2 (D[B:0]) / TTBR high-order register (0x48136): Trap table base address [27:16] TTBR3 (D[F:C]) / TTBR high-order register (0x48136): Trap table base address [31:28] (fixed at "0")

After an initial reset, the TTBR register is set to address 0x0C00000.

Therefore, even when the trap table position is changed, it is necessary that at least the reset vector be written to the above address.

TTBR0 and TTBR3 are read-only bits which are fixed at "0". Therefore, the trap table starting address always begins with a 1KB boundary address.

The TTBR register is normally write-protected to prevent them from being inadvertently rewritten. To remove this write protection function, another register, TBRP (D[7:0]) / TTBR write-protect register (0x4812D [byte]), is provided. A write to the TTBR register is enabled by writing "0x59" to TBRP and is disabled back again by a write to the most significant byte of the TTBR register (0x48137). Consequently, a write to the TTBR register needs to begin with the low-order half-word first. However, since an occurrence of NMI or the like between writes of the low-order and high-order half-words would cause a malfunction, it is recommended that the register be written in words.

## Control of Maskable Interrupts

### Structure of the Interrupt Controller

The interrupt controller is configured as shown in Figure 5.1.



Figure 5.1 Configuration of Interrupt Controller

The following sections explain the functions of the registers used to control interrupts.

## Processor Status Register (PSR)

The PSR is a special register incorporated in the core CPU and contains control bits to enable or disable an interrupt request to the CPU.

#### Interrupt Enable (IE) bit: PSR[4]

This bit is used to enable or disable an interrupt request to the CPU. When this bit is set to "1", the CPU is enabled to accept a maskable interrupt request. When this bit is reset to "0", no maskable interrupt request is accepted by the CPU.

When the CPU accepts an interrupt request (or some other trap occurs), it saves the PSR to the stack and resets the IE bit to "0". Consequently, no maskable interrupt request occurring thereafter will be accepted unless the IE bit is set to "1" in software program or the interrupt (trap) processing routine is terminated by the reti instruction.

The IE bit is initialized to "0" (interrupts disabled) by an initial reset.

#### Interrupt Level (IL): PSR[11:8]

The IL bits disable the interrupts whose priorities are below the set interrupt level. For example, if the interrupt level set in the IL is 3, the interrupts whose priorities are set below 3 in the interrupt priority register (described later) are not accepted by the CPU even if the IE bit is set to "1". The IL and the interrupt priority register together allow you to control the interrupt priorities in each interrupt system. For details about the interrupt levels, refer to "Interrupt Priority Register and Interrupt Levels".

When the CPU accepts a maskable interrupt request, it saves the PSR to the stack and sets the IL to the accepted interrupt's priority level. Therefore, even when the IE bit is set to "1" in the interrupt processing routine, no interrupts whose priority levels are equal or below that of the interrupt currently being processed are accepted unless the IL is rewritten.

The IL is restored to its previous status when the interrupt processing routine is terminated by the reti instruction.

The IL is rewritten for only maskable interrupts and not for any other traps (except a reset). The IL is set to level 0 (that is, all interrupts above level 1 are enabled) by an initial reset.

**Note:** As the S1C33000 Core CPU function, the IL allows interrupt levels to be set in the range of 0 to 15. However, since the interrupt priority register in the ITC consists of three bits, interrupt levels in each interrupt system can only be set for up to 8.

### Interrupt Factor Flag and Interrupt Enable Register

An interrupt factor flag and an interrupt enable register are provided for each maskable interrupt factor.

#### Interrupt factor flag

The interrupt factor flag is set to "1" when the corresponding interrupt factor occurs. Reading the flag enables you to determine what caused an interrupt, making it unnecessary to resort to the CPU's trap processing. The interrupt factor flag is reset only by writing data in software. Note that the method by which this flag is reset can be selected from the software application using either of the two methods described below. This selection is accomplished using RSTONLY (D0) / Interrupt factor flag reset method select register (0x4029F).

• Reset-only method (default)

This method is selected (RSTONLY = "1") when initially reset.

With this method, the interrupt factor flag is reset by writing "1". Although multiple interrupt factor flags are located at the same address of the interrupt control register, the interrupt factor flags for which "0" has been written can be neither set nor reset. Therefore, this method ensures that only a specific factor flag is reset. However, when using read-modify-write instructions (e.g., bset, bclr, or bnot), note that an interrupt factor flag that has been set to "1" is reset by writing.

In this method, no interrupt factor flag can be set in the software application.

• Read/write method

This method is selected by writing "0" to RSTONLY.

When this method is used, interrupt factor flags can be read and written as for other registers. Therefore, the flag is reset by writing "0" and set by writing "1". In this case, all factor flags for which "0" has been written are reset. Even in a read-modify-write operation, an interrupt factor can occur between the read and the write, so be careful when using this method.

Since interrupt factor flags are not initialized by an initial reset, be sure to reset them before enabling interrupts.

**Note:** Even when a maskable interrupt request is accepted by the CPU and control branches off to the interrupt processing routine, the interrupt factor flag is not reset. Consequently, if control is returned from the interrupt processing routine by the reti instruction without resetting the interrupt factor flag in a program, the same interrupt factor occurs again.

For details about interrupt factor generating conditions, refer to the description of each peripheral circuit in this manual.

#### Interrupt enable register

This register controls the output of an interrupt request to the CPU. Only when the interrupt enable bit of this register is set to "1" can an interrupt request to the CPU be enabled by an occurrence of the corresponding interrupt factor. If the bit is set to "0", no interrupt request is made to the CPU even when the corresponding interrupt factor occurs.

Interrupt enable bits can be read and written as for other registers. Therefore, the interrupt enable bit is reset by writing "0" and set by writing "1". By reading this register, its setup status can be checked at any time. Settings of the interrupt enable register do not affect the operation of interrupt factor flags, so when an interrupt factor occurs the interrupt factor flag is set to "1" even if the corresponding interrupt enable bit is set to "0". When initially reset, the interrupt enable register is set to "0" (interrupts are disabled).

When clearing standby mode (HALT or SLEEP mode) too, the corresponding interrupt enable bit must be set to "1".

The interrupt controller outputs an interrupt request to the CPU when the following conditions are met:

- An interrupt factor has occurred and the interrupt factor flag is set to "1".
- The bit of the interrupt enable register for the interrupt factor that has occurred is set to "1" (interrupt enable).

If two or more interrupt factors occur simultaneously, the interrupt factor that has the highest priority is allowed to signal an interrupt request to the CPU. (See the following section.)

When these conditions are met, the interrupt controller outputs an interrupt request signal to the CPU along with the setup content (interrupt level) of the interrupt priority register for the generated interrupt system and its vector number.

These signals remain asserted until the interrupt factor flag is reset to "0" or the corresponding bit of the interrupt enable register is set to "0" (interrupts are disabled) or until some other interrupt factor of higher priority occurs. They are not cleared if the CPU simply accepts the interrupt request.

### Interrupt Priority Register and Interrupt Levels

The interrupt priority register is a 3-bit register provided for each interrupt system. It allows the interrupt levels of a given interrupt system to be set in the range of 0 to 7. The default priorities shown in Table 5.1 can be modified according to system requirements by this setting.

The value set in this register is used by the interrupt controller and the CPU as described below.

#### Roles of the interrupt priority register in the interrupt controller

If two or more interrupt factors that have been enabled by the interrupt enable register occur simultaneously, the interrupt factor in the interrupt system whose interrupt priority register contains the greatest value is allowed by the interrupt controller to signal an interrupt request to the CPU.

If an interrupt factor occurs in two or more interrupt systems having the same value, the interrupt priority is resolved according to the default priorities in Table 5.1. Interrupt factors in the same interrupt system also have their priorities resolved according to the order in Table 5.1.

Other interrupt factors are kept pending until all interrupts of higher priority are accepted by the CPU.

When outputting an interrupt request signal to the CPU, the interrupt controller outputs the content of the interrupt priority register to the CPU along with it.

If another interrupt factor of higher priority occurs during outputting an interrupt request signal, the interrupt controller changes the vector number and interrupt level to those of the new interrupt factor before they are output to the CPU. The first interrupt request is left pending.

#### Roles of the interrupt priority register in CPU processing

The CPU compares the content of the interrupt priority register received from the interrupt controller with the interrupt level that is set in the IL of the PSR to determine whether or not to accept the interrupt request.

IE bit = "1" & IL < interrupt priority register: the interrupt request is accepted IE bit = "1" & IL  $\geq$  interrupt priority register: the interrupt request is rejected

Before interrupts can be controlled by an interrupt level, the interrupt disabling level must be written to the IL. For example, if the value written to the IL is 3, only the interrupts whose interrupt levels written in the interrupt priority register are 4 or more will be accepted.

When an interrupt is accepted, the interrupt level that is set in its interrupt priority register is written to the IL. As a result, the interrupt requests below that interrupt level can no longer be accepted. If the interrupt priority register for an interrupt is set to "0", the interrupt is disabled.

- **Notes:** As the S1C33000 Core CPU function, the IL allows interrupt levels to be set in the range of 0 to 15. However, since the interrupt priority register in the C33 Core Block consists of three bits, interrupt levels in each interrupt system can only be set for up to 8.
  - Multiple interrupts can also be handled by rewriting the interrupt level to the IL in the interrupt processing routine. However, if the interrupt level of the IL is set below the current level and the IE is set to enable interrupts before resetting the interrupt factor flag after an interrupt has occurred, the same interrupt may occur again.

## I/O Memory of Interrupt Controller

Table 5.2 shows the control bits of the interrupt controller.

Register name	Address	Bit	Name	Function	Setting	Init.	R/W	Remarks
Port input 0/1	0040260	D7	-	reserved	_	-	-	0 when being read.
interrupt	(B)	D6	PP1L2	Port input 1 interrupt level	0 to 7	Х	R/W	Ŭ
priority register	. ,	D5	PP1L1			x		
		D4	PP1L0			x		
		D3	-	reserved	_	-	-	0 when being read.
		D2	PP0L2	Port input 0 interrupt level	0 to 7	Х	R/W	<u>_</u>
		D1	PP0L1			x		
		D0	PP0L0			х		
Port input 2/3	0040261	D7	_	reserved		_	_	0 when being read
interrunt	(B)	D6	PP3L2	Port input 3 interrupt level	0 to 7	x	R/W	o whom being road.
priority register	(2)	D5	PP3L1		0.01	x	1011	
piterity regioner		D4	PP3L0			x		
		D3	-	reserved	_	-	_	0 when being read
		D2	PP2I 2	Port input 2 interrupt level	0 to 7	x	R/W	o mon bonig roud.
		D1	PP2L1	· · · · · · · · · · · · · · · · · · ·		x		
		D0	PP2L0			х		
Kov input	0040262	D7	_	reserved				0 when being read
interrunt	(B)	D6	- PK11 2	Key input 1 interrupt level	0 to 7	×		o when being read.
priority register	(2)	D5	PK111		0.01	x	1011	
priority regioner		D4	PK1L0			x		
		D3	-	reserved		-	_	0 when being read.
		D2	PK0L2	Key input 0 interrupt level	0 to 7	x	R/W	
		D1	PK0L1		0.01	x		
		DO	PKOLO			x		
16-bit timor 0/1	0040266		_	reserved				0 when being read
interrunt	(B)		- P16T12	16-bit timer 1 interrupt level	0 to 7	- X		o when being read.
nriority register	(5)	D5	P16T11		0107	x	10,00	
priority register			P16T10			x		
		D3	-	reserved		-	_	0 when being read
		D2	P16T02	16-bit timer 0 interrupt level	0 to 7	x	R/W	
		D1	P16T01	· · · · · · · · · · · · · · · · · · ·		x		
		D0	P16T00			х		
16-bit timer 2/3	0040267	D7	_	reserved	_		_	0 when being read
interrunt	(B)	D6	P16T32	16-bit timer 3 interrupt level	0 to 7	x	R/W	o when being read.
priority register	(-)	D5	P16T31		0.01	x		
		D4	P16T30			x		
		D3	-	reserved	_	-	-	0 when being read.
		D2	P16T22	16-bit timer 2 interrupt level	0 to 7	Х	R/W	<u>_</u>
		D1	P16T21			х		
		D0	P16T20			х		
16-bit timer 4/5	0040268	D7	_	reserved	-	-	_	0 when being read.
interrupt	(B)	D6	P16T52	16-bit timer 5 interrupt level	0 to 7	Х	R/W	<u>_</u>
priority register		D5	P16T51			X		
		D4	P16T50			Х		
		D3	-	reserved	-	-	-	0 when being read.
		D2	P16T42	16-bit timer 4 interrupt level	0 to 7	Х	R/W	
		D1	P16T41			Х		
		D0	P16T40			Х		
8-bit timer,	0040269	D7	-	reserved	-	-	-	0 when being read.
serial I/F Ch.0	(B)	D6	PSI002	Serial interface Ch.0	0 to 7	Х	R/W	
interrupt		D5	PSI001	interrupt level		Х		
priority register		D4	PSI000			Х		
		D3	-	reserved	_	-	-	0 when being read.
		D2	P8TM2	8-bit timer 0–3 interrupt level	0 to 7	Х	R/W	
		D1	P8TM1			Х		
		D0	P8TM0			Х		
Serial I/F Ch.1,	004026A	D7–3	-	reserved	-	-	-	0 when being read.
interrupt	(B)	D2	PSIO12	Serial interface Ch.1	0 to 7	X	R/W	
priority register		D1	PSIO11	interrupt level		Х		
		D0	PSIO10			X		
Clock timer	004026B	D7–3	-	reserved	_	-	-	Writing 1 not allowed.
interrupt	(B)	D2	PCTM2	Clock timer interrupt level	0 to 7	Х	R/W	
priority register		D1	PCTM1			X		
		D0	PCTM0			Х		

Table 5.2 Control Bits of Interrupt Controlle	Table 5.2	Control Bits of Interrupt Controller
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### II CORE BLOCK: ITC (Interrupt Controller)

Register name	Address	Bit	Name	Function		Set	ting	3	Init.	R/W	Remarks
Port input 4/5	004026C	D7	-	reserved			_		_	-	0 when being read.
interrupt	(B)	D6	PP5L2	Port input 5 interrupt level		0 t	07		Х	R/W	
priority register		D5	PP5L1						Х		
		D4	PP5L0						Х		
		D3	-	reserved			_		-	-	0 when being read.
		D2	PP4L2	Port input 4 interrupt level		0 t	07		Х	R/W	
		D1	PP4L1						Х		
		D0	PP4L0						Х		
Port input 6/7	004026D	D7	-	reserved			-		-	-	0 when being read.
interrupt	(B)	D6	PP7L2	Port input 7 interrupt level		0 t	07		Х	R/W	
priority register		D5	PP7L1						Х		
		D4	PP7L0						X		
		D3	-	reserved	<u> </u>				-	-	0 when being read.
		D2	PP6L2	Port input 6 interrupt level		0 t	07		X	R/W	
			PPOLI						Ŷ		
Kawinnut	0040270		FFULU	recented					^		O when heing read
Key input,	0040270 (B)	D7-6	-	reserved	1	Frahlad		Dischlad	-	-	0 when being read.
interrunt	(6)	D3		Key input 0	1'	Ellapleu	ľ	Disableu	0	R/W	
enable register		D4 D3	EP3	Port input 3	1				0	R/W	
chable register		D2	EP2	Port input 2	1				0	R/W	
		D1	EP1	Port input 1	1				0	R/W	
		D0	EP0	Port input 0	1				0	R/W	
16-bit timer 0/1	0040272	D7	E16TC1	16-bit timer 1 comparison A	1	Enabled	0	Disabled	0	R/W	
interrupt	(B)	D6	E16TU1	16-bit timer 1 comparison B	1.	LINGOIGG	ľ	Disablea	0	R/W	
enable register	(-)	D5-4	-	reserved			_		_	_	0 when being read.
		D3	E16TC0	16-bit timer 0 comparison A	1	Enabled	0	Disabled	0	R/W	<u> </u>
		D2	E16TU0	16-bit timer 0 comparison B	1				0	R/W	
		D1-0	-	reserved			_		-	-	0 when being read.
16-bit timer 2/3	0040273	D7	E16TC3	16-bit timer 3 comparison A	1	Enabled	0	Disabled	0	R/W	-
interrupt	(B)	D6	E16TU3	16-bit timer 3 comparison B	1				0	R/W	
enable register	.,	D5–4	-	reserved			_		_	-	0 when being read.
		D3	E16TC2	16-bit timer 2 comparison A	1	Enabled	0	Disabled	0	R/W	
		D2	E16TU2	16-bit timer 2 comparison B	1				0	R/W	
		D1-0	-	reserved			_		-	-	0 when being read.
16-bit timer 4/5	0040274	D7	E16TC5	16-bit timer 5 comparison A	1	Enabled	0	Disabled	0	R/W	
interrupt	(B)	D6	E16TU5	16-bit timer 5 comparison B					0	R/W	
enable register		D5–4	-	reserved		-	_		-	-	0 when being read.
		D3	E16TC4	16-bit timer 4 comparison A	1	Enabled	0	Disabled	0	R/W	
		D2	E16TU4	16-bit timer 4 comparison B					0	R/W	
		D1-0	-	reserved					-	-	0 when being read.
8-bit timer	0040275	D7–4	-	reserved			-		-	-	0 when being read.
interrupt	(B)	D3	E8TU3	8-bit timer 3 underflow	1	Enabled	0	Disabled	0	R/W	
enable register		D2	E8TU2	8-bit timer 2 underflow	1				0	R/W	
		D1	E8TU1	8-bit timer 1 underflow	4				0	R/W	
		DU	E8100	8-bit timer 0 underflow					0	R/W	
Serial I/F	0040276	D7–6	-	reserved			-		-	-	0 when being read.
interrupt	(B)	D5	ESTX1	SIF Ch.1 transmit buffer empty	1	Enabled	0	Disabled	0	R/W	
enable register		D4	ESRX1	SIF Ch.1 receive buffer full	-				0	R/W	
		03	ESERRI	SIF Ch. I receive error	-				0		
		D2 D1	ESRXO	SIF Ch.0 transmit buffer full	1				0	R/W	
			ESFRR0	SIF Ch 0 receive error	1				0	R/W	
Port input 4 7	0040277	D7 6		recented	+					1.0.11	0 when being read
clock timer	(B)	D7=0	FP7	Port input 7	1	Enabled	_ 	Disabled	-	= R/M	o when being read.
interrupt	(2)	D4	EP6	Port input 6	1.	LINGDICG	ľ	Diodolog	0	R/W	-
enable register		D3	EP5	Port input 5	1				Ō	R/W	1
		D2	EP4	Port input 4	1				0	R/W	1
		D1	ЕСТМ	Clock timer	1				0	R/W	1
		D0	-	reserved	T	•	-	•	0	R/W	Writing 1 not allowed.
Key input.	0040280	D7–6	İ-	reserved	İ		_		_	-	0 when being read
port input 0-3	(B)	D5	FK1	Key input 1	1	Factor is	0	No factor is	Х	R/W	
interrupt factor		D4	FK0	Key input 0	1	generated		generated	Х	R/W	
flag register		D3	FP3	Port input 3	]				Х	R/W	
		D2	FP2	Port input 2	]		1		Х	R/W	
		D1	FP1	Port input 1	1		1		Х	R/W	
		D0	FP0	Port input 0	1				Х	R/W	

Register name	Address	Bit	Name	Function		Sett	ting	1	Init.	R/W	Remarks
16-bit timer 0/1	0040282	D7	F16TC1	16-bit timer 1 comparison A	1	Factor is	0	No factor is	Х	R/W	
interrupt factor	(B)	D6	F16TU1	16-bit timer 1 comparison B	1	generated		generated	Х	R/W	
flag register		D5–4	-	reserved		-	-		-	-	0 when being read.
		D3	F16TC0	16-bit timer 0 comparison A	1	Factor is	0	No factor is	Х	R/W	
		D2	F16TU0	16-bit timer 0 comparison B		generated		generated	Х	R/W	
		D1-0	-	reserved		-	-		-	-	0 when being read.
16-bit timer 2/3	0040283	D7	F16TC3	16-bit timer 3 comparison A	1	Factor is	0	No factor is	X	R/W	
Interrupt factor	(B)	D6	F16TU3	16-bit timer 3 comparison B		generated		generated	X	R/W	O when being rood
flag register		D5-4	- F16TC2	16-bit timer 2 comparison A	1	- Factor is	0	No factor is	- X	- R/\/	0 when being read.
		D3	F16TU2	16-bit timer 2 comparison B	1'	denerated		generated	X	R/W	
		D1-0	-	reserved		-	-	gonoratoa	-	-	0 when being read.
16-bit timer 4/5	0040284	D7	F16TC5	16-bit timer 5 comparison A	1	Factor is	0	No factor is	х	R/W	<u>_</u>
interrupt factor	(B)	D6	F16TU5	16-bit timer 5 comparison B	1	generated		generated	Х	R/W	
flag register		D5-4	-	reserved		-	-		-	-	0 when being read.
		D3	F16TC4	16-bit timer 4 comparison A	1	Factor is	0	No factor is	Х	R/W	
		D2	F16TU4	16-bit timer 4 comparison B		generated		generated	Х	R/W	
		D1-0	-	reserved		-			-	-	0 when being read.
8-bit timer	0040285	D7-4	-	reserved		-	-	Nie feisten is	- V	-	0 when being read.
flag register	(В)	D3	F8103	8-bit timer 3 underflow	1	Factor is	0	NO factor is	X	R/W	
nag register		D2 D1	F8TU1	8-bit timer 1 underflow		generateu		generateu	X	R/W	
		D0	F8TU0	8-bit timer 0 underflow					X	R/W	
Serial I/F	0040286	D7-6	_	reserved			-		_	_	0 when being read.
interrupt factor	(B)	D5	FSTX1	SIF Ch.1 transmit buffer empty	1	Factor is	0	No factor is	Х	R/W	o mon boing roadi
flag register	.,	D4	FSRX1	SIF Ch.1 receive buffer full	1	generated		generated	Х	R/W	
		D3	FSERR1	SIF Ch.1 receive error					Х	R/W	
		D2	FSTX0	SIF Ch.0 transmit buffer empty					Х	R/W	
		D1	FSRX0	SIF Ch.0 receive buffer full					X	R/W	
	0040007	DU	FSERRO	SIF Ch.0 receive error	<u> </u>				X	R/W	
Port input 4–7,	0040287 (B)	D7-6	- ED7	Port input 7	1	- Eactor is	-	No factor is	- -	- D/\/	0 when being read.
interrunt factor	(6)	D3 D4	FP6	Port input 6	1'	racior is	0	denerated	X	R/W	-
flag register		D3	FP5	Port input 5	1	generated		generated	X	R/W	-
		D2	FP4	Port input 4	1				Х	R/W	1
		D1	FCTM	Clock timer					Х	R/W	1
		D0	-	reserved		-	-		Х	R/W	Writing 1 not allowed.
Flag set/reset	004029F	D7–1	-	reserved		-	-		-	-	
method select	(B)	D0	RSTONLY	Interrupt factor flag reset method	1	Reset only	0	RD/WR	1	R/W	
register											
TTBR write	004812D	D7	TBRP7	I I BR register write protect	Wr	iting 0101100	)1(( 00	JX59) (0x49124)	0	W	Undefined in read.
protect register	(6)	D5	TBRP5		wri	te protection	ы	(0840134)	0		
		D4	TBRP4		Wr	iting other da	ita s	sets the	0		
		D3	TBRP3		wri	te protection.			0		
		D2	TBRP2						0		
		D1	TBRP1						0		
		D0	TBRP0						0		
TTBR low-	0048134	DF	TTBR15	Trap table base address [15:10]					0	R/W	
order register	(HW)		TTDD12						0		
			TTBR12						0		
		DB	TTBR11						0		
		DA	TTBR10						0		
		D9	TTBR09	Trap table base address [9:0]		Fixed	d at	0	0	R	0 when being read.
		D8	TTBR08						0		Writing 1 not allowed.
		D7	TTBR07						0		
		D6	TTBR06								
		05	TTBROA								
		D3	TTBR03						0		
		D2	TTBR02						Ő		
		D1	TTBR01						0		
		D0	TTBR00						0		

#### II CORE BLOCK: ITC (Interrupt Controller)

Register name	Address	Bit	Name	Function	Setting	Init.	R/W	Remarks
TTBR high-	0048136	DF	TTBR33	Trap table base address [31:28]	Fixed at 0	0	R	0 when being read.
order register	(HW)	DE	TTBR32			0		Writing 1 not allowed.
		DD	TTBR31			0		
		DC	TTBR30			0		
		DB	TTBR2B	Trap table base address [27:16]	The initial value: 0x0C0	$\leftarrow$	R/W	
		DA	TTBR2A					
		D9	TTBR29					
		D8	TTBR28					
		D7	TTBR27					
		D6	TTBR26					
		D5	TTBR25					
		D4	TTBR24					
		D3	TTBR23					
		D2	TTBR22					
		D1	TTBR21					
		D0	TTBR20			1		

The following collectively explains the basic functions of each control register/bit. For details about individual interrupt systems and the contents classified by an interrupt factor, refer to the descriptions of the peripheral circuits in this manual.

#### Pxxx2–Pxxx0: Interrupt priority register

Set the priority levels of each interrupt system in the range of 0 to 7.

If this register is set below the IL value of the PSR, no interrupt is generated. The value of this register when initially reset is indeterminate.

#### Exxx: Interrupt enable register

Enable or disable interrupt generation to the CPU.

Write "1": Interrupt enabled Write "0": Interrupt disabled Read: Valid

Interrupts are enabled when the corresponding bits of this register are set to "1" and are disabled when the bits are set to "0".

For the interrupt factors used to clear the standby mode, the corresponding interrupt enable register bit must be set for interrupt enable.

When initially reset, this register is set to "0" (interrupt disabled).

#### Fxxx: Interrupt factor flag

Indicate the status of interrupt factors generated.

#### When read

Read "1": Interrupt factor generated Read "0": No interrupt factor generated

#### When written using the reset-only method (default)

Write "1": Factor flag is reset Write "0": Invalid

#### When written using the read/write method

Write "1": Factor flag is set

Write "0": Factor flag is reset

The interrupt factor flag is set to "1" when an interrupt factor occurs in each peripheral circuit.

If the following conditions are met at this time, an interrupt is generated to the CPU:

1. The corresponding bit of the interrupt enable register is set to "1".

2. No other interrupt request of higher priority has occurred.

3. The IE bit of the PSR is set to "1" (interrupt enabled).

4. The corresponding interrupt priority register is set to a level higher than the CPU's interrupt level (IL).

The interrupt factor flag is always set to "1" when an interrupt factor occurs no matter how the interrupt enable and interrupt priority registers are set.

In order for the next interrupt to be accepted after interrupt generation, the interrupt factor flag must be reset and the PSR must be set up again (by setting the IL below the level indicated by the interrupt priority register and setting the IE bit to "1" or executing the reti instruction).

The interrupt factor flag can only be reset by a write instruction in the software application. If the PSR is again set up to accept interrupts (or the reti instruction is executed) without resetting the interrupt factor flag, the same interrupt may occur again. Note also that the value to be written to reset the flag is "1" when using the reset-only method (RSTONLY = "1") and "0" when using the read/write method (RSTONLY = "0"). Be careful not to confuse these two conditions.

The interrupt factor flag becomes indeterminate when initially reset, so be sure to reset the flag in the software application.

#### RSTONLY: Interrupt factor flag reset method selection (D0) / Flag set/reset method select register (0x4029F)

Select the method for resetting the interrupt factor flag.

Write "1": Reset-only method Write "0": Read/write method Read: Valid

With the reset-only method, the interrupt factor flag is reset by writing "1".

The interrupt factor flags for which "0" has been written can neither be set nor reset. Therefore, this method ensures that only a specific factor flag is reset. However, when using read-modify-write instructions (e.g., bset, bclr, or bnot), note that an interrupt factor flag that has been set to "1" is reset by writing. This method cannot be used to set any interrupt factor flag in the software application.

The read/write method is selected by writing "0" to RSTONLY. When this method is selected, interrupt factor flags can be read and written as for other registers. Therefore, the flag is reset by writing "0" and set by writing "1". In this case all factor flags for which "0" has been written are reset. Even in a read-modify-write operation, an interrupt factor can occur between read and write instructions, so be careful when using this method. After an initial reset, RSTONLY is set to "1" (reset-only method).

**TBRP7–TBRP0**: TTBR register write protection ([D[7:0]) / TTBR write-protect register (0x4812D)

Remove write protection for the TTBR register.

Write 0x59: Write protection is removed Write not the above: No operation (write protected) Read: Valid

Before writing to the TTBR register, set TBRP to "0x59" to remove the write protection. Then when data is written to the most significant byte (0x48137) of the TTBR, the register once again becomes write-protected. After an initial reset, TBRP is set to "0x0" (write protected).

TTBR09–TTBR00: Trap table base address [9:0] (D[9:0]) / TTBR low-order register (0x48134[HW]) TTBR15–TTBR10: Trap table base address [15:10] (D[F:A]) / TTBR low-order register (0x48134[HW]) TTBR2B–TTBR20: Trap table base address [27:16] (D[B:0]) / TTBR high-order register (0x48136[HW]) TTBR33–TTBR30: Trap table base address [31:28] (D[F:C]) / TTBR high-order register (0x48136[HW])

Set the starting address of the trap table.

TTBR0 and TTBR3 are read-only registers and are fixed to "0". For this reason, the trap table starting address always begins with a 1KB boundary address.

The TTBR registers normally are write-protected to prevent them from being inadvertently rewritten. To remove this write protect function, another register, TBRP (D[F:8]) / TTBR write-protect register (0x4812D), is provided. A write to the TTBR register is enabled by writing "0x59" to TBRP and is disabled back again by a write to the most significant byte of the TTBR register (0x48137). Consequently, writes to the TTBR register need to begin with the low-order half-word first. However, since occurrences of NMI and the like between writes of the low-order and high-order half-words cause malfunctions, it is recommended that the register be written in words.

#### II CORE BLOCK: ITC (Interrupt Controller)

After an initial reset, the TTBR register address is set to "0x0C00000".

## **Programming Notes**

- (1) As the S1C33000 Core CPU function, the IL allows interrupt levels to be set in the range of 0 to 15. However, since the interrupt priority register in the C33 Core Block consists of three bits, interrupt levels in each interrupt system can only be set for up to 8.
- (2) When the reset-only method is used to reset the interrupt factor flag (by writing "1"), if a read-modify-write instruction (e.g., bset, bclr, or bnot) is executed, the other interrupt factor flags at the same address that have been set to "1" are reset by a write. This requires caution. In cases when the read/write method is used to reset the interrupt factor flag (by writing "0"), all factor flags for which "0" has been written are reset. When a read-modify-write operation is performed, an interrupt factor may occur between reads and writes, so be careful when using this method.
- (3) After an initial reset, the interrupt factor flags and interrupt priority registers all become indeterminate. To prevent unwanted interrupts, be sure to reset these flags and registers in the software application.
- (4) To prevent another interrupt from being generated for the same factor again after generation of an interrupt, be sure to reset the interrupt factor flag before enabling interrupts and setting the PSR again or executing the reti instruction.
# II-6 CLG (Clock Generator)

This section describes the method for controlling the system clock.

# Configuration of Clock Generator

The C33 Core Block has a built-in clock generator that consists of a high-speed oscillation circuit (OSC3) and a PLL. The high-speed (OSC3) oscillation circuit generates the main clock for the CPU and internal peripheral circuits (e.g., serial interface and programmable timer).

Furthermore, the clock generator can input a sub clock, such as low-speed (OSC1, 32.768 kHz, Typ.) clock generated by the Peripheral Block, for the clock timer and for operating the CPU at a low clock speed in order to reduce current consumption.

**Note:** When the Peripheral Block including the low-speed (OSC1) oscillation circuit is used, the source clocks for the CPU and the peripheral circuits (e.g., serial interface and programmable timer) can be selected between the OSC3 clock and the OSC1 clock independently. For details, refer to "Setting and Switching Over the CPU Operating Clock" in this section and "Prescaler" and "Low-Speed (OSC1) oscillation circuit" of the Peripheral Block.



Figure 6.1 shows the configuration of the clock generator.

After an initial reset, the output (OSC3 clock) of the high-speed (OSC3) oscillation circuit is set for the CPU operating clock.

When the low-speed (OSC1) oscillation circuit is used, the CPU operating clock can be switched to the output (OSC1 clock) of the low-speed (OSC1) oscillation circuit in a program. Furthermore, each oscillation circuit can be stopped in a program.

If the OSC3 clock is unnecessary such as when performing clock processing only, set the OSC1 clock for operation of the CPU and turn off the high-speed (OSC3) oscillation circuit in order to reduce current consumption. In addition, when SLEEP mode is set, the high-speed (OSC3) oscillation circuit is turned off, greatly reducing current consumption (no internal units except for the clock timer need to be operated).

# I/O Pins of Clock Generator

Table 6.1 lists the I/O pins of the clock generator.

Table 6.1 I/O Pins of Clock Generator

Pin name	I/O		Function				
OSC3	- 1	High-speed	d (OSC3) os	cillation input pin			
		Crystal/cer	amic oscilla	tion or external clock	input		
OSC4	0	High-speed	d (OSC3) os	cillation output pin			
		Crystal/cer	amic oscilla	tion (open when exte	ernal clock is used)		
PLLC	١	Capasitor of	connecting p	oin for PLL			
PLLS[1:0]	Ι	PLL set-up	pins				
		PLLS1	PLLS0	fin (fosc3)	fout (fpscin)		
		1	1	10–20MHz	20–40MHz		
		1	0	20–25MHz	40–50MHz		
		0	1	10–12.5MHz	40–50MHz		
		0	0	PLL is not used	L*		
		* When the	PLL is not	used, the OSC3 cloc	k is used directly.		

# High-Speed (OSC3) Oscillation Circuit

The high-speed (OSC3) oscillation circuit generates the main clock for the CPU and internal peripheral circuits (e.g., serial interface and programmable timer).

This circuit can be a crystal or a ceramic oscillation circuit. Optionally an external clock source can be used. Figure 6.2 shows the structure of the high-speed (OSC3) oscillation circuit.



Figure 6.2 High-Speed (OSC3) Oscillation Circuit

When using a crystal or a ceramic oscillation for this circuit, connect a crystal (X'tal2) or ceramic (Ceramic) resonator and feedback resistor (Rf) between the OSC3 and OSC4 pins, and two capacitors (CG2, CD2) between the OSC3 pin and Vss and the OSC4 pin and Vss, respectively.

When an external clock is used, leave the OSC4 pin open and input a square-wave clock to the OSC3 pin. The range of oscillation frequencies is 10 MHz to 33 MHz. This frequency range also applies when an external clock is used.

# **Note:** When using the PLL, the oscillation frequency range changes according to the PLL setting. See Table 6.2.

For details on oscillation characteristics and the external clock input characteristics, refer to "Electrical Characteristics".

# PLL

The PLL inputs the OSC3 clock and multiply its frequency. The multiply mode should be set using the PLLS[1:0] pins according to the OSC3 clock frequency.

PLLS1	PLLS0	Mode	fin (OSC3 clock)	fout
1	1	x2	10 to 25MHz	20 to 50MHz
0	1	x4	10 to 12.5MHz	40 to 50MHz
0	0	PLL Not used	_	Not used

Table 6.2	Setting the PLL S[1:0] Pins	
I able 0.2	Setting the FLLS[1.0] Fins	

Figure 6.3 shows a basic external connection diagram for the PLL pins.



Figure 6.3 External Connection Diagram

**Note:** When the PLL is not used, the OSC3 oscillation output is used as the source clock. In this case, the oscillation frequency range is 10 MHz to 33 MHz. Furthermore, leave the PLLC pin open.

### **Controlling Oscillation**

The high-speed (OSC3) oscillation circuit can be turned on or off using SOSC3 (D1) / Power control register (0x40180).

The oscillation circuit is turned off by writing "0" to SOSC3 and turned back on again by writing "1". SOSC3 is set to "1" at initial reset, so the oscillation circuit is turned on.

- **Notes:** When the high-speed (OSC3) oscillation circuit is used as the clock source for the CPU operating clock, it cannot be turned off. In this case, writing "0" to SOSC3 is ignored. Note also that writing to SOSC3 is allowed only when the power-control register protection flag is set to "0b10010110".
  - Immediately after the oscillation circuit is turned on, a certain period of time is required for oscillation to stabilize (for 3.3-V crystal resonator, this time is 10 ms max.). To prevent the device from operating erratically, do not use the clock until its oscillation has stabilized.

The high-speed (OSC3) oscillation circuit turns off when the CPU is set in SLEEP mode.

# Setting and Switching Over the CPU Operating Clock

#### Setting the CPU operating clock frequency

When operating the CPU with the high-speed (OSC3) clock, the operating frequency can be switched over in four steps. Use CLKDT[1:0] (D[7:6]) / Power control register (0x40180) for this switchover.

CLKDT1	CLKDT0	Division ratio
1	1	fout/8
1	0	fout/4
0	1	fout/2
0	0	fout/1

Table 6.3	Setting of	CPU O	perating	Clock
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fout: PLL output

The clock thus set becomes the system clock, which is used as the CPU operating clock and the bus clock. At initial reset, the division ratio is set to fout/1, so the CPU is operated directly by the PLL output clock. Since the device's current consumption can be decreased by reducing the CPU operating speed, switch over the operating frequency as necessary.

This setting is effective only for the high-speed (OSC3) clock, and has no effect when the low-speed (OSC1) clock is used as the system clock.

**Note:** Writing to CLKDT[1:0] is effective only when the power-control register protection flag is set to "0b10010110".

#### Switching over the CPU operating clock

**Note:** The CPU operating clock can be switched from OSC3 to OSC1 only when the low-speed (OSC1) oscillation circuit in the Peripheral Block is used.

After an initial reset, the CPU starts operating using the OSC3 clock. All internal peripheral circuits also operate.

In cases in which some peripheral circuits (e.g., programmable timer and serial interface) that are clocked by the OSC3 clock do not need to be operate and the CPU can process its jobs at a low clock speed, the CPU operating clock can be switched to the OSC1 clock, thereby reducing current consumption. Use CLKCHG (D2) / Power control register (0x40180) to switch over the operating clock.

#### Procedure for switching over from the OSC3 clock to the OSC1 clock

- 1. Turn on the low-speed (OSC1) oscillation circuit (by writing "1" to SOSC1).
- 2. Wait until the OSC1 oscillation stabilizes (three seconds or more).
- 3. Change the CPU operating clock (by writing "0" to CLKCHG).
- 4. Turn off the high-speed (OSC3) oscillation circuit (by writing "0" to SOSC3).

\* Steps 1 and 2 are required only when the low-speed (OSC1) oscillation circuit is inactive.

- **Notes:** Use separate instructions to switch from OSC3 to OSC1 and turn the OSC3 oscillation off. If these operations are processed simultaneously using one instruction, the CPU may operate erratically.
  - Make sure the operation of the peripheral circuits, such as the programmable timer and serial interface, which are clocked by the OSC3 oscillation circuit, is terminated before the OSC3 oscillation is turned off in order to prevent them from operating erratically.

#### Procedure for switching over from the OSC1 clock to the OSC3 clock

- 1. Turn on the high-speed (OSC3) oscillation circuit (by writing "1" to SOSC3).
- 2. Wait until the OSC3 oscillation stabilizes (10 ms or more for a 3.3-V crystal resonator).
- 3. Switch over the CPU operating clock (by writing "1" to CLKCHG).
- **Note:** The operating clock switchover by CLKCHG is effective only when both oscillation circuits are on and the power-control register protection flag is set to "0b10010110".

# **Power-Control Register Protection Flag**

The power-control register at address 0x40180, which is used to control the oscillation circuits and the CPU operating clock, is normally disabled against writing in order to prevent it from malfunctioning due to unnecessary writing.

To enable this register for writing, the power-control register protection flag CLGP[7:0] (D[7:0]) / Power-control protection register (0x4019E) must be set to "0b10010110". Note that this setting allows for the power-control register (0x40180) to be written to only once, so all bits of CLGP[7:0] are cleared to "0" when this address is written to. Therefore, CLGP[7:0] must be set to "0x10010110" each time the power-control register (0x40180) is written to. The flag CLGP[7:0] does not affect the readout from the power-control register (0x40180).

# **Operation in Standby Mode**

In HALT mode, which is entered by executing the halt instruction, the high-speed (OSC3) and low-speed (OSC1) oscillation circuits both retain their status before HALT mode is entered. Under normal conditions, therefore, there is no need to control the oscillation circuits before entering or after exiting HALT mode.

The high-speed (OSC3) oscillation circuit stops operating after SLEEP mode is entered, which is done by executing the slp (sleep) instruction. If the high-speed (OSC3) oscillation circuit was operating before SLEEP mode was entered, it automatically starts oscillating again after SLEEP mode is exited.

In addition, if the CPU was operating using the OSC3 clock before SLEEP mode was entered, the CPU starts operating using the OSC3 clock again even after SLEEP mode is exited. The high-speed (OSC3) oscillation circuit requires 10 ms max. (when using a 3.3-V crystal resonator) for its oscillation to stabilize after oscillation starts. To prevent the CPU from operating erratically upon restart during this period, the C33 Core Block is designed to allow the OSC3 clock supply to the CPU to be disabled in the hardware after SLEEP mode is exited. Use 8T1ON (D2) / Clock option register (0x40190) to select this function. Use 8-bit programmable timer 1 to set the waitting time before clock supply is started.

The processing procedure and the operations to be performed when this function is used are as follows:

- 1. Disable the 8-bit programmable timer 1 interrupt.
- Preset the initial count to 8-bit programmable timer 1.
   Set a value that will provide an ample stabilization waiting time. It is also necessary to set the input clock for 8-bit programmable timer 1 using the prescaler.
- Enable the interrupt used to exit SLEEP mode.
   Before enabling the interrupt, be sure to reset the interrupt factor flag.
- 4. Write "0" to 8T1ON (turn on the function for waiting until the oscillation stabilizes after exiting SLEEP mode).
- 5. Activate 8-bit programmable timer 1 to start counting.
- 6. Enter SLEEP mode using the slp instruction.

SLEEP mode

- 7. Exit SLEEP mode using an NMI, input port, or timer interrupt.
- 8. The high-speed (OSC3) oscillation circuit starts oscillating when SLEEP mode is exited. 8-bit programmable timer 1 also is made to start counting using the OSC3 clock.
- 8-bit programmable timer 1 underflows.
   The operating clock supply to the CPU is begun by the underflow signal, so that the CPU restarts.

For details on how to control the 8-bit programmable timer, prescaler, and interrupts, refer to the description of each item in this manual.

**Note:** The function for waiting until the high-speed (OSC3) oscillation is stabilized by 8T1ON is effective only when SLEEP mode is exited.

Writing to 8T1ON is effective only when the power-control register protection flag is set to "0b10010110".

# I/O Memory of Clock Generator

Table 6.4 lists the control bits of clock generator.

Register name	Address	Bit	Name	Function			Se	tting	J	Init.	R/W	Remarks
Power control	0040180	D7	CLKDT1	System clock division ratio	CI	_KD	T[1:0]	Div	vision ratio	0	R/W	
register	(B)	D6	CLKDT0	selection		1	1		1/8	0		
						1	0		1/4			
					(	0	1		1/2			
					(	0	0		1/1			
		D5	PSCON	Prescaler On/Off control	1	On		0	Off	1	R/W	
		D4–3	-	reserved				-		0	-	Writing 1 not allowed.
		D2	CLKCHG	CPU operating clock switch	1	OS	C3	0	OSC1	1	R/W	
		D1	SOSC3	High-speed (OSC3) oscillation On/Off	1	On		0	Off	1	R/W	
		D0	SOSC1	Low-speed (OSC1) oscillation On/Off	1	On		0	Off	1	R/W	
Clock option	0040190	D7–4	-	_				-		-	-	0 when being read.
register	(B)	D3	HLT2OP	HALT clock option	1	On		0	Off	0	R/W	
		D2	8T1ON	OSC3-stabilize waiting function	1	Off		0	On	1	R/W	
		D1	-	reserved				-		0	-	Writing 1 not allowed.
		D0	PF10N	OSC1 external output control	1	On		0	Off	0	R/W	
Power control	004019E	D7	CLGP7	Power control register protect flag	Wr	iting	100101	10 (0	x96)	0	R/W	
protect register	(B)	D6	CLGP6		rer	removes the write protection of		0				
		D5	CLGP5		the	the power control register		0				
		D4	CLGP4		(0x40180) and the clock option		0					
		D3	CLGP3		register (0x40190).		0					
		D2	CLGP2		Wr	Writing another value set the		0				
		D1	CLGP1		wri	te pr	rotection			0		
		D0	CLGP0							0		

Table 6.4 Control Bits of Clock Generator

#### SOSC1: Low-speed (OSC1) oscillation control (D0) / Power control register (0x40180)

Turns the low-speed (OSC1) oscillation on or off.

Write "1": OSC1 oscillation turned on

- Write "0": OSC1 oscillation turned off
  - Read: Valid

The oscillation of the low-speed (OSC1) oscillation circuit is stopped by writing "0" to SOSC1, and started again by writing "1".

Since a duration of maximum three seconds is required for oscillation to stabilize after the oscillation has been restarted, at least this length of time must pass before the OSC1 clock can be used.

Writing to SOSC1 is allowed only when CLGP[7:0] is set to "0b10010110". Note also that if the CPU is operating using the OSC1 clock, writing "0" to SOSC1 is ignored and the oscillation is not turned off.

At initial reset, SOSC1 is set to "1" (OSC1 oscillation turned on).

**Note:** This control bit is effective only when the low-speed (OSC1) oscillation circuit in the Peripheral Block is used.

SOSC3: High-speed (OSC3) oscillation control (D1) / Power control register (0x40180)

Turns the high-speed (OSC3) oscillation on or off.

Write "1": OSC3 oscillation turned onWrite "0": OSC3 oscillation turned offRead: Valid

The oscillation of the high-speed (OSC3) oscillation circuit is stopped by writing "0" to SOSC3, and started again by writing "1".

Since a duration of maximum 10 ms (for a 3.3-V crystal resonator) is required for oscillation to stabilize after the oscillation has been restarted, at least this length of time must pass before the OSC3 clock can be used.

Writing to SOSC3 is allowed only when CLGP[7:0] is set to "0b10010110". Note also that if the CPU is operating using the OSC3 clock, writing "0" to SOSC3 is ignored and the oscillation is not turned off.

At initial reset, SOSC3 is set to "1" (OSC3 oscillation turned on).

CLKCHG: CPU operating clock switch (D2) / Power control register (0x40180)

Selects the CPU operating clock.

Write "1": OSC3 clock Write "0": OSC1 clock Read: Valid

The OSC3 clock is selected as the CPU operating clock by writing "1" to CLKCHG, and OSC1 is selected by writing "0". The operating clock can be switched over in this way only when both the high-speed (OSC3) and low-speed (OSC1) oscillation circuits are on. In addition, writing to CLKCHG is effective only when CLGP[7:0] is set to "0b10010110". Immediately after the oscillation circuit has started oscillating, wait for the oscillation to stabilize before switching over the CPU operating clock.

At initial reset, CLKCHG is set to "1" (OSC3 clock).

**Note:** This control bit is effective only when the low-speed (OSC1) oscillation circuit in the Peripheral Block is used.

CLKDT1-CLKDT0: CPU operating frequency selection (D[7:6]) / Power control register (0x40180)

Table 6.	5 Setting of Cl	PU Operating Clock						
CLKDT1	CLKDT0	Division ratio						
1	1	fout/8						
1	0	fout/4						
0	1	fout/2						
0	0	fout/1						

Select the CPU operating clock frequency.

fout: PLL output

This setting is effective when the CPU is operated using the high-speed (OSC3) clock and has no effect on the low-speed (OSC1) clock. Writing to CLKDT[1:0] is allowed only when CLGP[7:0] is set to "0b10010110". At initial reset, CLKDT is set to "0" (fout/1).

8T1ON: High-speed (OSC3) oscillation waiting function (D2) / Clock option register (0x40190)

Sets the function for waiting until the high-speed (OSC3) oscillation stabilizes after SLEEP mode is exited.

Write "1": Off Write "0": On Read: Valid

After SLEEP mode is exited, the high-speed (OSC3) oscillation waiting function is effective by writing "1" to 8T1ON. For this function to be used, the waiting time must be set in 8-bit programmable timer 1 to allow it to start counting before entering SLEEP mode. After SLEEP mode is exited, the OSC3 clock is not supplied to the CPU until 8-bit programmable timer 1 underflows. This function will not work when 8T1ON is set to "0". The high-speed (OSC3) oscillation waiting function is effective only when SLEEP mode is exited. Writing to 8T1ON is effective only when CLGP[7:0] is set to "0b10010110". When writing to 8T1ON, always be sure to write "0" to the reserved bits at address 0x40190. At initial reset, 8T1ON is set to "0" (Off).

HLT2OP: HALT clock option (D3) / Clock option register (0x40190)

Select a HALT condition (basic mode or HALT2 mode).

Write "1": HALT2 mode Write "0": Basic mode Read: Valid

When "1" is written to HLT2OP, the CPU will enter HALT2 mode when the HALT instruction is executed. When "0" is written, the CPU will enter basic mode.

Writing to HLT2OP is allowed only when CLGP[7:0] is set to "0b10010110".

At initial reset, HLT2OP is set to "0" (basic mode).

The following shows the operating status in HALT mod	de (basic mode and HALT2 mode) and SLEEP mode.
--	--

r		e			
Standb	y mode	Operating status	Reactivating factor		
HALT mode	Basic mode	<ol> <li>The CPU clock is stopped. (CPU stop status)</li> <li>BCU clock is supplied. (BCU run status)</li> <li>Clocks for the peripheral circuits maintain the status before entering HALT mode. (run or stop)</li> <li>The high-speed oscillation circuit maintains the status before entering HALT mode.</li> <li>The low-speed oscillation circuit maintains the status before entering HALT mode.</li> </ol>	<ol> <li>(1) Reset, NMI</li> <li>(2) Enabled (not masked) interrupt factors</li> </ol>		
	HALT2 mode	<ol> <li>The CPU clock is stopped. (CPU stop status)</li> <li>BCU clock is stopped. (BCU stop status)</li> <li>Clocks for the peripheral circuits maintain the status before entering HALT mode. (run or stop)</li> <li>The high-speed oscillation circuit maintains the status before entering HALT mode.</li> <li>The low-speed oscillation circuit maintains the status before entering HALT mode.</li> </ol>	In HALT2 mode, the SIO, and timers (8-bit and 16-bit) continue operating without stopping, but since the synchronization clock is stopped, these circuits cannot be restarted. A restart is possible only in the case of: (1) Interrupt from input pin (2) Interrupt from clock timer (3) NMI (4) Reset		
SLEEP mode		<ol> <li>The CPU clock is stopped. (CPU stop status)</li> <li>BCU clock is stopped. (BCU stop status)</li> <li>Clocks for the peripheral circuits are stopped.</li> <li>The high-speed oscillation circuit is stopped.</li> <li>The low-speed oscillation circuit maintains the status before entering SLEEP mode.</li> </ol>	<ol> <li>Reset, NMI</li> <li>Enabled (not masked) input port interrupt factors</li> <li>Clock timer interrupt when the low-speed oscillation circuit is being operated</li> </ol>		

Table 6.6 Operating Status in Standby Mode

#### CLGP7-CLGP0: Power-control register protection flag ([D[7:0]) / Power control protection register (0x4019E)

These bits remove the protection against writing to addresses 0x40180 and 0x40190.

Write "0b10010110": Write protection removed Write other than the above: No operation (write-protected) Read: Valid

Before writing to address 0x40180 or 0x40190, set CLGP[7:0] to "0b10010110" to remove the protection against writing to that address. This clearing of write protection is effective for only one writing, so the bits are cleared to "0b00000000" by one writing. Therefore, CLGP[7:0] must be set each time the protected address is written to. At initial reset, CLGP is set to "0b00000000" (write-protected).

# **Programming Notes**

- Immediately after the high-speed (OSC3) oscillation circuit is turned on, a certain period of time is required for oscillation to stabilize (for a 3.3-V crystal resonator, this time is 10 ms max.). To prevent the device from operating erratically, do not use the clock until its oscillation has stabilized.
   In particular, if the CPU is set in SLEEP mode during operation using the OSC3 clock, the high-speed (OSC3) oscillation circuit is turned off during in SLEEP mode and starts oscillating again after SLEEP mode is exited. To prevent the CPU from operating erratically at restart due to an unstable OSC3 clock, set a sufficient stabilization waiting time in 8-bit programmable timer 1 to turn on the oscillation stabilization waiting function after SLEEP mode is exited before entering SLEEP mode.
- (2) The oscillation circuit used for the CPU operating clock cannot be turned off.
- (3) The CPU operating clock can only be switched over when both the OSC3 and OSC1 oscillation circuits are on. Furthermore, when turning off an oscillation circuit that has become unnecessary as a result of the CPU operating clock switchover, be sure to use separate instructions for switchover and oscillation turnoff. If these two operations are processed simultaneously using one instruction, the CPU may operate erratically.
- (4) If the high-speed (OSC3) oscillation circuit is turned off, all peripheral circuits operated using the OSC3 clock will be inactive.
- (5) If the OSC3 clock is unnecessary, use the OSC1 clock to operate the CPU and turn the high-speed (OSC3) oscillation circuit off. This helps reduce current consumption.
- (6) In the SLEEP state, the oscillation circuit clock stops, and in the HALT2 mode, the clock supply to peripheral circuits is stopped.

When restarting from this state, interrupt input from a port can be used as a trigger, but functionally, this interrupt input operates as level input. Therefore, a level input based restart is performed even in the case of set edge input.

Restart operation is as follows for rising and falling edges.

In case of rising edge interrupt setting: Restarted by High level input.

In case of falling edge interrupt setting: Restarted by Low level input.

In normal operation, a restart begins following the elapse of a given time after execution of the SLP instruction, but when restart by a falling (rising) level (edge) is set, the operation is as follows.

- The restart is effected immediately after execution of the SLP instruction.
- As ports are already at the low level when the SLP instruction is executed, there is no falling (rising) edge, and therefore the SLP state is entered only momentarily, and the restart is effected immediately afterwards.

There was a synchronization circuit using a clock signal in the port input circuit, and as the clock is stopped in the SLEEP state or HALT2 state, the configuration provided for this synchronization circuit to be bypassed when restarting. Therefore, a restart is effected when the input level from a port is active by level. Consequently, the system design should assume that a restart by means of port input from the SLEEP state or HALT2 state is performed by level.

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# II-7 DBG (Debug Unit)

# **Debug Circuit**

The C33 Core Block has a built-in debug circuit.

This functional block is provided to simply realize an advanced software development environment.

**Note**: The debug circuit does not work during normal operation. To construct a software development environment using the debug circuit, the S5U1C33000H (In-Circuit Debugger for S1C33 Family) is separately required.

# I/O Pins of Debug Circuit

Six pins used to exclusively connect the S5U1C33000H (In-Circuit Debugger for S1C33 Family) are reserved for the debug circuit. The I/O voltage level of these pins is 3.3 V.

Table 7.1 lists the I/O pins of the debug circuit.

-									
Pin name	I/O	Pull-up	Initial status	Voltage level	Function				
DCLK	0	-	1	3.3 V	Clock output for debugging				
DST2	0	-	0	3.3 V	Status output 2 for debugging				
DST1	0	-	1	3.3 V	Status output 1 for debugging				
DST0	0	-	1	3.3 V	Status output 0 for debugging				
DPCO	0	-	1	3.3 V	PC output for debugging				
DSIO	I/O	With pull-up	1 (Input)	3.3 V	Serial I/O for debugging				

Table 7.1	I/O P	ins of	Debug	Circuit

The DCLK, DST[2:0] and DPCO outputs are extended functions of the I/O port pins P14, P1[2:0] and P13, respectively. At initial reset, these pins are set as debug signal outputs.

If the debug circuit is not used, these pins can be used for I/O ports or the redefined peripheral circuits by writing "0" to CFEX[1:0] (D[1:0]) / Port function extension register (0x402DF). Refer to "I/O Ports (P Ports)" for the pin functions.

Note: When these pins are set as debug signal outputs, only the S5U1C33000H (In-Circuit Debugger for S1C33 Family) can be connected to these pins. Leave these pins open if the S5U1C33000H is not connected. For connecting the S5U1C33000H, refer to the "S5U1C33000H Manual (S1C33 Family In-Circuit Debugger)".

Furthermore, the pin status is fixed as shown in the above table after a user reset.

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# S1C33S01 FUNCTION PART

# **III-1 INTRODUCTION**

The peripheral block consists of a prescaler, four channels of 8-bit programmable timer, six channels of 16-bit programmable timer including watchdog timer function, two channels of serial interface, input and I/O ports, low-speed (OSC1) oscillation circuit and a clock timer.



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# **III-2 PRESCALER**

# Configuration of Prescaler

The prescaler divides the source clock (OSC3/PLL output clock or OSC1 clock) to generate the clocks for the internal peripheral circuits. The prescaler division ratio can be selected for each peripheral circuit in a program. A clock control circuit to control the clock supply to each peripheral circuit is also included.

The following are the peripheral circuits that use the output clock:

- 16-bit programmable timers 5 to 0 (and watchdog timer)
- 8-bit programmable timers 3 to 0 (and serial interface)

Figure 2.1 shows the configuration of the prescaler.

For details on control of each peripheral circuit, refer to each corresponding section in this manual.



Figure 2.1 Configuration of Prescaler and Clock Control Circuit

# Source Clock

The source clock for the prescaler can be selected using PSCDT0 (D0) / Prescaer clock select register (0x40181). When PSCDT0 = "0", the OSC3 clock (when the PLL is not used) or the PLL output clock (when the PLL is used) is selected.

When PSCDT0 = "1", the OSC1 clock (typ. 32 kHz) is selected.

At initial reset, the OSC3/PLL output clock is selected.

Note: For the prescaler clock, the clock source same as the CPU operating clock must be selected.

For details on how to control the oscillation circuit and CPU operating clock, refer to "CLG (Clock Generator)". At initial reset, the OSC3 clock is selected.

The source clock is supplied to the prescaler by writing "1" to PSCON (D5) / Power control register (0x40180). At initial reset, PSCON is set to "1", so the prescaler is in an operating state. If all of said peripheral circuits can be turned off, stop the prescaler by writing "0" to PSCON. This helps to reduce current consumption.

# Selecting Division Ratio and Output Control for Prescaler

The prescaler has registers for selecting the division ratio and clock output control separately for each peripheral circuit described above, allowing each peripheral circuit to be controlled.

The prescaler's division ratio can be selected from among eight ratios set for each peripheral circuit through the use of the division ratio selection bits. The divided clock is output to the corresponding peripheral circuit by writing "1" to the clock control bit.

Peripheral circuit	Division ratio selection bit	Clock control bit
16-bit programmable timer 0	P16TS0[2:0] (D[2:0]/0x40147)*1	P16TON0 (D3/0x40147)
16-bit programmable timer 1	P16TS1[2:0] (D[2:0]/0x40148)*1	P16TON1 (D3/0x40148)
16-bit programmable timer 2	P16TS2[2:0] (D[2:0]/0x40149)*1	P16TON2 (D3/0x40149)
16-bit programmable timer 3	P16TS3[2:0] (D[2:0]/0x4014A)*1	P16TON3 (D3/0x4014A)
16-bit programmable timer 4	P16TS4[2:0] (D[2:0]/0x4014B)*1	P16TON4 (D3/0x4014B)
16-bit programmable timer 5	P16TS5[2:0] (D[2:0]/0x4014C)*1	P16TON5 (D3/0x4014C)
8-bit programmable timer 0	P8TS0[2:0] (D[2:0]/0x4014D)*2	P8TON0 (D3/0x4014D)
8-bit programmable timer 1	P8TS1[2:0] (D[6:4]/0x4014D)*3	P8TON1 (D7/0x4014D)
8-bit programmable timer 2	P8TS2[2:0] (D[2:0]/0x4014E)*4	P8TON2 (D3/0x4014E)
8-bit programmable timer 3	P8TS3[2:0] (D[6:4]/0x4014E)*2	P8TON3 (D7/0x4014E)
	· · · · · · · · · · · · · · · · · · ·	• • • • • • • • • • • • • • • • • • • •

Table 2.1 Control Bits of the Clock Control Register	able 2.1	ts of the Clock Control Registe	ers
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\*1 to \*4: See Table 2.2.

I able 2.2	Division Ratio	

Bit setting	7	6	5	4	3	2	1	0
*1	θ/4096	θ/1024	θ/256	θ/64	θ/16	θ/4	θ/2	θ/1
*2	θ/256	θ/128	θ/64	θ/32	θ/16	θ/8	θ/4	θ/2
*3	θ/4096	θ/2048	θ/1024	θ/512	θ/256	θ/128	θ/64	θ/32
*4	θ/4096	θ/2048	θ/64	θ/32	θ/16	θ/8	θ/4	θ/2

( $\theta$  = Source clock selected by PSCDT0)

Current consumption can be reduced by turning off the clock output to the peripheral circuits that are unused among those listed above.

Note: In the following cases, the prescaler output clock may contain a hazard:

- If, when a clock is output, its division ratio is changed
- · When the clock output is switched between on and off

. When the oscillation circuit is turned off or the CPU operating clock is switched over

Before performing these operations, make sure the 16-bit and 8-bit programmable timers are turned off.

### Source Clock Output to 8-Bit Programmable Timer

In addition to the divided clock, the prescaler can output the source clock directly to the 8-bit programmable timer. This function can be selected for each 8-bit timer using P8TPCKx bit.

8-bit timer 0: P8TPCK0 (D0) / 8-bit timer clock select register (0x40146)

8-bit timer 1: P8TPCK1 (D1) / 8-bit timer clock select register (0x40146)

8-bit timer 2: P8TPCK2 (D2) / 8-bit timer clock select register (0x40146)

8-bit timer 3: P8TPCK3 (D3) / 8-bit timer clock select register (0x40146)

When P8TPCKx is set to "1", the prescaler input clock ( $\theta/1$ ) is selected for the 8-bit timer x operating clock. The clock output is controlled by the P8TONx bit even if P8TPCKx is set to "1".

When P8TPCKx is "0", the divided clock that is selected by P8TSx[2:0] will be output to the 8-bit timer x.

At initial reset, P8TPCKx is set to "0" and P8TSx[2:0] becomes effective.

# I/O Memory of Prescaler

Table 2.3 shows the control bits of the prescaler.

Register name	Address	Bit	Name	Function	Se	etting	Init.	R/W	Remarks
8-bit timer	0040146	D7-4	-	reserved		-	-	_	0 when being read.
clock select	(B)	D3	Р8ТРСКЗ	8-bit timer 3 clock selection	1 0/1	0 Divided clk.	0	R/W	θ: selected by
register	(-)	D2	P8TPCK2	8-bit timer 2 clock selection	1 0/1	0 Divided clk	0	R/W	Prescaler clock select
. og.oto.		D1	P8TPCK1	8-bit timer 1 clock selection	1 0/1	0 Divided clk	0	R/W	register (0x40181)
		D0	P8TPCK0	8-bit timer 0 clock selection	1 0/1	0 Divided clk	0	R/W	
16 hit timer 0	0040447					o Biridoù oila			O when heing read
16-bit timer 0	0040147	D7-4	-		4.0-	-	-	-	o when being read.
CIOCK CONTROL	(B)	D3	P16TONU	16-bit timer U clock control		0 Off	0	R/W	0. a a la ata d hu
register			P161502		P161S0[2:0]	Division ratio	0	R/W	e: selected by
		D1	P161S01	clock division ratio selection		0/4096	0		Prescaler clock select
		D0	P16TS00		1 1 0	θ/1024	0		register (0x40181)
					1 0 1	θ/256			
					1 0 0	0/64			16-bit timer 0 can be
					0 1 1	θ/16			used as a watchdog
					0 1 0	θ/4			timer.
					0 0 1	θ/2			
					0 0 0	θ/1			
16-bit timer 1	0040148	D7–4	-	reserved		-	-	-	0 when being read.
clock control	(B)	D3	P16TON1	16-bit timer 1 clock control	1 On	0 Off	0	R/W	
register		D2	P16TS12	16-bit timer 1	P16TS1[2:0]	Division ratio	0	R/W	θ: selected by
		D1	P16TS11	clock division ratio selection	1 1 1	0/4096	0		Prescaler clock select
		D0	P16TS10		1 1 0	0/1024	0		register (0x40181)
					1 0 1	0/256			Ŭ ( )
					1 0 0	0/64			
					0 1 1	θ/16			
					0 1 0	θ/4			
					0 0 1	θ/2			
					0 0 0	θ/1			
16-bit timer 2	0040149	D7-4	_	reserved		_	_	_	0 when being read
clock control	(B)		P16TON2	16-bit timer 2 clock control	1 On	0 Off	0	R/W	o whom being road.
register	(5)	D2	P16TS22	16-bit timer 2	P16TS2[2:0]	Division ratio	0	R/W	A: selected by
register			P16TS21	clock division ratio selection	1 1 1 1	A/4096	0	10,00	Prescaler clock select
			P16TS20			6/1024			register (0v/0181)
		00	1 101020			8/256			
						0/230			
						0/0 <del>4</del> 0/16			
						6/A			
						0/4			
						0/2			
						0/1			
16-bit timer 3	004014A	D7-4	-			-	-	-	0 when being read.
CIOCK CONTROL	(B)	D3	P1610N3	16-bit timer 3 clock control	1 On	10   Off	0	R/W	
register		D2	P161S32	16-bit timer 3	P161S3[2:0]	Division ratio	0	R/W	e: selected by
		DI	P161531	CIOCK DIVISION RATIO SELECTION		0/4096	0		Prescaler clock select
		DU	P161S30			0/1024	0		register (0x40181)
					1 0 1	0/256			
					1 0 0	0/64			
					0 1 1	0/16			
					0 1 0	θ/4			
					0 0 1	θ/2			
					0 0 0	θ/1			
16-bit timer 5	004014C	D7–4	-	reserved	<u> </u>	-	-	-	0 when being read.
clock control	(B)	D3	P16TON5	16-bit timer 5 clock control	1 On	0 Off	0	R/W	
register		D2	P16TS52	16-bit timer 5	P16TS5[2:0]	Division ratio	0	R/W	θ: selected by
		D1	P16TS51	clock division ratio selection	1 1 1	θ/4096	0		Prescaler clock select
		D0	P16TS50		1 1 0	θ/1024	0		register (0x40181)
					1 0 1	0/256			
					1 0 0	0/64			
					0 1 1	0/16			
					0 1 0	θ/4			
					0 0 1	θ/2			
					0 0 0	θ/1			

Table 2.3	Control Bits of Prescaler

#### **III PERIPHERAL BLOCK: PRESCALER**

Register name	Address	Bit	Name	Function			S	etting	Init.	R/W	Remarks
8-bit timer 0/1	004014D	D7	P8TON1	8-bit timer 1 clock control	1	On		0 Off	0	R/W	
clock control	(B)	D6	P8TS12	8-bit timer 1	P8	TS1	[2:0]	Division ratio	0	R/W	θ: selected by
register		D5	P8TS11	clock division ratio selection	1	1	1	0/4096	0		Prescaler clock select
		D4	P8TS10		1	1	0	θ/2048	0		register (0x40181)
					1	0	1	θ/1024			
					1	0	0	0/512			8-bit timer 1 can
					0	1	1	0/256			generate the OSC3
					0	1	0	0/128			oscillation-stabilize
					0	0	1	0/64			waiting period.
					0	0	0	θ/32			
		D3	P8TON0	8-bit timer 0 clock control	1	On	10.01	0 Off	0	R/W	
		D2	P81502	8-bit timer 0	198	150	[2:0]	Division ratio	0	R/W	e: selected by
		D1	P81501	Clock division ratio selection	1	1	1	0/1256	0		Prescaler clock select
		00	P01300					0/04	0		register (0x40161)
								0/04			8-bit timor 0 can
							1	0/32			deporate the DRAM
					0			0/10 0/8			refresh clock
					0		1	0/0 0/4			Terrestreidek.
					0	0	0	θ/2			
8-bit timer 2/3	004014F	D7	P8TON3	8-bit timer 3 clock control	1	On	1 - 1	0.0ff	0	R/W	
clock control	(B)	D6	P8TS32	8-bit timer 3	P8	TS3	[2:0]	Division ratio	0	R/W	θ: selected by
register		D5	P8TS31	clock division ratio selection	1	1	1	0/256	0		Prescaler clock select
		D4	P8TS30		1	1	0	θ/128	0		register (0x40181)
					1	0	1	0/64			
					1	0	0	θ/32			8-bit timer 3 can
					0	1	1	θ/16			generate the clock for
					0	1	0	θ/8			the serial I/F Ch.1.
					0	0	1	θ/4			
					0	0	0	θ/2			
		D3	P8TON2	8-bit timer 2 clock control	1	On TOO	10.01	0 Off	0	R/W	0. and a start by
			P81522	8-bit timer 2	1	152	[2:0]	Division ratio	0	R/W	9: selected by Proscalar clock salact
			P01321					0/4090	0		register (0x40181)
		00	101020					0/2040			
					1	0	0	0/32			8-bit timer 2 can
					0	1	1	θ/16			generate the clock for
					0	1	0	θ/8			the serial I/F Ch.0.
					0	0	1	θ/4			
					0	0	0	θ/2			
Power control	0040180	D7	CLKDT1	System clock division ratio	CL	KDT	[1:0]	Division ratio	0	R/W	
register	(B)	D6	CLKDT0	selection	1		1	1/8	0		
					1		0	1/4			
					0		1	1/2			
		<b>D</b> 5	20001		0		0	1/1		DAM	
		D5	PSCON	Prescaler On/Off control	1	Un		10 0 10 10 10 10 10 10 10 10 10 10 10 10	1	R/W	Writing 1 pot allowed
		D7 3		CPLL operating clock switch	1	050	3	0.0501	1	R/W	witting i not allowed.
		D1	SOSC3	High-speed (OSC3) oscillation On/Off	1	On		0 Off	1	R/W	
		D0	SOSC1	Low-speed (OSC1) oscillation On/Off	1	On		0 Off	1	R/W	
Prescaler clock	0040181	D7–1	-	reserved				_	0	_	
select register	(B)	D0	PSCDT0	Prescaler clock selection	1	osc	21	0 OSC3/PLL	0	R/W	
Power control	004019E	D7	CLGP7	Power control register protect flag	Wri	ting 1	10010	110 (0x96)	0	R/W	
protect register	(B)	D6	CLGP6		rem	loves	s the v	vrite protection of	0		
		D5	CLGP5		the	pow	er con	trol register	0		
		D4	CLGP4		(0x4	4018	0) and	the clock option	0		
		D3	CLGP3		regi	ister	(0x40	190).	0		
		D2	CLGP2		Wri	ting a	anothe	er value set the	0		
		D1	CLGP1		writ	e pro	otectio	n.	0		
1	1	I D0	I CLGP0	1	1				1 0	1	1

#### PSCON: Prescaler on/off control (D5) / Power control register (0x40180)

Turns the prescaler on or off.

Write "1": On Write "0": Off Read: Valid

The source clock is input to the prescaler by writing "1" to PSCON, thereby starting a dividing operation. The prescaler is turned off by writing "0". If the peripheral circuits do not need to be operated, write "0" to this bit to reduce current consumption. Since PSCON is protected against writing the same as SOSC1, SOSC3, CLKCHG and CLKDT[1:0], CLGP[7:0] must be set to "0b10010110" before PSCON can be changed. At initial reset, PSCON is set to "1" (On).

CLGP7-CLGP0: Power-control register protection flag ([D[7:0]) / Power control protection register (0x4019E)

These bits remove the protection against writing to addresses 0x40180 and 0x40190.

Write "0b10010110": Write protection removed Write other than the above: No operation (write-protected) Read: Valid

Before writing to address 0x40180 or 0x40190, set CLGP[7:0] to "0b10010110" to remove the protection against writing to that address. This clearing of write protection is effective for only one writing, so the bits are cleared to "0b00000000" by one writing. Therefore, CLGP[7:0] must be set each time the protected address is written to. At initial reset, CLGP is set to "0b00000000" (write-protected).

PSCDT0: Prescaler clock selection (D0) / Prescaler clock select register (0x40181)

Select the source clock for the prescaler.

Write "1": OSC1 clock Write "0": OSC3 clock/PLL output clock Read: Valid

When "1" is written to PSCDT0, the OSC1 clock (typ. 32 kHz) is selected.

When "0" is written, the OSC3 clock (when the PLL is not used) or the PLL output clock (when the PLL is used) is selected.

For the prescaler clock, the clock source same as the CPU operating clock must be selected. At initial reset, PSCDT0 is set to "0" (OSC3 clock/PLL output clock).

P16TS0[2:0]: 16-bit timer 0 clock division ratio (D[2:0]) / 16-bit timer 0 clock control register (0x40147) P16TS1[2:0]: 16-bit timer 1 clock division ratio (D[2:0]) / 16-bit timer 1 clock control register (0x40148) P16TS2[2:0]: 16-bit timer 2 clock division ratio (D[2:0]) / 16-bit timer 2 clock control register (0x4014A) P16TS3[2:0]: 16-bit timer 3 clock division ratio (D[2:0]) / 16-bit timer 3 clock control register (0x4014A) P16TS4[2:0]: 16-bit timer 4 clock division ratio (D[2:0]) / 16-bit timer 4 clock control register (0x4014B) P16TS5[2:0]: 16-bit timer 5 clock division ratio (D[2:0]) / 16-bit timer 5 clock control register (0x4014C) P8TS0[2:0]: 8-bit timer 0 clock division ratio (D[2:0]) / 8-bit timer 0/1 clock control register (0x4014D) P8TS1[2:0]: 8-bit timer 1 clock division ratio (D[6:4]) / 8-bit timer 0/1 clock control register (0x4014E) P8TS3[2:0]: 8-bit timer 3 clock division ratio (D[6:4]) / 8-bit timer 2/3 clock control register (0x4014E)

Select a clock for each peripheral circuit.

The desired division ratio can be selected from among the eight ratios shown on the I/O map. Note that the division ratio differs for each peripheral circuit.

These bits can also be read out.

At initial reset, all of these bits are set to "0b000" (highest frequency available).

P16TON0: 16-bit timer 0 clock control (D3) / 16-bit timer 0 clock control register (0x40147) P16TON1: 16-bit timer 1 clock control (D3) / 16-bit timer 1 clock control register (0x40148) P16TON2: 16-bit timer 2 clock control (D3) / 16-bit timer 2 clock control register (0x40149) P16TON3: 16-bit timer 3 clock control (D3) / 16-bit timer 3 clock control register (0x4014A) P16TON4: 16-bit timer 4 clock control (D3) / 16-bit timer 4 clock control register (0x4014B) P16TON5: 16-bit timer 5 clock control (D3) / 16-bit timer 5 clock control register (0x4014B) P16TON5: 16-bit timer 5 clock control (D3) / 16-bit timer 5 clock control register (0x4014C) P8TON0: 8-bit timer 0 clock control (D3) / 8-bit timer 0/1 clock control register (0x4014D) P8TON1: 8-bit timer 1 clock control (D7) / 8-bit timer 0/1 clock control register (0x4014D) P8TON2: 8-bit timer 2 clock control (D3) / 8-bit timer 2/3 clock control register (0x4014E) P8TON3: 8-bit timer 3 clock control (D7) / 8-bit timer 2/3 clock control register (0x4014E)

Control the clock supply to each peripheral circuit.

Write "1": On Write "0": Off Read: Valid

The clock selected using the division ratio setup bits is output to the corresponding peripheral circuit by writing "1" to these bits.

The clock is not output by writing "0". If the peripheral circuits do not need to be operated, write "0" to these bits. This helps to reduce current consumption.

At initial reset, all of these bits are set to "0" (Off).

```
P8TPCK0: 8-bit timer 0 clock selection (D0) / 8-bit timer clock select register (0x40146)

P8TPCK1: 8-bit timer 1 clock selection (D1) / 8-bit timer clock select register (0x40146)

P8TPCK2: 8-bit timer 2 clock selection (D2) / 8-bit timer clock select register (0x40146)

P8TPCK3: 8-bit timer 3 clock selection (D3) / 8-bit timer clock select register (0x40146)
```

Select the operating clock for the 8-bit programmable timer.

Write "1": Prescaler input clock (θ/1)Write "0": Divided clockRead: Valid

When "1" is written to P8TPCKx, the prescaler input clock ( $\theta$ /1) is selected for the 8-bit timer x operating clock. The clock output is controlled by the P8TONx bit even if P8TPCKx is set to "1".

When "0" is written, the divided clock that is selected by P8TSx[2:0] will be output to the 8-bit timer x. At initial reset, P8TPCKx is set to "0" (divided clock).

### **Programming Notes**

- (1) For the prescaler clock, the clock source same as the CPU operating clock must be selected.
- (2) In the following cases, the prescaler output clock may contain a hazard:
  - If, during outputting of a clock, its division ratio is changed
  - · When the clock output is switched between on and off
  - When the oscillation circuit is turned off or the CPU operating clock is switched over

Before performing these operations, make sure the 16-bit and 8-bit programmable timers are turned off.

(3) When the 16-bit and 8-bit programmable timers do not need to be operated, turn off the clock supply to those peripheral circuits. This helps to reduce current consumption.

# **III-3 8-BIT PROGRAMMABLE TIMERS**

### Configuration of 8-Bit Programmable Timer

The Peripheral Block contains four channels of 8-bit programmable timers (timers 0 to 3). Figure 3.1 shows the structure of the 8-bit programmable timer.



Figure 3.1 Structure of 8-Bit Programmable Timer

Each timer consists of an 8-bit presentable counter and can output a clock generated by the counter's underflow signal to the internal peripheral circuits or external devices. The output clock cycle can be selected from a wide range of cycles by setting the preset data that can be set in the software and the input clock in the prescaler.

# **Output Pins of 8-Bit Programmable Timers**

Table 3.1 shows the pins that are used to output the underflow signals of the 8-bit programmable timers to external devices.

Table 3.1 Output Pins of 8-Bit Programmable Timers						
Pin name	1/0	Function	Function select bit			
P10/EXCL0/	I/O	I/O port / 16-bit timer 0 event counter	CFP10(D0)/P1 function select register (0x402D4)			
T8UF0		input / 8-bit timer 0 output / DST0 output	CFEX1(D1)/Port function extension register (0x402DF)			
P11/EXCL1/	I/O	I/O port / 16-bit timer 1 event counter	CFP11(D1/P1 function select register (0x402D4)			
T8UF1		input / 8-bit timer 1 output / DST1 output	CFEX1(D1)/Port function extension register (0x402DF)			
P12/EXCL2/	I/O	I/O port / 16-bit timer 2 event counter	CFP12(D2/P1 function select register (0x402D4)			
T8UF2		input / 8-bit timer 2 output / DST2 output	CFEX0(D0)/Port function extension register (0x402DF)			
P13/EXCL3/	I/O	I/O port / 16-bit timer 3 event counter	CFP13(D3/P1 function select register (0x402D4)			
T8UF3		input / 8-bit timer 3 output / DPCO output	CFEX1(D1)/Port function extension register (0x402DF)			

#### T8UFx (output pin of the 8-bit programmable timer)

This pin outputs a clock divided in each 8-bit programmable timer. The pulse width is equal to that of input clock of the 8-bit programmable timer (prescaler output). Therefore, the pulse width varies according to the prescaler setting.

#### How to set the output pins of the 8-bit programmable timer

All pins used by the 8-bit programmable timers are shared with I/O ports, event counter inputs of the 16-bit programmable timers and debug signal outputs. At cold start, all these pins are set for the debug signal outputs (function select bit CFP1[3:0] = "0", port extended function bit CFEX[1:0] = "1"). When using the clock output function of the 8-bit programmable timer, write "0" to the port extended function bit CFEXx and write "1" to the function select bit CFP1x for the corresponding pin.

Then, after setting the above, write "1" to the I/O port's I/O control bit IOC1x (D[3:0]) / P1 I/O control register (0x402D6) to set to output mode. In input mode, the pin functions as the 16-bit programmable timer's event counter input and cannot be used to output a clock of the 8-bit programmable timer. At cold start, the register is set to input mode. At hot start, the register retains its status from prior to the reset.

### Uses of 8-Bit Programmable Timers

The down-counter of the 8-bit programmable timer cyclically outputs an underflow signal according to the preset data that is set in the software. This underflow signal is used to generate an interrupt request to the CPU or to control the internal peripheral circuits. In addition, this signal can be output to external devices.

Furthermore, each 8-bit programmable timer generates a clock from the underflow signal by dividing it by 2, and the resulting clock is output to a specific internal peripheral circuit.

#### **CPU** interrupt request

Each timer's underflow condition can be used as an interrupt factor to output an interrupt request to the CPU. Therefore, an interrupt can be generated at an interval that is set in the software.

#### Clock output to external devices

The underflow signal can be output from the chip to the outside. This output can be used to control external devices. The output pins of each timer are described in the preceding section.

#### Control of and clock supply to internal peripheral circuits

The following describes the functions controlled by the underflow signal from the 8-bit programmable timer and the internal peripheral circuits that use the timer's output clock.

#### 8-bit programmable timer 0

#### DRAM refresh

When the BCU has a DRAM directly connected to its external bus, the underflow signal from timer 0 can be used as a DRAM refresh request signal. This enables the intervals of the refresh cycle to be programmed.

To use this function, write "1" to the BCU's control bit RPC (D9) / Bus control register (0x4812E) to enable the DRAM refresh.

#### 8-bit programmable timer 1

• Oscillation stabilization wait time of the high-speed (OSC3) oscillation circuit

When SLEEP mode is cleared by an external interrupt, the high-speed (OSC3) oscillation circuit starts oscillating. To prevent the CPU from being operated erratically by an unstable clock before the oscillation stabilizes, the C33 Core Block enables setting of the waiting time before the CPU starts operating after SLEEP is cleared. Use the 8-bit programmable timer 1 to generate this waiting time. If the 8-bit programmable timer 1 is set so that the timer is actuated when the high-speed (OSC3) oscillation circuit starts oscillating the timer and, after the oscillation stabilization time elapses, an underflow signal is generated, then the CPU can be started up by that underflow signal.

To use this function, write "0" to the oscillation circuit control bit 8T1ON (D2) / Clock option register (0x40190) to enable the oscillation stabilization waiting function.

#### 8-bit programmable timer 2

• Clock supply to the Ch.0 serial interface

When using the Ch.0 serial interface in the clock-synchronized master mode or the internal clock-based asynchronous mode, the output clock derived from the underflow signal of the 8-bit programmable timer 2 by dividing it by 2 is supplied to the serial interface as its operating clock. This enables the transfer rate of the serial interface to be programmed.

To use this function, write "0" to the serial interface control bit SSCK0 (D2) / Serial I/F Ch.0 control register (0x401E3) to select the internal clock.

#### 8-bit programmable timer 3

Clock supply to the Ch.1 serial interface

When using the Ch.1 serial interface in the clock-synchronized master mode or the internal clock-based asynchronous mode, the output clock derived from the underflow signal of the 8-bit programmable timer 3 by dividing it by 2 is supplied to the serial interface as its operating clock. This enables the transfer rate of the serial interface to be programmed.

To use this function, write "0" to the serial interface control bit SSCK1 (D2) / Serial I/F Ch.1 control register (0x401E8) to select the internal clock.

# Control and Operation of 8-Bit Programmable Timer

With the 8-bit programmable timer, the following settings must first be made before it starts counting:

- 1. Setting the output pin (only when necessary)
- 2. Setting the input clock
- 3. Setting the preset data (initial counter value)
- 4. Setting the interrupt

Setting of an output pin is necessary only when the output clock of the 8-bit programmable timer is supplied to external devices. For details on how to set the pin, refer to "Output Pins of 8-Bit Programmable Timers". For details on how to set interrupts, refer to "8-Bit Programmable Timer Interrupts".

**Note:** The 8-bit programmable timers 0 through 3 all operate in the same way during counting, and the structure of their control registers is also the same. The control bit names are assigned the numerals "0" through "3" to denote the timer numbers. Since all these timers have common functions, timer numbers here are represented it is by "x" unless necessary to specify a timer number.

#### Setting the input clock

The 8-bit programmable timer is operated by the prescaler's output clock. The prescaler's division ratio can be selected for each timer.

Division ratio select bit	Clock control bit	Register
8-bit timer 0: P8TS0[2:0] (D2:0])	P8TON0 (D3)	8-bit timer 0/1 clock control register (0x4014D)
8-bit timer 1: P8TS1[2:0] (D6:4])	P8TON1 (D7)	8-bit timer 0/1 clock control register (0x4014D)
8-bit timer 2: P8TS2[2:0] (D2:0])	P8TON2 (D3)	8-bit timer 2/3 clock control register (0x4014E)
8-bit timer 3: P8TS3[2:0] (D6:4])	P8TON3 (D7)	8-bit timer 2/3 clock control register (0x4014E)

Note that the division ratios differ for each timer (see Table 3.2).

Furthermore, the prescaler input clock can be directly supplied to the 8-bit timer by writing "1" to the P8TCPKx bit in the 8-bit timer clock select register (0x40146).

Timer 0 clock selection: P8TCPK0 (D0) / 8-bit timer clock select register (0x40146)

Timer 1 clock selection: P8TCPK1 (D1) / 8-bit timer clock select register (0x40146)

Timer 2 clock selection: P8TCPK2 (D2) / 8-bit timer clock select register (0x40146)

Timer 3 clock selection: P8TCPK3 (D3) / 8-bit timer clock select register (0x40146)

When using the divided clock selected by P8TSx, set P8TCPKx to "0".

Timer	P8TSx = 7	P8TSx = 6	P8TSx = 5	P8TSx = 4	P8TSx = 3	P8TSx = 2	P8TSx = 1	P8TSx = 0	P8TCPK = 1
Timer 0	fpscin/256	fpscin/128	fpscin/64	fpscin/32	fpscin/16	fpscin/8	fpscin/4	fpscin/2	fpscin/1
Timer 1	fpscin/4096	fpscin/2048	fpscin/1024	fpscin/512	fpscin/256	fpscin/128	fpscin/64	fpscin/32	fpscin/1
Timer 2	fpscin/4096	fpscin/2048	fpscin/64	fpscin/32	fpscin/16	fpscin/8	fpscin/4	fpscin/2	fpscin/1
Timer 3	fpscin/256	fpscin/128	fpscin/64	fpscin/32	fpscin/16	fpscin/8	fpscin/4	fpscin/2	fpscin/1

Table 3.2 Input Clock Selection

fPSCIN: Prescaler input clock frequency

The selected clock is output from the prescaler to the 8-bit programmable timer by writing "1" to P8TONx.

# Notes: • The 8-bit programmable timer operates only when the prescaler is operating. (Refer to "Prescaler".)

- Do not use a clock that is faster than the CPU operating clock as the 8-bit programmable timer.
- When setting an input clock, make sure the 8-bit programmable timer is turned off.

#### Setting preset data (initial counter value)

Each timer has an 8-bit down-counter and a reload data register. The reload data register RLDx is used to set the initial value of the down-counter of each timer.

Timer 0 reload data: RLD0[7:0] (D[7:0]) / 8-bit timer 0 reload data register (0x40161)

Timer 1 reload data: RLD1[7:0] (D[7:0]) / 8-bit timer 1 reload data register (0x40165)

Timer 2 reload data: RLD2[7:0] (D[7:0]) / 8-bit timer 2 reload data register (0x40169)

Timer 3 reload data: RLD3[7:0] (D[7:0]) / 8-bit timer 3 reload data register (0x4016D)

The reload data registers can be read and written. At initial reset, the reload data registers are not initialized.

The data written to this register is preset in the down-counter, and the counter starts counting down from the preset value.

Data is thus preset in the down-counter in the following two cases:

#### 1. When it is preset in the software

Presetting in the software is performed using the preset control bit PSETx. When this bit is set to "1", the content of the reload data register is loaded into the down-counter at that point.

Timer 0 preset: PSET0 (D1) / 8-bit timer 0 control register (0x40160)

Timer 1 preset: PSET1 (D1) / 8-bit timer 1 control register (0x40164)

Timer 2 preset: PSET2 (D1) / 8-bit timer 2 control register (0x40168)

Timer 3 preset: PSET3 (D1) / 8-bit timer 3 control register (0x4016C)

#### 2. When the down-counter underflown during counting

Since the reload data is preset in the down-counter upon underflow, its underflow cycle is determined by the value that is set in the reload data register. This underflow signal controls each function described in the preceding section.

Before starting the 8-bit programmable timer, set the initial value in the reload data register and use the PSETx bit to preset the data in the down-counter.

The underflow cycle is determined by the prescaler setting and the reload data. The relationship between these two parameters is expressed by the following equation:

Under flow cycle =  $\frac{RLDx + 1}{fPSCIN \times pdr}$  [sec.]

fPSCIN: Prescaler input clock frequency [Hz]

pdr: Prescaler division ratio set by P8TSx

RLDx: Set value of the RLDx register (0 to 255)

#### **Timer RUN/STOP control**

Each timer has a PTRUNx bit to control RUN/STOP.

Timer 0 RUN/STOP control: PTRUN0 (D0) / 8-bit timer 0 control register (0x40160)

Timer 1 RUN/STOP control: PTRUN1 (D0) / 8-bit timer 1 control register (0x40164)

Timer 2 RUN/STOP control: PTRUN2 (D0) / 8-bit timer 2 control register (0x40168)

Timer 3 RUN/STOP control: PTRUN3 (D0) / 8-bit timer 3 control register (0x4016C)

The timer is initiated to start counting down by writing "1" to PTRUNx. Writing "0" to PTRUNx disables the clock input and causes the timer to stop counting.

This RUN/STOP control does not affect the counter data. Even when the timer has stopped counting, the counter retains its count so that it can start counting again from that point.

When the terminal count is reached and the counter underflows, the initial value is reloaded from the reload data register into the counter.

When both the timer RUN/STOP control bit (PTRUNx) and the timer preset bit (PSETx) are set to "1" at the same time, the timer starts counting after presetting the reload register value into the counter.

#### **III PERIPHERAL BLOCK: 8-BIT PROGRAMMABLE TIMERS**



Figure 3.2 Basic Operation Timing of Counter

#### Reading out counter data

The counter data is read out via a PTDx data buffer. The counter data can be read out at any time.

Timer 0 data: PTD0[7:0] (D[7:0]) / 8-bit timer 0 counter data register (0x40162)

Timer 1 data: PTD1[7:0] (D[7:0]) / 8-bit timer 1 counter data register (0x40166) Timer 2 data: PTD2[7:0] (D[7:0]) / 8-bit timer 2 counter data register (0x4016A)

Timer 3 data: PTD3[7:0] (D[7:0]) / 8-bit timer 3 counter data register (0x4016E)

# **Control of Clock Output**

When outputting an underflow signal of the 8-bit programmable timer to external devices, or when supplying a clock generated by the underflow signal to the serial interface, it is necessary to control the clock output of the timer.

Timer 0 clock output control: PTOUT0 (D2) / 8-bit timer 0 control register (0x40160)

Timer 1 clock output control: PTOUT1 (D2) / 8-bit timer 1 control register (0x40164)

Timer 2 clock output control: PTOUT2 (D2) / 8-bit timer 2 control register (0x40168) Timer 3 clock output control: PTOUT3 (D2) / 8-bit timer 3 control register (0x4016C)

To output the underflow signal/clock, write "1" to PTOUTx. If an output pin has been set, the underflow signal is

output from that pin. The same applies when timer 2 or 3 has been set as the clock source of the serial interface. A clock generated from the underflow signal by dividing it by 2 is output to the serial interface through this control. The clock output is turned off by writing "0" to PTOUTx, and the external output is fixed at "0" and the internal clock output is fixed at "1".

Figure 3.3 shows the waveforms of the output signals.



The underflow signal's pulse width (duration of the high period) is equal to that of the timer's input clock (prescaler's output).

#### 8-bit timer external output (P10–P13 ports)

- 1) After an initial reset (cold start), the ports (P10-P13) are set to debug signal putput ports.
- 2) The port (P10–P13) outputs "0" when it is set to the 8-bit timer output (timer output is off status).
- 3) The timer output is left as "0" when the timer output is turned on after setting the input clock and timer initial value.
- 4) When an underflow occurs after starting the timer, the port outputs a pulse with the same width as the 8-bit timer input clock pulse (prescaler's output).

### 8-Bit Programmable Timer Interrupts

The 8-bit programmable timer has a function to generate an interrupt based on the underflow state of each timer. The timing at which an interrupt is generated is shown in Figure 3.2 in the preceding section.

#### Control registers of the interrupt controller

Table 3.3 shows the interrupt controller's control register provided for each timer.

Timer		Interrupt factor flag	Interrupt enable register	Interrupt priority register
Timer	0	F8TU0(D0/0x40285)	E8TU0(D0/0x40275)	P8TM[2:0](D[2:0]/0x40269)
Timer	1	F8TU1(D1/0x40285)	E8TU1(D1/0x40275)	
Timer	2	F8TU2(D2/0x40285)	E8TU2(D2/0x40275)	
Timer	3	F8TU3(D3/0x40285)	E8TU3(D3/0x40275)	

Table 3.3	Control Registers	of Interrupt	Controlle

When the timer underflows, the corresponding interrupt factor flag is set to "1". If the interrupt enable register bit corresponding to that interrupt factor flag has been set to "1", an interrupt request is generated. An interrupt caused by a timer can be disabled by leaving the interrupt enable register bit for that timer set to "0". The interrupt factor flag is set to "1" whenever the timer underflows, regardless of how the interrupt enable register is set (even when it is set to "0").

The interrupt priority register sets an interrupt priority level (0 to 7) for the four timers as one interrupt source. Within 8-bit programmable timers, timer 0 has the highest priority and timer 3 the lowest. An interrupt request to the CPU is accepted on the condition that no other interrupt request of a higher priority has been generated. It is only when the PSR's IE bit = "1" (interrupts enabled) and the set value of the IL is smaller than the timer interrupt level set by the interrupt priority register, that a timer interrupt request is actually accepted by the CPU.

For details on these interrupt control registers and device operation when an interrupt has occurred, refer to "ITC (Interrupt Controller)".

#### **Trap vectors**

The trap vector addresses for individual underflow interrupt factors are set by default as shown below:

Timer 0 underflow interrupt:	0x0C000D0
Timer 1 underflow interrupt:	0x0C000D4
Timer 2 underflow interrupt:	0x0C000D8
Timer 3 underflow interrupt:	0x0C000DC

The base address of the trap table can be changed using the TTBR register (0x48134 to 0x48137).

# I/O Memory of 8-Bit Programmable Timers

Table 3.4 shows the control bits of the 8-bit programmable timers.

For details on the I/O memory of the prescaler used to set a clock, refer to "Prescaler".

Pogistor name	Addross	Di+	Namo	Function	Sotting				Init	D/M	Pomarke
Register name	Auuress	DIL	Name	Function	Setting			init.	1.7.44	Reillai KS	
8-bit timer 0	0040160	D7-3	-	reserved		-		o."	-	-	0 when being read.
control register	(B)	D2	PTOUTO	8-bit timer 0 clock output control	1	On	0	Off	0	R/W	
		D1	PSET0	8-bit timer 0 preset	1	Preset	0	Invalid	-	W	0 when being read.
		D0	PTRUN0	8-bit timer 0 Run/Stop control	1	Run	0	Stop	0	R/W	
8-bit timer 0	0040161	D7	RLD07	8-bit timer 0 reload data	0 to 255			5	Х	R/W	
reload data	(B)	D6	RLD06	RLD07 = MSB					X		
register		D5	RLD05	RLD00 = LSB					X		
		D4	RLD04						X		
		D3	RLD03						X		
		D2	RLD02						Х		
		D1	RLD01						Х		
		D0	RLD00						X		
8-bit timer 0	0040162	D7	PTD07	8-bit timer 0 counter data	0 to 255				X	R	
counter data	(B)	D6	PTD06	PTD07 = MSB				-	X		
register	(-)	D5	PTD05	PTD00 = ISB					x		
. og.oto.		D4	PTD04						x		
		D3	PTD03					x			
		D2	PTD02						x		
		D1	PTD01						×		
			PTD00						x		
	0040404	D7 0	11000								O when he is a seed
8-bit timer 1	0040164	D7-3	-			-		0"	-	-	0 when being read.
control register	(В)	D2	PICUIT	8-bit timer 1 clock output control	1	On	0	Uff	0	R/VV	O uch an h air a sea d
			PSEIT	8-bit timer 1 preset	1	Preset	0	Invalid	-	VV DAA/	0 when being read.
		DU	PIRUNI	8-bit timer 1 Run/Stop control	1	Run	0	Stop	0	R/W	
8-bit timer 1	0040165	D7	RLD17	8-bit timer 1 reload data		0 to	25	5	X	R/W	
reload data	(B)	D6	RLD16	RLD17 = MSB					X		
register		D5	RLD15	RLD10 = LSB					X		
		D4	RLD14						X		
		D3	RLD13						X		
		D2	RLD12						X		
		D1	RLD11						X		
		D0	RLD10						Х		
8-bit timer 1	0040166	D7	PTD17	8-bit timer 1 counter data		0 to	25	5	Х	R	
counter data	(B)	D6	PTD16	PTD17 = MSB					X		
register		D5	PTD15	PTD10 = LSB					X		
		D4	PTD14						Х		
		D3	PTD13						Х		
		D2	PTD12						Х		
		D1	PTD11						Х		
		D0	PTD10					Х			
8-bit timer 2	0040168	D7–3	-	reserved		_			_	_	0 when being read.
control register	(B)	D2	PTOUT2	8-bit timer 2 clock output control	1	On	0	Off	0	R/W	
	(-)		PSET2	8-bit timer 2 preset	1	Preset	0	Invalid	† <u>-</u>	W	0 when being read.
		D0	PTRUN2	8-bit timer 2 Run/Stop control	1	Run	0	Stop	0	R/W	<b>J</b>
8-bit timer 2	0040169	D7	RI D27	8-bit timer 2 reload data	F	0 to	25	5	X	R/M	
roload data	(B)					0.0	20,	J	Ŷ	12/11	
register	(6)	D5	RLD20						Ŷ		
register			RED23						L Û		
		D4							Û		
		03	RLD23						Û		
									Û		
			RI D20						l 🗘		
			REDZU		-		0				 
8-bit timer 2	004016A	D7	PTD27	8-bit timer 2 counter data		0 to	25	5	X	R	
counter data	(B)	D6	PTD26	PID27 = MSB					X		
register		D5	PTD25	PID20 = LSB					X		
		D4	PTD24						X		
		D3	PTD23						X		
		D2	PTD22						X		
		D1	PTD21						X		
		D0	PTD20						X		

Table 3.4 Control Bits of 8-Bit Programmable Timer

#### **III PERIPHERAL BLOCK: 8-BIT PROGRAMMABLE TIMERS**

Register name	Address	Bit	Name	Function	Setting			Init.	R/W	Remarks	
8-bit timer 3	004016C	D7–3	-	reserved			-		-	-	0 when being read.
control register	(B)	D2	PTOUT3	8-bit timer 3 clock output control	1	On	0	Off	0	R/W	
		D1	PSET3	8-bit timer 3 preset	1	Preset	0	Invalid	-	W	0 when being read.
		D0	PTRUN3	8-bit timer 3 Run/Stop control	1	Run	0	Stop	0	R/W	
8-bit timer 3	004016D	D7	RLD37	8-bit timer 3 reload data		0 to	25	5	Х	R/W	
reload data	(B)	D6	RLD36	RLD37 = MSB				х			
register		D5	RLD35	RLD30 = LSB					Х		
		D4	RLD34						Х		
		D3	RLD33						Х		
		D2	RLD32						Х		
		D1	RLD31						Х		
		D0	RLD30						Х		
8-bit timer 3	004016E	D7	PTD37	8-bit timer 3 counter data		0 to	25	5	Х	R	
counter data	(B)	D6	PTD36	PTD37 = MSB					Х		
register		D5	PTD35	PTD30 = LSB							
		D4	PTD34						Х		
		D3	PTD33						Х		
		D2	PTD32						Х		
		D1	PTD31						Х		
		D0	PTD30						Х		
8-bit timer,	0040269	D7	-	reserved		-			-	-	0 when being read.
serial I/F Ch.0	(B)	D6	PSIO02	Serial interface Ch.0		0 t	o 7		Х	R/W	
interrupt		D5	PSIO01	interrupt level					Х		
priority register		D4	PSIO00						Х		
		D3	-	reserved			-		-	-	0 when being read.
		D2	P8TM2	8-bit timer 0–3 interrupt level		0 t	07		X	R/W	
		D1	P8TM1						X		
		D0	P8TM0						Х		
8-bit timer	0040275	D7–4	-	reserved			-		-	-	0 when being read.
interrupt	(B)	D3	E8TU3	8-bit timer 3 underflow	1	Enabled	0	Disabled	0	R/W	
enable register		D2	E8TU2	8-bit timer 2 underflow					0	R/W	
		D1	E8TU1	8-bit timer 1 underflow					0	R/W	
		DO	E8TU0	8-bit timer 0 underflow					0	R/W	
8-bit timer	0040285	D7–4	-	reserved			-		-	-	0 when being read.
interrupt factor	(B)	D3	F8TU3	8-bit timer 3 underflow	1	Factor is	0	No factor is	X	R/W	
flag register		D2	F8TU2	8-bit timer 2 underflow		generated		generated	X	R/W	
		D1	F8TU1	8-bit timer 1 underflow					X	R/W	
		DU	F8100	8-bit timer 0 underflow					X	R/W	
P1 function	00402D4	D7	-	reserved			-		-	-	0 when being read.
select register	(B)	D6	CFP16	P16 function selection	1	EXCL5	0	P16	0	R/W	
		D5	CFP15	P15 function selection	1	EXCL4	0	P15	0	R/W	<b>F</b> ( ) ( ) ( )
		D4	CFP14	P14 function selection	1	FUSCI	0	P14	0	R/W	
		03	GFP13	P 13 Iunction selection	1		0	1913	0	R/VV	(0X402DF)
		D2	CED12	P12 function solection	1	EXCL2	0	D12	0		
		02	01112		l '	T8UE2	ľ	1 12		10,00	
		D1	CFP11	P11 function selection	1	EXCL1	0	P11	0	R/W	
						T8UF1	-		-		
		D0	CFP10	P10 function selection	1	EXCL0	0	P10	0	R/W	
						T8UF0					
P1 I/O control	00402D6	D7	-	reserved		•	_		_	_	0 when being read.
register	(B)	D6	IOC16	P16 I/O control	1	Output	0	Input	0	R/W	<b>J</b>
	.,	D5	IOC15	P15 I/O control	1			·	0	R/W	
		D4	IOC14	P14 I/O control	1				0	R/W	
		D3	IOC13	P13 I/O control	1				0	R/W	
		D2	IOC12	P12 I/O control					0	R/W	
		D1	IOC11	P11 I/O control	1				0	R/W	
		D0	IOC10	P10 I/O control					0	R/W	
Port function	00402DF	D7-4	-	reserved			_		0	R/W	Writing 1 not allowed.
extension	(B)	D3	CFEX3	P31 port extended function	1	#GARD	0	P31, etc.	0	R/W	
register		D2	CFEX2	P21 port extended function	1	#GAAS	0	P21, etc.	0	R/W	
		D1	CFEX1	P10, P11, P13 port extended	1	DST0	0	P10, etc.	1	R/W	
				function		DST1		P11, etc.			
						DPC0		P13, etc.		_	
		D0	CFEX0	P12, P14 port extended function	1	DST2	0	P12, etc.	1	R/W	
						IDCLK		P14, etc.			

#### CFP13-CFP10: P1[3:0] pin function selection (D[3:0]) / P1 function select register (0x402D4)

Selects the pin that is used to output a timer underflow signal to external devices.

Write "1": Underflow signal output pin Write "0": I/O port pin Read: Valid

Select the pin used to output a timer underflow signal to external devices from among P10 through P13 by writing "1" to the corresponding bit, CFP10 through CFP13. P10 through P13 correspond to timers 0 through 3, respectively. If "0" is written to CFP1x, the pin is set for an I/O port. At cold start, CFP1x is set to "0" (I/O port). At hot start, the bit retains its state from prior to the initial reset.

#### IOC13-IOC10: P1[3:0] port I/O control (D[3:0]) / P1 I/O control register (0x402D6)

Sets input or output mode for P10 through P13.

Write "1": Output mode Write "0": Input mode Read: Valid

If a pin chosen from among P10 through P13 is used to output an underflow signal, write "1" to the corresponding I/O control bit to set it to output mode. If the pin is set to input mode, even if its CFP1x is set to "1", it functions as the event counter input pin of a 16-bit programmable timer cannot be used to output a timer underflow signal. At cold start, IOC1x is set to "0" (input mode). At hot start, the bit retains its state from prior to the initial reset.

**CFEX1**: P10, P11, P13 port extended function (D1) / Port function extension register (0x402DF) **CFEX0**: P12, P14 port extended function (D0) / Port function extension register (0x402DF)

Sets whether the function of an I/O-port pin is to be extended.

Write "1": Function-extended pinWrite "0": I/O-port/peripheral-circuit pinRead: Valid

When CFEX[1:0] is set to "1", the P13–P10 ports function as debug signal output ports. When CFEX[1:0] = "0", the CFP1[3:0] bit becomes effective, so the settings of these bits determine whether the P13–P10 ports function as I/O port s or timer underflow signal output ports.

At cold start, CFEX[1:0] is set to "1" (function-extended pins). At hot start, CFEX[1:0] retains its state from prior to the initial reset.

**RLD07–RLD00**: Timer 0 reload data (D[7:0]) / 8-bit timer 0 reload data register (0x40161) **RLD17–RLD10**: Timer 1 reload data (D[7:0]) / 8-bit timer 1 reload data register (0x40165) **RLD27–RLD20**: Timer 2 reload data (D[7:0]) / 8-bit timer 2 reload data register (0x40169) **RLD37–RLD30**: Timer 3 reload data (D[7:0]) / 8-bit timer 3 reload data register (0x4016D)

Set the initial counter value of each timer.

The reload data set in this register is loaded into each counter, and the counter starts counting down beginning with this data, which is used as the initial count.

There are two cases in which the reload data is loaded into the counter: when data is preset after "1" is written to PSETx, or when data is automatically reloaded upon counter underflow.

At initial reset, RLD is not initialized.

PTD07–PTD00: Timer 0 counter data (D[7:0]) / 8-bit timer 0 counter data (0x4)	0162)
PTD17-PTD10: Timer 1 counter data (D[7:0]) / 8-bit timer 1 counter data (0x4	0166)
PTD27-PTD20: Timer 2 counter data (D[7:0]) / 8-bit timer 2 counter data (0x4	016A)
PTD37-PTD30: Timer 3 counter data (D[7:0]) / 8-bit timer 3 counter data (0x4	016E)

The 8-bit programmable timer data can be read out from these bits.

These bits function as buffers that retain the counter data when read out, enabling the data to be read out at any time. At initial reset, PTD is not initialized.

```
PSET0: Timer 0 preset (D1) / 8-bit timer 0 control register (0x40160)
PSET1: Timer 1 preset (D1) / 8-bit timer 1 control register (0x40164)
PSET2: Timer 2 preset (D1) / 8-bit timer 2 control register (0x40168)
PSET3: Timer 3 preset (D1) / 8-bit timer 3 control register (0x4016C)
```

Preset the reload data in the counter.

Write "1": Preset Write "0": Invalid Read: Always "0"

The reload data of RLDx is preset in the counter of timer x by writing "1" to PSETx. If the counter is preset when in a RUN state, the counter starts counting immediately after the reload data is preset.

If the counter is preset when in a STOP state, the reload data that has been preset is retained.

Writing "0" results in No Operation.

Since PSETx is a write-only bit, its content when read is always "0".

**PTRUN0**: Timer 0 RUN/STOP control (D0) / 8-bit timer 0 control register (0x40160) **PTRUN1**: Timer 1 RUN/STOP control (D0) / 8-bit timer 1 control register (0x40164) **PTRUN2**: Timer 2 RUN/STOP control (D0) / 8-bit timer 2 control register (0x40168) **PTRUN3**: Timer 3 RUN/STOP control (D0) / 8-bit timer 3 control register (0x4016C)

Controls the counter's RUN/STOP states.

Write "1": RUN Write "0": STOP Read: Valid

The counter of each timer starts counting down when "1" written to PTRUNx, and stops counting when "0" is written.

While in a STOP state, the counter retains its count until it is preset with reload data or placed in a RUN state. When the state is changed from STOP to RUN, the counter can restart counting beginning with the retained count. At initial reset, PTRUNx is set to "0" (STOP).

**PTOUT0**: Timer 0 clock output control register (D2) / 8-bit timer 0 control register (0x40160) **PTOUT1**: Timer 1 clock output control register (D2) / 8-bit timer 1 control register (0x40164) **PTOUT2**: Timer 2 clock output control register (D2) / 8-bit timer 2 control register (0x40168) **PTOUT3**: Timer 3 clock output control register (D2) / 8-bit timer 3 control register (0x4016C)

Controls the clock output of each timer.

Write "1": On Write "0": Off Read: Valid

The underflow signal of timer x is output from the external output pin set by CFP1x by writing "1" to PTOUTx. When using timer 2 or 3 as the clock source of the serial interface, a clock generated from the underflow signal by dividing it by 2 is output to the corresponding channel of the serial interface.

The clock output is turned off by writing "0" to PTOUT, and the external output is fixed at "0" and the internal clock output is fixed at "1".

At initial reset, PTOUT is set to "0" (off).

P8TM2-P8TM0: 8-bit timer interrupt level (D[2:0]) / 8-bit timer, serial I/F Ch.0 interrupt priority register (0x40269)

Set the priority level of the 8-bit programmable timer interrupt in the range of 0 to 7.

At initial reset, the content of the P8TM register becomes indeterminate.

**E8TU0**: Timer 0 interrupt enable (D0) / 8-bit timer interrupt enable register (0x40275) **E8TU1**: Timer 1 interrupt enable (D1) / 8-bit timer interrupt enable register (0x40275) **E8TU2**: Timer 2 interrupt enable (D2) / 8-bit timer interrupt enable register (0x40275) **E8TU3**: Timer 3 interrupt enable (D3) / 8-bit timer interrupt enable register (0x40275)

Enables or disables generation of an interrupt to the CPU.

Write "1": Interrupt enabled Write "0": Interrupt disabled Read: Valid

E8TUx is the interrupt enable bit which controls the interrupt generated by each timer. The interrupt set to "1" by this bit is enabled, and the interrupt set to "0" by this bit is disabled. At initial reset, E8TUx is set to "0" (interrupt disabled).

**F8TU0**: Timer 0 interrupt factor flag (D0) / 8-bit timer interrupt factor flag register (0x40285) **F8TU1**: Timer 1 interrupt factor flag (D1) / 8-bit timer interrupt factor flag register (0x40285) **F8TU2**: Timer 2 interrupt factor flag (D2) / 8-bit timer interrupt factor flag register (0x40285) **F8TU3**: Timer 3 interrupt factor flag (D3) / 8-bit timer interrupt factor flag register (0x40285)

Indicates the interrupt generation status of the 8-bit programmable timer.

#### When read

Read "1": Interrupt factor has occurred Read "0": No interrupt factor has occurred

When written using the reset-only method (default)

Write "1": Interrupt factor flag is reset

Write "0": Invalid

#### When written using the read/write method

Write "1": Interrupt flag is set Write "0": Interrupt flag is reset

F8TUx is the interrupt factor flag corresponding to each timer. It is set to "1" when the counter underflows. At this time, if the following conditions are met, an interrupt to the CPU is generated:

1. The corresponding interrupt enable register bit is set to "1".

2. No other interrupt request of a higher priority has been generated.

3. The IE bit of the PSR is set to "1" (interrupts enabled).

4. The value set in the corresponding interrupt priority register is higher than the interrupt level (IL) of the CPU.

The interrupt factor flag is set to "1" whenever interrupt generation conditions are met, regardless of how the interrupt enable and interrupt priority registers are set.

If the next interrupt is to be accepted after an interrupt has occurred, it is necessary that the interrupt factor flag be reset, and that the PSR be set again (by setting the IE bit to "1" after setting the IL to a value lower than the level indicated by the interrupt priority register, or by executing the reti instruction).

The interrupt factor flag can be reset only by writing to it in the software. Note that if the PSR is set again to accept interrupts generated (or if the reti instruction is executed) without resetting the interrupt factor flag, the same interrupt occurs again. Note also that the value to be written to reset the flag is "1" when the reset-only method (RSTONLY = "1") is used, and "0" when the read/write method (RSTONLY = "0") is used.

At initial reset, the content of F8TUx becomes indeterminate, so be sure to reset it in the software.

# **Programming Notes**

- (1) The 8-bit programmable timer operates only when the prescaler is operating.
- (2) Do not use a clock that is faster than the CPU operating clock for the 8-bit programmable timer.
- (3) When setting an input clock, make sure the 8-bit programmable timer is turned off.
- (4) Since the underflow interrupt condition and the timer output status are undefined after an initial reset, the counter initial value should be set to the 8-bit timer before resetting the interrupt factor flag or turning the timer output on.
- (5) After an initial reset, the interrupt factor flag (F8TUx) becomes indeterminate. To prevent generation of an unwanted interrupt, be sure to reset this flag in the software.
- (6) To prevent another interrupt from being generated again by the same factor after an interrupt has occurred, be sure to reset the interrupt factor flag (F8TUx) before setting the PSR again or executing the reti instruction.

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# **III-4 16-BIT PROGRAMMABLE TIMERS**

## Configuration of 16-Bit Programmable Timer

The Peripheral Block contains six systems of 16-bit programmable timers (timers 0 to 5). They also have an event counter function using an I/O port pin.

**Note:** On the following pages, each timer is identified as timer x (x = 0 to 5). The functions and control register structures of 16-bit programmable timers 0 to 5 are the same. Control bit names are assigned numerals "0" to "5" denoting timer numbers. Since explanations are common to all timers, timer numbers are represented by "x" unless it is necessary to specify a timer number.



Figure 4.1 shows the structure of one channel of the 16-bit programmable timer.

Figure 4.1 Structure of 16-Bit Programmable Timer

In each timer, a 16-bit up-counter (TCx), as well as two 16-bit comparison data registers (CRxA, CRxB) and their buffers (CRBxA, CRBxB), are provided.

The 16-bit counter can be reset to "0" by software and counts up using the prescaler output clock or an external signal input from the I/O port. The counter value can be read by software.

The comparison data registers A and B are used to store the data to be compared with the content of the up-counter. This register can be directly read and written. Furthermore, comparison data can be set via the comparison register buffer. In this case, the set value is loaded to the comparison data register when the counter is reset by the comparison match B signal or software (by writing "1" to PRESETx bit). The software can select whether comparison data is written to the comparison data register or the buffer.

When the counter value matches to the content of each comparison data register, the comparator outputs a signal that controls the interrupt and the output signal. Thus the registers allow interrupt generating intervals and the timer's output clock frequency and duty ratio to be programmed.

## I/O Pins of 16-Bit Programmable Timers

Table 4.1 shows the input/output pins used for the 16-bit programmable timers.

Pin name	I/O	Function	Function select bit
P10/EXCL0/	I/O	I/O port / 16-bit timer 0 event counter input (I) /	CFP10(D0)/P1 function select register(0x402D4)
T8UF0/DST0		8-bit timer 0 output (O) / DST0 output (Ex)	CFEX1(D1)/Port function extension register(0x402DF)
P11/EXCL1/	I/O	I/O port / 16-bit timer 1 event counter input (I) /	CFP11(D1)/P1 function select register(0x402D4)
T8UF1/DST1		8-bit timer 1 output (O) / DST1 output (Ex)	CFEX1(D1)/Port function extension register(0x402DF)
P12/EXCL2/	I/O	I/O port / 16-bit timer 2 event counter input (I) /	CFP12(D2)/P1 function select register(0x402D4)
T8UF2/DST2		8-bit timer 2 output (O) / DST2 output (Ex)	CFEX0(D0)/Port function extension register(0x402DF)
P13/EXCL3/	I/O	I/O port / 16-bit timer 3 event counter input (I) /	CFP13(D3)/P1 function select register(0x402D4)
T8UF3/DPCO		8-bit timer 3 output (O) / DPCO output (Ex)	CFEX1(D1)/Port function extension register(0x402DF)
P15/EXCL4	I/O	I/O port / 16-bit timer 4 event counter input (I)	CFP15(D5)/P1 function select register(0x402D4)
P16/EXCL5	I/O	I/O port / 16-bit timer 5 event counter input (I)	CFP16(D6)/P1 function select register(0x402D4)
P22/TM0	I/O	I/O port / 16-bit timer 0 output	CFP22(D2)/P2 function select register(0x402D8)
P23/TM1	I/O	I/O port / 16-bit timer 1 output	CFP23(D3)/P2 function select register(0x402D8)
P24/TM2	I/O	I/O port / 16-bit timer 2 output	CFP24(D4)/P2 function select register(0x402D8)
P25/TM3	I/O	I/O port / 16-bit timer 3 output	CFP25(D5)/P2 function select register(0x402D8)
P26/TM4	I/O	I/O port / 16-bit timer 4 output	CFP26(D6)/P2 function select register(0x402D8)
P27/TM5	I/O	I/O port / 16-bit timer 5 output	CFP27(D7)/P2 function select register(0x402D8)

Table 4.1 I/O Pins of 16-Bit Programmable Timer

(I): Input mode, (O): Output mode, (Ex): Extended function

## TMx (output pin of the 16-bit programmable timer)

This pin outputs a clock generated by the timer x.

## EXCLx (event counter input pin)

When using the timer x as an event counter, input count pulses from an external source to this pin.

## How to set the input/output pins of 16-bit programmable timers

All clock output pins used by the 16-bit programmable timers are shared with I/O ports. At cold start, all these pins are set for the I/O port pins P2x (function select bit CFP2x = "0"), and go into high-impedance. When using the clock output function of the 16-bit programmable timer, select the desired timer and write "1" to the function select bit CFP2x for the corresponding pin. At hot start, these pins retain their status before from prior to the reset.

All event-counter input pins are also shared with I/O-ports. At cold start, the EXCL[3:0] pins are set for debug signal output pins (function extension bit CFEX[1:0] = "1") and the EXCL[5:4] pins are set for I/O-port pins P1[5:4] (function select bit CFP1[5:4] = "0"). When using the event counter function, select the desired timer and write "1" to the function select bit CFP1x and write "0" to the function select bit CFEXx for the corresponding pin.

Note that these pins are also shared with output pins for the 8-bit programmer timers, etc. When the input/output pins are set in input mode, they function as event counter inputs. Therefore, it is necessary to set the I/O port's I/O control bit IOC1x to "0" in advance. At cold start, these pins are set in input mode. At hot start, they retain their status from prior to the reset.

## Uses of 16-Bit Programmable Timers

The up-counters of the 16-bit programmable timer cyclically output a comparison-match signal in accordance with the comparison data that are set in the software. This signal is used to generate an interrupt request to the CPU or control the internal peripheral circuits. A clock generated from the signal can also be output to external devices.

## **CPU** interrupt request

Each timer's comparison match (matching of counter and comparison data) can be used as an interrupt factor to generate an interrupt request to the CPU. Therefore, an interrupt can be generated at an interval that is set in the software.

## **Clock output to external devices**

A clock generated from the comparison-match signal can be output from the chip to the outside. The clock cycle is determined by comparison data B, and the duty ratio is determined by comparison data A. This output can be used to control external devices. The output pins of each timer are described in the preceding section.

### Watchdog timer

The 16-bit programmable timer 0 can be used as a watchdog timer to monitor CPU crash. In this case, the comparison-match B of this timer serves as an NMI request signal to the CPU.

To use this function, write "1" to the watchdog timer control bit EWD (D1) / Watchdog timer enable register (0x40171) to enable the NMI. For details on how to control the watchdog timer, refer to "Watchdog Timer".

## Control and Operation of 16-Bit Programmable Timer

The following settings must first be made before the 16-bit programmable timer starts counting:

- 1. Setting pins for input/output (only when necessary)
- 2. Setting input clock
- 3. Selecting comparison data register/buffer
- 4. Setting clock output conditions (signal active level, fine mode)
- 5. Setting comparison data
- 6. Setting interrupt

For details on how to set clock output conditions and interrupts, refer to "Controlling Clock Output" and "16-Bit Programmable Timer Interrupts".

### Setting pin for input/output

The pin must be set for output for the output clock of the 16-bit programmable timer to be fed to external devices.

The pin for input must be set for the 16-bit programmable timer to be used as an event counter that counts external clock pulses.

For details on how to set the pin, refer to "I/O Pins of 16-Bit Programmable Timers".

### Setting the input clock

The count clock for each timer can be selected from between an internal clock and an external clock. Use the following control bits to select the input clock:

Timer 0 input clock selection: CKSL0 (D3) / 16-bit timer 0 control register (0x48186)

Timer 1 input clock selection: CKSL1 (D3) / 16-bit timer 1 control register (0X4818E)

Timer 2 input clock selection: CKSL2 (D3) / 16-bit timer 2 control register (0x48196)

Timer 3 input clock selection: CKSL3 (D3) / 16-bit timer 3 control register (0x4819E)

Timer 4 input clock selection: CKSL4 (D3) / 16-bit timer 4 control register (0x481A6)

Timer 5 input clock selection: CKSL5 (D3) / 16-bit timer 5 control register (0x481AE)

An external clock is selected by writing "1" to CKSLx, and the internal clock is selected by writing "0". At initial reset, CKSLx is set for the internal clock.

An external clock can be used for the timer for which the pin is set for input.

#### Internal clock

When the internal clock is selected as a timer, the timer is operated by the prescaler output clock. The prescaler division ratio can be selected for each timer.

Timer	Control register	Division ratio select bit	Clock control bit
Timer 0	16-bit timer 0 clock control register (0x40147)	P16TS0[2:0] (D2:0])	P16TON0 (D3)
Timer 1	16-bit timer 1 clock control register (0x40148)	P16TS1[2:0] (D2:0])	P16TON1 (D3)
Timer 2	16-bit timer 2 clock control register (0x40149)	P16TS2[2:0] (D2:0])	P16TON2 (D3)
Timer 3	16-bit timer 3 clock control register (0x4014A)	P16TS3[2:0] (D2:0])	P16TON3 (D3)
Timer 4	16-bit timer 4 clock control register (0x4014B)	P16TS4[2:0] (D2:0])	P16TON4 (D3)
Timer 5	16-bit timer 5 clock control register (0x4014C)	P16TS5[2:0] (D2:0])	P16TON5 (D3)

Table 4.2 Setting the Internal Clock

The division ratio can be selected from among eight types as shown in Table 4.3.

	Table 4.3 Input Clock Selection												
P16TS = 7	P16TS = 6	P16TS = 1	P16TS = 0										
fpscin/4096	fpscin/1024	fpscin/256	fpscin/64	fpscin/16	fpscin/4	fpscin/2	fpscin/1						
fPSCIN: Prescaler input clock frequency													

The selected clock is output from the prescaler to the 16-bit programmable timer by writing "1" to P16TONx.

- **Notes:** When the internal clock is used, the 16-bit programmable timer operates only when the prescaler is operating (refer to "Prescaler").
  - When setting an input clock, make sure the 16-bit programmable timer is turned off.

#### External clock

When using the timer as an event counter by supplying clock pulses from an external source, make sure the event cycle is at least the CPU operating clock period.

#### Selecting comparison data register/buffer

The comparison data registers A and B are used to store the data to be compared with the content of the upcounter. This register can be directly read and written. Furthermore, comparison data can be set via the comparison register buffer. In this case, the set value is loaded to the comparison data register when the counter is reset by the comparison match B signal or software (by writing "1" to PRESETx bit). Select whether comparison data is written to the comparison data register or the buffer using the following control bits:

Timer 0 comparison register buffer enable: SELCRB0 (D5) / 16-bit timer 0 control register (0x48186) Timer 1 comparison register buffer enable: SELCRB1 (D5) / 16-bit timer 1 control register (0x4818E) Timer 2 comparison register buffer enable: SELCRB2 (D5) / 16-bit timer 2 control register (0x48196) Timer 3 comparison register buffer enable: SELCRB3 (D5) / 16-bit timer 3 control register (0x4819E) Timer 4 comparison register buffer enable: SELCRB4 (D5) / 16-bit timer 4 control register (0x481A6) Timer 5 comparison register buffer enable: SELCRB5 (D5) / 16-bit timer 5 control register (0x481AE)

When "1" is written to SELCRBx, the comparison register buffer is selected and when "0" is written, the comparison data register is selected.

At initial reset, the comparison data register is selected.

### Setting comparison data

The programmable timer contains two data comparators that allows the count data to be compared with given values. The following registers are used to set these values.

Timer 0 comparison data A: CR0A[15:0] (D[F:0]) / 16-bit timer 0 comparison data A set-up register (0x48180) Timer 0 comparison data B: CR0B[15:0] (D[F:0]) / 16-bit timer 0 comparison data B set-up register (0x48182) Timer 1 comparison data A: CR1A[15:0] (D[F:0]) / 16-bit timer 1 comparison data A set-up register (0x48188) Timer 1 comparison data B: CR1B[15:0] (D[F:0]) / 16-bit timer 1 comparison data B set-up register (0x4818A) Timer 2 comparison data A: CR2A[15:0] (D[F:0]) / 16-bit timer 2 comparison data A set-up register (0x48190) Timer 2 comparison data B: CR2B[15:0] (D[F:0]) / 16-bit timer 2 comparison data B set-up register (0x48192) Timer 3 comparison data A: CR3A[15:0] (D[F:0]) / 16-bit timer 3 comparison data A set-up register (0x48198) Timer 3 comparison data B: CR3B[15:0] (D[F:0]) / 16-bit timer 3 comparison data B set-up register (0x4819A) Timer 4 comparison data A: CR4A[15:0] (D[F:0]) / 16-bit timer 4 comparison data A set-up register (0x481A0) Timer 4 comparison data B: CR4B[15:0] (D[F:0]) / 16-bit timer 4 comparison data B set-up register (0x481A2) Timer 5 comparison data A: CR5A[15:0] (D[F:0]) / 16-bit timer 5 comparison data A set-up register (0x481A8) Timer 5 comparison data B: CR5B[15:0] (D[F:0]) / 16-bit timer 5 comparison data B set-up register (0x481AA)

When SELCRBx is set to "0", these registers allow direct reading/writing from/to the comparison data register. When SELCRBx is set to "1", these registers are used to read/write from/to the comparison register buffer. The content of the buffer is loaded to the comparison data register when the counter is reset. At initial reset, the comparison data registers/buffers are not initialized.

The programmable timer compares the comparison data register and count data and, when the two values are equal, generates a comparison match signal. This comparison match signal controls the clock output (TMx signal) to external devices, in addition to generating an interrupt. The comparison data B is also used to reset the counter.

### **Resetting the counter**

Each timer includes the PRESETx bit to reset the counter.

Timer 0 reset: PRESET0 (D1) / 16-bit timer 0 control register (0x48186) Timer 1 reset: PRESET1 (D1) / 16-bit timer 1 control register (0x4818E) Timer 2 reset: PRESET2 (D1) / 16-bit timer 2 control register (0x48196) Timer 3 reset: PRESET3 (D1) / 16-bit timer 3 control register (0x4819E) Timer 4 reset: PRESET4 (D1) / 16-bit timer 4 control register (0x481A6) Timer 5 reset: PRESET5 (D1) / 16-bit timer 5 control register (0x481AE)

Normally, reset the counter before starting count-up by writing "1" to this control bit. After the counter starts counting, it will be reset by comparison match B.

## **Timer RUN/STOP control**

Each timer includes the PRUNx bit to control RUN/STOP.

Timer 0 RUN/STOP control: PRUN0 (D0) / 16-bit timer 0 control register (0x48186) Timer 1 RUN/STOP control: PRUN1 (D0) / 16-bit timer 1 control register (0x4818E) Timer 2 RUN/STOP control: PRUN2 (D0) / 16-bit timer 2 control register (0x48196) Timer 3 RUN/STOP control: PRUN3 (D0) / 16-bit timer 3 control register (0x4819E) Timer 4 RUN/STOP control: PRUN4 (D0) / 16-bit timer 4 control register (0x481A6) Timer 5 RUN/STOP control: PRUN5 (D0) / 16-bit timer 5 control register (0x481AE)

The timer starts counting when "1" is written to PRUNx. The clock input is disabled and the timer stops counting when "0" is written to PRUNx.

This RUN/STOP control does not affect the counter data. Even when the timer has stopped counting, the counter retains its count so that the timer can start counting again from that point.

If the count of the counter matches the set value of the comparison data register during count-up, the timer generates a comparison match interrupt.

When the counter matches comparison data B, an interrupt is generated and the counter is reset. At the same time, the values set in the compare register buffer are loaded to the compare data register if SELCRBx is set to "1".

The counter continues counting up regardless of which interrupt has occurred. In the case of a comparison B interrupt, the counter starts counting beginning with 0.

When both the timer RUN/STOP control bit (PRUNx) and the timer reset bit (PRESETx) are set to "1" at the same time, the timer starts counting after resetting the counter.



#### **Reading counter data**

The counter data can be read out from the following addresses shown below at any time: Timer 0 counter data: TC0[15:0] (D[F:0]) / 16-bit timer 0 counter data register (0x48184) Timer 1 counter data: TC1[15:0] (D[F:0]) / 16-bit timer 1 counter data register (0x4818C) Timer 2 counter data: TC2[15:0] (D[F:0]) / 16-bit timer 0 counter data register (0x48194) Timer 3 counter data: TC3[15:0] (D[F:0]) / 16-bit timer 1 counter data register (0x4819C) Timer 4 counter data: TC4[15:0] (D[F:0]) / 16-bit timer 0 counter data register (0x481A4) Timer 5 counter data: TC5[15:0] (D[F:0]) / 16-bit timer 1 counter data register (0x481A4)

## **Controlling Clock Output**

The timers can generate a TMx signal using the comparison match signals from the counter.

### Setting the signal active level

By default, an active high signal (normal low) is generated. This logic can be inverted using the OUTINVx bit. When "1" is written to the OUTINVx bit, the timer generates an active low (normal high) signal.

Timer 0 clock output inversion: OUTINV0 (D4) / 16-bit timer 0 control register (0x48186)

Timer 1 clock output inversion: OUTINV1 (D4) / 16-bit timer 1 control register (0x4818E)

Timer 2 clock output inversion: OUTINV2 (D4) / 16-bit timer 2 control register (0x48196)

Timer 3 clock output inversion: OUTINV3 (D4) / 16-bit timer 3 control register (0x4819E)

Timer 4 clock output inversion: OUTINV4 (D4) / 16-bit timer 4 control register (0x481A6)

Timer 5 clock output inversion: OUTINV5 (D4) / 16-bit timer 5 control register (0x481AE)

See Figure 4.3 for the waveforms.

### Setting the output port

The TMx signal generated here can be output from the clock output pins (see Table 4.1), enabling a programmable clock to be supplied to external devices.

After a cold start, the output pins are set for the I/O ports and set in input mode. The pins go into high-impedance status.

When the pin function is switched to the timer output, the pin goes low if OUTINVx is set to "0" or goes high if OUTINVx is set to "1".

## Starting clock output

To output the TMx clock, write "1" to the clock output control bit PTMx. Clock output is stopped by writing "0" to PTMx and goes to the off level according to the OUTINVx setting (low when OUTINVx = "0" or high when OUTINVx = "1").

Timer 0 clock output control: PTM0 (D2) / 16-bit timer 0 control register (0x48186)

Timer 1 clock output control: PTM1 (D2) / 16-bit timer 1 control register (0x4818E)

Timer 2 clock output control: PTM2 (D2) / 16-bit timer 2 control register (0x48196)

Timer 3 clock output control: PTM3 (D2) / 16-bit timer 3 control register (0x4819E)

Timer 4 clock output control: PTM4 (D2) / 16-bit timer 4 control register (0x481A6)

Timer 5 clock output control: PTM5 (D2) / 16-bit timer 5 control register (0x481AE)

Figure 4.3 shows the waveform of the output signal.



Figure 4.3 Waveform of 16-Bit Programmable Timer Output

### When OUTINVx = "0" (active high):

The timer outputs a low level until the counter becomes equal to the comparison data A set in the CRxA register. When the counter is incremented to the next value from the comparison data A, the output pin goes high and a comparison A interrupt occurs. When the counter becomes equal to the comparison data B set in the CRxB register, the counter is reset and the output pin goes low. At the same time a comparison B interrupt occurs.

### When OUTINVx = "1" (active low):

The timer outputs a high level until the counter becomes equal to the comparison data A set in the CRxA register. When the counter is incremented to the next value from the comparison data A, the output pin goes low and a comparison A interrupt occurs. When the counter becomes equal to the comparison data B set in the CRxB register, the counter is reset and the output pin goes high. At the same time a comparison B interrupt occurs.

### Setting clock output fine mode

By default (after an initial reset), the clock output signal changes at the rising edge of the input clock when CRxA[15:0] becomes equal to TCx[15:0].

In fine mode, the output signal changes according to CRxA[0] when CRxA[15:1] becomes equal to TCx[14:0]. When CRxA[0] is "0", the output signal changes at the rising edge of the input clock.

When CRxA[0] is "1", the output signal changes at the falling edge of the input clock a half cycle from the default setting.

Example) CRxA = 3, CRxB = 5



Figure 4.4 Clock Output in Fine Mode

As shown in the figure above, in fine mode the output clock duty ratio can be adjusted in the half cycle of the input clock. However, when the CRxA value is "0", the timer outputs a pulse with a 1-cycle width as the input clock, the same as the default setting.

In fine mode, the maximum value of CRxB is  $2^{15} - 1 = 32,767$  and the range of CRxA that can be set is 0 to (2 × CRxB - 1).

The fine mode is set by the following registers:

Timer 0 fine mode selection: SELFM0 (D6) / 16-bit timer 0 control register (0x48186)

Timer 1 fine mode selection: SELFM1 (D6) / 16-bit timer 1 control register (0x4818E)

Timer 2 fine mode selection: SELFM2 (D6) / 16-bit timer 2 control register (0x48196)

Timer 3 fine mode selection: SELFM3 (D6) / 16-bit timer 3 control register (0x4819E)

Timer 4 fine mode selection: SELFM4 (D6) / 16-bit timer 4 control register (0x481A6)

Timer 5 fine mode selection: SELFM5 (D6) / 16-bit timer 5 control register (0x481AE)

When "1" is written to the SELFMx bit, fine mode is set. At initial reset, the fine mode is disabled.

## Precautions

- If a same value is set to the comparison data A and B registers, a hazard may be generated in the output signal. Therefore, do not set the comparison registers as A = B. There is no problem when the interrupt function only is used.
- 2) When using the output clock, set the comparison data registers as A ≥ 0 and B ≥ 1. The minimum settings are A = 0 and B = 1. In this case, the timer output clock cycle is the input clock × 1/2.
- 3) When the comparison data registers are set as A > B, no comparison A signal is generated. In this case, the output signal is fixed at the off level.

## 16-Bit Programmable Timer Interrupts

The 16-bit programmable timer has a function for generating an interrupt using the comparison match A and B states. The timing at which an interrupt is generated is shown in Figure 4.2 in the preceding section.

### Control registers of the interrupt controller

Table 4.4 shows the control registers of the interrupt controller provided for each timer.

Interrupt factor	Interrupt factor flag	Interrupt enable register	Interrupt priority register			
Timer 0 comparison A	F16TC0 (D3/0x40282)	E16TC0 (D3/0x40272)	P16T0[2:0] (D[2:0]/0x40266)			
Timer 0 comparison B	F16TU0 (D2/0x40282)	E16TU0 (D2/0x40272)				
Timer 1 comparison A	F16TC1 (D7/0x40282)	E16TC1 (D7/0x40272)	P16T1[2:0] (D[6:4]/0x40266)			
Timer 1 comparison B	F16TU1 (D6/0x40282)	E16TU1 (D6/0x40272)				
Timer 2 comparison A	F16TC2 (D3/0x40283)	E16TC2 (D3/0x40273)	P16T2[2:0] (D[2:0]/0x40267)			
Timer 2 comparison B	F16TU2 (D2/0x40283)	E16TU2 (D2/0x40273)				
Timer 3 comparison A	F16TC3 (D7/0x40283)	E16TC3 (D7/0x40273)	P16T3[2:0] (D[6:4]/0x40267)			
Timer 3 comparison B	F16TU3 (D6/0x40283)	E16TU3 (D6/0x40273)				
Timer 4 comparison A	F16TC4 (D3/0x40284)	E16TC4 (D3/0x40274)	P16T4[2:0] (D[2:0]/0x40268)			
Timer 4 comparison B	F16TU4 (D2/0x40284)	E16TU4 (D2/0x40274)				
Timer 5 comparison A	F16TC5 (D7/0x40284)	E16TC5 (D7/0x40274)	P16T5[2:0] (D[6:4]/0x40268)			
Timer 5 comparison B	F16TU5 (D6/0x40284)	E16TU5 (D6/0x40274)				

Table 4.4	Control Registers	of Interrupt	Controller
10010 1.1	o on the of the glotter of	or mitorrapt	00110101101

When a comparison match state occurs in the timer, the corresponding interrupt factor flag is set to "1". If the interrupt enable register bit corresponding to that interrupt factor flag has been set to "1", an interrupt request is generated.

An interrupt caused by a timer can be disabled by leaving the interrupt enable register bit for that timer set to "0". The interrupt factor flag is always set to "1" by the timer's comparison match state, regardless of how the interrupt enable register is set (even when set to "0").

The interrupt priority register sets an interrupt priority level (0 to 7) for each timer. Priorities within a timer block are such that timers of smaller numbers have a higher priority. Priorities between interrupt types are such that the comparison B interrupt has priority over the comparison A interrupt. An interrupt request to the CPU is accepted only when no other interrupt request of a higher priority has been generated.

It is only when the PSR's IE bit = "1" (interrupts enabled) and the set value of the IL is smaller than the timer interrupt level set by the interrupt priority register, that a timer interrupt request is actually accepted by the CPU.

For details on these interrupt control registers, as well as the device operation when an interrupt has occurred, refer to "ITC (Interrupt Controller)".

## **Trap vectors**

The trap vector addresses for each default interrupt factor are set as shown below:

Timer 0 comparison B:	0x0C00078
Timer 0 comparison A:	0x0C0007C
Timer 1 comparison B:	0x0C00088
Timer 1 comparison A:	0x0C0008C
Timer 2 comparison B:	0x0C00098
Timer 2 comparison A:	0x0C0009C
Timer 3 comparison B:	0x0C000A8
Timer 3 comparison A:	0x0C000AC
Timer 4 comparison B:	0x0C000B8
Timer 4 comparison A:	0x0C000BC
Timer 5 comparison B:	0x0C000C8
Timer 5 comparison A:	0x0C000CC

The base address of the trap table can be changed using the TTBR register (0x48134 to 0x48137).

## I/O Memory of 16-Bit Programmable Timers

Table 4.5 shows the control bits of the 16-bit programmable timers.

For details on the I/O memory of the prescaler used to set a clock, refer to "Prescaler".

Register name	Address	Bit	Name	Function		Sett	ind	<u>יייי</u>	Init.	R/W	Remarks
16-bit timer 0/1	0040266		_	reserved				2			0 when being read
interrunt	(B)	D6	P16T12	16-bit timer 1 interrupt level		0 to	- - 7		X	R/W	o when being read.
priority register	(2)	D5	P16T11			0 10			x	10.11	
priority register		D4	P16T10						x		
		D3	-	reserved		_	-		_	-	0 when being read
		D2	P16T02	16-bit timer 0 interrupt level		0 to	h 7		x	R/W	o when being roud.
		D1	P16T01	· · · · · · · · · · · · · · · · · · ·					x		
		D0	P16T00						х		
16-bit timer 2/3	0040267	D7	-	reserved		_	-		_	_	0 when being read
interrupt	(B)	D6	P16T32	16-bit timer 3 interrupt level		0 to	o 7		x	R/W	o when being road.
priority register	(-)	D5	P16T31	· · · · · · · · · · · · · · · · · · ·					x		
		D4	P16T30						x		
		D3	-	reserved		-	-		-	-	0 when being read.
		D2	P16T22	16-bit timer 2 interrupt level		0 to	o 7		Х	R/W	
		D1	P16T21	-					х		
		D0	P16T20						Х		
16-bit timer 4/5	0040268	D7	-	reserved	<u> </u>	_	-		-	-	0 when being read.
interrupt	(B)	D6	P16T52	16-bit timer 5 interrupt level		0 to	o 7		Х	R/W	
priority register		D5	P16T51						Х		
		D4	P16T50						Х		
		D3	-	reserved		_	-		-	-	0 when being read.
		D2	P16T42	16-bit timer 4 interrupt level		0 to	o 7		Х	R/W	
		D1	P16T41						Х		
		D0	P16T40			·	_		Х		
16-bit timer 0/1	0040272	D7	E16TC1	16-bit timer 1 comparison A	1	Enabled	0	Disabled	0	R/W	
interrupt	(B)	D6	E16TU1	16-bit timer 1 comparison B					0	R/W	
enable register		D5–4	-	reserved		-	-	1	-	-	0 when being read.
		D3	E16TC0	16-bit timer 0 comparison A	1	Enabled	0	Disabled	0	R/W	
		D2	E16TU0	16-bit timer 0 comparison B					0	R/W	
		D1-0	-	reserved			-		-	-	0 when being read.
16-bit timer 2/3	0040273	D7	E16TC3	16-bit timer 3 comparison A	1	Enabled	0	Disabled	0	R/W	
interrupt	(B)	D6	E16TU3	16-bit timer 3 comparison B					0	R/W	O where he is a second
enable register		D5-4	-	reserved	1	Enchlod	-	Dischlod	-	- D///	0 when being read.
		D3 D2	E10102	16-bit timer 2 comparison B	1	Enableu	0	Disableu	0	R/W	
		D1_0	_	reserved					-	_	0 when being read
16-bit timor 4/5	0040274		E16TC5	16-bit timer 5 comparison A	1	Enabled	0	Disabled	0	D/M/	o when being read.
interrunt	(B)	D6	E16TU5	16-bit timer 5 comparison B	1	Lilableu	0	Disableu	0	R/W	
enable register	(5)	D5-4	_	reserved		I	-		_	_	0 when being read
chable register		D3	F16TC4	16-bit timer 4 comparison A	1	Enabled	0	Disabled	0	R/W	o when being roud.
		D2	E16TU4	16-bit timer 4 comparison B			-		0	R/W	
		D1-0	-	reserved		-	-		_	_	0 when being read.
16-bit timer 0/1	0040282	D7	F16TC1	16-bit timer 1 comparison A	1	Factor is	0	No factor is	х	R/W	ŭ
interrupt factor	(B)	D6	F16TU1	16-bit timer 1 comparison B	1	generated		generated	х	R/W	
flag register	.,	D5-4	-	reserved		-	-	0	-	-	0 when being read.
		D3	F16TC0	16-bit timer 0 comparison A	1	Factor is	0	No factor is	Х	R/W	
		D2	F16TU0	16-bit timer 0 comparison B	1	generated		generated	Х	R/W	
		D1-0	-	reserved		-	-		-	-	0 when being read.
16-bit timer 2/3	0040283	D7	F16TC3	16-bit timer 3 comparison A	1	Factor is	0	No factor is	Х	R/W	
interrupt factor	(B)	D6	F16TU3	16-bit timer 3 comparison B		generated		generated	Х	R/W	
flag register		D5–4	-	reserved		-	-		-	-	0 when being read.
		D3	F16TC2	16-bit timer 2 comparison A	1	Factor is	0	No factor is	Х	R/W	
		D2	F16TU2	16-bit timer 2 comparison B		generated		generated	Х	R/W	
		D1–0	-	reserved			-		-	-	0 when being read.
16-bit timer 4/5	0040284	D7	F16TC5	16-bit timer 5 comparison A	1	Factor is	0	No factor is	Х	R/W	
interrupt factor	(B)	D6	F16TU5	16-bit timer 5 comparison B		generated		generated	Х	R/W	
flag register		D5-4	-	reserved		-	-		-	-	0 when being read.
		D3	F16TC4	16-bit timer 4 comparison A	1	Factor is	0	No factor is	X	R/W	
		D2	F161U4	16-bit timer 4 comparison B	-	generated		generated	X	K/W	O where he's state
1		0–10 ן	-	reserved	1	-	-		-	- 1	u when being read.

Table 4.5	Control Bit	s of	16-Bit	Programmable	Timer
1 4010 4.0		3 01		riogrammabic	THILL

Register name	Address	Bit	Name	Function	Setting			9	Init.	R/W	Remarks
P1 function	00402D4	D7	-	reserved		-	-		-	-	0 when being read.
select register	(B)	D6	CFP16	P16 function selection	1	EXCL5	0	P16	0	R/W	Ť
_		D5	CFP15	P15 function selection	1	EXCL4	0	P15	0	R/W	
		D4	CFP14	P14 function selection	1	FOSC1	0	P14	0	R/W	Extended functions
		D3	CFP13	P13 function selection	1	EXCL3 T8UE3	0	P13	0	R/W	(0x402DF)
		D2	CFP12	P12 function selection	1	EXCL2	0	P12	0	R/W	
		D1	CFP11	P11 function selection	1	EXCL1	0	P11	0	R/W	
		D0	CFP10	P10 function selection	1	EXCL0	0	P10	0	R/W	
P2 function	00402D8	D7	CEP27	P27 function selection	1	TM5	0	P27	0	R/W	
select register	(B)	D6	CFP26	P26 function selection	1	TM4	0	P26	0	R/W	
Select register	(2)	D5	CFP25	P25 function selection	1	TM3	0	P25	0	R/W	
		D4	CFP24	P24 function selection	1	TM2	0	P24	0	R/W	
		D3	CFP23	P23 function selection	1	TM1	0	P23	0	R/W	
		D2	CFP22	P22 function selection	1	TM0	0	P22	0	R/W	
		D1	CFP21	P21 function selection	1	#DWE	0	P21	0	R/W	Ext. func.(0x402DF)
		D0	CFP20	P20 function selection	1	#DRD	0	P20	0	R/W	
Port function	00402DF	D7-4	-	reserved		-	_		0	R/W	Writing 1 not allowed.
extension	(B)	D3	CFEX3	P31 port extended function	1	#GARD	0	P31, etc.	0	R/W	
register	``	D2	CFEX2	P21 port extended function	1	#GAAS	0	P21, etc.	0	R/W	
		D1	CFEX1	P10, P11, P13 port extended	1	DST0	0	P10, etc.	1	R/W	
				function		DST1		P11, etc.			
						DPC0		P13, etc.			
		D0	CFEX0	P12, P14 port extended function	1	DST2	0	P12, etc.	1	R/W	
						DCLK		P14, etc.			
16-bit timer 0	0048180	DF	CR0A15	16-bit timer 0 comparison data A		0 to 6	655	35	Х	R/W	
comparison	(HW)	DE	CR0A14	CR0A15 = MSB					X		
data A set-up		DD	CR0A13	CR0A0 = LSB					X		
register		DC	CR0A12						Х		
		DB	CR0A11						Х		
		DA	CR0A10						X		
		D9	CR0A9						X		
		D8	CR0A8						Х		
		D7	CR0A7						Х		
		D6	CR0A6						Х		
		D5	CR0A5						Х		
		D4	CR0A4						X		
		D3	CR0A3						Х		
		D2	CR0A2						X		
		D1	CR0A1						X		
		D0	CR0A0						Х		
16-bit timer 0	0048182	DF	CR0B15	16-bit timer 0 comparison data B		0 to 6	655	35	Х	R/W	
comparison	(HW)	DE	CR0B14	CR0B15 = MSB					Х		
data B set-up		DD	CR0B13	CR0B0 = LSB					Х		
register		DC	CR0B12						Х		
		DB	CR0B11						Х		
		DA	CR0B10						Х		
		D9	CR0B9						Х		
		D8	CR0B8						X		
		D7	CR0B7						X		
		D6	CR0B6						X		
		D5	CR0B5						X		
		D4	CR0B4						X		
		D3	CR0B3						X		
		D2	CR0B2						X		
		D1	CR0B1						X		
		D0	CR0B0						Х		

Register name	Address	Bit	Name	Function	Setting			1	Init.	R/W	Remarks
16-bit timer 0	0048184	DF	TC015	16-bit timer 0 counter data		0 to 6	555	35	Х	R	
counter data	(HW)	DE	TC014	TC015 = MSB				-	X		
register	```	DD	TC013	TC00 = LSB					х		
		DC	TC012						х		
		DB	TC011						х		
		DA	TC010						х		
		D9	TC09						х		
		D8	TC08						Х		
		D7	TC07						Х		
		D6	TC06						Х		
		D5	TC05						Х		
		D4	TC04						Х		
		D3	TC03						Х		
		D2	TC02						Х		
		D1	TC01						Х		
		D0	TC00						Х		
16-bit timer 0	0048186	D7	-	reserved		-	-		0	-	0 when being read.
control register	(B)	D6	SELFM0	16-bit timer 0 fine mode selection	1	Fine mode	0	Normal	0	R/W	
		D5	SELCRB0	16-bit timer 0 comparison buffer	1	Enabled	0	Disabled	0	R/W	
		D4	OUTINV0	16-bit timer 0 output inversion	1	Invert	0	Normal	0	R/W	
		D3	CKSL0	16-bit timer 0 input clock selection	1	External clock	0	Internal clock	0	R/W	
		D2	PTM0	16-bit timer 0 clock output control	1	On	0	Off	0	R/W	
		D1	PRESET0	16-bit timer 0 reset	1	Reset	0	Invalid	0	W	0 when being read.
		D0	PRUN0	16-bit timer 0 Run/Stop control	1	Run	0	Stop	0	R/W	
16-bit timer 1	0048188	DF	CR1A15	16-bit timer 1 comparison data A		0 to 6	655	35	Х	R/W	
comparison	(HW)	DE	CR1A14	CR1A15 = MSB					Х		
data A set-up		DD	CR1A13	CR1A0 = LSB					Х		
register		DC	CR1A12						X		
		DB	CR1A11						Х		
		DA	CR1A10						Х		
		D9	CR1A9						X		
		D8	CR1A8						X		
		D7	CR1A7						X		
		D6	CR1A6						X		
		D5	CR1A5						X		
		D4	CR1A4								
		D3	CRIAS								
			CRIAZ								
			CRIAI								
		00	CRIAU		-						
16-bit timer 1	004818A		CR1B15	16-bit timer 1 comparison data B		0 to 6	55	35	X	R/W	
doto B cot un	(ПVV)		CR1D14						$\hat{\mathbf{v}}$		
rogistor			CR1013	CRIBU = LSB					Ŷ		
register		DB	CR1B11						x		
			CR1B10						x		
		D9	CR1B9						x		
		D8	CR1B8						x		
		D7	CR1B7						x		
		D6	CR1B6						x		
		D5	CR1B5						х		
		D4	CR1B4						х		
		D3	CR1B3						х		
		D2	CR1B2						х		
		D1	CR1B1						х		
		D0	CR1B0						Х		
16-bit timer 1	004818C	DF	TC115	16-bit timer 1 counter data		0 to 6	555	35	Х	R	
counter data	(HW)	DE	TC114	TC115 = MSB					х		
register	. ,	DD	TC113	TC10 = LSB					х		
_		DC	TC112						Х		
		DB	TC111						Х		
		DA	TC110						Х		
		D9	TC19						Х		
		D8	TC18						Х		
		D7	TC17						Х		
		D6	TC16		1				Х		
		D5	TC15						Х		
		D4	TC14						Х		
		D3	TC13						X		
		D2	TC12						X		
		D1	TC11						X		
		D0	TC10		1				X		1

Register name	Address	Bit	Name	Function	Setting				Init.	R/W	Remarks
16-bit timer 1	004818E	D7	_	reserved		_	-		0	_	0 when being read.
control register	(B)	D6	SELFM1	16-bit timer 1 fine mode selection	1	Fine mode	0	Normal	0	R/W	o mion boing roadi
g	(=)	D5	SELCRB1	16-bit timer 1 comparison buffer	1	Enabled	0	Disabled	0	R/W	
		D4	OUTINV1	16-bit timer 1 output inversion	1	Invert	0	Normal	0	R/W	
		D3	CKSL1	16-bit timer 1 input clock selection	1	External clock	0	Internal clock	0	R/W	
		D2	PTM1	16-bit timer 1 clock output control	1	On	0	Off	0	R/W	
		D1	PRESET1	16-bit timer 1 reset	1	Reset	0	Invalid	0	W	0 when being read.
		D0	PRUN1	16-bit timer 1 Run/Stop control	1	Run	0	Stop	0	R/W	Ŭ
16-bit timer 2	0048190	DF	CR2A15	16-bit timer 2 comparison data A	Ē	0 to 6	555	35	x	R/W	
comparison	(HW)	DE	CR2A14	CR2A15 = MSB		0.000000					
data A set-up	(,	DD	CR2A13	CR2A0 = LSB					x		
register		DC	CR2A12						х		
		DB	CR2A11						х		
		DA	CR2A10						х		
		D9	CR2A9						Х		
		D8	CR2A8						х		
		D7	CR2A7						Х		
		D6	CR2A6						Х		
		D5	CR2A5						Х		
		D4	CR2A4						Х		
		D3	CR2A3						Х		
		D2	CR2A2						Х		
		D1	CR2A1						Х		
		D0	CR2A0						Х		
16-bit timer 2	0048192	DF	CR2B15	16-bit timer 2 comparison data B		0 to 6	655	35	Х	R/W	
comparison	(HW)	DE	CR2B14	CR2B15 = MSB					Х		
data B set-up		DD	CR2B13	CR2B0 = LSB							
register		DC	CR2B12						X		
		DB	CR2B11						X		
		DA	CR2B10						X		
		D9	CR2B9						X		
		D8	CR2B8						X		
			CR2B7								
			CR2D0						$\hat{}$		
		D3	CD2B4						Ŷ		
		D3	CR2B3						x		
		D2	CR2B2						x		
		D1	CR2B1						x		
		D0	CR2B0						x		
16-bit timer 2	0048194	DF	TC215	16-bit timer 2 counter data	Ē	0 to 6	655	35	X	R	
counter data	(HW)	DE	TC214	TC215 = MSB					x		
register	```	DD	TC213	TC20 = LSB					х		
U U		DC	TC212						х		
		DB	TC211						х		
		DA	TC210						Х		
		D9	TC29						Х		
		D8	TC28						Х		
		D7	TC27						Х		
		D6	TC26						Х		
		D5	TC25						Х		
		D4	TC24						X		
		D3	TC23						X		
		D2	TC22						X		
		D1	1021								
		00	1620		-				<u>^</u>		
16-bit timer 2	0048196	D7		reserved		-	-	Norm-1	0	-	0 when being read.
control register	(B)	D6	SELEM2	10-DIT TIMER 2 TINE MODE selection	1	Fine mode		Disabled	0	K/W	
				16-bit timer 2 output inversion	1	Invert	0	Normal	0	R/W	
		D3	CKSI 2	16-bit timer 2 input clock selection	1	External clock	0	Internal clock	0	R/W	
		D2	PTM2	16-bit timer 2 clock output control	1	On	0	Off	0	R/W	
		D1	PRESET2	16-bit timer 2 reset	1	Reset	0	Invalid	0	W	0 when being read.
		D0	PRUN2	16-bit timer 2 Run/Stop control	1	Run	0	Stop	0	R/W	

Register name	Address	Bit	Name	Function		Sett	ing	1	Init.	R/W	Remarks
16-bit timer 3	0048198	DF	CR3A15	16-bit timer 3 comparison data A		0 to 6	55	35	Х	R/W	
comparison	(HW)	DE	CR3A14	CR3A15 = MSB					x		
data A set-up	. ,	DD	CR3A13	CR3A0 = LSB					х		
register		DC	CR3A12						х		
		DB	CR3A11						х		
		DA	CR3A10						Х		
		D9	CR3A9						Х		
		D8	CR3A8						Х		
		D7	CR3A7						Х		
		D6	CR3A6						Х		
		D5	CR3A5						Х		
		D4	CR3A4						X		
		D3	CR3A3						X		
		D2	CR3A2						X		
			CR3AI						$\hat{\mathbf{v}}$		
	0040404	DU	CR3AU		+	0.4-0				DAV	
16-bit timer 3	004819A		CR3B15	16-bit timer 3 comparison data B		0 to 6	22,	55		R/W	
data B cot un	(ПVV)		CR3D14	CR3BIS = MSB					$\hat{\mathbf{v}}$		
register			CR3B12	CR3BU = L3B					Ŷ		
register		DB	CR3B11						x		
		DA	CR3B10						x		
		D9	CR3B9						x		
		D8	CR3B8						x		
		D7	CR3B7						х		
		D6	CR3B6						х		
		D5	CR3B5						х		
		D4	CR3B4						х		
		D3	CR3B3						Х		
		D2	CR3B2						Х		
		D1	CR3B1						Х		
		D0	CR3B0						Х		
16-bit timer 3	004819C	DF	TC315	16-bit timer 3 counter data		0 to 6	553	35	Х	R	
counter data	(HW)	DE	TC314	TC315 = MSB					X		
register		DD	10313	1C30 = LSB					X		
		DC	TC312								
			TC240								
			TC30								
		D9	TC38						x		
		D7	TC37						x		
		D6	TC36						х		
		D5	TC35						х		
		D4	TC34						х		
		D3	TC33						х		
		D2	TC32						Х		
		D1	TC31						Х		
		D0	TC30						Х		
16-bit timer 3	004819E	D7	-	reserved		-			0	-	0 when being read.
control register	(B)	D6	SELFM3	16-bit timer 3 tine mode selection	1	Fine mode	0	Normal	0	R/W	
		D3	OUTINV2	16-bit timer 3 output inversion	1	Invert	0	Normal	0	R/W	
		D3	CKSL3	16-bit timer 3 input clock selection	1	External clock	0	Internal clock	0	R/W	
		D2	PTM3	16-bit timer 3 clock output control	1	On	0	Off	0	R/W	
		D1	PRESET3	16-bit timer 3 reset	1	Reset	0	Invalid	0	W	0 when being read.
		D0	PRUN3	16-bit timer 3 Run/Stop control	1	Run	0	Stop	0	R/W	
16-bit timer 4	00481A0	DF	CR4A15	16-bit timer 4 comparison data A		0 to 6	553	35	Х	R/W	
comparison	(HW)	DE	CR4A14	CR4A15 = MSB					Х		
data A set-up		DD	CR4A13	CR4A0 = LSB					Х		
register		DC	CR4A12						Х		
		DB	CR4A11						Х		
		DA	CR4A10						Х		
		D9	CR4A9						X		
		D8	CR4A8						X		
		D7	CR4A7						X		
			CR4A0						Ŷ		
		D3	CR444						Ŷ		
		D3	CR4A3						x		
		D2	CR4A2						x		
		D1	CR4A1						x		
		D0	CR4A0						x		

Register name	Address	Bit	Name	Function		Set	ting	1	Init.	R/W	Remarks
16-bit timer 4	00481A2	DF	CR4B15	16-bit timer 4 comparison data B		0 to 6	355	35	X	R/W	
comparison	(HW)	DE	CR4B14	CR4B15 = MSB					X		
data B set-up	, ,	DD	CR4B13	CR4B0 = LSB					x		
register		DC	CR4B12						X		
J		DB	CR4B11						x		
		DA	CR4B10						x		
		D9	CR4B9						x		
		D8	CR4B8						х		
		D7	CR4B7						х		
		D6	CR4B6						х		
		D5	CR4B5						х		
		D4	CR4B4						x		
		D3	CR4B3						x		
		D2	CR4B2						X		
		D1	CR4B1						х		
		D0	CR4B0						х		
16-bit timer 4	00481A4	DF	TC415	16-bit timer 4 counter data		0 to 6	355	35	x	R	
counter data	(HW)	DE	TC414	TC415 = MSB					x		
register	(,	DD	TC413	TC40 = LSB					x		
- ground		DC	TC412						x		
		DB	TC411						X		
		DA	TC410						x		
		D9	TC49						x		
		D8	TC48						x		
		D7	TC47						х		
		D6	TC46						х		
		D5	TC45						х		
		D4	TC44						х		
		D3	TC43						х		
		D2	TC42						Х		
		D1	TC41						Х		
		D0	TC40						Х		
16-bit timer 4	00481A6	D7	-	reserved		-	-		0	-	0 when being read.
control register	(B)	D6	SELFM4	16-bit timer 4 fine mode selection	1	Fine mode	0	Normal	0	R/W	_
		D5	SELCRB4	16-bit timer 4 comparison buffer	1	Enabled	0	Disabled	0	R/W	
		D4	OUTINV4	16-bit timer 4 output inversion	1	Invert	0	Normal	0	R/W	
		D3	CKSL4	16-bit timer 4 input clock selection	1	External clock	0	Internal clock	0	R/W	
		D2	PTM4	16-bit timer 4 clock output control	1	On	0	Off	0	R/W	
		D1	PRESET4	16-bit timer 4 reset	1	Reset	0	Invalid	0	W	0 when being read.
		D0	PRUN4	16-bit timer 4 Run/Stop control	1	Run	0	Stop	0	R/W	
16-bit timer 5	00481A8	DF	CR5A15	16-bit timer 5 comparison data A		0 to 6	655	35	X	R/W	
comparison	(HW)	DE	CR5A14	CR5A15 = MSB					X		
data A set-up		DD	CR5A13	CR5A0 = LSB					X		
register		DC	CR5A12						X		
		DB	CR5A11						X		
		DA	CR5A10						X		
		D9	CR5A9								
			CR5A0						$\hat{\mathbf{v}}$		
		Dr	CR5A/								
			CR5A5						Ŷ		
		D4	CR5A4						x		
		D3	CR5A3						x		
		D2	CR5A2						x		
		D1	CR5A1						x		
		D0	CR5A0						х		
16-bit timer 5	00481AA	DF	CR5B15	16-bit timer 5 comparison data B		0 to P	355	35	Х	R/W	
comparison	(HW)	DE	CR5B14	CR5B15 = MSB					x		
data B set-up	, ,	DD	CR5B13	CR5B0 = LSB					х		
register		DC	CR5B12						х		
-		DB	CR5B11						х		
		DA	CR5B10						Х		
		D9	CR5B9						Х		
		D8	CR5B8						Х		
		D7	CR5B7						Х		
		D6	CR5B6						Х		
		D5	CR5B5						Х		
		D4	CR5B4						Х		
		D3	CR5B3						Х		
		D2	CR5B2						Х		
		D1	CR5B1						Х		
		D0	CR5B0		1				X	l I	

Register name	Address	Bit	Name	Function		Set	ting	g	Init.	R/W	Remarks
16-bit timer 5	00481AC	DF	TC515	16-bit timer 5 counter data		0 to 6	655	35	Х	R	
counter data	(HW)	DE	TC514	TC515 = MSB					Х		
register		DD	TC513	TC50 = LSB					Х		
-		DC	TC512						Х		
		DB	TC511						Х		
		DA	TC510						Х		
		D9	TC59						Х		
		D8	TC58						Х		
		D7	TC57						Х		
		D6	TC56						Х		
		D5	TC55						Х		
		D4	TC54						Х		
		D3	TC53						Х		
		D2	TC52						Х		
		D1	TC51						Х		
		D0	TC50						Х		
16-bit timer 5	00481AE	D7	-	reserved		-	-		0	-	0 when being read.
control register	(B)	D6	SELFM5	16-bit timer 5 fine mode selection	1	Fine mode	0	Normal	0	R/W	
		D5	SELCRB5	16-bit timer 5 comparison buffer	1	Enabled	0	Disabled	0	R/W	
		D4	OUTINV5	16-bit timer 5 output inversion	1	Invert	0	Normal	0	R/W	
		D3	CKSL5	16-bit timer 5 input clock selection	1	External clock	0	Internal clock	0	R/W	
		D2	PTM5	16-bit timer 5 clock output control	1	On	0	Off	0	R/W	
		D1	PRESET5	16-bit timer 5 reset	1	Reset	0	Invalid	0	W	0 when being read.
		D0	PRUN5	16-bit timer 5 Run/Stop control	1	Run	0	Stop	0	R/W	

#### CFP16-CFP10: P1[6:0] pin function selection (D[6:0]) / P1 function select register (0x402D4)

Selects the pin to be used for input of an external count clock to the timer.

Write "1": Clock input pin

Write "0": I/O port pin

Read: Valid

Select clock input pins for the timers that are used as an event counter from among P10 through P16, by writing "1" to CFP10–CFP16. For the relationship between each pin and timer, refer to Table 4.1. The pin is set for an I/O port by writing "0" to CFP1x.

In addition to pin selection here, the pin to be used for clock input to the 16-bit programmable timer must be set to input mode using the I/O control register.

At cold start, CFP1x is set to "0" (I/O port). At hot start, CFP1x retains its status from prior to the initial reset.

CFP27-CFP22: P2[7:2] pin function selection (D[7:2]) / P2 function select register (0x402D8)

Selects the pin used for clock output.

Write "1": Clock output pin Write "0": I/O port pin Read: Valid

Select the pin to be used to output a timer-generated clock to external devices from among P22 through P27, by writing "1" to CFP22–CFP27. For the relationship between each pin and timer, refer to Table 4.1. The pin is set for an I/O port by writing "0" to CFP2x.

At cold start, CFP2x is set to "0" (I/O port). At hot start, CFP2x retains its status from prior to the initial reset.

**CFEX1**: P10, P11, P13 port extended function (D1) / Port function extension register (0x402DF) **CFEX0**: P12, P14 port extended function (D0) / Port function extension register (0x402DF)

Sets whether the function of an I/O-port pin is to be extended.

Write "1": Function-extended pinWrite "0": I/O-port/peripheral-circuit pinRead: Valid

When CFEX[1:0] is set to "1", the P14–P10 ports function as debug signal output ports. When CFEX[1:0] = "0", the CFP1[4:0] bit becomes effective, so the settings of these bits determine whether the P14–P10 ports function as I/O port s or external clock input ports.

At cold start, CFEX[1:0] is set to "1" (function-extended pins). At hot start, CFEX[1:0] retains its state from prior to the initial reset.

IOC16-IOC10: P1[6:0] port I/O control (D[6:0]) / P1 I/O control register (0x402D6)

Directs P10 through P16 for input or output.

Write "1": Output mode Write "0": Input mode Read: Valid

For the pin selected from among P10 through P16 for use for external clock input, write "0" to the corresponding I/O control bit to set it to input mode. If the pin is set to output mode, even though its CFP1x may be set to "1", it functions as the output pin of an 8-bit programmable timer and cannot be used to receive an external clock. At cold start, all IOC1x is set to "0" (input mode). At hot start, IOC1x retains its state from prior to the initial reset.

SELFM0: Timer 0 fine mode selection (D6) / 16-bit timer 0 control register (0x48186) SELFM1: Timer 1 fine mode selection (D6) / 16-bit timer 1 control register (0x4818E) SELFM2: Timer 2 fine mode selection (D6) / 16-bit timer 2 control register (0x48196) SELFM3: Timer 3 fine mode selection (D6) / 16-bit timer 3 control register (0x4819E) SELFM4: Timer 4 fine mode selection (D6) / 16-bit timer 4 control register (0x481A6) SELFM5: Timer 5 fine mode selection (D6) / 16-bit timer 5 control register (0x481AE)

Sets fine mode for clock output.

Write "1": Fine mode Write "0": Normal output Read: Valid

When SELFMx is set to "1", clock output is set in fine mode which allows adjustment of the output signal duty ratio in units of a half cycle for the input clock.

When SELFMx is set to "0", normal clock output will be performed.

At initial reset, SELCFMx is set to "0" (normal output).

SELCRB0: Timer 0 comparison register buffer enable (D5) / 16-bit timer 0 control register (0x48186)
SELCRB1: Timer 1 comparison register buffer enable (D5) / 16-bit timer 1 control register (0x4818E)
SELCRB2: Timer 2 comparison register buffer enable (D5) / 16-bit timer 2 control register (0x48196)
SELCRB3: Timer 3 comparison register buffer enable (D5) / 16-bit timer 3 control register (0x4819E)
SELCRB4: Timer 4 comparison register buffer enable (D5) / 16-bit timer 4 control register (0x481A6)
SELCRB5: Timer 5 comparison register buffer enable (D5) / 16-bit timer 5 control register (0x481AE)

Enables or disables writing to the comparison register buffer.

Write "1": Enabled Write "0": Disabled Read: Valid

When SELCRBx is set to "1", comparison data is read and written from/to the comparison register buffer. The content of the buffer is loaded to the comparison data register when the counter is reset by the software or the comparison B signal.

When SELCRBx is set to "0", comparison data is read and written from/to the comparison data register. At initial reset, SELCRBx is set to "0" (disabled).

```
OUTINV0: Timer 0 output inversion (D4) / 16-bit timer 0 control register (0x48186)
OUTINV1: Timer 1 output inversion (D4) / 16-bit timer 1 control register (0x4818E)
OUTINV2: Timer 2 output inversion (D4) / 16-bit timer 2 control register (0x48196)
OUTINV3: Timer 3 output inversion (D4) / 16-bit timer 3 control register (0x4819E)
OUTINV4: Timer 4 output inversion (D4) / 16-bit timer 4 control register (0x481A6)
OUTINV5: Timer 5 output inversion (D4) / 16-bit timer 5 control register (0x481AE)
```

Selects a logic of the output signal.

Write "1": Inverted (active low) Write "0": Normal (active high) Read: Valid

By writing "1" to OUTINVx, an active-low signal (off level = high) is generated for the TMx output. When OUTINVx is set to "0", an active-high signal (off level = low) is generated. At initial reset, OUTINVx is set to "0" (normal).

```
CKSL0: Timer 0 input clock selection (D3) / 16-bit timer 0 control register (0x48186)
CKSL1: Timer 1 input clock selection (D3) / 16-bit timer 1 control register (0x4818E)
CKSL2: Timer 2 input clock selection (D3) / 16-bit timer 2 control register (0x48196)
CKSL3: Timer 3 input clock selection (D3) / 16-bit timer 3 control register (0x4819E)
CKSL4: Timer 4 input clock selection (D3) / 16-bit timer 4 control register (0x481A6)
CKSL5: Timer 5 input clock selection (D3) / 16-bit timer 5 control register (0x481AE)
```

Selects the input clock of each timer.

Write "1": External clock Write "0": Internal clock Read: Valid

The internal clock (prescaler output) is selected for the input clock of each timer by writing "0" to CKSLx. An external clock (one that is fed from the clock input pin) is selected by writing "1", and the timer functions as an event counter. In this case, the clock input pin must be set using CFP1x before an external clock is selected here. At initial reset, CKSLx is set to "0" (internal clock).

<b>PTM0</b> : Timer 0 clock output control (D2) / 16-bit timer 0 control register (0x48186)	
PTM1: Timer 1 clock output control (D2) / 16-bit timer 1 control register (0x4818E)	
PTM2: Timer 2 clock output control (D2) / 16-bit timer 2 control register (0x48196)	
PTM3: Timer 3 clock output control (D2) / 16-bit timer 3 control register (0x4819E)	
PTM4: Timer 4 clock output control (D2) / 16-bit timer 4 control register (0x481A6)	
PTM5: Timer 5 clock output control (D2) / 16-bit timer 5 control register (0x481AE)	

Controls the output of the TMx signal (timer output clock).

Write "1": On Write "0": Off Read: Valid

The TMx signal is output from the clock output pin by writing "1" to PTMx. Clock output is stopped by writing "0" to PTMx and goes to the off level according to the OUTINVx setting (low when OUTINVx = "0" or high when OUTINVx = "1"). In this case, the clock output pin must be set using CFP2x before outputting the TMx signal here. At initial reset, PTMx is set to "0" (off).

```
PRESET0: Timer 0 reset (D1) / 16-bit timer 0 control register (0x48186)PRESET1: Timer 1 reset (D1) / 16-bit timer 1 control register (0x4818E)PRESET2: Timer 2 reset (D1) / 16-bit timer 2 control register (0x48196)PRESET3: Timer 3 reset (D1) / 16-bit timer 3 control register (0x4819E)PRESET4: Timer 4 reset (D1) / 16-bit timer 4 control register (0x481A6)PRESET5: Timer 5 reset (D1) / 16-bit timer 5 control register (0x481AE)
```

Resets the counter.

Write "1": Reset Write "0": Invalid Read: Always "0"

The counter of timer x is reset by writing "1" to PRESETx.

Writing "0" results in No Operation.

Since PRESETx is a write-only bit, its content when read is always "0".

```
PRUN0: Timer 0 RUN/STOP control (D0) / 16-bit timer 0 control register (0x48186)
PRUN1: Timer 1 RUN/STOP control (D0) / 16-bit timer 1 control register (0x4818E)
PRUN2: Timer 2 RUN/STOP control (D0) / 16-bit timer 2 control register (0x48196)
PRUN3: Timer 3 RUN/STOP control (D0) / 16-bit timer 3 control register (0x4819E)
PRUN4: Timer 4 RUN/STOP control (D0) / 16-bit timer 4 control register (0x481A6)
PRUN5: Timer 5 RUN/STOP control (D0) / 16-bit timer 5 control register (0x481AE)
```

Controls the timer's RUN/STOP state.

Write "1": RUN Write "0": STOP Read: Valid

Each timer is made to start counting up by writing "1" to PRUNx and made to stop counting by writing "0". In the STOP state, the counter data is retained until the timer is reset or placed in a RUN state. By changing states from STOP to RUN, the timer can restart counting beginning at the retained count. At initial reset, PRUNx is set to "0" (STOP).

CR0A15–CR0A0: Timer 0 comparison data A (D[F:0]) / 16-bit timer 0 comparison data A set-up register (0x48180) CR1A15–CR1A0: Timer 1 comparison data A (D[F:0]) / 16-bit timer 1 comparison data A set-up register (0x48188) CR2A15–CR2A0: Timer 2 comparison data A (D[F:0]) / 16-bit timer 2 comparison data A set-up register (0x48190) CR3A15–CR3A0: Timer 3 comparison data A (D[F:0]) / 16-bit timer 3 comparison data A set-up register (0x48198) CR4A15–CR4A0: Timer 4 comparison data A (D[F:0]) / 16-bit timer 4 comparison data A set-up register (0x481A0) CR5A15–CR5A0: Timer 5 comparison data A (D[F:0]) / 16-bit timer 5 comparison data A set-up register (0x481A8)

Sets the comparison data A of each timer.

When SELCRBx is set to "0", comparison data is directly read or writing from/to the comparison data register A. When SELCRBx is set to "1", comparison data is read or written from/to the comparison register buffer A. The content of the buffer is loaded to the comparison data register A when the counter is reset.

The data set in this register is compared with each corresponding counter data. When the contents match, a comparison A interrupt is generated and the output signal rises (OUTINVx = "0") or falls (OUTINVx = "1"). This does not affect the counter value and count-up operation.

At initial reset, CRxA is not initialized.

CR0B15–CR0B0: Timer 0 comparison data B (D[F:0]) / 16-bit timer 0 comparison data B set-up register (0x48182) CR1B15–CR1B0: Timer 1 comparison data B (D[F:0]) / 16-bit timer 1 comparison data B set-up register (0x4818A) CR2B15–CR2B0: Timer 2 comparison data B (D[F:0]) / 16-bit timer 2 comparison data B set-up register (0x48192) CR3B15–CR3B0: Timer 3 comparison data B (D[F:0]) / 16-bit timer 3 comparison data B set-up register (0x4819A) CR4B15–CR4B0: Timer 4 comparison data B (D[F:0]) / 16-bit timer 4 comparison data B set-up register (0x481A2) CR5B15–CR5B0: Timer 5 comparison data B (D[F:0]) / 16-bit timer 5 comparison data B set-up register (0x481AA)

Sets the comparison data B of each timer.

When SELCRBx is set to "0", comparison data is directly read or writing from/to the comparison data register B. When SELCRBx is set to "1", comparison data is read or written from/to the comparison register buffer B. The content of the buffer is loaded to the comparison data register B when the counter is reset.

The data set in this register is compared with each corresponding counter data. When the contents match, a comparison B interrupt is generated and the output signal falls (OUTINVx = "0") or rises (OUTINVx = "1"). Furthermore, the counter is reset to "0".

At initial reset, CRxB is not initialized.

TC015–TC00: Timer 0 counter data (D[F:0]) / 16-bit timer 0 counter data register (0x48184) TC115–TC10: Timer 1 counter data (D[F:0]) / 16-bit timer 1 counter data register (0x4818C) TC215–TC20: Timer 2 counter data (D[F:0]) / 16-bit timer 2 counter data register (0x48194) TC315–TC30: Timer 3 counter data (D[F:0]) / 16-bit timer 3 counter data register (0x4819C) TC415–TC40: Timer 4 counter data (D[F:0]) / 16-bit timer 4 counter data register (0x481A4) TC515–TC50: Timer 5 counter data (D[F:0]) / 16-bit timer 5 counter data register (0x481AC)

The counter data of each timer can be read from this register.

The data can be read out at any time.

Since TCx is a read-only register, writing to this register is ignored.

At initial reset, TCx is not initialized.

P16T02-P16T00: Timer 0 interrupt level (D[2:0]) / 16-bit timer 0/1 interrupt priority register (0x40266) P16T12-P16T10: Timer 1 interrupt level (D[6:4]) / 16-bit timer 0/1 interrupt priority register (0x40267) P16T32-P16T20: Timer 2 interrupt level (D[2:0]) / 16-bit timer 2/3 interrupt priority register (0x40267) P16T32-P16T30: Timer 3 interrupt level (D[6:4]) / 16-bit timer 2/3 interrupt priority register (0x40267) P16T42-P16T40: Timer 4 interrupt level (D[2:0]) / 16-bit timer 4/5 interrupt priority register (0x40268) P16T52-P16T50: Timer 5 interrupt level (D[6:4]) / 16-bit timer 4/5 interrupt priority register (0x40268)

Sets the priority levels of 16-bit programmable timer interrupts.

The priority level can be set in the range of 0 to 7.

At initial reset, P16Tx becomes indeterminate.

E16TU0, E16TC0: Timer 0 interrupt enable (D2, D3) / 16-bit timer 0/1 interrupt enable register (0x40272) E16TU1, E16TC1: Timer 1 interrupt enable (D6, D7) / 16-bit timer 0/1 interrupt enable register (0x40272) E16TU2, E16TC2: Timer 2 interrupt enable (D2, D3) / 16-bit timer 2/3 interrupt enable register (0x40273) E16TU3, E16TC3: Timer 3 interrupt enable (D6, D7) / 16-bit timer 2/3 interrupt enable register (0x40273) E16TU4, E16TC4: Timer 4 interrupt enable (D2, D3) / 16-bit timer 4/5 interrupt enable register (0x40274) E16TU5, E16TC5: Timer 5 interrupt enable (D6, D7) / 16-bit timer 4/5 interrupt enable register (0x40274)

Enables or disables the generation of an interrupt to the CPU.

Write "1": Interrupt enabled Write "0": Interrupt disabled Read: Valid

The E16TUx and E16TCx are provided for the comparison B and comparison A interrupt factors, respectively. The interrupt for which the bit is set to "1" is enabled, and the interrupt for which the bit is set to "0" is disabled. At initial reset, these bits are set to "0" (interrupt disabled).

F16TU0, F16TC0: Timer 0 interrupt factor flag (D2, D3) / 16-bit timer 0/1 interrupt factor flag register (0x40282) F16TU1, F16TC1: Timer 1 interrupt factor flag (D6, D7) / 16-bit timer 0/1 interrupt factor flag register (0x40282) F16TU2, F16TC2: Timer 2 interrupt factor flag (D2, D3) / 16-bit timer 2/3 interrupt factor flag register (0x40283) F16TU3, F16TC3: Timer 3 interrupt factor flag (D6, D7) / 16-bit timer 2/3 interrupt factor flag register (0x40283) F16TU4, F16TC4: Timer 4 interrupt factor flag (D2, D3) / 16-bit timer 4/5 interrupt factor flag register (0x40284) F16TU5, F16TC5: Timer 5 interrupt factor flag (D6, D7) / 16-bit timer 4/5 interrupt factor flag register (0x40284)

Indicates the status of 16-bit programmable timer interrupt generation.

#### When read

Read "1": Interrupt factor has occurred Read "0": No interrupt factor has occurred

#### When written using the reset-only method (default)

Write "1": Interrupt factor flag is reset

Write "0": Invalid

## When written using the read/write method

Write "1": Interrupt flag is set Write "0": Interrupt flag is reset

F16TUx and F16TCx are the interrupt factor flags corresponding to the comparison B and comparison A interrupts, respectively. The flag is set to "1" when each interrupt factor occurs.

At this time, if the following conditions are met, an interrupt to the CPU is generated:

1. The corresponding interrupt enable register bit is set to "1".

- 2. No other interrupt request of a higher priority has been generated.
- 3. The PSR's IE bit is set to "1" (interrupts enabled).

4. The value set in the corresponding interrupt priority register is higher than the CPU's interrupt level (IL).

The interrupt factor flag is set to "1" whenever interrupt generation conditions are met, regardless of how the interrupt enable and interrupt priority registers are set.

If the next interrupt is to be accepted after an interrupt has occurred, it is necessary that the interrupt factor flag be reset, and that the PSR be set again (by setting the IE bit to "1" after setting the IL to a value lower than the level indicated by the interrupt priority register, or by executing the reti instruction).

The interrupt factor flag can be reset only by writing to it in the software. Note that if the PSR is set again to accept interrupts generated (or if the reti instruction is executed) without resetting the interrupt factor flag, the same interrupt occurs again. Note also that the value to be written to reset the flag is "1" when the reset-only method (RSTONLY = "1") is used, and "0" when the read/write method (RSTONLY = "0") is used.

At initial reset, all these flags become indeterminate, so be sure to reset them in the software.

## **Programming Notes**

- (1) The 16-bit programmable timers clocked by the internal clock operate only when the prescaler is operating.
- (2) When setting the input clock or operation mode, make sure the 16-bit programmable timer is turned off.
- (3) If a same value is set to the comparison data A and B registers, a hazard may be generated in the output signal. Therefore, do not set the comparison registers as A = B. There is no problem when the interrupt function only is used.
- (4) When using the output clock, set the comparison data registers as  $A \ge 0$  and  $B \ge 1$ . The minimum settings are A = 0 and B = 1. In this case, the timer output clock cycle is the input clock  $\times 1/2$ .
- (5) When the comparison data registers are set as A > B in normal mode, no comparison A interrupt is generated. In this case, the output signal is fixed at the off level. In fine mode, no comparison A interrupt is generated when the comparison data registers are set as A > 2×B+
  1.
- (6) After an initial reset, the interrupt factor flag becomes indeterminate. To prevent generation of an unwanted interrupt, be sure to reset this flag and register in the software.
- (7) To prevent another interrupt from being generated by the same factor after an interrupt has occurred, be sure to reset the interrupt factor flag before setting the PSR again or executing the reti instruction.
- (8) Be aware that unnecessary pulse may be generated according to the control of the clock output and port configuration when a 16-bit programmable timer is used to output the TMx clock. For example, when TMx is set as inverted output (OUTINVx = "1"), the output waveform falls with the comparison B signal and it rises with the comparison A signal. Furthermore, the output pin is fixed at high level when PTMx is set to "0" to stop the clock output. When switching the output pin to the I/O port pin and then setting the port to low after the TMx signal falls with the comparison A signal, a high level pulse will be generated if "0" is written to PTMx before setting the port to low. It can be prevented by writing "0" to PTMx after setting the port to low.

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# **III-5 WATCHDOG TIMER**

## Configuration of Watchdog Timer

The Periheral Block incorporates a watchdog timer function to detect the CPU's crash.

This function is implemented through the use of the 16-bit programmable timer 0. When this function is enabled, an NMI (nonmaskable interrupt) is generated by the comparison B signal from the 16-bit programmable timer 0 (generating intervals can be set through the use of software). The 16-bit programmable timer 0 set in the software so as not to generate the NMI, making it possible to detect a program crash that may not pass through this processing routine.

Figure 5.1 shows the block diagram of the watchdog timer.



## Control of Watchdog Timer

## Setting the operating clock and NMI generating interval

The watchdog timer is operated by the prescaler's output clock. Therefore, the watchdog timer function cannot be used when the prescaler is inactive.

The NMI is generated every time the 16-bit programmable timer 0 is reset by the comparison B setting. Therefore, this interval is determined by the prescaler's P16TS0[2:0] (D[2:0]) / 16-bit timer 0 clock control register (0x40147), and the comparison data B set in CR0B[15:0] (D[F:0]) / 16-bit timer 0 comparison register B (0x48182).

The NMI generating interval is calculated using the following equation:

NMI generating interval =  $\frac{CR0B + 1}{f_{PSCIN} \times pdr}$  [sec.]

fPSCIN: Prescaler input clock frequency [Hz]

pdr: Prescaler's division ratio set by the P16TS0 register (1/4096, 1/1024, 1/256, 1/64, 1/16, 1/4, 1/2, 1/1) CR0B: Set value of the CR0B register (0 to 65,535)

For details on how to control the prescaler and the 16-bit programmable timer 0, refer to "Prescaler" and "16-Bit Programmable Timers".

## Setting the watchdog timer function

To use the watchdog timer function, enable the NMI that is generated by the comparison B signal from the 16-bit programmable timer 0. For this purpose, use EWD (D1) / Watchdog timer enable register (0x40171). The NMI is enabled by writing "1" to EWD. At initial reset, EWD is set to "0", so generation of the NMI is disabled.

To prevent an unwanted NMI from being generated by erroneous writing to EWD, this register is normally write-protected. To write-enable EWD, write "1" to WRWD (D7) / Watchdog timer write-protect register (0x40170). Only one writing to EWD is enabled in this way by the WRWD bit. When data is written to EWD after it is write-enabled, the WRWD bit is reset back to "0", thus making EWD write-protected again.

For the 16-bit programmable timer 0, set an appropriate comparison B value to make it start operating.

If the watchdog timer function is not to be used, set EWD to "0" and do not change it.

## Resetting the watchdog timer

When using the watchdog timer, prepare a routine to reset the 16-bit programmable timer 0 before an NMI is generated in a location where it will be periodically processed. Make sure this routine is processed within the NMI generation interval described above.

The 16-bit programmable timer 0 is reset by writing "1" to PRESET0 (D1) / 16-bit timer 0 control register (0x48186). At this point, the timer counter is set to 0, and the timer starts counting the NMI generation interval over again from that point.

If the watchdog timer is not reset within the set interval for any reason, the CPU is made to enter trap processing by an NMI and starts executing the processing routine indicated by the NMI vector. The NMI trap vector address by default is set to "0x0C0001C".

The trap table base address can be changed using the TTBR registers (0x48134 to 0x48137).

## **Operation in Standby Modes**

## **During HALT mode**

In HALT mode (basic mode or HALT2 mode), the prescaler and watchdog timer are operating. Consequently, if HALT mode continues beyond the NMI generation interval, HALT mode is cleared by the NMI.

To disable the watchdog timer in HALT mode, set EWD to "0" before executing the halt instruction or turn off the 16-bit programmable timer 0.

If the NMI is disabled by EWD, the 16-bit programmable timer 0 continues counting even in HALT mode. To reenable the NMI after clearing HALT mode, reset the 16-bit programmable timer 0 in advance. If HALT mode was entered after the 16-bit programmable timer 0 was turned off, reset the timer before restarting it.

## **During SLEEP mode**

In SLEEP mode, the prescaler is turned off. Therefore, the watchdog timer also stops operating. To prevent generation of an unwanted NMI after clearing SLEEP mode, reset the 16-bit programmable timer 0 before executing the slp instruction. In addition, disable generation of the NMI by EWD as necessary.

## I/O Memory of Watchdog Timer

Table 5.1 shows the control bits of the watchdog timer.

			-					
Register name	Address	Bit	Name	Function	Setting	Init.	R/W	Remarks
Watchdog	0040170	D7	WRWD	EWD write protection	1 Write enabled 0 Write-protect	0	R/W	
timer write-	(B)	D6-0	-	-	-	-	-	0 when being read.
protect register								
Watchdog	0040171	D7–2	-	-	-	-	-	0 when being read.
timer enable	(B)	D1	EWD	Watchdog timer enable	1 NMI enabled 0 NMI disabled	0	R/W	
register		D0	-	_	-	-	-	0 when being read.

Table 5.1 Control Bits of Watchdog Timer

WRWD: EWD write protection (D7) / Watchdog timer write-protect register (0x40170)

Enables writing to the EWD register.

Write "1": Writing enabled Write "0": Write-protected Read: Valid

The EWD bit is write-protected to prevent unwanted modifications. Writing to this bit is enabled for only one writing by setting WRWD to "1". WRWD is reset back to "0" by writing to EWD, so EWD is write-protected again. If WRWD is reset to "0" when EWD is write-enabled (WRWD = "1"), EWD becomes write-protected again. At initial reset, WRWD is set to "0" (write-protected).

#### **EWD**: NMI enable (D1) / Watchdog timer enable register (0x40171)

Controls the generation of a nonmaskable interrupt (NMI) by the watchdog timer.

Write "1": NMI is enabled Write "0": NMI is disabled Read: Valid

The watchdog timer's interrupt signal is masked by writing "0" to EWD, so a nonmaskable interrupt (NMI) to the CPU is not generated. If EWD is set to "1", an NMI is generated by the 16-bit programmable timer 0 comparison B signal.

Writing to EWD is valid only when WRWD = "1".

Even when EWD is set to "0", the 16-bit programmable timer 0 does not stop counting. Therefore, if the NMI has been temporarily disabled, be sure to reset the 16-bit programmable timer 0 before setting the EWD register back to "1".

At initial reset, EWD is set to "0" (NMI disabled).

## **Programming Notes**

- (1) If the watchdog timer's NMI is enabled, the watchdog timer must be reset in the software before the 16-bit programmable timer 0 outputs the comparison B signal.
- (2) Even when EWD is set to "0", the 16-bit programmable timer 0 does not stop counting. Therefore, if the NMI has been temporarily disabled, be sure to reset the 16-bit programmable timer 0 before setting EWD back to "1".

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# **III-6 LOW-SPEED (OSC1) OSCILLATION CIRCUIT**

## Configuration of Low-Speed (OSC1) Oscillation Circuit

The Peripheral Block has a built-in low-speed (OSC1) oscillation circuit.

The low-speed (OSC1) oscillation circuit generates a 32.768-kHz (Typ.) subclock.

The OSC1 clock output by this circuit is delivered to the CLG (clock generator) in the Core Block and is used as the source clock for the clock timer. It can also be used as a sub-clock for the low-speed (low-power) operation of the CPU and peripheral circuits (switchable in a program).

Figure 6.1 shows the configuration of the clock system.



Figure 6.1 Configuration of Clock System

The CPU operating clock can be switched to the output (OSC1 clock) of the low-speed (OSC1) oscillation circuit in a program. Furthermore, the oscillation circuit can be stopped in a program.

If the OSC3 clock is unnecessary such as when performing clock processing only, set the OSC1 clock for operation of the CPU/peripheral circuits and turn off the high-speed (OSC3) oscillation circuit in order to reduce current consumption.

The low-speed (OSC1) oscillation circuit does not stop in SLEEP mode.

For the control method when using the OSC1 clock for the operating clock of the peripheral circuits, refer to "Prescaler".

## I/O Pins of Low-Speed (OSC1) Oscillation Circuit

Table 6.1 lists the I/O pins of the low-speed (OSC1) oscillation circuit.

		Table 6.1 I/O Pins of Low-Speed (OSC1) Oscillation Circuit
Pin name	I/O	Function
OSC1	Ι	Low-speed (OSC1) oscillation input pin
		Crystal oscillation or external clock input
OSC2	0	Low-speed (OSC1) oscillation output pin
		Crystal oscillation (open when external clock is used)
P14/FOSC1/DCLK	I/O	I/O port / Low-speed (OSC1) oscillation clock output / DCLK signal output

## **Oscillator Types**

In the low-speed (OSC1) oscillation circuit, either a crystal oscillation or an external clock input can be selected as the type of oscillation circuit.

Figure 6.2 shows the structure of the low-speed (OSC1) oscillation circuit.



Figure 6.2 Low-Speed (OSC1) Oscillation Circuit

When using a crystal oscillation for this circuit, connect a crystal resonator X'tal1 (32.768 kHz, Typ.) and feedback resistor (Rf) between the OSC1 and OSC2 pins, and two capacitors (CG1, CD1) between the OSC1 pin and Vss and the OSC2 pin and Vss, respectively.

When an external clock source is used, leave the OSC2 pin open and input a square-wave clock to the OSC1 pin. If the low-speed (OSC1) oscillation circuit is not used, connect the OSC1 pin to Vss and leave the OSC2 pin open.

The oscillation frequency is 32.768 kHz (Typ.). Use a crystal resonator or external clock that oscillates at this frequency. No other frequency can be used for clock applications.

For details on oscillation characteristics and the external clock input characteristics, refer to "Electrical Characteristics".

## **Controlling Oscillation**

The low-speed (OSC1) oscillation circuit can be turned on or off using SOSC1 (D0) / Power control register (0x40180).

The oscillation circuit is turned off by writing "0" to SOSC1 and turned back on again by writing "1". SOSC1 is set to "1" at initial reset, so the oscillation circuit is turned on.

- Notes: When the low-speed (OSC1) oscillation circuit is used as the clock source for the CPU operating clock, it cannot be turned off. In this case, writing "0" to SOSC1 is ignored. Note also that writing to SOSC1 is allowed only when the power-control register protection flag is set to "0b10010110".
  - Immediately after the oscillation circuit is turned on, a certain period of time is required for oscillation to stabilize (3 sec max.). To prevent the device from operating erratically, do not use the clock until its oscillation has stabilized.

The low-speed (OSC1) oscillation circuit does not stop when the CPU is set in SLEEP mode.

## Switching Over the CPU Operating Clock

After an initial reset, the CPU starts operating using the OSC3 clock.

In cases in which some peripheral circuits (e.g., programmable timer, serial interface, and A/D converter) that are clocked by the OSC3 clock do not need to be operate and the CPU can process its jobs at a low clock speed, the CPU operating clock can be switched to the OSC1 clock, thereby reducing current consumption. Use CLKCHG (D2) / Power control register (0x40180) to switch over the operating clock.

## Procedure for switching over from the OSC3 clock to the OSC1 clock

- 1. Turn on the low-speed (OSC1) oscillation circuit (by writing "1" to SOSC1).
- 2. Wait until the OSC1 oscillation stabilizes (three seconds or more).
- 3. Change the CPU operating clock (by writing "0" to CLKCHG).
- 4. Turn off the high-speed (OSC3) oscillation circuit (by writing "0" to SOSC3).

\* Steps 1 and 2 are required only when the low-speed (OSC1) oscillation circuit is inactive.

- **Notes:** Use separate instructions to switch from OSC3 to OSC1 and turn the OSC3 oscillation off. If these operations are processed simultaneously using one instruction, the CPU may operate erratically.
  - Make sure the operation of the peripheral circuits, such as the programmable timer and serial interface, which are clocked by the OSC3 oscillation circuit, is terminated before the OSC3 oscillation is turned off in order to prevent them from operating erratically.

## Procedure for switching over from the OSC1 clock to the OSC3 clock

- 1. Turn on the high-speed (OSC3) oscillation circuit (by writing "1" to SOSC3).
- 2. Wait until the OSC3 oscillation stabilizes (10 ms or more for a 3.3-V crystal resonator).
- 3. Switch over the CPU operating clock (by writing "1" to CLKCHG).
- **Note:** The operating clock switchover by CLKCHG is effective only when both oscillation circuits are on and the power-control register protection flag is set to "0b10010110".

## **Power-Control Register Protection Flag**

The power-control register (SOSC1, SOSC3, CLKCHG, CLKDT[1:0]) at address 0x40180, which is used to control the oscillation circuits and the CPU operating clock, is normally disabled against writing in order to prevent it from malfunctioning due to unnecessary writing.

To enable this register for writing, the power-control register protection flag CLGP[7:0] (D[7:0]) / Power-control protection register (0x4019E) must be set to "0b10010110". Note that this setting allows for the power-control register (0x40180) to be written to only once, so all bits of CLGP[7:0] are cleared to "0" when this address is written to. Therefore, CLGP[7:0] must be set to "0b10010110" each time the power-control register (0x40180) is written to. The flag CLGP[7:0] does not affect the readout from the power-control register (0x40180).

## **Operation in Standby Mode**

In HALT mode, which is entered by executing the halt instruction, the low-speed (OSC1) oscillation circuits retains its status before HALT mode is entered. Under normal conditions, therefore, there is no need to control the oscillation circuit before entering or after exiting HALT mode.

The low-speed (OSC1) oscillation circuit does not stop operating in SLEEP mode set by executing the slp (sleep) instruction. Therefore, if the CPU was operating using the OSC1 clock before SLEEP mode was entered, the CPU keeps operating using the OSC1 clock in SLEEP mode.

## **OSC1 Clock Output to External Devices**

The low-speed (OSC1) oscillation clock can be output from the FOSC1 (P14) pin to external devices.

Table 6.2 OSC1 Clock Output Pin								
Pin name	I/O	Function	Function select bit					
P14/FOSC1/	I/O	I/O port / Low-speed (OSC1) oscillation	CFP14(D4) / P1 function select register (0x402D4)					
DCLK		clock output / DCLK signal output	CFEX0 (D0) / Port function extension register (0x402DF)					

## Setting the clock output pin

The pin used to output the OSC1 clock to external devices is shared with the P14 I/O port and the debug clock signal DCLK.

At cold start, it is set for the DCLK signal output (CFP14 = "0" and CFEX0 = "1"). When using the clock output function, write "1" to CFP14 and "0" to CFEX0 and "1" to IOC14 (0x402D6/D4) (refer to "I/O Ports"). At hot start, the pin retains its pre-reset status.

## **Output control**

To start clock output, write "1" to PF1ON (D0) / Clock option register (0x40190). The clock output is stopped by writing "0".

At initial reset, PF1ON is set to "0" (output disabled).





## I/O Memory of Clock Generator

Table 6.3 lists the control bits of clock generator.

Register name	Address	Bit	Name	Function		5	Settin	g	Init.	R/W	Remarks
Power control	0040180	D7	CLKDT1	System clock division ratio	CL	.KDT[1:0]	Di	vision ratio	0	R/W	
register	(B)	D6	CLKDT0	selection	1	1		1/8	0		
					1	0		1/4			
					0	) 1		1/2			
					0	) 0		1/1			
		D5	PSCON	Prescaler On/Off control	1	On	0	Off	1	R/W	
		D4–3	-	reserved			-		0	-	Writing 1 not allowed.
		D2	CLKCHG	CPU operating clock switch	1	OSC3	0	OSC1	1	R/W	
		D1	SOSC3	High-speed (OSC3) oscillation On/Off	1	On	0	Off	1	R/W	
		D0	SOSC1	Low-speed (OSC1) oscillation On/Off	1	On	0	Off	1	R/W	
Clock option	0040190	D7–4	-	-			-		-	-	0 when being read.
register	(B)	D3	HLT2OP	HALT clock option	1	On	0	Off	0	R/W	
		D2	8T1ON	OSC3-stabilize waiting function	1	Off	0	On	1	R/W	
		D1	-	reserved			-		0	-	Writing 1 not allowed.
		D0	PF10N	OSC1 external output control	1	On	0	Off	0	R/W	
Power control	004019E	D7	CLGP7	Power control register protect flag	Wri	ting 10010	)110 ((	0x96)	0	R/W	
protect register	(B)	D6	CLGP6		rem	noves the	write p	protection of	0		
		D5	CLGP5		the	power co	ntrol re	egister	0		
		D4	CLGP4		(0x4	40180) an	d the	clock option	0		
		D3	CLGP3		regi	ister (0x40	)190).		0		
		D2	CLGP2		Wri	ting anoth	er valı	ue set the	0		
		D1	CLGP1		writ	e protectio	on.		0		
		D0	CLGP0						0		
P1 function	00402D4	D7	-	reserved			-		-	-	0 when being read.
select register	(B)	D6	CFP16	P16 function selection	1	EXCL5	0	P16	0	R/W	
		D5	CFP15	P15 function selection	1	EXCL4	0	P15	0	R/W	
		D4	CFP14	P14 function selection	1	FOSC1	0	P14	0	R/W	Extended functions
		D3	CFP13	P13 function selection	1	EXCL3	0	P13	0	R/W	(0x402DF)
						T8UF3					
		D2	CFP12	P12 function selection	1	EXCL2	0	P12	0	R/W	
						T8UF2					
		D1	CFP11	P11 function selection	1	EXCL1	0	P11	0	R/W	
			05540			T8UF1		<b>B</b> 40		DAA	
		DO	CFP10	P10 function selection	1	EXCLO	0	P10	0	R/W	
						160F0					
Port function	00402DF	D7-4	-	reserved			-	D04	0	R/W	Writing 1 not allowed.
extension	(B)	03		P31 port extended function		#GARD	0	P31, etc.		R/W	
register		D2		P21 port extended function	1	#GAAS	0	P21, etc.	0	R/W	
		וט	GPEAT	function	'	DOTU	0	P11 oto		rt/ VV	
						DBCO		P13 otc			
		D0	CFFX0	P12 P14 port extended function	1	DST2	0	P12 etc.	1	R/W	
		20			'	DCLK		P14, etc.	·		

Table 6.3 Control Bits of Clock Generator

SOSC1: Low-speed (OSC1) oscillation control (D0) / Power control register (0x40180)

Turns the low-speed (OSC1) oscillation on or off.

Write "1": OSC1 oscillation turned on

Write "0": OSC1 oscillation turned off

Read: Valid

The oscillation of the low-speed (OSC1) oscillation circuit is stopped by writing "0" to SOSC1, and started again by writing "1".

Since a duration of maximum three seconds is required for oscillation to stabilize after the oscillation has been restarted, at least this length of time must pass before the OSC1 clock can be used.

Writing to SOSC1 is allowed only when CLGP[7:0] is set to "0b10010110". Note also that if the CPU is operating using the OSC1 clock, writing "0" to SOSC1 is ignored and the oscillation is not turned off.

At initial reset, SOSC1 is set to "1" (OSC1 oscillation turned on).

#### CLKCHG: CPU operating clock switch (D2) / Power control register (0x40180)

Selects the CPU operating clock.

Write "1": OSC3 clock Write "0": OSC1 clock Read: Valid

The OSC3 clock is selected as the CPU operating clock by writing "1" to CLKCHG, and OSC1 is selected by writing "0". The operating clock can be switched over in this way only when both the high-speed (OSC3) and low-speed (OSC1) oscillation circuits are on. In addition, writing to CLKCHG is effective only when CLGP[7:0] is set to "0b10010110". Immediately after the oscillation circuit has started oscillating, wait for the oscillation to stabilize before switching over the CPU operating clock.

At initial reset, CLKCHG is set to "1" (OSC3 clock).

For controlling the high-speed (OSC3) oscillation circuit, refer to "CLG (Clock Generator)" in the Core Block.

#### HLT2OP: HALT clock option (D3) / Clock option register (0x40190)

Select a HALT condition (basic mode or HALT2 mode).

Write "1": HALT2 mode Write "0": Basic mode Read: Valid

When "1" is written to HLT2OP, the CPU will enter HALT2 mode when the HALT instruction is executed. When "0" is written, the CPU will enter basic mode.

Writing to HLT2OP is allowed only when CLGP[7:0] is set to "0b10010110".

At initial reset, HLT2OP is set to "0" (basic mode).

The following shows the operating status in HALT mode (basic mode and HALT2 mode) and SLEEP mode.

Table 6.4	Operating Status in Standby Made	
1 able 0.4	Operating Status in Standby Mode	

Standt	oy mode	Operating status Reactivating factor
HALT mode	Basic mode	<ol> <li>The CPU clock is stopped. (CPU stop status)</li> <li>BCU clock is supplied. (BCU run status)</li> <li>Clocks for the peripheral circuits maintain the status before entering HALT mode.</li> <li>The high-speed oscillation circuit maintains the status before entering HALT mode.</li> <li>The low-speed oscillation circuit maintains the status before entering HALT mode.</li> </ol>
	HALT2 mode	<ol> <li>The CPU clock is stopped. (CPU stop status)</li> <li>BCU clock is stopped. (BCU stop status)</li> <li>Clocks for the peripheral circuits maintain the status before entering HALT mode. (run or stop)</li> <li>The high-speed oscillation circuit maintains the status before entering HALT mode.</li> <li>The low-speed oscillation circuit maintains the status before entering HALT mode.</li> </ol>
SLEEP mode	·	<ol> <li>The CPU clock is stopped. (CPU stop status)</li> <li>BCU clock is stopped. (BCU stop status)</li> <li>Clocks for the peripheral circuits are stopped.</li> <li>Clocks for the peripheral circuit is stopped.</li> <li>The high-speed oscillation circuit maintains the status before entering SLEEP mode.</li> <li>Clocks for the peripheral circuit are stopped.</li> <li>Clocks for the peripheral circuit is stopped.</li> <li>Clocks for the peripheral circuit is stopped.</li> <li>Clocks for the peripheral circuit is stopped.</li> <li>Clocks for the peripheral circuit is stopped.</li> <li>Clock timer interrupt when the low-speed oscillation circuit is being operated</li> </ol>

PF10N: OSC1 external output control (D0) / Clock option register (0x40190)

Turns the low-speed (OSC1) clock output to external devices on or off.

Write "1": On Write "0": Off Read: Valid

The low-speed (OSC1) clock is output from the FOSC1 pin to an external device by writing "1" to PF1ON. However, for this setting to be effective, the P14 pin must be set for the FOSC1 pin by CFP14 and CFEX0, and output must be set by setting IOC14 (D4/0x402D6 <P1 I/O control register>) to "1".

The clock output is disabled by writing "0".

Writing to PF1ON is allowed only when CLGP[7:0] is set to "0b10010110".

At initial reset, PF1ON is set to "0" (Off).

CLGP7-CLGP0: Power-control register protection flag ([D[7:0]) / Power control protection register (0x4019E)

These bits remove the protection against writing to addresses 0x40180 and 0x40190.

Write "0b10010110": Write protection removed Write other than the above: No operation (write-protected) Read: Valid

Before writing to address 0x40180 or 0x40190, set CLGP[7:0] to "0b10010110" to remove the protection against writing to that address. This clearing of write protection is effective for only one writing, so the bits are cleared to "0b00000000" by one writing. Therefore, CLGP[7:0] must be set each time the protected address is written to. At initial reset, CLGP is set to "0b00000000" (write-protected).

CFP14: P14 function selection (D4) / P1 function select register (0x402D4)

Selects the pin function of the P14 I/O port.

Write "1": OSC1 clock output pin Write "0": I/O port pin Read: Invalid

The P14 pin is set for OSC1 clock output (FOSC1) by writing "1" to CFP14.

When this pin is used as the FOSC1 output pin, also set IOC14 (D4/0x402D6 <P1 I/O control register>) to "1" (output).

At cold start, CFP14 is set to "0" (I/O port pin). At hot start, CFP14 retains its status from before the initial reset.

CFEX0: P12, P14 extended function (D0) / Port function extension register (0x402DF)

Sets whether the function of the P14 pin is to be extended.

Write "1": DCLK output pinWrite "0": P14/FOSC1 output pinRead: Invalid

When CFEX0 is set to "1", the P14 pin functions as a debug clock DCLK output pin. When CFEX0 = "0", the CFP14 register becomes effective, so the settings of this register determine whether the P14 pin functions as an P14I/O port or a FOSC1 output pin.

At cold start, CFEX0 is set to "1" (DCLK output pin). At hot start, CFEX0 retains its state from prior to the initial reset.

## **Programming Notes**

- Immediately after the low-speed (OSC1) oscillation circuit is turned on, a certain period of time is required for oscillation to stabilize (3 sec max.). To prevent the device from operating erratically, do not use the clock until its oscillation has stabilized.
- (2) The oscillation circuit used for the CPU operating clock cannot be turned off.
- (3) The CPU operating clock can only be switched over when both the OSC3 and OSC1 oscillation circuits are on. Furthermore, when turning off an oscillation circuit that has become unnecessary as a result of the CPU operating clock switchover, be sure to use separate instructions for switchover and oscillation turnoff. If these two operations are processed simultaneously using one instruction, the CPU may operate erratically.
- (4) If the low-speed (OSC1) oscillation circuit is turned off, all peripheral circuits operated using the OSC1 clock will be inactive.
- (5) If the OSC3 clock is unnecessary, use the OSC1 clock to operate the CPU and turn the high-speed (OSC3) oscillation circuit off. This helps reduce current consumption.
- (6) When the P14/FOSC1/DCLK pin is used as the FOSC1 output pin, set IOC14 (D4/0x402D6) to "1" (output) in addition to the CFP14 (D4/0x402D4) and CFEX0 (D0/0x402DF) settings.
# **III-7 CLOCK TIMER**

# Configuration of Clock Timer

The clock timer consists of an 8-bit binary counter that is clocked by a 256-Hz signal derived from the low-speed (OSC1) oscillation clock fosC1, and second, minute, hour, and day counters, allowing all data (128 Hz to 1 Hz, seconds, minutes, hours, and day) to be read out in a software. It can also generate an interrupt using a 32-Hz, 8-Hz, 2-Hz, or 1-Hz (1-second) signal or when a one-minute, one-hour, or one-day count is up, in addition to generating an alarm at a specified time (minute or hour) or day.

The low-speed (OSC1) oscillation circuit and the clock timer can be kept operating even when the CPU and other internal peripheral circuits are placed in standby mode (HALT or SLEEP).

Normally, this clock timer should be used for a clock and various other clocking functions.

Figure 7.1 shows the structure of the clock timer.

**Note:** Since the clock timer is driven by a clock originating from the low-speed (OSC1) oscillation circuit, this timer cannot be used unless the low-speed (OSC1) oscillation circuit (32.768 kHz, Typ.) is used.



Figure 7.1 Structure of Clock Timer

# Control and Operation of the Clock Timer

## **Initial setting**

At initial reset, the clock timer's counter data, setup contents of alarms, and control bits including RUN/STOP, are not initialized. (This does not include the CPU core power on/off flag TCHVOF or OSC1 auto-off flag TCAOFF.)

Therefore, when using the clock timer, initialize it as follows:

- 1. Before you start setting up, stop the clock timer and disable the clock timer interrupt.
- 2. Reset the counters.
- 3. Preset the minute, hour, and day data (only when necessary).
- 4. Select an interrupt factor.
- 5. Select the alarm function.
- 6. Enable the interrupt.
- 7. Start the clock timer.

The following shows how to set and control each of the above. For details on interrupt control, refer to "Interrupt Function".

### **Resetting the counters**

Each counter of the clock timer can only be reset to "0" in the software. Note that they are not reset by an initial reset or the auto-off function.

To reset the clock timer, write "1" to TCRST (D1) / Clock timer Run/Stop register (0x40151). Note, however, that this reset input is accepted only when the clock timer is inactive, and is ignored when the timer is operating.

- **Notes:** The clock timer reset bit TCRST and the clock timer RUN/STOP control bit TCRUN are located at the same address (0x40151). However, the clock timer cannot be reset at the same time it is set to RUN by writing "1" to both. In this case, the reset input is ignored and the timer starts counting up from the counter values then in effect. Always make sure TCRUN = "0" before resetting the timer.
  - When the counters are cleared as the clock timer is reset, an interrupt may be generated depending on the timer settings. Therefore, first disable the clock timer interrupt before resetting the clock timer, and after resetting the clock timer, reset the interrupt factor flag, interrupt factor generation flag, and alarm factor generation flag.

#### Presetting minute, hour, and day data

The clock timer's minute, hour, and day counters have a data preset function, enabling the desired time and day to be set.

Counter	Data register	Preset value
Minute counter	TCHD[5:0] (D[5:0]) / Clock timer minute register (0x40155)	0 to 59
Hour counter	TCDD[4:0] (D[4:0]) / Clock timer hour register (0x40156)	0 to 23
Day counter	TCND[15:0](D[7:0]) / Clock timer day (high-order) register (0x40158)	0 to 65535
	(D[7:0]) / Clock timer day (low-order) register (0x40157)	

Table 71	Presetting	the	Counters
	1 resetting	uie	Counters

When using the clock timer as an RTC, be sure to set these counter values before starting operating of the clock timer. For the day counter, set a number of days starting from the reference day (e.g., January 1, 1990).

### **RUN/STOP** the clock timer

The clock timer starts counting when "1" is written to TCRUN (D0) / Clock timer Run/Stop register (0x40151) and stops counting when "0" is written.

When the clock timer is made to RUN, the 256-Hz clock input is enabled at a falling edge of the low-speed (OSC1) oscillation clock pulse, and the 8-bit binary counter counts up at each falling edge of this 256-Hz clock. Figure 7.2 shows the operation of the 8-bit binary counter.

fosc1/128	256 Hz	
TCD0	128 Hz	
TCD1	64 Hz	
TCD2	32 Hz	
TCD3	16 Hz	
TCD4	8 Hz	
TCD5	4 Hz	
TCD6	2 Hz	
TCD7	1 Hz	
32 Hz i	interrupt	
8 Hz i	interrupt	<b>† † † † † † † †</b>
2 Hz i	interrupt	f f
1 Hz i	interrupt	<u>↑</u>

Figure 7.2 Timing Chart of 8-Bit Binary Counter

The 8-bit binary counter outputs a 1-Hz signal in its final stage.

The second counter counts the 1-Hz signal thus output. When it counts 60 seconds, the counter outputs a 60-second signal and is reset to 0 seconds.

Similarly, the minute and hour counters count 60 minutes and 24 hours, respectively, using the signals output by each preceding counter.

The day counter is a 16-bit binary counter and can count up to 65,536 days using the 24-hour signal output by the hour counter.

One of the following signals output by each counter can be selected to generate an interrupt:

32 Hz, 8 Hz, 2 Hz, 1 Hz (1 second), 1 minute, 1 hour, 1 day

If "0" is written to TCRUN, the clock timer is stopped at a rising edge of the low-speed (OSC1) oscillation clock to prevent device malfunction caused by the concurrent termination of counting (falling edge of the 256-Hz clock).

Even when the clock timer is stopped, each counter retains the data set at that point. When the timer is made to RUN again while in that state, each counter restarts counting from the retained value.

#### Reading out counter data

The data in each counter can be read out in a software as binary data.

Table 7.2 Reading Out Counter Data							
Counter	Counter data						
1 Hz to 128 Hz	TCD[7:0] (D[7:0]) / Clock timer divider register (0x40153)						
Second counter	TCMD[5:0] (D[5:0]) / Clock timer second counter (0x40154)						
Minute counter	TCHD[5:0] (D[5:0]) / Clock timer minute counter (0x40155)						
Hour counter	TCDD[4:0] (D[4:0]) / Clock timer hour counter (0x40156)						
Day counter	TCND[15:0](D[7:0]) / Clock timer day (high-order) counter (0x40158)						
	(D[7:0]) / Clock timer day (low-order) counter (0x40157)						

Data is read directly from the counter during operation. For this reason, a counter can overflow while reading data from each counter, so the data thus read may not be exact. For example, if the 8-bit binary counter is read at 0xFF and then overflows before reading the next seconds counter, the value of the seconds counter is its count plus the one second that has elapsed since the 8-bit binary counter was read. To prevent this problem, try reading out each counter several times and make sure data has not been modified.

### Setting alarm function

The clock timer has an alarm function, enabling an interrupt to be generated at a specified time and day. This specification can be made in minutes, hours, and days for each alarm or a combination of multiple alarms. Use TCASE[2:0] (D[4:2) / Clock timer interrupt control register (0x40152) for this specification.

TCASE2	TCASE1	TCASE0	Alarm factor							
Х	X X 1		Minutes alarm							
Х	1	Х	Hours alarm							
1	Х	Х	Day alarm							
0	0	0	None							

|--|

For example, if TCASE is set to "001", only a minutes alarm is enabled and an alarm is generated at a specified minute every hour. If TCASE is set to "111", an alarm is generated on each specified day at each specified hour and minute. If alarms are not to be used, set TCASE to "000".

An interrupt can be generated every minute, every hour, and every day through the use of the counter's interrupt function instead of the alarm function.

To specify a day, hours, and minutes, use the registers shown below:

To specify minutes:	TCCH[5:0] (D[5:0]) / Minute-comparison data register (90x40159)	0 to 59 minutes*
To specify hours:	TCCD[4:0] (D[4:0]) / Hour-comparison data register (0x4015A)	0 to 23 hours*
To specify day:	TCCN4[4:0] (D[4:0]) / Day-comparison data register 0x4015B)	0 to 31 days after

\* The minute-comparison data register (6 bits) and hour-comparison data register (5 bits) can be set for up to 63 minutes and 31 hours, respectively. Note that even when the data set in these registers exceeds 59 minutes or 23 hours, the data is not considered invalid.

The values set in these registers are compared with those of each counter, and when they match, the alarm factor generation flag TCAF (D0) / Clock timer interrupt control register (0x40152) is set to "1". If clock timer interrupts have been enabled using the interrupt controller, an interrupt is generated when the flag is set. The day-comparison data register is a 5-bit register, and its value is compared with the five low-order bits of the day counter. Therefore, an alarm can be generated for up to 31 days after the register is set.

# Interrupt Function

## **Clock timer interrupt factors**

The clock timer can generate an interrupt using a 32-Hz, 8-Hz, 2-Hz, 1-Hz (1-second), 1-minute, 1-hour, or 1-day signal. The interrupt factor to be used from among these signals can be selected using the interrupt factor selection bit TCISE[2:0] (D[7:5]) / Clock timer interrupt control register (0x40152).

I able 7.4 Selecting Interrupt Factor								
TCISE2	TCISE1	TCISE0	Interrupt factor					
1	1	1	None					
1	1	0	1 day					
1	0	1	1 hour					
1	0	0	1 minute					
0	1	1	1 Hz					
0	1	0	2 Hz					
0	0	1	8 Hz					
0	0	0	32 Hz					

Table 7.4 Selecting Interrupt Factor

An interrupt factor is generated at intervals of a selected signal (each falling edge of the signal).

If interrupts based on these signals are not to be used, set TCISE to "111".

When a selected interrupt factor is generated, the interrupt factor generation flag TCIF (D1) / Clock timer interrupt control register (0x40152) is set to "1". At the same time, the clock timer interrupt factor flag FCTM (D1) / Port input 4–7, clock timer, interrupt factor flag register (0x40287) also is set to "1". At this time, if the interrupt conditions set by the interrupt control registers are met, an interrupt to the CPU is generated.

An interrupt can be generated on a specified alarm day at a specified time as described in the preceding section. Interrupts generated by a signal and those generated by an alarm can both be used. However, since the clock timer has only one interrupt factor flag, it is the same interrupt that is generated by the timer. Therefore, if both types of interrupts are used, when an interrupt occurs, read the interrupt factor generation flag TCIF and alarm factor generation flag TCAF to determine which factor has generated the interrupt.

Once the factor generation flag is set to "1", it remains set until it is reset by writing "1" in the software. After confirming that the flag is set, write "1" to reset it.

The interrupt factor generation flag TCIF and alarm factor generation flag TCAF should be reset after at least 4 ms have passed from generation of an interrupt or an alarm.

**Note:** To prevent generation of an unwanted interrupt, disable the clock timer interrupt before selecting the interrupt and alarm factors. Then, before reenabling the interrupt, reset each factor generation flag and the interrupt factor flag.

#### Control registers of the interrupt controller

The following lists the clock timer interrupt control registers:

Interrupt factor flag: FCTM (D1) / Port input 4–7, clock timer, interrupt factor flag register (0x40287)Interrupt enable:ECTM (D1) / Port input 4–7, clock timer, interrupt enable register (0x40277)Interrupt level:PCTM[2:0] (D[2:0]) / Clock timer interrupt priority register (0x4026B)

When an interrupt factor occurs, the clock timer sets the interrupt actor flag to "1" as described above. At this time, if the interrupt enable register bit is set to "1", an interrupt request is generated.

Interrupts can be disabled by leaving the interrupt enable register bit reset to "0". The interrupt factor flag is always set to "1" when an interrupt factor is generated, regardless of the setting of the interrupt enable register (even when it is set to "0").

The interrupt priority register sets the priority levels (0 to 7) of interrupts. An interrupt request to the CPU is accepted on the condition that no other interrupt request has been generated that is of a higher priority. It is only when the PSR's IE bit = "1" (interrupts enabled) and the set value of the IL is smaller than the clock timer interrupt level set by the interrupt priority register that a clock timer interrupt request is actually accepted by the CPU.

For details on these interrupt control registers, as well as the device operation when an interrupt has occurred, refer to "ITC (Interrupt Controller)".

#### **Trap vectors**

The trap vector addresses for the clock-timer interrupt by default are set to "0x0C00104".

The trap table base address can be changed using the TTBR registers (0x48134 to 0x48137).

# Examples of Use of Clock Timer

The following shows examples of use of the clock timer and how to control the timer in each case.

### To use the clock timer as a timer/counter

Example in which while the CPU is inactive, the clock timer is kept operating in order to start again the CPU after a specified length of time has elapsed (e.g., three days):

- Make sure the low-speed (OSC1) oscillation circuit is oscillating stably (SOSC1 = "1"). Wait for approximately three seconds after the oscillation starts for its oscillation to stabilize.
- 2. Disable the clock timer interrupt using the interrupt controller (ECTM = "0").
- 3. Stop the clock timer and set "3 days" in the day-comparison register (TCRUN = "0", TCCN = "3").
- 4. Choose a "day-specified alarm" using the alarm-factor select bit and set "none" in the interrupt-factor select bit (TCASE = "100", TCISE = "111").
- 5. Reset the interrupt factor and alarm factor generation flags (FCTM = "0", TCAF = "0").
- 6. Reenable the clock timer interrupt using the interrupt controller (ECTM = "1").
- 7. Switch the CPU operating clock to the low-speed (OSC1) clock (CLKCHG = "0").
- 8. Turn off the high-speed (OSC3) oscillation circuit (SOSC3 = "0").
- 9. Reset the clock timer (TCRST = "0").
- 10. Start the clock timer (TCRUN = "1").
- 11. Execute the halt instruction to stop the CPU.

Wait until an interrupt is generated by a day-specified alarm from the clock timer. When an interrupt occurs, the CPU starts up using the OSC1 clock.

12. If necessary, turn on the high-speed (OSC3) oscillation circuit and change the CPU operating clock back to the OSC3 clock.

In the above example, if the device is reset before a three-day period has elapsed, the device operates as follows:

• The CPU starts up using the OSC3 clock.

• The clock timer counters are not reset. They remain in the RUN state.

The time during which the CPU has been idle can be checked by reading out the clock timer counters.

## For using the clock timer as RTC

Example in which the clock timer is kept operating and an alarm is generated at 10:00 A.M. every day:

- 1. Disable the clock timer interrupt using the interrupt controller (ECTM = "0").
- 2. Stop the clock timer (TCRUN = "0").
- 3. Reset the clock timer (TCRST = "1").
- 4. Set the current day and time in the minute (TCHD), hour (TCDD), and day (TCND) counters. For the day counter, set a number of days starting from the reference day (e.g., January 1, 1990). When the count is read, it is converted into the current date by the software.
- 5. Set "10:00" in the hour-compare register (TCCD = "0x0A").
- 6. Select an a "hour-specified alarm" using the alarm factor select bit, and set "none" in the interrupt factor select bit (TCASE = "010", TCISE = "111").
- 7. Reset the interrupt factor and alarm-factor generation flags (FCTM = "1", TCAF = "0").
- 8. Reenable the clock timer interrupt using the interrupt controller (ECTM = "1").
- 9. Start the clock timer (TCRUN = "1").

The clock timer is made to generate an interrupt at 10:00 every day by an hour-specified alarm.

In the above example, if any interrupt factor other than an alarm is selected, an interrupt is also generated by that interrupt factor. To determine which factor caused the interrupt generated, read the interrupt factor generation flag TCIF and alarm factor generation flag TCAF. If TCAF is set to 1, the interrupt has been caused by an alarm. If you select an interrupt factor (other than a 1-day factor) along with the hour-specified alarm, the selected interrupt factor occurs at the same time as the alarm factor.

# I/O Memory of Clock Timer

Table 7.5 shows the control bits of the clock timer.

Register name	Address	Bit	Name	Function	Setting		Init.	R/W	Remarks
Clock timer	0040151	D7–2	-	reserved		_	-	-	0 when being read.
Run/Stop	(B)	D1	TCRST	Clock timer reset	1 Reset	0 Invalid	Х	W	0 when being read.
register		D0	TCRUN	Clock timer Run/Stop control	1 Run	0 Stop	Х	R/W	Ŭ
Clock timer	0040152	D7	TCISE2	Clock timer interrupt factor	TCISE[2:0	1 Interrunt factor	x	R/W	
interrupt	(B)	D6	TCISE1	selection		None	x	1011	
control register	(-)	D5	TCISE0			Dav	x		
oonn of rogicite		20				Hour	~		
						Minute			
						1 Hz			
						2 Hz			
						8 Hz			
						32 Hz			
		D4	TCASE2	Clock timer alarm factor selection	TCASEI2:0	) Alarm factor	x	R/W	
		D3	TCASE1			Dav	x		
		D2	TCASEO		X 1 X	Hour	x		
						Minute	~		
						None			
		D1	TCIF	Interrupt factor generation flag	1 Genera	ted 0 Not generated	x	R/W	Reset by writing 1
		D0	TCAF	Alarm factor generation flag	1 Genera	ted 0 Not generated	X	R/W	Reset by writing 1
Cleak timer	0040452	D7	TCDZ		1   Liah		v		
divider register	(P)		TCDE		1 High			P	
annuer register	(6)	D6	TCD5	Clock timer data 4 Hz	1 High		$\frac{1}{2}$	P	
		D3	TCD4	Clock timer data 4 Hz	1 High		× ×		
		D4 D3	TCD4	Clock timer data 36 Hz	1 High		X	R	
		D2	TCD2	Clock timer data 32 Hz	1 High		X	R	
		D1	TCD1	Clock timer data 64 Hz	1 High		X	R	
			TCD0	Clock timer data 128 Hz	1 High	0 1 ow	X	R	
Clock timer	0040154			reconved			~		0 when being read
clock timer	(B)	D7=0		Clock timer second counter data			- V		o when being read.
register	(5)		TCMD3	TCMD5 - MSB	010	39 3600103	Ŷ		
register			TCMD3						
			TCMD3				Ŷ		
			TCMD1				Ŷ		
			TCMD0						
	0040455		TCNIDU				^		
Clock timer	0040155	D7-6		reserved	0.1	-	-	-	0 when being read.
minute register	(D)	D5			010	5 59 minutes		R/VV	
		D4							
		D3	тенра	ICHD0 = LSB			$\hat{\mathbf{v}}$		
			TCHD2				$\hat{\mathbf{v}}$		
			тенро				Ŷ		
Ola ala timan	0040450		TCHE				^		O where he is a second
Clock timer	0040156	D7-5	-		0 to 23 hours		-	-	0 when being read.
hour register	(B)	D4	TCDD4	Clock timer hour counter data	0	to 23 hours	X	R/W	
		D3	TCDD3						
			TCDD2	ICDD0 = LSB					
			TCDDT				$\hat{\mathbf{v}}$		
		U					^		
Clock timer	0040157	D7	TCND7	Clock timer day counter data	0 to	65535 days	X	R/W	
day (low-order)	(B)	D6	TCND6	(low-order 8 bits)	(IOW	-order 8 bits)	X		
register		D5	TCND5	ICND0 = LSB			X		
		D4	TCND4				X		
		D3	TCND3				X		
		D2	TCND2						
			TCND1						
		DU	TCNDU				^		
Clock timer	0040158	D7	TCND15	Clock timer day counter data	0 to 65535 days		X	R/W	
day (high-	(B)	D6	TCND14	(high-order 8 bits)	(high	n-order 8 bits)	X		
order) register		D5	TCND13	ICND15 = MSB			X		
			TCND12				X		
		D3	TCND11						
			TCNDTU						
			TCND9						
1	i i		I CND6	1	1				1

Table 7.5 Control Bits of Clock Timer

#### **III PERIPHERAL BLOCK: CLOCK TIMER**

Register name	Address	Bit	Name	Function		Set	ting	9	Init.	R/W	Remarks
Clock timer	0040159	D7–6	-	reserved		-	-		-	-	0 when being read.
minute	(B)	D5	TCCH5	Clock timer minute comparison		0 to 59	mir	nutes	Х	R/W	
comparison		D4	TCCH4	data	(N	lote) Can be	set	within 0–63.	Х		
register		D3	TCCH3	TCCH5 = MSB					Х		
		D2	TCCH2	TCCH0 = LSB					Х		
		D1	TCCH1						Х		
		D0	TCCH0						Х		
Clock timer	004015A	D7–5	-	reserved		-	-		-	-	0 when being read.
hour	(B)	D4	TCCD4	Clock timer hour comparison data		0 to 23	3 ho	ours	Х	R/W	
comparison		D3	TCCD3	TCCD4 = MSB	(N	lote) Can be	set	within 0–31.	Х		
register		D2	TCCD2	TCCD0 = LSB					Х		
		D1	TCCD1						Х		
		D0	TCCD0						Х		
Clock timer	004015B	D7–5	-	reserved		-	-		-	-	0 when being read.
day	(B)	D4	TCCN4	Clock timer day comparison data		0 to 3	1 d	ays	Х	R/W	Compared with
comparison		D3	TCCN3	TCCN4 = MSB			Х		TCND[4:0].		
register		D2	TCCN2	TCCN0 = LSB			Х				
		D1	TCCN1				Х				
		D0	TCCN0				Х				
Clock timer	004026B	D7–3	-	reserved		-	-		-	-	Writing 1 not allowed.
interrupt	(B)	D2	PCTM2	Clock timer interrupt level	0 to 7		Х	R/W			
priority register		D1	PCTM1				Х				
		D0	PCTM0				Х				
Port input 4–7,	0040277	D7–6	-	reserved		-		-	-	0 when being read.	
clock timer,	(B)	D5	EP7	Port input 7	1	Enabled	0	Disabled	0	R/W	
interrupt		D4	EP6	Port input 6					0	R/W	
enable register		D3	EP5	Port input 5					0	R/W	
		D2	EP4	Port input 4					0	R/W	
		D1	ECTM	Clock timer					0	R/W	
		D0	-	reserved	-		0	R/W	Writing 1 not allowed.		
Port input 4–7,	0040287	D7–6	-	reserved		-	-		-	-	0 when being read.
clock timer,	(B)	D5	FP7	Port input 7	1	Factor is	0	No factor is	Х	R/W	
interrupt factor		D4	FP6	Port input 6		generated		generated	Х	R/W	
flag register		D3	FP5	Port input 5					Х	R/W	
		D2	FP4	Port input 4					Х	R/W	
		D1	FCTM	Clock timer					Х	R/W	
		D0	-	reserved		-	-		Х	R/W	Writing 1 not allowed.

TCRST: Clock timer reset (D1) / Clock timer Run/Stop register (0x40151)

Resets the clock timer.

Write "1": The clock timer is reset

Write "0": Invalid

Read: Always "0"

The clock timer is reset by writing "1" to TCRST when the timer is inactive. All timer counters are cleared to "0". The clock timer cannot be reset when in the RUN state, nor can it be reset at the same time it is made to RUN through the execution of one write to address 0x40151. (The clock timer is started, but not reset.) In this case, first reset the clock timer and then use another instruction to RUN the clock timer. When the counters are cleared as the clock timer is reset, an interrupt may be generated, depending on the register settings. Therefore, before resetting the clock timer, first disable the clock timer interrupt, and after resetting the clock timer, reset the interrupt factor flag and the interrupt factor and alarm factor generation flags.

Writing "0" to TCRST results in No Operation. Since this TCRST is a write-only bit, its value when read is always "0".

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The clock timer is not reset by an initial reset.

TCRUN: Clock timer RUN/STOP control (D0) / Clock timer Run/Stop register (0x40151)

Controls the RUN/STOP of the clock timer.

Write "1": RUN Write "0": STOP Read: Valid

The clock timer is made to start counting by writing "1" to the TCRUN register and made to stop by writing "0". The timer data is retained even in the STOP state. The timer can also be made to start counting from the retained data by changing its state from STOP to RUN.

The TCRUN register is not initialized at initial reset.

TCD7–TCD0:	1–128 Hz counter data (D[7:0]) / Clock timer divider register (0x40153)
TCMD5-TCMD0:	Second counter data (D[5:0]) / Clock timer second register (0x40154)
TCHD5-TCHD0:	Minute counter data (D[5:0]) / Clock timer minute register (0x40155)
TCDD4-TCDD0:	Hour counter data (D[4:0]) / Clock timer hour register (0x40156)
TCND15-TCND0:	Day counter data (D[7:0]) / Clock timer day (high-order) register (0x40158)
	(D[7:0]) / Clock timer day (low-order) register (0x40157)

Data can be read out from each counter.

The minute, hour, and day counters allow data to be written to, in addition to being read out.

The 1–128 Hz counter and seconds counter are read-only, so writing to these registers is ignored.

The unused high-order bits at each address of the second, minute, and hour counter data are always "0" when read out.

The counter data is not initialized at initial reset.

TCCH5-TCCH0: Minute-comparison data (D[5:0]) / Clock timer minute-comparison register (0x40159) TCCD4-TCCD0: Hour-comparison data (D[4:0]) / Clock timer hour-comparison register (0x4015A) TCCN4-TCCN0: Day-comparison data (D[4:0]) / Clock timer day-comparison register (0x4015B)

Set a day on which and a time at which an alarm is to be generated.

The comparison data register corresponding to the alarm factor selected using the TCASE register is compared with the counter data, and when the data matches, an alarm interrupt request is generated.

The day-comparison data is compared with the 5 low-order bits of the day counter.

Each register can be read out.

These registers are not initialized at initial reset.

TCISE2-TCISE0: Interrupt factor selection (D[7:5]) / Clock timer interrupt control register (0x40152)

Selects the factor for which the clock timer interrupt is to be generated.

Table 7.6 Selecting Interrupt Factor									
TCISE2	TCISE1	TCISE0	Interrupt factor						
1	1	1	None						
1	1	0	1 day						
1	0	1	1 hour						
1	0	0	1 minute						
0	1	1	1 Hz						
0	1	0	2 Hz						
0	0	1	8 Hz						
0	0	0	32 Hz						

When the clock timer interrupt is enabled, an interrupt is generated cyclically at each falling edge of the selected signal. If you the interrupt caused by these factors is not be used set TCISE to "111".

TCISE is not initialized at initial reset.

**TCASE2–TCASE0**: Alarm factor select register (D[4:2]) / Clock timer interrupt control register (0x40152)

Selects the factor for which an alarm is to be generated.

Table 7.7 Selecting Alarm Factor					
TCASE2	TCASE1	Alarm factor			
Х	Х	1	Minute alarm		
Х	X 1		Hour alarm		
1	Х	Х	Day alarm		
0	0	0	None		

Use the TCASE2, TCASE1, and TCASE0 bits to select a day, hour, and minute alarm, respectively. It is therefore possible to select multiple alarm factors. When one of these bits is set to "1", the contents of the comparison data register that corresponds to the selected alarm factor is compared with the counter. If the comparison data of all selected alarm factors matches the counter data, an alarm interrupt request is generated. The comparison data register from which the alarm factor is unselected by writing "0" is not compared with the counter data. TCASE is not initialized at initial reset.

**TCIF**: Interrupt factor generation flag (D1) / Clock timer interrupt control register (0x40152)

Indicates whether an interrupt factor has occurred.

Read "1": Interrupt factor has occurred

Read "0": No interrupt factor has occurred

Write "1": Flag is reset

Write "0": Invalid

TCIF is set to "1" when an interrupt factor selected using TCISE occurs. Since there is only one source for the clock timer interrupt, use this flag to differentiate it from interrupts caused by an alarm.

Once set to "1", TCIF remains set until it is reset by writing "1".

TCIF is not initialized at initial reset.

This bit does not affect generation of an interrupt even if it is set to "1" or "0".

#### TCAF: Alarm factor generation flag (D0) / Clock timer interrupt control register (0x40152)

Indicates whether an alarm factor has occurred.

Read "1": Alarm factor has occurred

Read "0": No alarm factor has occurred

Write "1": Flag is reset

Write "0": Invalid

TCAF is set to "1" when all alarm factors selected using the TCASE register occur. Since there is only one source for the clock timer interrupt, use this flag to differentiate it from interrupts due to other interrupt factors.

Once set to "1", TCAF remains set until it is reset by writing "1".

TCAF is not initialized at initial reset.

This bit does not affect generation of an alarm even if it is set to "1" or "0".

#### PCTM2-PCTM0: Clock timer interrupt level (D[2:0]) / Clock timer interrupt priority register (0x4026B)

Sets the priority level of the clock timer interrupt between 0 and 7. At initial reset, PCTM becomes indeterminate.

**ECTM**: Clock timer interrupt enable (D1) / Port input 4–7, clock timer, interrupt enable register (0x40277)

Enables or disables generation of an interrupt to the CPU.

Write "1": Interrupt enabled Write "0": Interrupt disabled Read: Valid

This bit controls the clock timer interrupt. The interrupt is enabled by setting ECTM to "1" and is disabled by setting it to "0".

At initial reset, ECTM is set to "0" (interrupt disabled).

FCTM: Clock timer interrupt factor flag (D1) / Port input 4-7, clock timer, interrupt factor flag register (0x40287)

Indicates whether the clock timer interrupt factor has occurred.

#### When read

Read "1": Interrupt factor has occurred

Read "0": No interrupt factor has occurred

#### When written using the reset-only method (default)

Write "1": Interrupt factor flag is reset

Write "0": Invalid

#### When written using the read/write method

Write "1": Interrupt flag is set

Write "0": Interrupt flag is reset

FCTM is set to "1" when the selected interrupt factor or alarm factor occurs.

At this time, if the following conditions are met, an interrupt to the CPU is generated:

1. The corresponding interrupt enable register bit is set to "1".

2. No other interrupt request of a higher interrupt priority is generated.

3. The IE bit of the PSR is set to "1" (interrupt enabled).

4. The corresponding interrupt priority register is set to a value higher than the CPU interrupt level (IL).

The interrupt factor flag is always set to "1" when an interrupt factor occurs, no matter how the interrupt enable and interrupt priority registers are set.

For the next interrupt to be accepted after an interrupt has occurred, it is necessary that the interrupt factor flag be reset, and that the PSR be set again (by setting the IE bit to "1" after setting the IL to a value lower than the level indicated by the interrupt priority register, or by executing the reti instruction).

The interrupt factor flag can be reset only by writing to it in the software. Note that if the PSR is set again to accept generated interrupts (or if the reti instruction is executed) without the interrupt factor flag being reset, the same interrupt occurs again. Note also that the value to be written to reset the flag is "1" when the reset-only method (RSTONLY = "1") is used, and "0" when the read/write method (RSTONLY = "0") is used.

The FCTM flag becomes indeterminate at initial reset, so be sure to reset it in the software.

# **Programming Notes**

- The low-speed (OSC1) oscillation circuit, which is the clock source for the clock timer, requires a muxmum of three seconds for its oscillation to stabilize after it is started up. Therefore, immediately after power-on, wait until the oscillation stabilizes before starting the clock timer.
- (2) At initial reset, the clock timer counter data, the setup contents of alarms, and control bits, including RUN/STOP, are not initialized. Therefore, always initialize the clock timer in the software following poweron.
- (3) The clock timer reset bit TCRST and the clock timer RUN/STOP control bit TCRUN are located at the same address (0x40151). However, the clock timer cannot be reset at the same time it is set to RUN by writing "1" to both. In this case, the reset input is ignored and the timer starts counting up from the counter values then in effect. When resetting the timer, always make sure TCRUN = "0" (timer stopped).
- (4) When the counters are cleared as the clock timer is reset, an interrupt may be generated depending on the register settings. Therefore, before resetting the clock timer, first disable the clock timer interrupt and, after resetting the clock timer, reset the interrupt factor flag and the interrupt factor generation and alarm factor generation flags.
- (5) To prevent generation of an unwanted interrupt, disable the clock timer interrupt before selecting the interrupt and alarm factors. Then, before reenabling the interrupt, reset each factor generation flag and the interrupt factor flag.
- (6) The interrupt factor flag (FCTM) becomes indeterminate at initial reset. To prevent generation of an unwanted interrupt, be sure to reset the flag in a program.
- (7) To prevent regeneration of interrupts with the same factor after an interrupt has occurred, be sure to reset the interrupt factor flag (FCTM) before setting the PSR again or executing the reti instruction.

# **III-8 SERIAL INTERFACE**

# **Configuration of Serial Interfaces**

# Features of Serial Interfaces

The Peripheral Block contains two channels (Ch.0, Ch.1) of serial interfaces, the features of which are described below. The functions of these two serial interfaces are the same.

• A clock-synchronized or asynchronous mode can be selected for the transfer method.

Clock-synchronized mode

Data length: 8 bits, fixed (No start, stop, and parity bits)

Receive error: An overrun error can been detected.

#### Asynchronous mode

Data length:7 or 8 bits, selectableReceive error:Overrun, framing, or parity errors can been detected.Start bit:1 bit, fixedStop bit:1 or 2 bits, selectableParity bit:Even, odd, or none; selectable

Since the transmit and receive units are independent, full-duplex communication is possible.

- Baud-rate setting: Any desired baud rate can be set by selecting the prescaler's division ratio, setting the 8-bit programmable timer, or using external clock input (asynchronous mode only).
- The receive and transmit units are constructed with a double-buffer structure, allowing for successive receive and transmit operations.
- Three types of interrupts (transmit data empty, receive data full, and receive error) can be generated.

Figure 8.1 shows the configuration of the serial interface (one channel).



Figure 8.1 Configuration of Serial Interface

**Note:** Ch.0 and Ch.1 have the same configuration and the same function. The signal and control bit names are suffixed by a 0 or a 1 to indicate the channel number, enabling discrimination between channels 0 and 1. In this manual, however, channel numbers 0 and 1 are replaced with "x" unless discrimination is necessary, because explanations are common to both channels.

# I/O Pins of Serial Interface

Table 8.1 lists the I/O pins used by the serial interface.

 Table 8.1
 Serial-Interface Pin Configuration

Pin name I/O Function		Function	Function select bit		
P00/SIN0	I/O	I/O port / Serial IF Ch.0 data input	CFP00(D0)/P0 function select register(0x402D0)		
P01/SOUT0	I/O	I/O port / Serial IF Ch.0 data output	CFP01(D1)/P0 function select register(0x402D0)		
P02/#SCLK0	I/O	I/O port / Serial IF Ch.0 clock input/output	CFP02(D2)/P0 function select register(0x402D0)		
P03/#SRDY0	I/O	I/O port / Serial IF Ch.0 ready input/output	CFP03(D3)/P0 function select register(0x402D0)		
P04/SIN1	I/O	I/O port / Serial IF Ch.1 data input	CFP04(D4)/P0 function select register(0x402D0)		
P05/SOUT1	I/O	I/O port / Serial IF Ch.1 data output	CFP05(D5)/P0 function select register(0x402D0)		
P06/#SCLK1	I/O	I/O port / Serial IF Ch.1 clock input/output	CFP06(D6)/P0 function select register(0x402D0)		
P07/#SRDY1	I/O	I/O port / Serial IF Ch.1 ready input/output	CFP07(D7)/P0 function select register(0x402D0)		

## SINx (serial-data input pin)

This pin is used to input serial data to the device, regardless of the transfer mode.

## SOUTx (serial-data output pin)

This pin is used to output serial data from the device, regardless of the transfer mode.

## #SCLKx (clock input/output pin)

This pin is used to input or output a clock.

In the clock-synchronized slave mode, it is used as a clock input pin; in the clock-synchronized master mode, it is used as a clock output pin.

In the asynchronous mode, this pin is used as clock input when an external clock is used. This pin is not used when the internal clock is used, so it can be used as an I/O port.

## #SRDYx (ready-signal input/output pin)

This pin is used to input or output the ready signal that is used in the clock-synchronized mode.

In the clock-synchronized slave mode, it is used as a ready-signal output pin; in the clock-synchronized master mode, it is used as a ready-signal input pin.

This pin is not used in the asynchronous mode, so it can be used as an I/O port.

## Method for setting the serial-interface input/output pins

All of the pins used in the serial interface are shared with I/O ports. At cold start, they are all set for I/O port pins P0x (function select bit CFP0x = "0"). When using the serial interface, write "1" to CFP0x for the pin to be used in accordance with the channel and transfer mode used.

At hot start, the pins retain their status from prior to the reset.

# Setting Transfer Mode

The transfer mode of the serial interface can be set using SMDx[1:0] individually for each channel as shown in Table 8.2 below.

	Table	8.2 Transfer Mode
SMDx1	SMDx0	Transfer mode
1	1	8-bit asynchronous mode
1	0	7-bit asynchronous mode
0	1	Clock-synchronized slave mode
0	0	Clock-synchronized master mode

At initial reset, SMDx becomes indeterminate, so be sure to initialize it in the software.

When using the IrDA interface, set the transfer mode for the asynchronous 7-bit or asynchronous 8-bit mode. The input/output pins are configured differently, depending on the transfer mode. The pin configuration in each mode is shown in Table 8.3.

Transfer mode	SINx (P00/P04)	SOUTx (P01/P05)	#SCLKx (P02/P06)	#SRDYx (P03/P07)
8-bit asynchronous	Data input	Data output	Clock input/P port	P port
7-bit asynchronous	Data input	Data output	Clock input/P port	P port
Clock-synchronized slave	Data input	Data output	Clock input	Ready output
Clock-synchronized	Data input	Data output	Clock output	Ready input
master				

#### Table 8.3 Pin Configuration by Transfer Mode

All four pins are used in the clock-synchronized mode.

In the asynchronous mode, since #SRDYx is unused, P03 (or P07) can be used as an I/O (P) port. In addition, when an external clock is not used, P02 (or P06) can also be used as an I/O port.

The I/O control and data registers for the I/O ports used in the serial interface can be used as general-purpose read/write registers.

**Note:** To enable the IrDA interface to be set, IRMDx[1:0] (D[1:0]) / Serial I/F Ch.0 IrDA register (0x401E4) or Serial I/F Ch.1 IrDA register (0x401E9) is provided. Since these bits become indeterminate at initial reset, be sure to initialize them by writing "00" when using as the normal interface or "10" when using as the IrDA interface.

# Clock-Synchronized Interface

# **Outline of Clock-Synchronized Interface**

In the clock-synchronized transfer mode, 8 bits of data are synchronized to the common clock on both the transmit and receive sides when the data is transferred. Since the transmit and receive units both have a double-buffer structure, successive transmit and receive operations are possible. Since the clock line is shared between the transmit and receive units, the communication mode is half-duplex.

## Master and slave modes

Either the clock-synchronized master mode or the clock-synchronized slave mode can be selected using SMDx[1:0].

## Clock-synchronized master mode (SMDx[1:0] = "00")

In this mode, clock-synchronized 8-bit serial transfers, in which the serial interface functions as the master, can be performed using the internal clock to synchronize the operation of the internal shift registers.

The synchronizing clock is output from the #SCLKx pin, enabling an external (slave side) serial input/output device to be controlled. The #SRDYx pin is also used to input a signal that indicates whether the external serial input/output device is ready to transmit or receive (when ready in a low level).

## Clock-synchronized slave mode (SMDx[1:0] = "01")

In this mode, clock-synchronized 8-bit serial transfers, in which the serial interface functions as a slave, can be performed using the synchronizing clock that is supplied by an external (master side) serial input/output device. The synchronizing clock is input from the #SCLKx pin for use as the synchronizing clock of the serial interface. In addition, a #SRDYx signal indicating whether the serial interface is ready to transmit or receive (when ready in a low level) is output from the #SRDYx pin.

Figure 8.2 shows an example of how the input/output pins are connected in the clock-synchronized mode.



Figure 8.2 Example of Connection in Clock-Synchronized Mode

## Clock-synchronized transfer data format

In clock-synchronized transfers, the data format is fixed as shown below.

Data length: 8 bitsStart bit:NoneStop bit:NoneParity bit:None



Figure 8.3 Clock-Synchronized Transfer Data Format

Serial data is transmitted and received starting with the LSB.

# Setting Clock-Synchronized Interface

When performing clock-synchronized transfers via the serial interface, the following settings must be made before data transfer is actually begun:

- 1. Setting input/output pins
- 2. Setting the interface mode
- 3. Setting the transfer mode
- 4. Setting the input clock
- 5. Setting interrupts

The following explains the content of each setting. For details on interrupt settings, refer to "Serial Interface Interrupts".

**Note:** Always make sure the serial interface is inactive (TXENx and RXENx = "0") before these settings are made. A change of settings during operation may cause a malfunction.

#### Setting input/output pins

All four pins—SINx, SOUTx, #SCLKx, and #SRDYx—are used in the clock-synchronized mode. When using Ch.0, set CFP0[3:0] (D[3:0]) / P0 function select register (0x402D0) to "1111" and when using Ch.1, set CFP0[7:4] (D[7:4]) / P0 function select register (0x402D0) to "1111". (It is possible to use both channels.)

### Setting the interface mode

IRMDx[1:0] (D[1:0]) / Serial I/F Ch.0 IrDA register (0x401E4) or Serial I/F Ch.1 IrDA register (0x401E9) is used to set the interface mode (normal or IrDA interface). Write "00" to IRMDx[1:0] to choose the ordinary interface. Since IRMDx[1:0] becomes indeterminate at initial reset, it must be initialized.

#### Setting the transfer mode

Use SMDx to set the transfer mode of the serial interface as described earlier. When using the serial interface as the master for clock-synchronized transfer, set SMDx[1:0] to "00"; when using the serial interface as a slave, set SMDx[1:0] to "01".

#### Setting the input clock

#### Clock-synchronized master mode

This mode operates using an internally derived clock. The clock source for each channel is as follows: Ch.0: A clock output by 8-bit programmable timer 2

Ch.1: A clock output by 8-bit programmable timer 3

Therefore, in order for the serial interface to be used in the clock-synchronized master mode, the following conditions must be met:

1. The prescaler is feeding a clock to 8-bit programmable timer 2 (3).

2. The 8-bit programmable timer 2 (3) is generating a clock.

Any desired clock frequency can be selected by setting the division ratio of the prescaler and the reload data of the 8-bit programmable timer as necessary. The relationship between the contents of these settings and the transfer rate is expressed by Eq. 1 below.

To ensure that the duty ratio of the clock to be fed to the serial interface is 50%, the 8-bit programmable timer further divides the underflow signal frequency by 2 internally. This 1/2 frequency division is factored into Eq. 1.

 $RLD = \frac{fPSCIN \times pdr}{2 \times bps} - 1 \qquad (Eq. 1)$ 

RLD: Reload data register setup value of the 8-bit programmable timer

fPSCIN: Prescaler input clock frequency (Hz)

bps: Transfer rate (bits/second)

pdr: Division ratio of the prescaler

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**Note:** The division ratios selected by the prescaler differ between 8-bit programmable timers 2 and 3, so be careful when setting the ratio.

8-bit programmable timer 2: 1/2, 1/4, 1/8, 1/16, 1/32, 1/64, <u>1/2048</u>, <u>1/4096</u> 8-bit programmable timer 3: 1/2, 1/4, 1/8, 1/16, 1/32, 1/64, <u>1/128</u>, <u>1/256</u>

For details on how to control the prescaler and 8-bit programmable timers, refer to "Prescaler", and "8-Bit Programmable Timers".

The serial-interface control register contains an SSCKx bit to select the clock source used for the asynchronous mode. Although this bit does not affect the clock in the clock-synchronized mode, its content becomes indeterminate at initial reset. Therefore, be sure to initialize this bit by writing "0" (Internal clock), even when using the serial interface in the clock-synchronized mode.

#### Clock-synchronized slave mode

This mode operates using the clock that is output by the external master. This clock is input from the #SCLK pin.

Therefore, there is no need to control the prescaler or 8-bit programmable timer.

Initialize SSCKx by writing "1" (#SCLKx).

# Control and Operation of Clock-Synchronized Transfer

## **Transmit control**

### (1) Enabling transmit operation

Use the transmit-enable bit TXENx for transmit control.

Ch.0 transmit-enable: TXEN0 (D7) / Serial I/F Ch.0 control register (0x401E3)

Ch.1 transmit-enable: TXEN1 (D7) / Serial I/F Ch.1 control register (0x401E8)

When transmit is enabled by writing "1" to this bit, the clock input to the shift register is enabled (ready for input), thus allowing for data to be transmitted. The synchronizing clock input/output of the #SCLKx pin is also enabled (ready for input/output).

Transmit is disabled by writing "0" to TXENx.

After the P0 function select register is set for the serial interface, the I/O direction of the #SRDY and #SCLK pins are changed at follows:

#SRDY: When transmission is enabled in slave mode, P03 (P07) enters output mode. Otherwise, P03 (P07) stays in input mode.

- #SCLK: When transmission is enabled in master mode, P02 (P06) enters output mode. Otherwise, P02 (P06) stays in input mode.
- **Note:** In clock-synchronized transfers, the clock line is shared between the transmit and receive units, so the communication mode is half-duplex. Therefore, TXENx and receive-enable bit RXENx cannot be enabled simultaneously. When transmitting data, fix RXENx at "0" and do not change it during a transmit operation.

In addition, make sure TXENx is not set to "0" during a transmit operation.

#### (2) Transmit procedure

The serial interface contains a transmit shift register and a transmit data register (transmit data buffer), which are provided independently of those used for a receive operation.

Ch.0 transmit data: TXD0[7:0] (D[7:0]) / Serial I/F Ch.0 transmit data register (0x401E0)

Ch.1 transmit data: TXD1[7:0] (D[7:0]) / Serial I/F Ch.1 transmit data register (0x401E5)

The serial interface contains a status bit to indicate the status of the transmit data register.

Ch.0 transmit data buffer empty: TDBE0(D1) / Serial I/F Ch.0 status register (0x401E2)

Ch.1 transmit data buffer empty: TDBE1(D1) / Serial I/F Ch.1 status register (0x401E7)

This bit is reset to "0" by writing data to the transmit-data register, and set to "1" again (buffer empty) when the data is transferred to the shift register.

The serial interface starts transmitting when data is written to the transmit data register.

The transfer status can be checked using the transmit-completion flag (TENDx).

Ch.0 transmit-completion flag: TEND0 (D5) / Serial I/F Ch.0 status register (0x401E2)

Ch.1 transmit-completion flag: TEND1 (D5) / Serial I/F Ch.1 status register (0x401E7)

This bit goes "1" when data is being transmitted and goes "0" when the transmission has completed.

When data is transmitted successively in clock-synchronized master mode, TENDx maintains "1" until all data is transmitted (Figure 8.4). In slave mode, TENDx goes "0" every time 1-byte data is transmitted (Figure 8.5).

Following explains transmit operation in both the master and slave modes.

#### Clock-synchronized master mode

The timing at which the device starts transmitting in the master mode is as follows: When #SRDY is on a low level while TDBEx = "0" (the transmit-data register contains data written to it) or when TDBEx is set to "0" (data has been written to the transmit-data register) while #SRDY is on a low level. Figure 8.4 shows a transmit timing chart in the clock-synchronized master mode.

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Figure 8.4 Transmit Timing Chart in Clock-Synchronized Master Mode

- 1. If the **#SRDY**x signal from the slave is on a high level, the master waits until it is on a low level (ready to receive).
- 2. If #SRDYx is on a low level, the synchronizing clock input to the serial interface begins. The synchronizing clock is also output from the #SCLKx pin to the slave device.
- 3. The content of the data register is transferred to the shift register synchronously with the first falling edge of the clock. At the same time, the LSB of the data transferred to the shift register is output from the SOUTx pin.
- 4. The data in the shift register is shifted 1 bit by the next falling edge of the clock, and the bit following the LSB is output from SOUTx. This operation is repeated until all 8 bits of data are transmitted.

The slave device must take in each bit synchronously with the rising edges of the synchronizing clock.

#### Clock-synchronized slave mode

Figure 8.5 shows a transmit timing chart in the clock-synchronized slave mode.



Figure 8.5 Transmit Timing Chart in Clock-Synchronized Slave Mode

- 1. After setting the #SRDYx signal to a low level (ready to transmit), the slave waits for clock input from the master.
- 2. When the synchronizing clock is input from the #SCLKx pin, the content of the data register is transferred to the shift register synchronously with the first falling edge of the clock. At the same time, the LSB of the data transferred to the shift register is output from the SOUTx pin. The #SRDYx signal is returned to a high level at this point.
- 3. The data in the shift register is shifted 1 bit by the next falling edge of the clock, and the bit following the LSB is output from SOUTx. This operation is repeated until all 8 bits of data are transmitted.
- 4. The #SRDYx signal is set to a low level when the last bit (8th bit) is output from the SOUTx pin.

The master device must take in each bit synchronously with the rising edges of the synchronizing clock.

#### Successive transmit operations

When the data in the transmit data register is transferred to the shift register, TDBEx is reset to "1" (buffer empty). Once this occurs, the next transmit data can be written to the transmit data register, even during data transmission.

This allows data to be transmitted successively. The transmit procedure is described above.

When TDBEx is set to "1", a transmit-data empty interrupt factor occurs. Since an interrupt can be generated as set by the interrupt controller, the next piece of transmit data can be written using an interrupt processing routine.

For details on how to control interrupts, refer to "Serial Interface Interrupts".

#### (3) Terminating transmit operation

Upon completion of data transmission, write "0" to the transmit-enable bit TXENx to disable transmit operation.

### **Receive control**

#### (1) Enabling receive operation

Use the receive-enable bit RXENx for receive control.

Ch.0 receive-enable: RXEN0 (D6) / Serial I/F Ch.0 receive-enable register (0x401E3)

Ch.1 receive-enable: RXEN1 (D6) / Serial I/F Ch.1 receive-enable register (0x401E8)

When receive operations are enabled by writing "1" to this bit, clock input to the shift register is enabled (ready for input), thereby starting a data-receive operation. The synchronizing clock input/output on the #SCLKx pin also is enabled (ready for input/output). Receive operations are disabled by writing "0" to RXENx.

After the P0 function select register is set for the serial interface, the I/O direction of the #SRDY and #SCLK pins are changed at follows:

- #SRDY: When receive operation is enabled in slave mode, P03 (P07) enters output mode. Otherwise, P03 (P07) stays in input mode.
- #SCLK: When receive operation is enabled in master mode, P02 (P06) enters output mode. Otherwise, P02 (P06) stays in input mode.
- **Note:** In clock-synchronized transfers, the clock line is shared between the transmit and receive units, so the communication mode is half-duplex. Therefore, RXENx and transmit-enable bit TXENx cannot be enabled simultaneously. When receiving data, fix TXENx at "0" and do not change it during a receive operation. In addition, make sure RXENx is not set to "0" during a receive operation.

#### (2) Receive procedure

This serial interface has a receive shift register and a receive data register (receive data buffer) that are provided independently of those used for transmit operations.

Ch.0 receive data: RXD0[7:0] (D[7:0]) / Serial I/F Ch.0 receive data register (0x401E1)

Ch.1 receive data: RXD1[7:0] (D[7:0]) / Serial I/F Ch.1 receive data register (0x401E6)

The receive data can be read out from this register.

A status bit is also provided that indicates the status of the receive data register.

Ch.0 receive data buffer full: RDBF0 (D0) / Serial I/F Ch.0 status register (0x401E2)

Ch.1 receive data buffer full: RDBF1 (D0) / Serial I/F Ch.1 status register (0x401E7)

This bit is set to "1" (buffer full) when the MSB of serial data is received and the data in the shift register is transferred to the receive data register, indicating that the received data can be read out. When the data is read out, the bit is reset to "0".

The following describes a receive operation in the master and slave modes.

#### Clock-synchronized master mode

Figure 8.6 shows a receive timing chart in the clock-synchronized master mode.



Figure 8.6 Receive Timing Chart in Clock-Synchronized Master Mode

- 1. If the #SRDYx signal from the slave is on a high level, the master waits until it turns to a low level (ready to receive).
- 2. If #SRDYx is on a low level, synchronizing clock input to the serial interface begins. The synchronizing clock is also output from the #SCLKx pin to the slave device.
- 3. The slave device outputs each bit of data synchronously with the falling edges of the clock. The LSB is output first.
- 4. This serial interface takes the SIN input into the shift register at the rising edges of the clock. The data in the shift register is sequentially shifted as bits are taken in. This operation is repeated until the MSB of data is received.
- 5. When the MSB is taken in, the data in the shift register is transferred to the receive data register, enabling the data to be read out.

#### Clock-synchronized slave mode

Figure 8.7 shows a receive timing chart in the clock-synchronized slave mode.



A First data is read. C An overrun error occurs because the receive operation has completed when RDBFx = "1". B 3rd data is read. D Send the busy signal to the master device to stop the clock.

Figure 8.7 Receive Timing Chart in Clock-Synchronized Slave Mode

- 1. After setting the #SRDYx signal to a low level (ready to receive), the slave waits for clock input from the master.
- 2. The master device outputs each bit of data synchronously with the falling edges of the clock. The LSB is output first.
- 3. This serial interface takes the SIN input into the shift register at the rising edges of the clock that is input from #SCLKx. The data in the shift register is sequentially shifted as bits are taken in. This operation is repeated until the MSB of data is received.
- 4. When the MSB is taken in, the data in the shift register is transferred to the receive data register, enabling the data to be read out.

#### • Successive receive operations

When the data received in the shift register is transferred to the receive data register, RDBFx is set to "1" (buffer full), indicating that the received data can be read out.

Since the receive data register can be read out while receiving the next data, data can be received successively. The procedure for receiving is described above.

When RDBFx is set to "1", a receive-data full interrupt factor occurs. Since an interrupt can be generated as set by the interrupt controller, the received data can be read by an interrupt processing routine.

For details on how to control interrupts, refer to "Serial Interface Interrupts".

#### (3) Overrun error

If, during successive receive operation, a receive operation for the next data is completed before the receive data register is read out, the receive data register is overwritten with the new data. Therefore, the receive data register must always be read out before a receive operation for the next data is completed.

When the receive data register is overwritten, an overrun error is generated and the overrun error flag is set to "1".

Ch.0 overrun error flag: OER0 (D2) / Serial I/F Ch.0 status register (0x401E2)

Ch.1 overrun error flag: OER1 (D2) / Serial I/F Ch.1 status register (0x401E7)

Once the overrun error flag is set to "1", it remains set until it is reset by writing "0" to it in the software. The overrun error is one of the receive-error interrupt factors in the serial interface. An interrupt can be generated for this error by setting the interrupt controller as necessary, so that the error can be processed by an interrupt processing routine.

#### (4) **#SRDYx** in slave mode

When receive operations are enabled by writing "1" to RXENx, the #SRDYx signal is turned to a low level, thereby indicating to the master device that the slave is ready to receive. When the LSB of serial data is received, #SRDYx is turned to a high level; when the MSB is received, #SRDYx is returned to a low level, in preparation for the next receive operation.

If an overrun error occurs, #SRDYx is turned to a high level (unable to receive) at that point, with receive operations for the following data thus suspended. In this case, #SRDYx is returned to a low by reading out the data overwritten in the receive data register, and if any receive data follows, the slave restarts receiving data.

#### (5) Terminating receive operation

Upon completion of a data receive operation, write "0" to the receive-enable bit RXENx to disable receive operations.

# Asynchronous Interface

# **Outline of Asynchronous Interface**

Asynchronous transfers are performed by adding a start bit and a stop bit to the start and end points of each serialconverted data. With this method, there is no need to use a clock that is fully synchronized on the transmit and receive sides; instead, transfer operations are timed by the start and stop bits added to the start and end points of each data.

In the 8-bit asynchronous mode (SMDx[1:0] = "11"), 8 bits of data can be transferred; in the 7-bit asynchronous mode (SMDx[1:0] = "10"), 7 bits of data can be transferred.

In either mode, it is possible to select the stop-bit length, add a parity bit, and choose between even and odd parity. The start bit is fixed at "1".

The operating clock can be selected between an internal clock generated by an 8-bit programmable timer or an external clock that is input from the #SCLKx pin.

Since the transmit and receive units are both constructed with a double-buffer structure, successive transmit and receive operations are possible. Furthermore, since the transmit and receive units are independent, full-duplex communication in which transmit and receive operations are performed simultaneously is also possible. Figure 8.8 shows an example of how input/output pins are connected for transfers in the asynchronous mode.



When the asynchronous mode is selected, it is possible to use the IrDA interface function.

## Asynchronous-transfer data format

The data format for asynchronous transfer is shown below.

Data length: 7 or 8 bits (determined by the selected transfer mode)

Start bit: 1 bit, fixed

Stop bit: 1 or 2 bits

Parity bit: Even or odd parity, or none

Sampling clock (for transmitting)	
7-bit asynchronous mode (Stop bit: 1 bit, parity: none)	<u>s1 ( D0 ( D1 ( D2 ( D3 ) D4 ) D5 ( D6 )</u> s2
(Stop bit: 1 bit, parity: used)	<u>s1 ( D0 ) D1 ( D2 ) D3 ( D4 ) D5 ( D6 ) p </u> s2
(Stop bit: 2 bits, parity: none)	<u>s1 ( D0 ) D1 ( D2 ) D3 ( D4 ) D5 ) D6 ) s2 s3</u>
(Stop bit: 2 bits, parity: used)	s1 ( D0 ) D1 ( D2 ) D3 ( D4 ) D5 ( D6 ) p / s2 s3
8-bit asynchronous mode (Stop bit: 1 bit, parity: none)	<u>s1 ( D0 ) D1 ( D2 ) D3 ) D4 ) D5 ) D6 ) D7 </u> s2
(Stop bit: 1 bit, parity: used)	s1 ( D0 ) D1 ) D2 ( D3 ) D4 ) D5 ) D6 ) D7 ( p ) s2
(Stop bit: 2 bits, parity: non)	s1 ( D0 ) D1 ) D2 ( D3 ) D4 ) D5 ) D6 ) D7 ) s2 s3
(Stop bit: 2 bits, parity: used)	s1 ( D0 ) D1 ) D2 ( D3 ) D4 ) D5 ) D6 ) D7 ) p ) s2 s3
	s1: start bit, s2 & s3: stop bit, p: parity bit

Figure 8.9 Data Format for Asynchronous Transfer

Serial data is transmitted and received, starting with the LSB.

# Setting Asynchronous Interface

When performing asynchronous transfer via the serial interface, the following must be done before data transfer can be started:

- 1. Setting input/output pins
- 2. Setting the interface mode
- 3. Setting the transfer mode
- 4. Setting the input clock
- 5. Setting the data format
- 6. Setting interrupt

The following describes how to set each of the above. For details on interrupt settings, refer to "Serial Interface Interrupts".

**Note:** Always make sure the serial interface is inactive (TXENx and RXENx = "0") before making these settings. A change in settings during operation may result in a malfunction.

#### Setting input/output pins

In the asynchronous mode, two pins–SINx and SOUTx–are used. When external clock input is used, one more pin, #SCLKx, is also used.

Set CFP0[7:0] (D[7:0]) / P0 function select register (0x402D0) according to the pins used. (Both channels can be used, if necessary.) Since the #SRDYx pin is not used, P03 or P07 can be used as an I/O port. During operation using the internal clock, P03 or P06 can also be used as an I/O port.

#### Setting the interface mode

IRMDx[1:0] (D[1:0]) / Serial I/F Ch.0 IrDA register (0x401E4) is used to set the IrDA interface. Since IRMDx[1:0] becomes indeterminate at initial reset, initialize it by writing "00" when using the serial interface as a normal interface, or "10" when using the serial interface as an IrDA interface. This setting must be made before a transfer mode is set.

#### Setting the transfer mode

Use SMDx to set the transfer mode of the serial interface as described earlier. When using the serial interface in the 8-bit asynchronous mode, set SMDx[1:0] to "11", when using the serial interface in the 7-bit asynchronous mode, set SMDx[1:0] to "10".

#### Setting the input clock

In the asynchronous mode, the operating clock can be selected between the internal clock and an external clock. Ch.0 input clock selection: SSCK0 (D2) / Serial I/F Ch.0 control register (0x401E3)

Ch.1 input clock selection: SSCK1 (D2) / Serial I/F Ch.1 control register (0x401E8)

The external clock is selected (input from the #SCLKx pin) by writing "1" to SSCKx, and an internal clock is selected by writing "0".

Note: SSCKx becomes indeterminate at initial reset, so be sure to reset it in the software.

#### Internal clock

When the internal clock is selected, the serial interface is clocked by a clock generated using an 8-bit programmable timer. The clock source for each channel is as follows: Ch.0: Clock output by 8-bit programmable timer 2

Ch.1: Clock output by 8-bit programmable timer 3

Therefore, before the internal clock can be used, the following conditions must be met:

1. The prescaler is outputting a clock to the 8-bit programmable timer 2 (or 3).

2. The 8-bit programmable timer 2 (or 3) is outputting a clock.

Any desired clock frequency can be obtained by setting the prescaler division ratio and the reload data of the 8-bit programmable timer as necessary. The relationship between the contents of these setting and the transfer rate is expressed by Eq. 2.

The 8-bit programmable timer has its underflow signal further divided by 2 internally, in order to ensure that the duty ratio of the clock supplied to the serial interface is 50%.

Furthermore, the clock output by the 8-bit programmable timer is divided by 16 or 8 internally in the serial interface, in order to create a sampling clock (refer to "Sampling clock"). This division ratio must also be considered when setting the transfer rate.

These division ratios are taken into account in Eq. 2.

 $RLD = \frac{fPSCIN \times pdr \times sdr}{2 \times bps} - 1$  (Eq. 2)

RLD: Set value of the 8-bit programmable timer's reload data register

fPSCIN: Prescaler input clock frequency (Hz)

bps: Transfer rate (bits/second)

pdr: Division ratio of the prescaler

sdr: Internal division ratio of the serial interface (1/16 or 1/8)

**Note:** The division ratio selected using the prescaler differs between 8-bit programmable timers 2 and 3. Take this into account when setting a division ratio.

8-bit programmable timer 2: 1/2, 1/4, 1/8, 1/16, 1/32, 1/64, <u>1/2048</u>, <u>1/4096</u>

8-bit programmable timer 3: 1/2, 1/4, 1/8, 1/16, 1/32, 1/64, <u>1/128, 1/256</u>

Table 8.4 shows examples of prescaler division ratios and the reload data settings of the programmable timer, in cases in which the internal division ratio of the serial interface is set to 1/16.

Transfer rate		fpscin = 20 MHz		fpscin = 25 MHz			fpscin = 33 MHz		
(bps)	RLD	pdr	Error (%)	RLD	pdr	Error (%)	RLD	pdr	Error (%)
300	129	1/16	0.16025	162	1/16	-0.14698	216	1/16	0.00640
1200	129	1/4	0.16025	162	1/4	-0.14698	216	1/4	0.00640
2400	129	1/2	0.16025	162	1/2	-0.14698	216	1/2	0.00640
4800	64	1/2	0.16025	80	1/2	-0.46939	108	1/2	-0.45234
9600	32	1/2	-1.35732	40	1/2	-0.75584	53	1/2	0.46939
14400	21	1/2	-1.35732	13	1/4	-3.11880	35	1/2	0.46939
28800	10	1/2	-1.35732	13	1/2	-3.11880	17	1/2	0.46939

Table 8.4 Example of Transfer Rate Settings

Make sure the error is within 1%. Calculate the error using the following equation:

$$Error = \{ \frac{fPSCIN \times pdr}{(RLD + 1) \times 32 \times bps} -1 \} \times 100 [\%]$$

For details on how to control the prescaler and 8-bit programmable timers, refer to "Prescaler" and "8-Bit Programmable Timers".

## • External clock

When an external clock is selected, the serial interface is clocked by a clock input from the #SCLKx pin. Therefore, there is no need to control the prescaler and 8-bit programmable timers.

Any desired clock frequency can be set. The clock input from the #SCLKx pin is internally divided by 16 or 8 in the serial interface, in order to create a sampling clock (refer to "Sampling clock"). This division ratio must also be considered when setting the transfer rate.

#### Sampling clock

In the asynchronous mode, TCLK (the clock output by the 8-bit programmable timer or input from the #SCLKx pin) is internally divided in the serial interface, in order to create a sampling clock.

A 1/16 division ratio is selected by writing "1" to DIVMDx , and a 1/8 ratio is selected by writing "0".

Ch.0 clock division ratio selection: DIVMD0 (D4) / Serial I/F Ch.0 IrDA register (0x401E4)

Ch.1 clock division ratio selection: DIVMD1 (D4) / Serial I/F Ch.1 IrDA register (0x401E9)

**Note:** The DIVMDx bit becomes indeterminate at initial reset, so be sure to reset it in the software. Settings of this bit are valid only in the asynchronous mode (and when using the IrDA interface).



Figure 8.10 Sampling Clock for Asynchronous Receive Operation (when 1/16 division is selected)

As shown in Figure 8.10, the sampling clock is created by dividing TCLK by 16 (or 8). Its duty ratio (low: high ratio) is 6:10 (or 2:6 when divided by 8), and not 50%. Since the receive data is sampled in the middle point of each bit, the sampling clock recognizes the start bit first, and then changes the level from high to low at the second falling edge of TCLK. And at the 8th (4th for 1/8) falling edge of TCLK, it changes the level from low to high. This change in levels is repeated for the following bits of data:

Each bit of data is sampled at each rising edge of this sampling clock. When the stop bit is sampled, the sampling clock is fixed at high level until the next start bit is sampled.

If the SINx pin is returned to high level at the second falling edge of TCLK when it recognize the start bit, the data is assumed to be noise, and generation of the sampling clock is stopped.

If the SINx pin is not on a low level when the start bit is sampled at the 8th (4th for 1/8) clock, such as when the baud rate is not matched between the transmit and receive units, the serial interface stops sampling the following data and returns to a start-bit detection mode. In this case, no error is generated.



Figure 8.11 Sampling Clock for Asynchronous Transmit Operation (when 1/16 division is selected)

When transmitting data, a sampling clock of a 50% duty cycle is generated from TCLK by dividing it by 16(or 8), and each bit of data is output synchronously with this clock.

## Setting the data format

In the asynchronous mode, the data length is 7 or 8 bits as determined by the transfer mode set. The start bit is fixed at 1.

The stop and parity bits can be set as shown in the Table 8.5 using the following control bits:Stop-bit selectionCh.0: STPB0 (D3) / Serial I/F Ch.0 control register (0x401E3)Parity enableCh.0: EPR0 (D5) / Serial I/F Ch.0 control register (0x401E3)Ch.1: EPR1 (D5) / Serial I/F Ch.1 control register (0x401E3)Ch.1: EPR1 (D5) / Serial I/F Ch.1 control register (0x401E8)Parity-mode selectionCh.0: PMD0 (D4) / Serial I/F Ch.0 control register (0x401E3)

Ch.1: PMD1 (D4) / Serial I/F Ch.1 control register (0x401E8)

STPBx	EPRx	PMDx	Stop bit	Parity bit
1	1	1	2 bits	Odd
		0	2 bits	Even
	0	*	2 bits	None
0	1	1	1 bit	Odd
		0	1 bit	Even
	0	*	1 bit	Non

Table 8.5	Stop Bit	and Parity	Rit	Settings
1 able 0.5	Stop Bit	and Fanty	Ъπ	Settings

\* Setting PMDx is invalid when EPRx = "0".

Note: These bits become indeterminate at initial reset, so be sure to initialize them in the software.

# **Control and Operation of Asynchronous Transfer**

## **Transmit control**

## (1) Enabling transmit operation

Use the transmit-enable bit TXENx for transmit control. Ch.0 transmit-enable: TXEN0 (D7) / Serial I/F Ch.0 control register (0x401E3) Ch.1 transmit-enable: TXEN1 (D7) / Serial I/F Ch.1 control register (0x401E8) When transmit is enabled by writing "1" to this bit, the clock input to the shift register is enabled (ready for input), thus allowing data to be transmitted. Transmit is disabled by writing "0" to TXENx.

Note: Do not set TXENx to "0" during a transmit operation.

#### (2) Transmit procedure

The serial interface has a transmit shift register and a transmit data register (transmit data buffer) that are provided independently of those used for receive operations.

Ch.0 transmit data: TXD0[7:0] (D[7:0]) / Serial I/F Ch.0 transmit data register (0x401E0)

Ch.1 transmit data: TXD1[7:0] (D[7:0]) / Serial I/F Ch.1 transmit data register (0x401E5)

The serial interface starts a transmit operation by writing data to this register. In the 7-bit asynchronous mode, bit 7 (MSB) in each register is ignored.

The serial interface also contains a status bit to indicate the status of the transmit data register.

Ch.0 transmit data buffer empty: TDBE0 (D1) / Serial I/F Ch.0 status register (0x401E2)

Ch.1 transmit data buffer empty: TDBE1 (D1) / Serial I/F Ch.1 status register (0x401E7)

This bit is reset to "0" by writing data to the transmit data register, and set back to "1" (buffer empty) when the data is transferred to the shift register. The transfer begins when the serial interface starts sending the start bit.

The transfer status can be checked using the transmit-completion flag (TENDx).

Ch.0 transmit-completion flag: TEND0 (D5) / Serial I/F Ch.0 status register (0x401E2)

Ch.1 transmit-completion flag: TEND1 (D5) / Serial I/F Ch.1 status register (0x401E7)

This bit goes "1" when data is being transmitted and goes "0" when the transmission has completed. When data is transmitted successively in asynchronous mode, TENDx maintains "1" until all data is transmitted.



Figure 8.12 Transmit Timing Chart in Asynchronous Mode

- 1. The contents of the data register are transferred to the shift register synchronously with the first falling edge of the sampling clock. At the same time, the SOUTx pin is setting to a low level to send the start bit.
- 2. Each bit of data in the shift register is transmitted beginning with the LSB at each falling edge of the subsequent sampling clock. This operation is repeated until all 8 (or 7) bits of data are transmitted.
- 3. After sending the MSB, the parity bit (if EPRx = "1") and the stop bit are transmitted insuccession.

#### · Successive transmit operation

When the data in the transmit data register is transferred to the shift register, TDBEx is reset to "1" (buffer empty). Once this occurs, the next transmit data can be written to the transmit data register, even during data transmission.

This allows data to be transmitted successively. The transmit procedure is described above.

When TDBEx is set to "1", a transmit-data empty interrupt factor simultaneously occurs. Since an interrupt can be generated as set by the interrupt controller, the next transmit data can be written using an interrupt processing routine.

For details on how to control interrupts, refer to "Serial Interface Interrupts".

#### (3) Terminating transmit operations

When data transmission is completed, write "0" to the transmit-enable bit TXENx to disable transmit operations.

#### **Receive control**

#### (1) Enabling receive operations

Use the receive-enable bit RXENx for receive control. Ch.0 receive-enable: RXEN0 (D6) / Serial I/F Ch.0 control register (0x401E3) Ch.1 receive-enable: RXEN1 (D6) / Serial I/F Ch.1 control register (0x401E8) When receiving enabled by writing "1" to this bit, clock input to the shift register is enabled (ready for input), meaning that it is ready to receive data. Receive operations are disabled by writing "0" to RXENx.

**Note:** Do not set RXENx to "0" during a receive operation.

#### (2) Receive procedure

This serial interface has a receive shift register and a receive data register (receive data buffer) that are provided independently of those used for transmit operations.

Ch.0 receive data: RXD0[7:0] (D[7:0]) / Serial I/F Ch.0 receive data register (0x401E1) Ch.1 receive data: RXD1[7:0] (D[7:0]) / Serial I/F Ch.1 receive data register (0x401E6) Receive data can be read out from this register.

A status bit is also provided to indicate the status of the receive data register.

Ch.0 receive data buffer full: RDBF0 (D0) / Serial I/F Ch.0 status register (0x401E2)

Ch.1 receive data buffer full: RDBF1 (D0) / Serial I/F Ch.1 status register (0x401E7)

This bit is set to "1" (buffer full) when data is transferred from the shift register to the receive data register after the stop bit is sampled (the second bit if two stop bits are used), indicating that the received data can be read out. When the data is read out, the bit is reset to "0".

Figure 8.13 shows a receive timing chart in the asynchronous mode.



Figure 8.13 Receive Timing Chart in Asynchronous Mode

- 1. The serial interface starts sampling when the start bit is input (SINx = low).
- 2. When the start bit is sampled at the first rising edge of the sampling clock, each bit of receive data is taken into the shift register, beginning with the LSB at each rising edge of the subsequent clock. This operation is repeated until the MSB of data is received.
- 3. When the MSB is taken in, the parity bit that follows is also taken in (if EPRx = "1").
- 4. When the stop bit is sampled, the data in the shift register is transferred to the receive data register, enabling the data to be read out.

The parity is checked when data is transferred to the receive data register (if EPRx = "1").

**Note**: The receive operation is terminated when the first stop bit is sampled even if the stop bit is configured with two bits.

#### • Successive receive operations

When the data received in the shift register is transferred to the receive data register, RDBFx is set to "1" (buffer full), indicating that the received data can be read out. Thereafter, data can be received successively because the receive data register can be read out while the next data is received. The procedure for receiving is described above.

When RDBFx is set to "1", a receive-data full interrupt factor occurs. Since an interrupt can be generated as set by the interrupt controller, the received data can be read using an interrupt processing routine. For details on how to control interrupts, refer to "Serial Interface Interrupts".

#### (3) Receive errors

Three types of receive errors can be detected when receiving data in the asynchronous mode. Since an interrupt can be generated by setting the interrupt controller, the error can be processed using an interrupt processing routine. For details on receive error interrupts, refer to "Serial Interface Interrupts".

### • Parity error

If EPRx is set to "1" (parity added), the parity is checked when data is received.

This parity check is performed when the data received in the shift register is transferred to the receive data register in order to check conformity with PMDx settings (odd or even parity). If any nonconformity is found in this check, a parity error is assumed and the parity error flag is set to "1".

Ch.0 parity error flag: PER0 (D3) / Serial I/F Ch.0 status register (0x401E2)

Ch.1 parity error flag: PER1 (D3) / Serial I/F Ch.1 status register (0x401E7)

Even when this error occurs, the received data in error is transferred to the receive data register and the receive operation is continued. However, the content of the received data for which a parity error is flagged cannot be guaranteed.

The PERx flag is reset to "0" by writing "0".

### • Framing error

If data with a stop bit = "0" is received, the serial interface assumes that the data is out of synchronization and generates a framing error.

If two stop bits are used, only the first stop bit is checked.

When this error occurs, the framing-error flag is set to "1".

Ch.0 framing-error flag: FER0 (D4) / Serial I/F Ch.0 status register (0x401E2)

Ch.1 framing-error flag: FER1 (D4) / Serial I/F Ch.1 status register (0x401E7)

Even when this error occurs, the received data in error is transferred to the receive data register and the receive operation is continued. However, the content of the received data for which a framing error is flagged cannot be guaranteed, even if no framing error is found in the following data received.

The FERx flag is reset to "0" by writing "0".

#### Overrun error

If during successive receive operations, a receive operation for the next data is completed before the receive data register is read out, the receive data register is overwritten with the new data. Therefore, the receive data register must always be read out before a receive operation for the next data is completed.

When the receive data register is overwritten, an overrun error is generated and the overrun-error flag is set to "1".

Ch.0 overrun-error flag: OER0 (D2) / Serial I/F Ch.0 status register (0x401E2)

Ch.1 overrun-error flag: OER1 (D2) / Serial I/F Ch.1 status register (0x401E7)

Even when this error occurs, the received data in error is transferred to the receive data register and the receive operation is continued.

The OERx flag is reset to "0" by writing "0".

#### (4) Terminating receive operation

When a data receive operation is completed, write "0" to the receive-enable bit RXENx to disable receive operations.

# IrDA Interface

# **Outline of IrDA Interface**

Each channel of the serial interface contains a PPM modulator circuit, allowing an infrared-ray communication circuit to be configured based on IrDA 1.0 simply by adding a simple external circuit.



Figure 8.14 Configuration Example of IrDA Interface

This IrDA interface function can be used only when the selected transfer mode is an asynchronous mode. Since the contents of the asynchronous mode are applied directly for the serial-interface functions other than the IrDA interface unit, refer to "Asynchronous Interface", for details on how to set and control the data formats and data transfers.

# Setting IrDA Interface

When performing infrared-ray communication, the following settings must be made before communication can be started:

- 1. Setting input/output pins
- 2. Selecting the interface mode (IrDA interface function)
- 3. Setting the transfer mode
- 4. Setting the input clock
- 5. Setting the data format
- 6. Setting the interrupt
- 7. Setting the input/output logic

The contents for items 1 through 5 have been explained in connection with the asynchronous interface. For details, refer to "Asynchronous Interface". For details on item 6, refer to "Serial Interface Interrupts".

**Note:** Before making these settings, always make sure the serial interface is inactive (TXENxand RXENx are both set to "0"), as a change in settings during operation could cause a malfunction. In addition, be sure to set the transfer mode in (3) and the following items before selecting the IrDA interface function in (2).

### Selecting the IrDA interface function

To use the IrDA interface function, select it using the control bits shown below and then set the 8-bit (or 7-bit) asynchronous mode as the transfer mode.

Ch.0 IrDA interface-function selection: IRMD0[1:0] (D[1:0]) / Serial I/F Ch.0 IrDA register (0x401E4) Ch.1 IrDA interface-function selection: IRMD1[1:0] (D[1:0]) / Serial I/F Ch.1 IrDA register (0x401E9)

Table 6.6 Setting of ILDA Interface					
IRMDx1	IRMDx0	Interface mode			
1	1	Do not set. (reserved)			
1	0	IrDA 1.0 interface			
0 1 Do not set. (re		Do not set. (reserved)			
0	0	Normal interface			

Table 8.6	Setting of	IrDA	Interface
	Settinu Or	IIDA	intenace

Note: The IRMDx bit becomes indeterminate when initially reset, so be sure to initialize it in the software.

#### Setting the input/output logic

When using the IrDA interface, the logic of the input/output signals of the PPM modulator circuit can be changed in accordance with the infrared-ray communication module or the circuit connected externally to the chip. The logic of the internal serial interface is "active-low". If the input/output signals are active-high, the logic of these signals must be inverted before they can be used. The input SINx and output SOUTx logic can be set individually through the use of the IRRLx and IRTLx bits, respectively.

IrDA input logic inversion	Ch.0: IRRL0 (D2) / Serial I/F Ch.0 IrDA	register (0x401E4)
	Ch.1: IRRL1 (D2) / Serial I/F Ch.1 IrDA	register (0x401E9)
IrDA output logic inversion	Ch.0: IRTL0 (D3) / Serial I/F Ch.0 IrDA	register (0x401E4)
	Ch.1: IRTL1 (D3) / Serial I/F Ch.1 IrDA	register (0x401E9)

The logic of the input/output signal is inverted by writing "1" to each corresponding bit. Logic is not inverted if the bit is set to "0".



**Note:** The IRRLx and IRTLx bits become indeterminate at initial reset, so be sure to initialize them in the software.

# Control and Operation of IrDA Interface

The transmit/receive procedures have been explained in the section on the asynchronous interface, so refer to "Control and Operation of Asynchronous Transfer".

The following describes the data modulation and demodulation performed using the PPM modulator circuit:

## When transmitting

During data transmission, the pulse width of the serial interface output signal is set to 3/16 before the signal is output from the SOUTx pin.



Figure 8.16 Data Modulation by PPM Circuit

## When receiving

During data reception, the pulse width of the input signal from SINx is set to 16/3 before the signal is transferred to the serial interface.



Figure 8.17 Demodulation by PPM Circuit

**Note:** When using the IrDA interface, set the internal division ratio of the serial interface 1/16 (DIVMDx = "1"), rather than 1/8 (DIVMDx = "0").

# Serial Interface Interrupts

The serial interface can generate the following three types of interrupts in each channel:

- Transmit-buffer empty interrupt
- Receive-buffer full interrupt
- Receive-error interrupt

#### Transmit-buffer empty interrupt factor

This interrupt factor occurs when the transmit data set in the transmit data register is transferred to the shift register, in which case the interrupt factor flag FSTXx is set to "1". At this time, if the interrupt conditions set using the interrupt control register are met, an interrupt to the CPU is generated.

Occurrence of this interrupt factor indicates that the next transmit data can be written to the transmit data register.

#### **Receive-completion interrupt**

This interrupt factor occurs when a receive operation is completed and the receive data taken into the shift register is transferred to the receive data register, in which case the interrupt factor flag FSRXx is set to "1". At this time, if the interrupt conditions set using the interrupt control register are met, an interrupt to the CPU is generated. Occurrence of this interrupt factor indicates that the received data can be read out.

#### **Receive-error interrupt**

This interrupt factor occurs when a parity, framing, or overrun error is detected during data reception, in which case the interrupt factor flag FSERRx is set to "1". At this time, if the interrupt conditions set using the interrupt control register are met, an interrupt to the CPU is generated.

Since all three types of errors generate the same interrupt factor, check the error flags PERx (parity error), OERx (overrun error), and FERx (framing error) to identify the type of error that has occurred. In the clock-synchronized mode, parity and framing errors do not occur.

**Note:** If a receive error (parity or framing error) occurs, the receive-error interrupt and receive-buffer full interrupt factors occur simultaneously. However, since the receive-error interrupt has priority over the receive-buffer full interrupt, the receive-error interrupt is processed first. It is therefore necessary for the receive-buffer full interrupt factor flag be cleared through the use of the receive-error interrupt processing routine.

	T			
Channel	Interrupt factor	Interrupt factor flag	Interrupt enable register	Interrupt priority register
Ch.0	Receive-error interrupt	FSERR0(D0/0x40286)	ESERR0(D0/0x40276)	PSIO0[2:0](D[6:4]/0x40269)
	Receive-buffer full	FSRX0(D1/0x40286)	ESRX0(D1/0x40276)	
	Transmit-buffer empty	FSTX0(D2/0x40286)	ESTX0(D2/0x40276)	
Ch.1	Receive-error interrupt	FSERR1(D3/0x40286)	ESERR1(D3/0x40276)	PSIO1[2:0](D[2:0]/0x4026A)
	Receive-buffer full	FSRX1(D4/0x40286)	ESRX1(D4/0x40276)	
	Transmit-buffer empty	FSTX1(D5/0x40286)	ESTX1(D5/0x40276)	

#### Control registers of the interrupt controller

Table 8.7 shows the interrupt controller's control registers provided for each interrupt source (channel).

When the interrupt factor described above occurs, the corresponding interrupt factor flag is set to "1". If the interrupt enable register bit for that interrupt factor has been set to "1", an interrupt request is generated. Interrupts caused by an interrupt factor can be disabled by leaving the interrupt enable register bit for that factor set to "0". The interrupt factor flag is set to "1" whenever interrupt conditions are met, regardless of the setting of the interrupt enable register (even if it is set to "0").

The interrupt priority register sets the interrupt priority level of each interrupt source in a range between 0 and 7. An interrupt request to the CPU is accepted only when no other interrupt request of a higher priority has been generated.

In addition, only when the PSR's IE bit = "1" (interrupts enabled) and the set value of the IL is smaller than the input interrupt level set by the interrupt priority register, will the input interrupt request actually be accepted by the CPU.

For details on these interrupt control registers, as well as the device operation when an interrupt has occurred, refer to "ITC (Interrupt Controller)".

## **Trap vectors**

The trap-vector address of each default interrupt factor is set as follows:

Ch.0 receive-error interrupt:	0x0C000E0
Ch.0 receive-buffer full interrupt:	0x0C000E4
Ch.0 transmit-buffer empty interrupt:	0x0C000E8
Ch.1 receive-error interrupt:	0x0C000EC
Ch.1 receive-buffer full interrupt:	0x0C000F0
Ch.1 transmit-buffer empty interrupt:	0x0C000F4

The base address of the trap table can be changed using the TTBR register (0x48134 to 0x48137).
# I/O Memory of Serial Interface

Table 8.8 shows the control bits of the serial interface.

For details on the I/O memory of the prescaler that is used to set clocks, as well of that of 8-bit programmable timers, refer to "Prescaler" and "8-Bit Programmable Timers", respectively.

Register name	Address	Bit	Name	Function			Setti	ng	I	Init.	R/W	Remarks
Serial I/F Ch.0	00401E0	D7	TXD07	Serial I/F Ch.0 transmit data		0x0 t	o 0xF	F(	0x7F)	Х	R/W	7-bit asynchronous
transmit data	(B)	D6	TXD06	TXD07(06) = MSB						х		mode does not use
register		D5	TXD05	TXD00 = LSB						Х		TXD07.
		D4	TXD04							Х		
		D3	TXD03							Х		
		D2	TXD02							х		
		D1	TXD01							Х		
		D0	TXD00						Х			
Serial I/F Ch.0	00401E1	D7	RXD07	Serial I/F Ch.0 receive data		0x0 t	o 0xF	F(	0x7F)	Х	R	7-bit asynchronous
receive data	(B)	D6	RXD06	RXD07(06) = MSB						х		mode does not use
register		D5	RXD05	RXD00 = LSB						Х		RXD07 (fixed at 0).
		D4	RXD04							Х		
		D3	RXD03							Х		
		D2	RXD02							Х		
		D1	RXD01							Х		
		D0	RXD00							Х		
Serial I/F Ch.0	00401E2	D7–6	-	-			-			-	-	0 when being read.
status register	(B)	D5	TEND0	Ch.0 transmit-completion flag	1	Transmit	ting	0	End	0	R	
		D4	FER0	Ch.0 flaming error flag	1	Error		0	Normal	0	R/W	Reset by writing 0.
		D3	PER0	Ch.0 parity error flag	1	Error		0	Normal	0	R/W	Reset by writing 0.
		D2	OER0	Ch.0 overrun error flag	1	Error		0	Normal	0	R/W	Reset by writing 0.
		D1	TDBE0	Ch.0 transmit data buffer empty	1	Empty		0	Buffer full	1	R	
		D0	RDBF0	Ch.0 receive data buffer full	1	Buffer fu	III	0	Empty	0	R	
Serial I/F Ch.0	00401E3	D7	TXEN0	Ch.0 transmit enable	1	Enabled	1	0	Disabled	0	R/W	
control register	(B)	D6	RXEN0	Ch.0 receive enable	1	Enabled	1	0	Disabled	0	R/W	
		D5	EPR0	Ch.0 parity enable	1	With pa	rity	0	No parity	Х	R/W	Valid only in
		D4	PMD0	Ch.0 parity mode selection	1	Odd		0	Even	Х	R/W	asynchronous mode.
		D3	STPB0	Ch.0 stop bit selection	1	2 bits		0	1 bit	Х	R/W	
		D2	SSCK0	Ch.0 input clock selection	1	#SCLK0	)	0	Internal clock	Х	R/W	
		D1	SMD01	Ch.0 transfer mode selection	SI	MD0[1:0]	Т	rar	nsfer mode	Х	R/W	
		D0	SMD00		1	1   1	8-b	it a	synchronous	Х		
					1	1 0	7-b	it a	synchronous			
						) 1	CI	ocł	sync. Slave			
					(	0 0	Clo	ock	sync. Master			
Serial I/F Ch.0	00401E4	D7–5	-	-			_	_		-	-	0 when being read.
IrDA register	(B)	D4	DIVMD0	Ch.0 async. clock division ratio	1	1/8		0	1/16	Х	R/W	
		D3	IRTL0	Ch.0 IrDA I/F output logic inversion	1	Inverted		0	Direct	Х	R/W	Valid only in
		D2	IRRL0	Ch.0 IrDA I/F input logic inversion	1	Inverted		0	Direct	X	R/W	asynchronous mode.
		D1	IRMD01	Ch.0 interface mode selection	IR	MD0[1:0	1	1/	F mode	X	R/W	
		DO	IRMD00					r	eserved	х		
								1	rDA 1.0			
								r	eserved			
		_						Ge	eneral I/F			
Serial I/F Ch.1	00401E5	D7	TXD17	Serial I/F Ch.1 transmit data		0x0 t	o OxF	F(	0x7F)	X	R/W	7-bit asynchronous
transmit data	(B)	D6	TXD16	IXD17(16) = MSB						X		mode does not use
register		D5	TXD15	TXD10 = LSB						X		TXD17.
		D4	TXD14							X		
		D3	TXD13							X		
		D2	TXD12							X		
		D1	TXD11							X		
	0040456				╞	0.0			075)	^ 		7 63
Serial I/F Ch.1	00401E6		RXD17	Serial I/F Ch.1 receive data		OXO t	O UXF	· F (	UX7F)	X	R	7-bit asynchronous
receive data	(B)	D6	RXD16	KXD17(16) = MSB						X		mode does not use
register		D5	RXD15	KAD10 = LSB						X		KAD17 (fixed at 0).
										X		
		D3								X		
										X		
										×		
1		00	KYD10	1	1					X		1

Table 8.8 Control Bits of Serial Interface

#### **III PERIPHERAL BLOCK: SERIAL INTERFACE**

Register name	Address	Bit	Name	Function	Setting		J	Init.	R/W	Remarks		
Serial I/F Ch.1	00401E7	D7–6	-	-				-		-	-	0 when being read.
status register	(B)	D5	TEND1	Ch.1 transmit-completion flag	1	Tran	smitting	g 0	End	0	R	
		D4	FER1	Ch.1 flaming error flag	1	Erro	or	0	Normal	0	R/W	Reset by writing 0.
		D3	PER1	Ch.1 parity error flag	1	Erro	or	0	Normal	0	R/W	Reset by writing 0.
		D2	OER1	Ch.1 overrun error flag	1	Erro	or	0	Normal	0	R/W	Reset by writing 0.
		D1	TDBE1	Ch.1 transmit data buffer empty	1	Emp	oty	0	Buffer full	1	R	
		DU	RDBF1	Ch.1 receive data butter full	1	Buff	er tull	0	Empty	0	R	
Serial I/F Ch.1	00401E8	D7	TXEN1	Ch.1 transmit enable	1	Ena	bled	0	Disabled	0	R/W	
control register	(6)	D6	EDD1	Ch.1 narity onable	1	Ena	Died	0	No parity	V		Valid only in
		D3 D4	PMD1	Ch 1 parity mode selection	1	Odd	i panty I	0	Even	X	R/W	asynchronous mode
		D3	STPB1	Ch.1 stop bit selection	1	2 bit	ts	0	1 bit	X	R/W	
		D2	SSCK1	Ch.1 input clock selection	1	#SC	LK1	0	Internal clock	Х	R/W	
		D1	SMD11	Ch.1 transfer mode selection	S	MD1	[1:0]	Trar	nsfer mode	Х	R/W	
		D0	SMD10			1	1 8	3-bit a	synchronous	X		
						1	0 7	7-bit a	synchronous			
						0	1	Clock	sync. Slave			
						0	0	CIOCK	sync. Master			
Serial I/F Ch.1	00401E9	D7-5	-			4 (0		-	4/40	-	-	0 when being read.
IrDA register	(B)	D4		Ch.1 async. clock division ratio	1	1/8	rtod	0	1/16 Direct	×	R/W	Valid only in
		D3 D2		Ch 1 IrDA I/F input logic inversion	1	Inve	arted	0	Direct	×	R/W	asynchronous mode
		D2		Ch 1 interface mode selection	IR	MD1	[1:0]	10	E mode	x	R/W	asynchronous mode.
		D0	IRMD10			1	1	n n	eserved	x		
						1	0	I	rDA 1.0			
						0	1	r	eserved			
					- (	0	0	Ge	eneral I/F			
8-bit timer,	0040269	D7	-	reserved				-		-	-	0 when being read.
serial I/F Ch.0	(B)	D6	PSIO02	Serial interface Ch.0			0	to 7		X	R/W	
interrupt		D5	PSIO01	Interrupt level						X		
priority register		D4	PSIO00	reconved						X		0 when being read
		D3 D2	- P8TM2	8-bit timer 0-3 interrupt level			0	- to 7		- X		o when being read.
		D1	P8TM1				0	10 1		x	1011	
		D0	P8TM0							х		
Serial I/F Ch.1,	004026A	D7–3	-	reserved				-		-	-	0 when being read.
interrupt	(B)	D2	PSIO12	Serial interface Ch.1			0	to 7		Х	R/W	
priority register		D1	PSIO11	interrupt level						Х		
		D0	PSIO10							Х		
Serial I/F	0040276	D7–6	-	reserved						_	-	0 when being read.
interrupt	(B)	D5	ESTX1	SIF Ch.1 transmit buffer empty	1	Ena	bled	0 Disabled		0	R/W	
enable register		D4	ESRX1	SIF Ch.1 receive butter full						0	R/W	
		D3 D2	ESERRI	SIF Ch.1 receive error						0	R/W	
		D2	FSRX0	SIF Ch 0 receive buffer full						0	R/W	
		D0	ESERRO	SIF Ch.0 receive error						0	R/W	
Serial I/F	0040286	D7-6	_	reserved				_		_	_	0 when being read
interrupt factor	(B)	D5	FSTX1	SIF Ch.1 transmit buffer empty	1	Fact	tor is	0	No factor is	Х	R/W	g
flag register		D4	FSRX1	SIF Ch.1 receive buffer full	1	gene	erated		generated	Х	R/W	1
		D3	FSERR1	SIF Ch.1 receive error						Х	R/W	
		D2	FSTX0	SIF Ch.0 transmit buffer empty						Х	R/W	
		D1	FSRX0	SIF Ch.0 receive buffer full						X	R/W	
		D0	FSERR0	SIF Ch.0 receive error						X	R/W	
P0 function	00402D0	D7	CFP07	P07 function selection	1	#SR	DY1	0	P07	0	R/W	Extended functions
select register	(B)	D6	CFP06	P06 function selection	1	#50		0	P06	0	R/W	(0x402DF)
			CFP05	P05 function selection	1	SIN	1	0	P05	0	R/W	
		D3	CFP03	P03 function selection	1	#SR		0	P03	0	R/W	
		D2	CFP02	P02 function selection	1	#SC	LK0	0	P02	0	R/W	
		D1	CFP01	P01 function selection	1	SOL	JT0	0	P01	0	R/W	
		D0	CFP00	P00 function selection	1	SIN	0	0	P00	0	R/W	
Port function	00402DF	D7–4	-	reserved				-		0	R/W	Writing 1 not allowed.
extension	(B)	D3	CFEX3	P31 port extended function	1	#GA	RD	0	P31, etc.	0	R/W	
register			CFEX2	P21 port extended function	1	#GA	AS	0	P21, etc.	0	R/W	
		וט	CFEX1	Fiu, P11, P13 port extended	1	וצטן דפח	1U T1	0	P10, etc.	1	K/W	
				Turiotion .		DPC	20		P13. etc.			
		D0	CFEX0	P12, P14 port extended function	1	DST	2	0	P12, etc.	1	R/W	
						DCL	ĸ		P14, etc.			

CFP07-CFP00: P0[7:0] pin function selection (D[7:0]) / P0 function select register (0x402D0)

Selects the pins used for the serial interface.

Write "1": Serial-interface input/output pin Write "0": I/O port pin Read: Valid

Select the pins used for the serial interface from among P00 through P07 by writing "1" to CFP00 through CFP07. P00–P03 (SIN0, SOUT0, #SCLK0, #SRDY0) are used for channel 0; P04–P07 (SIN1, SOUT1, #SCLK1, #SRDY1) are used for channel 1. If the bit for a pin is set to "0", the pin functions as an I/O port. The necessary input/output pins differ depending on the transfer mode set (see Table 8.3). At cold start, CFP is set to "0" (I/O port). At hot start, CFP retains its state from prior to the initial reset.

TXD07–TXD00: Ch.0 transmit data (D[7:0]) / Serial I/F Ch.0 transmit data register (0x401E0) TXD17–TXD10: Ch.1 transmit data (D[7:0]) / Serial I/F Ch.1 transmit data register (0x401E5)

Sets transmit data.

When data is written to this register (transmit buffer) after "1" is written to TXENx, a transmit operation is begun. TDBEx is set to "1" (transmit-buffer empty) when the data is transferred to the shift register. A transmit-buffer empty interrupt factor is simultaneously generated. The next transmit data can be written to the buffer at any time thereafter, even when the serial interface is sending data.

In the 7-bit asynchronous mode, TXDx7 (MSB) is ignored.

The serial-converted data is output from the SOUT pin beginning with the LSB, in which the bits set to "1" are output as high-level signals and those set to "0" output as low-level signals.

This register can be read as well as written.

At initial reset, the content of TXDx becomes indeterminate.

**RXD07–RXD00**: Ch.0 receive data (D[7:0]) / Serial I/F Ch.0 receive data register (0x401E1) **RXD17–RXD10**: Ch.1 receive data (D[7:0]) / Serial I/F Ch.1 receive data register (0x401E6)

Stores received data.

When a receive operation is completed and the data received in the shift register is transferred to this register (receive buffer), RDBFx is set to "1" (receive buffer full). At the same time, a receive-buffer full interrupt factor is generated. Thereafter, the data can be read out at any time before a receive operation for the next data is completed. If the next data receive operation is completed before this register is read out, the data in it is overwritten with the newly received data, causing an overrun error to occur.

In the 7-bit asynchronous mode, "0" is stored in RXDx7.

The serial data input from the SINx pin is converted into parallel data beginning with the LSB, with the high-level signals changed to "1"s and the low-level signals changed to "0"s. The resulting data is stored in this buffer. This register is a read-only register, so no data can be written to it.

At initial reset, the content of RXDx becomes indeterminate.

#### **TEND0**: Ch.0 transmit-completion flag (D5) / Serial I/F Ch.0 status register (0x401E2) **TEND1**: Ch.1 transmit-completion flag (D5) / Serial I/F Ch.1 status register (0x401E7)

Indicates the transmission status.

- Read "1": During transmitting Read "0": End of transmission
  - Write: Invalid

TENDx goes "1" when data is being transmitted and goes "0" when the transmission has completed.

When data is transmitted successively in clock-synchronized master mode or asynchronous mode, TENDx maintains "1" until all data is transmitted (see Figure 8.4 and Figure 8.12). In clock-synchronized slave mode, TENDx goes "0" every time 1-byte data is transmitted (see Figure 8.5).

At initial reset, TENDx is set to "0" (End of transmission).

**FER0**: Ch.0 framing-error flag (D4) / Serial I/F Ch.0 status register (0x401E2) **FER1**: Ch.1 framing-error flag (D4) / Serial I/F Ch.1 status register (0x401E7)

Indicates whether a framing error occurred.

Read "1": An error occurred Read "0": No error occurred Write "1": Invalid Write "0": Reset to "0"

The FERx flag is an error flag indicating whether a framing error occurred. When an error has occurred, it is set to "1". A framing error occurs when data with a stop bit = "0" is received in the asynchronous mode. The FERx flag is reset by writing "0".

At initial reset, as well as when RXENx and TXENx both are set to "0", the FERx flag is set to "0" (no error).

**PER0**: Ch.0 parity-error flag (D3) / Serial I/F Ch.0 status register (0x401E2) **PER1**: Ch.1 parity-error flag (D3) / Serial I/F Ch.1 status register (0x401E7)

Indicates whether a parity error occurred.

Read "1": An error occurred Read "0": No error occurred Write "1": Invalid Write "0": Reset to "0"

The PERx flag is an error flag indicating whether a parity error occurred. When an error has occurred, it is set to "1". Parity checks are valid only in the asynchronous mode with EPRx set to "1" (parity added). This check is performed when the received data is transferred from the shift register to the receive data register.

The PERx flag is reset by writing "0".

At initial reset, as well as when RXENx and TXENx both are set to "0", PERx is set to "0" (no error).

**OER0**: Ch.0 overrun-error flag (D2) / Serial I/F Ch.0 status register (0x401E2) **OER1**: Ch.1 overrun-error flag (D2) / Serial I/F Ch.1 status register (0x401E7)

Indicates whether an overrun error occurred.

Read "1": An error occurred Read "0": No error occurred Write "1": Invalid Write "0": Reset to "0"

The OERx flag is an error flag indicating whether an overrun error occurred. When an error has occurred, it is set to "1". An overrun error occurs when the next receive operation is completed before the receive data register is read out, resulting in the receive data register being overwritten.

The OERx flag is reset by writing "0".

At initial reset, as well as when RXENx and TXENx both are set to "0", OERx is set to "0" (no error).

# **TDBE0**: Ch.0 transmit data buffer empty (D1) / Serial I/F Ch.0 status register (0x401E2) **TDBE1**: Ch.1 transmit data buffer empty (D1) / Serial I/F Ch.1 status register (0x401E7)

Indicates the status of the transmit data register (buffer).

Read "1": Buffer empty Read "0": Buffer full Write: Invalid

TDBEx is set to "0" when transmit data is written to the transmit data register, and is set to "1" when this data is transferred to the shift register (transmit operation started).

Transmit data is written to the transmit data register when this bit = "1".

At initial reset, TDBEx is set to "1" (buffer empty).

**RDBF0**: Ch.0 receive data buffer full (D0) / Serial I/F Ch.0 status register (0x401E2) **RDBF1**: Ch.1 receive data buffer full (D0) / Serial I/F Ch.1 status register (0x401E7)

Indicates the status of the receive data register (buffer).

Read "1": Buffer full Read "0": Buffer empty Write: Invalid

RDBFx is set to "1" when the data received in the shift register is transferred to the receive data register (receive operation completed), indicating that the received data can be read out. This bit is reset to "0" when the data is read out.

At initial reset, RDBFx is set to "0" (buffer empty).

**TXEN0**: Ch.0 transmit enable (D7) / Serial I/F Ch.0 control register (0x401E3) **TXEN1**: Ch.1 transmit enable (D7) / Serial I/F Ch.1 control register (0x401E8)

Enables each channel for transmit operations.

Write "1": Transmit enabled Write "0": Transmit disabled Read: Valid

When TXENx for a channel is set to "1", the channel is enabled for transmit operations. When TXENx is set to "0", the channel is disabled for transmit operations.

Always make sure the TXENx = "0" before setting the transfer mode and other conditions. At initial reset, TXENx is set to "0" (transmit disabled).

**RXEN0**: Ch.0 receive enable (D6) / Serial I/F Ch.0 control register (0x401E3) **RXEN1**: Ch.1 receive enable (D6) / Serial I/F Ch.1 control register (0x401E8)

Enables each channel for receive operations.

Write "1": Receive enabled Write "0": Receive disabled Read: Valid

When RXENx for a channel is set to "1", the channel is enabled for receive operations. When RXENx is set to "0", the channel is disabled for receive operations.

Always make sure the RXENx = "0" before setting the transfer mode and other conditions. At initial reset, RXENx is set to "0" (receive disabled).

**EPR0**: Ch.0 parity enable (D5) / Serial I/F Ch.0 control register (0x401E3) **EPR1**: Ch.1 parity enable (D5) / Serial I/F Ch.1 control register (0x401E8)

Selects a parity function.

Write "1": Parity added Write "0": No parity added Read: Valid

EPRx is used to select whether receive data is to be checked for parity, and whether a parity bit is to be added to transmit data. When EPRx is set to "1", the receive data is checked for parity. A parity bit is automatically added to the transmit data. When EPRx is set to "0", parity is not checked and no parity bit is added.

The parity function is only valid in the asynchronous mode. Settings of EPRx have no effect in the clocksynchronized mode.

At initial reset, EPRx becomes indeterminate.

**PMD0**: Ch.0 parity mode selection (D4) / Serial I/F Ch.0 control register (0x401E3) **PMD1**: Ch.1 parity mode selection (D4) / Serial I/F Ch.1 control register (0x401E8)

Selects an odd or even parity.

Write "1": Odd parity Write "0": Even parity Read: Valid

Odd parity is selected by writing "1" to PMDx, and even parity is selected by writing "0". Parity check and the addition of a parity bit are only effective in asynchronous transfers in which EPRx is set to "1". If EPRx = "0", settings of PMDx do not have any effect.

At initial reset, PMDx becomes indeterminate.

**STPB0**: Ch.0 stop bit selection (D3) / Serial I/F Ch.0 control register (0x401E3) **STPB1**: Ch.1 stop bit selection (D3) / Serial I/F Ch.1 control register (0x401E8)

Selects a stop-bit length during the performance of an asynchronous transfer.

Write "1": 2 bits Write "0": 1 bit Read: Valid

STPBx is only valid in an asynchronous transfer. Two stop bits are selected by writing "1" to STPBx, and one stop bit is selected by writing "0". The start bit is fixed at 1 bit.

Settings of STPBx are ignored during the performance of a clock-synchronized transfer. At initial reset, STPBx becomes indeterminate.

**SSCK0**: Ch.0 input clock selection (D2) / Serial I/F Ch.0 control register (0x401E3) **SSCK1**: Ch.1 input clock selection (D2) / Serial I/F Ch.1 control register (0x401E8)

Selects the clock source for an asynchronous transfer.

Write "1": #SCLK (external clock) Write "0": Internal clock Read: Valid

During operation in the asynchronous mode, this bit is used to select the clock source between an internal clock (output by an 8-bit programmable timer) and an external clock (input from the #SCLKx pin). An external clock is selected by writing "1" to this bit, and an internal clock is selected by writing "0". At initial reset, SSCKx becomes indeterminate.

**SMD01–SMD00**: Ch.0 transfer mode selection (D[1:0]) / Serial I/F Ch.0 control register (0x401E3) **SMD11–SMD10**: Ch.1 transfer mode selection (D[1:0]) / Serial I/F Ch.1 control register (0x401E8)

Sets the transfer mode of the serial interface as shown in Table 8.9 below.

	l able 8.9	Setting of Transfer Mode					
SMDx1	SMDx0 Transfer mode						
1	1	8-bit asynchronous mode					
1	0	7-bit asynchronous mode					
0	1	Clock-synchronized slave mode					
0	0	Clock-synchronized master mode					

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The SMDx bit can be read as well as written.

When using the IrDA interface, always be sure to set an asynchronous mode for the transfer mode. At initial reset, SMDx becomes indeterminate.

**DIVMD0**: Sampling clock division ratio (D4) / Serial I/F Ch.0 IrDA register (0x401E4) **DIVMD1**: Sampling clock division ratio (D4) / Serial I/F Ch.1 IrDA register (0x401E9)

Selects the division ratio of the sampling clock.

Write "1": 1/8 Write "0": 1/16 Read: Valid

Select the division ratio necessary to generate the sampling clock for asynchronous transfers. When DIVMDx is set to "1", the sampling clock is generated from the input clock of the serial interface (output by an 8-bit programmable timer or input from #SCLKx) by dividing it by 8. When DIVMDx is set to "0", the input clock is divided by 16. At initial reset, DIVMDx becomes indeterminate.

**IRTL0**: Ch.0 IrDA output logic inversion (D3) / Serial I/F Ch.0 IrDA register (0x401E4) **IRTL1**: Ch.1 IrDA output logic inversion (D3) / Serial I/F Ch.1 IrDA register (0x401E9)

Inverts the logic of the IrDA output signal.

Write "1": Inverted Write "0": Not inverted Read: Valid

When using the IrDA interface, set the logic of the SOUTx output signal to suit the infrared-ray communication circuit that is connected external to the chip. If IRTLx is set to "1", a high pulse is output when the output data = "0" (held low-level when the output data = "1"). If IRTLx is set to "0", a low pulse is output when the output data = "0" (held high-level when the output data = "1").

At initial reset, IRTLx becomes indeterminate.

**IRRL0**: Ch.0 IrDA input logic inversion (D2) / Serial I/F Ch.0 IrDA register (0x401E4) **IRRL1**: Ch.1 IrDA input logic inversion (D2) / Serial I/F Ch.1 IrDA register (0x401E9)

Inverts the logic of the IrDA input signal.

Write "1": Inverted Write "0": Not inverted Read: Valid

When using the IrDA interface, set the logic of the signal that is input from an external infrared-ray communication circuit to the chip to suit the serial interface. If IRRLx is set to "1", a high pulse is input as a logic "0". If IRRLx is set to "0", a low pulse is input as a logic "0".

At initial reset, IRRLx becomes indeterminate.

**IRMD01–IRMD00**: Ch.0 IrDA interface mode selection (D[1:0]) / Serial I/F Ch.0 IrDA register (0x401E4) **IRMD11–IRMD10**: Ch.1 IrDA interface mode selection (D[1:0]) / Serial I/F Ch.1 IrDA register (0x401E9)

Selects the IrDA interface function.

Table 8.10 IrDA Interface Setting									
IRMDx1	IRMDx0	Interface mode							
1	1	Do not set. (reserved)							
1	0	IrDA 1.0 interface							
0	1	Do not set. (reserved)							
0	0	Normal interface							

When using the IrDA interface function, write "10" to IRMDx while setting to an asynchronous mode for the transfer mode. If the IrDA interface function is not to be used, write "00" to IRMDx. At initial reset, IRMDx becomes indeterminate.

Note: This selection must always be performed before the transfer mode and other conditions are set.

**PSIO02–PSIO00**: Ch.0 interrupt level (D[6:4]) / 8-bit timer, serial I/F Ch.0 interrupt priority register (0x40269) **PSIO12–PSIO10**: Ch.1 interrupt level (D[2:0]) / Serial I/F Ch.1, A/D interrupt priority register (0x4026A)

Sets the priority level of the serial-interface interrupt.

The interrupt priority level can be set for each channel in the range of 0 to 7.

At initial reset, PSIOx becomes indeterminate.

**ESERR0, ESRX0, ESTX0**: Ch.0 interrupt enable (D0,D1,D2) / Serial I/F interrupt enable register (0x40276) **ESERR1, ESRX1, ESTX1**: Ch.1 interrupt enable (D3,D4,D5) / Serial I/F interrupt enable register (0x40276)

Enable or disable interrupt generation to the CPU.

Write "1": Interrupt enabled

Write "0": Interrupt disabled Read: Valid

The ESERRx, ESRXx, and ESTXx bits are interrupt enable bits corresponding to receive-error, receive-buffer full, and transmit-buffer empty interrupt factors, respectively, in each channel. The interrupts for which this bit is set to "1" are enabled, and the interrupts for which this bit is set to "0" are disabled.

At initial reset, all these bits are set to "0" (interrupts disabled).

**FSERR0, FSRX0, FSTX0**: Ch.0 interrupt factor flags (D0,D1,D2) / Serial I/F interrupt factor flag register (0x40286) **FSERR1, FSRX1, FSTX1**: Ch.1 interrupt factor flags (D3,D4,D5) / Serial I/F interrupt factor flag register (0x40286)

Indicate the status of serial-interface interrupt generation.

#### When read

Read "1": An interrupt factor occurred

Read "0": No interrupt factor occurred

#### When written using the reset-only method (default)

Write "1": Flag is reset

Write "0": Invalid

#### When written using the read/write method

Write "1": Flag is set

Write "0": Flag is reset

The FSERRx, FSRXx, and FSTXx flags are interrupt factor flags corresponding to receive-error, receive-buffer full, and transmit-buffer empty interrupts, respectively, in each channel. The flag is set to "1" when each interrupt factor occurs.

A transmit-buffer empty interrupt factor occurs when transmit data is transferred from the transmit data register to the shift register.

A receive-buffer full interrupt factor occurs when receive data is transferred from the shift register to the receive data register.

A receive-error interrupt factor occurs when a parity, framing, or overrun error is detected during reception of data. At this time, if the following conditions are met, an interrupt to the CPU is generated:

1. The corresponding interrupt enable register bit is set to "1".

2. No other interrupt request of a higher priority has been generated.

3. The PSR's IE bit is set to "1" (interrupts enabled).

4. The set value of the corresponding interrupt priority register is higher than the CPU interrupt level (IL).

The interrupt factor flag is set to "1" whenever an interrupt factor occurs, regardless of the settings of the interruptenable and interrupt priority registers.

If the next interrupt is to be accepted following the occurrence of an interrupt, it is necessary that the interrupt factor flag be reset, and that the PSR be set up again (by setting the IE bit to "1" after setting the IL to a value lower than the level indicated by the interrupt priority register, or by executing the reti instruction).

The interrupt factor flag can only be reset by writing to it in the software. Note that if the PSR is set up again to accept interrupts generated (or if the reti instruction is executed) without resetting the interrupt factor flag, the same interrupt occurs again. Note also that the value to be written to reset the flag is "1" when the reset-only method (RSTONLY = "1") is used, and "0" when the read/write method (RSTONLY = "0") is used.

At initial reset, all of these flags become indeterminate, so be sure to reset them in the software.

# Programming Notes

- (1) Before setting various serial-interface parameters, make sure the transmit and receive operations are disabled (TXENx = RXENx = "0").
- (2) When the serial interface is transmitting or receiving data, do not set TXENx or RXENx to "0", and do not execute the slp instruction.
- (3) In clock-synchronized transfers, the mode of communication is half-duplex, in which the clock line is shared between the transmit and receive units. Therefore, RXENx and TXENx cannot be enabled simultaneously.
- (4) After an initial reset, the interrupt factor flag becomes indeterminate. To prevent generation of an unwanted interrupt, reset this flag in the program.
- (5) If a receive error occurs, the receive-error interrupt and receive-buffer full interrupt factors occur simultaneously. However, since the receive-error interrupt has priority over the receive-buffer full interrupt, the receive-error interrupt is processed first. Therefore, it is necessary to reset the receive-buffer full interrupt factor flag through the use of the receive-error interrupt processing routine
- (6) To prevent the regeneration of interrupts due to the same factor following the occurrence of an interrupt, always be sure to reset the interrupt factor flag before setting the PSR again or executing the reti instruction.
- (7) Follow the procedure described below to initialize the serial interface.



Figure 8.18 Serial Interface Initialize Procedure

- (8) When transmitting data in the clock-synchronized master mode, transmit data is written to the transmit data register after the initial setting is performed following the flow in item (7). However, the clock generated by the 8-bit timer must be supplied to the serial interface (at least one underflow has had to have occurred in the 8-bit tier) before this writing. Otherwise, 0xFF will be transmitted prior to the written data.
- (9) The maximum transfer rate of the serial interface is limited to 1 Mbps.
- (10) If the receive circuit is stopped during reception, set both transmission and reception to the disabled status.

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# **III-9 INPUT/OUTPUT PORTS**

The Peripheral Block has a total of 29 input/output ports. Although each pin is used for input/output from/to the internal peripheral circuits, some pins can be used as general-purpose input/output ports unless they are used for the peripheral circuits.

# I/O Ports (P Ports)

# Structure of I/O Port

The Peripheral Block contains 29 bits of I/O ports (P00 to P07, P10 to P16, P20 to P27, P30 to P35) that can be directed for input or output through the use of a program.

Figure 9.1 shows the structure of a typical I/O port.



Figure 9.1 Structure of I/O Port

# I/O Port Pins

The I/O ports concurrently serve as the input/output pins for peripheral circuits, as shown in Table 9.1. Whether they are used as I/O ports or for peripheral circuits can be set bit-for-bit using a function select register. All pins not used for peripheral circuits can be used as general-purpose I/O ports.

Pin name	1/0	Pull-up	Function	Function select bit				
P00/SIN0	1/0		I/O port / Serial IF Ch.0 data input	CFP00(D0)/P0 function select register(0x402D0)				
P01/SOUT0	I/O	_	I/O port / Serial IF Ch.0 data output	CFP01(D1)/P0 function select register(0x402D0)				
P02/#SCLK0	I/O	_	I/O port / Serial IF Ch.0 clock input/output	CFP02(D2)/P0 function select register(0x402D0)				
P03/#SRDY0	I/O	-	I/O port / Serial IF Ch.0 ready input/output	CFP03(D3)/P0 function select register(0x402D0)				
P04/SIN1	I/O	-	I/O port / Serial IF Ch.1 data input	CFP04(D4)/P0 function select register(0x402D0)				
P05/SOUT1	I/O	-	I/O port / Serial IF Ch.1 data output	CFP05(D5)/P0 function select register(0x402D0)				
P06/#SCLK1	I/O	-	I/O port / Serial IF Ch.1 clock input/output	CFP06(D6)/P0 function select register(0x402D0)				
A23/P07/#SRDY	I/O	-	Address bus (A23) / I/O port / Serial IF Ch. 0	CFA23 (D7)/Address bus function select register				
			data input	(0x40300)				
				CFP07 (D7)/P0 function select register (0x402D0)				
P10/EXCL0/	I/O	-	I/O port / 16-bit timer 0 event counter input (I) /	CFP10(D0)/P1 function select register(0x402D4)				
T8UF0/DST0 *			8-bit timer 0 output (O) / DST0 output (Ex)	CFEX1(D1)/Port function extension register(0x402DF)				
P11/EXCL1/	I/O	-	I/O port / 16-bit timer 1 event counter input (I) /	CFP11(D1)/P1 function select register(0x402D4)				
T8UF1/DST1 *			8-bit timer 1 output (O) / DST1 output (Ex)	CFEX1(D1)/Port function extension register(0x402DF)				
P12/EXCL2/	I/O	-	I/O port / 16-bit timer 2 event counter input (I) /	CFP12(D2)/P1 function select register(0x402D4)				
T8UF2/DST2 *			8-bit timer 2 output (O) / DST2 output (Ex)	CFEX0(D0)/Port function extension register(0x402DF)				
P13/EXCL3/	I/O	-	I/O port / 16-bit timer 3 event counter input (I) /	CFP13(D3)/P1 function select register(0x402D4)				
T8UF3/DPCO *			8-bit timer 3 output (O) / DPCO output (Ex)	CFEX1(D1)/Port function extension register(0x402DF)				
P14/FOSC1/	I/O	-	I/O port / Low-speed (OSC1) clock output /	CFP14(D4)/P1 function select register(0x402D4)				
DCLK *			DCLK output (Ex)	CFEX0(D0)/Port function extension register(0x402DF)				
#CE4/P15/	I/O	-	Area 4 chip enable / I/O port / 16-bit timer 4	CFCE4 (D0)/Chip enable function select register				
EXCL4			event counter input (I)	(0x40301)				
				CFP15 (D5)/P1 function select register (0x402D4)				
#CE5/P16/	I/O	-	Area 5 chip enable / I/O port / 16-bit timer 5	CFCE5 (D1)/Chip enable function select register				
EXCL5			event counter input (I)	(0x40301)				
				CFP16 (D6)/P1 function select register (0x402D4)				

(I): Input mode, (O): Output mode, (Ex): Extended function

\*: A 3-V system I/O voltage can only be used for the P10–P14 pins.

Pin name	I/O	Pull-up	Function	Function select bit
#CE6/P20/#DRD	I/O	-	Area 6 chip enable / I/O port / #DRD output	CFCE6 (D2)/Chip enable function select register
				(0x40301)
				CFP20 (D0)/P2 function select register (0x402D8)
#CE7/P21/	I/O	-	Area 7 chip enable / I/O port / #DWE output /	CFCE7 (D3)/Chip enable function select register
#DWE/#GAAS			GA address strobe output (Ex)	(0x40301)
				CFP21 (D1)/P2 function select register (0x402D8)
				CFEX2 (D2)/Port function extension register (0x402DF)
P22/TM0	I/O	-	I/O port / 16-bit timer 0 output	CFP22(D2)/P2 function select register(0x402D8)
P23/TM1	I/O	-	I/O port / 16-bit timer 1 output	CFP23(D3)/P2 function select register(0x402D8)
P24/TM2	I/O	-	I/O port / 16-bit timer 2 output	CFP24(D4)/P2 function select register(0x402D8)
P25/TM3	I/O	-	I/O port / 16-bit timer 3 output	CFP25(D5)/P2 function select register(0x402D8)
P26/TM4	I/O	-	I/O port / 16-bit timer 4 output	CFP26(D6)/P2 function select register(0x402D8)
P27/TM5	I/O	-	I/O port / 16-bit timer 5 output	CFP27(D7)/P2 function select register(0x402D8)
P30/#WAIT/ #CE4&5	I/O	-	I/O port / #WAIT input (I) / #CE4&5 output (O)	CFP30 (D0)/P3 function select register (0x402DC)
#CE8/P31/	I/O	_	Area 8 chip enable / I/Oport / #BUSGET output	CFCE8 (D4)/Chip enable function select register
#BUSGET/			/ GA read signal output (Ex)	(0x40301)
#GARD				CFP31 (D1)/P3 function select register (0x402DC)
				CFEX3 (D3)/Port function extension register (0x402DF)
#CE9/P32	I/O	_	Area 9 chip enable / I/O port	CFCE9 (D5)/Chip enable function select register
				(0x40301)

(I): Input mode, (O): Output mode, (Ex): Extended function

#### **III PERIPHERAL BLOCK: INPUT/OUTPUT PORTS**

Pin name	I/O	Pull-up	Function	Function select bit
A20/P33	I/O	-	Address bus (A20) / I/O port	CFA20 (D4)/Address bus function select register
				(0x40300)
A21/P34/	I/O	-	Address bus (A21) / I/O port / #BUSREQinput	CFA21 (D5)/Address bus function select register
#BUSREQ/#CE6			(I) / #CE6 output (O)	(0x40300)
				CFP34 (D4)/P3 function select register 0x402DC)
A22/P35/	I/O	-	Address bus(A22)/I/O port/#BUSACK output	CFA22 (D6)/Address bus function select register
#BUSACK				(0x40300)
				CFP35 (D5)/P3 function select register 0x402DC)

(I): Input mode, (O): Output mode, (Ex): Extended function

At cold start, all pins are set for I/O ports Pxx (function select register CFPxx = "0"). When these pins are used for the internal peripheral circuits, write "1" to CFPxx. For details on pin functions in this case, refer to the description of each peripheral circuit in this manual.

At hot start, the pins retain their state from prior to the reset.

In addition to being an I/O port, the P10–P13, P30 and P34 pins are shared with two types (three types for P10–P13) of peripheral circuits. The type of peripheral circuit for which these pins are used is determined by the direction (input or output) in which the pin is set using an I/O control register, as will be described later.

The P10–P14, P21 and P31 ports have extended functions indicated with (Ex) in the table. They can be selected by writing "1" to CFEXx / Port function extension register (0x402DF).

The setting of CFEXx has priority over the CFPxx.

At cold start, CFEX1 and CFEX0 are set to "1", so the P10–P14 pins are set for debug signal outputs.

## I/O Control Register and I/O Modes

The I/O ports are directed for input or output modes by writing data to an I/O control register corresponding to each port bit.

P07–P00 I/O control: IOC0[7:0] (D[7:0]) / P0 I/O control register (0x402D2)

P16–P10 I/O control: IOC1[6:0] (D[6:0]) / P1 I/O control register (0x402D6)

P27–P20 I/O control: IOC2[7:0] (D[7:0]) / P2 I/O control register (0x402DA)

P35–P30 I/O control: IOC3[5:0] (D[5:0]) / P3 I/O control register (0x402DE)

To set an I/O port for input, write "0" to the I/O control bit. I/O ports set for input mode are placed in the high-impedance state, and thus function as input ports.

In the input mode, the state of the input pin is read directly, so the data is "1" when the pin state is high (VDD level) or "0" when the pin state is low (Vss level).

Even in the input mode, data can be written to the data register without affecting the pin state.

To set an I/O port for output, write "1" to the I/O control bit. I/O port set for output function as output ports. When the port output data is "1", the port outputs a high level (VDD level); when the data is "0", the port outputs a low level (Vss level).

At cold start, the I/O control register is set to "0" (input mode). At hot start, the pins retain their state from prior to the reset.

**Note:** If pins P10–P13, P30 and P34 are set for use with peripheral circuits, their pin functions vary depending on the input/output direction control by the IOC1x register.

# I/O Memory of I/O Ports

Table 9.2 shows the control bits of the I/O ports.

Table 9.2 Control Bits of I/O Ports

Register name	Address	Bit	Name	Function	Setting		9	Init.	R/W	Remarks	
P0 function	00402D0	D7	CFP07	P07 function selection	1	#SRDY1	0	P07	0	R/W	Extended functions
select register	(B)	D6	CFP06	P06 function selection	1	#SCLK1	0	P06	0	R/W	(0x402DF)
J	``	D5	CFP05	P05 function selection	1	SOUT1	0	P05	0	R/W	()
		D4	CFP04	P04 function selection	1	SIN1	0	P04	0	R/W	
		D3	CFP03	P03 function selection	1	#SRDY0	0	P03	0	R/W	
		D2	CFP02	P02 function selection	1	#SCLK0	0	P02	0	R/W	
		D1	CFP01	P01 function selection	1	SOUT0	0	P01	0	R/W	
		D0	CFP00	P00 function selection	1	SIN0	0	P00	0	R/W	
P0 I/O port data	00402D1	D7	P07D	P07 I/O port data	1	Hiah	0	Low	0	R/W	
register	(B)	D6	P06D	P06 I/O port data	1	g	ľ	2011	0	R/W	
<b>g</b>	(=)	D5	P05D	P05 I/O port data					0	R/W	
		D4	P04D	P04 I/O port data					0	R/W	
		D3	P03D	P03 I/O port data					0	R/W	
		D2	P02D	P02 I/O port data					0	R/W	
		D1	P01D	P01 I/O port data	1				0	R/W	
		D0	P00D	P00 I/O port data	1				0	R/W	
P0 I/O control	00402D2	D7	10C07	P07 I/O control	1	Output	0	Input	0	R/W	
register	(B)	D6	10C06	P06 I/O control	· ·	output	ľ	put	0	R/W	
	(=)	D5	IOC05	P05 I/O control					0	R/W	
		D4	IOC04	P04 I/O control					0	R/W	
		D3	10C03	P03 I/O control					0	R/W	
		D2	IOC02	P02 I/O control					0	R/W	
		D1	IOC01	P01 I/O control	1				0	R/W	
		D0	10C00	P00 I/O control	1				0	R/W	
P1 function	00402D4	D7	-	reserved	F	-	-	1	_	_	0 when being read.
select register	(B)	D6	CFP16	P16 function selection	1	EXCL5	0	P16	0	R/W	o mon boing road.
concerne giote.	(=)	D5	CFP15	P15 function selection	1	EXCL4	0	P15	0	R/W	
		D4	CFP14	P14 function selection	1	FOSC1	0	P14	0	R/W	Extended functions
		D3	CFP13	P13 function selection	1	EXCL3	0	P13	0	R/W	(0x402DF)
						T8UF3		-	-		()
		D2	CFP12	P12 function selection	1	EXCL2	0	P12	0	R/W	
						T8UF2					
		D1	CFP11	P11 function selection	1	EXCL1	0	P11	0	R/W	
						T8UF1					
		D0	CFP10	P10 function selection	1	EXCL0	0	P10	0	R/W	
						T8UF0					
P1 I/O port data	00402D5	D7	-	reserved		-	_		_	-	0 when being read.
register	(B)	D6	P16D	P16 I/O port data	1	High	0	Low	0	R/W	0
		D5	P15D	P15 I/O port data	1				0	R/W	
		D4	P14D	P14 I/O port data					0	R/W	
		D3	P13D	P13 I/O port data					0	R/W	
		D2	P12D	P12 I/O port data					0	R/W	
		D1	P11D	P11 I/O port data					0	R/W	
		D0	P10D	P10 I/O port data					0	R/W	
P1 I/O control	00402D6	D7	-	reserved		-	-		-	-	0 when being read.
register	(B)	D6	IOC16	P16 I/O control	1	Output	0	Input	0	R/W	
		D5	IOC15	P15 I/O control					0	R/W	
		D4	IOC14	P14 I/O control					0	R/W	
		D3	IOC13	P13 I/O control					0	R/W	
		D2	IOC12	P12 I/O control					0	R/W	
		D1	IOC11	P11 I/O control					0	R/W	
		D0	IOC10	P10 I/O control					0	R/W	
P2 function	00402D8	D7	CFP27	P27 function selection	1	TM5	0	P27	0	R/W	
select register	(B)	D6	CFP26	P26 function selection	1	TM4	0	P26	0	R/W	
		D5	CFP25	P25 function selection	1	TM3	0	P25	0	R/W	
		D4	CFP24	P24 function selection	1	TM2	0	P24	0	R/W	
		D3	CFP23	P23 function selection	1	TM1	0	P23	0	R/W	
		D2	CFP22	P22 function selection	1	TM0	0	P22	0	R/W	
		D1	CFP21	P21 function selection	1	#DWE	0	P21	0	R/W	Ext. func.(0x402DF)
		D0	CFP20	P20 function selection	1	#DRD	0	P20	0	R/W	

#### **III PERIPHERAL BLOCK: INPUT/OUTPUT PORTS**

Register name	Address	Bit	Name	Function		Set	ting	9	Init.	R/W	Remarks
P2 I/O port data	00402D9	D7	P27D	P27 I/O port data	1	High	0	Low	0	R/W	
register	(B)	D6	P26D	P26 I/O port data	]				0	R/W	
		D5	P25D	P25 I/O port data					0	R/W	
		D4	P24D	P24 I/O port data					0	R/W	
		D3	P23D	P23 I/O port data	]				0	R/W	
		D2	P22D	P22 I/O port data					0	R/W	
		D1	P21D	P21 I/O port data					0	R/W	
		D0	P20D	P20 I/O port data	1				0	R/W	
P2 I/O control	00402DA	D7	IOC27	P27 I/O control	1	Output	0	Input	0	R/W	
register	(B)	D6	IOC26	P26 I/O control	1				0	R/W	
	. ,	D5	IOC25	P25 I/O control	1				0	R/W	
		D4	IOC24	P24 I/O control	1				0	R/W	
		D3	IOC23	P23 I/O control	1				0	R/W	
		D2	IOC22	P22 I/O control	1				0	R/W	
		D1	IOC21	P21 I/O control	1				0	R/W	
		D0	IOC20	P20 I/O control	1				0	R/W	
P3 function	00402DC	D7-6	_	reserved			-		-	_	0 when being read
select register	(B)	D5	CEP35	P35 function selection	1	#BUSACK	0	P35	0	R/W	o when being read.
concernegiene.	(=)	D4	CFP34	P34 function selection	1	#BUSREQ	0	P34	0	R/W	
					·	#CE6	ľ		ľ		
		D3-2	_	reserved					0	R/W	Writing 1 not allowed
		D1	CEP31	P31 function selection	1	#BUSGET	0	P31	0	R/W	Ext_func (0x402DE)
		D0	CFP30	P30 function selection	1	#WAIT	0	P30	0	R/W	
		20			·	#CE4/#CE5	ľ		ľ		
P3 I/O port data	0040200	D7_6	_	reserved					_	_	0 when being read
register	(B)	D5	P35D	P35 I/O port data	1	High	0	Low	0	R/W	o whom boing road.
regiotei	(2)	D0	P34D	P34 I/O port data	1.	i iigii	ľ	2011	0	R/W	
		D3	P33D	P33 I/O port data	1				0	R/W	
		D2	P32D	P32 I/O port data	1				0	R/M	
		D1	P31D	P31 I/O port data					0	R/W	
			P30D	P30 I/O port data					0	R/W	
B2 I/O control	00402DE			received					-		0 when being read
register	(D)	D7=0	-		1	Output	_	Input	-	- D///	o when being read.
register	(5)	D3	1003		1'	Output	ľ	mput	0	D/W	
			10034		1				0	DAM	
		D3 D2	10033		1				0	D/W	
		D2 D1	10032		1				0	D/W	
			10031						0	DAM	
Dent from etile of	0040005		10030						0	DAA	Multine Areat allowed
Port function	00402DF	D7-4	-	reserved	4		-	DO1 ata	0	R/W	vvriting 1 not allowed.
extension	(6)	D3	CEEVO	P31 port extended function	1	#GARD	0	P31, etc.	0		
register		D2 D1		P21 poil extended function	1	#GAAS	0	P21, etc.	1		
			CFEAT	function	1	DSTU DST1	0	P10, etc.		R/VV	
				Idiction		DBCO		P11, etc.			
		<b>D</b> 0	CEEVO	B12 B14 part avtended function	1	DECO	0	P13, etc.	1	DAM	
		00	CILXU	r 12, r 14 poir extended function	l '		ľ	P12, etc.	'	10/00	
Address bus	0040200	DZ	CEA22	A22 function coloction	1	DOLIX DOZ oto		1 14, 010.	0	DAA/	
Address bus	0040300		CEA23	A23 function selection	1	P07 etc.	0	A23	0		
register		D5	CEA21	A21 function selection	1	P3/ etc.	0	Δ21	0	R/W	
register		D3	CEA20	A20 function selection	1	P33	0	A20	0	R/W	
		D3-0	-	reserved	Ľ		-	A20	_	_	0 when being read
Chin anabla	0040204				-						0 when being read.
Chip enable	0040301	D7-0	-	#CE0 function colection	4		-	#CE0 ata	-	-	o when being read.
register			CECES	#CE9 function selection	1	P21 oto	0	#CE9, etc.			
register		D4	CECE7	#CE7 function selection	1	P21_ctc	0	#CE7 ofc			
		03	CECEP	#CEC function selection		P20, etc.		#CE6 ata			
				#CES function selection	1	P20, etc.		#CE5 off			
			CECEA	#CE3 function selection	1	P15, etc.	0	#CE4 otc			
		00	00024	#OL4 IUNCION SEIECIION	11	F 15, etc.	10	#UE4, etc.		LLV/11	

CFP07–CFP00: P0[7:0] function selection (D[7:0]) / P0 function select register (0x402D0) CFP16–CFP10: P1[6:0] function selection (D[6:0]) / P1 function select register (0x402D4) CFP27–CFP20: P2[7:0] function selection (D[7:0]) / P2 function select register (0x402D8) CFP35–CFP30: P3[5:0] function selection (D[5:0]) / P3 function select register (0x402DC)

Selects the function of each I/O port pin.

Write "1": Used for peripheral circuit Write "0": I/O port pin Read: Valid

When a bit of the CFP register is set to "1", the corresponding pin is set for use with peripheral circuits (see Table 9.1). The pins for which register bits are set to "0" can be used as general-purpose I/O ports. At cold start, CFP is set to "0" (I/O port). At hot start, CFP retains its state from prior to the initial reset.

**P07D–P00D**: P0[7:0] I/O port data (D[7:0]) / P0 I/O port data register (0x402D1) **P16D–P10D**: P1[6:0] I/O port data (D[6:0]) / P1 I/O port data register (0x402D5) **P27D–P20D**: P2[7:0] I/O port data (D[7:0]) / P2 I/O port data register (0x402D9) **P35D–P30D**: P3[5:0] I/O port data (D[5:0]) / P3 I/O port data register (0x402DD)

This register reads data from I/O-port pins or sets output data.

#### When writing data

Write "1": High level Write "0": Low level

When an I/O port is set for output, the data written to it is directly output to the I/O port pin. If the data written to the port is "1", the port pin is set high (VDD level); if the data is "0", the port pin is set low (Vss level). Even in the input mode, data can be written to the port data register.

#### When reading data

Read "1": High level Read "0": Low level

The voltage level on the port pin is read out regardless of whether an I/O port is set for input or output mode. If the pin voltage is high (VDD level), "1" is read out as input data; if the pin voltage is low (VSS level), "0" is read out as input data.

At cold start, all data bits are set to "0". At hot start, they retain their state from prior to the initial reset.

**IOC07–IOC00**: P0[7:0] port I/O control (D[7:0]) / P0 port I/O control register (0x402D2) **IOC16–IOC10**: P1[6:0] port I/O control (D[6:0]) / P1 port I/O control register (0x402D6) **IOC27–IOC20**: P2[7:0] port I/O control (D[7:0]) / P2 port I/O control register (0x402DA) **IOC35–IOC30**: P3[5:0] port I/O control (D[5:0]) / P3 port I/O control register (0x402DE)

Directs an I/O port for input or output.

Write "1": Output mode Write "0": Input mode Read: Valid

This I/O control register corresponds bit-for-bit to each I/O port. When an IOC bit is set to "1", the corresponding I/O port is directed for output; if it is set to "0", the I/O port is directed for input.

At cold start, all IOC bits are set to "0" (input). At hot start, IOC1x and IOC3x retain its state from prior to the initial reset.

If pins P10–P14, P15–P16, P30, P31 and P34 are set for use with peripheral circuits, their pin functions vary depending on the input/output direction control by the IOC1x register.

CFEX0: P12, P14 function extension (D0) / Port function extension register (0x402DF) CFEX1: P10, P11, P13 function extension (D1) / Port function extension register (0x402DF) CFEX2: P21 function extension (D2) / Port function extension register (0x402DF) CFEX3: P31 function extension (D3) / Port function extension register (0x402DF)

Sets whether the function of an I/O-port pin is to be extended.

Write "1": Function-extended pinWrite "0": I/O-port/peripheral-circuit pinRead: Valid

When CFEXx is set to "1", the corresponding pin is set to the extended function input/output pin. When CFEXx = "0", the corresponding CFP bit becomes effective.

At cold start, CFEX0 and CFEX1 are set to "1" (function-extended pin) and other bits are set to "0" (I/O-port/peripheral-circuit pin). At hot start, CFEX retains its state from prior to the initial reset.

**CFA20**: A20 function selection (D4) / Address bus function select register (0x40300) **CFA21**: A21 function selection (D5) / Address bus function select register (0x40300) **CFA22**: A22 function selection (D6) / Address bus function select register (0x40300) **CFA23**: A23 function selection (D7) / Address bus function select register (0x40300)

Sets whether the function of an address bus pin is to be extended.

Write "1": I/O-port/bus control pin Write "0": Address bus pin Read: Valid

When CFA20 is set to "1", the corresponding pin is set to the extended function input/output pin (P33). When CFA20 is set to "0", the pin is set to an address bus pin.

When CFA21, CFA22, and CFA23 are set to "1", bits CFP34, CFP35, and CFP07, respectively, become effective; when set to "0", the pins are set to address bus pins.

At cold start, CFA2x is set to "0" (address bus pin). At hot start, CFA2x retains its state from prior to the initial reset.

**CFCE4**: #CE4 function selection (D0) / Chip enable function select register (0x40301) **CFCE5**: #CE5 function selection (D1) / Chip enable function select register (0x40301) **CFCE6**: #CE6 function selection (D2) / Chip enable function select register (0x40301) **CFCE7**: #CE7 function selection (D3) / Chip enable function select register (0x40301) **CFCE8**: #CE8 function selection (D4) / Chip enable function select register (0x40301) **CFCE9**: #CE9 function selection (D5) / Chip enable function select register (0x40301)

Sets whether the function of a chip enable pin is to be extended.

Write "1": I/O-port/bus control/peripheral-circuit pinWrite "0": Chip enable pinRead: Valid

When CFCE4, CFCE5, CFCE6, CFCE7, and CFCE8 are set to "1", bits CFP15, CFP16, CFP20, CFP21, and CFP31, respectively, become effective; when set to "0", the pins are set to chip enable pins.

When CFCE9 is set to "1", the corresponding pin is set to an I/O port pin (P32). When CFCE9 is set to "0", the pin is set to the Area 9 chip enable pin.

At cold start al the bits are set to "0" (chip enable pin). At hot start, the pins retain their states from prior to the initial reset.

# Input Interrupt

The input ports and the I/O ports support eight system of port input interrupts and two systems of key input interrupts.

# Port Input Interrupt

The port input interrupt circuit has eight interrupt systems (FPT7–FPT0) and a port can be selected for generating each interrupt factor.

The interrupt condition can also be selected from between input signal edge and input signal level.

Figure 9.2 shows the configuration of the port input interrupt circuit.



Figure 9.2 Configuration of Port Input Interrupt Circuit

#### Selecting input pins

The interrupt factors allows selection of an input pin from the four predefined pins independently. Table 9.3 shows the control bits and the selectable pins for each factor.

Interrupt	Control bit	SPT settings				
factor		11	10	01	00	
FPT7	SPT7[1:0] (D[7:6])/Port input interrupt select register 2 (0x402C7)	P27	P07	P33	-	
FPT6	SPT6[1:0] (D[5:4])/Port input interrupt select register 2 (0x402C7)	P26	P06	P32	-	
FPT5	SPT5[1:0] (D[3:2])/Port input interrupt select register 2 (0x402C7)	P25	P05	P31	-	
FPT4	SPT4[1:0] (D[1:0])/Port input interrupt select register 2 (0x402C7)	P24	P04	-	-	
FPT3	SPT3[1:0] (D[7:6])/Port input interrupt select register 1 (0x402C6)	P23	P03	-	-	
FPT2	SPT2[1:0] (D[5:4])/Port input interrupt select register 1 (0x402C6)	P22	P02	-	-	
FPT1	SPT1[1:0] (D[3:2])/Port input interrupt select register 1 (0x402C6)	P21	P01	-	-	
FPT0	SPT0[1:0] (D[1:0])/Port input interrupt select register 1 (0x402C6)	P20	P00	_	_	

Table 9.3 Selecting Pins for Port Input Interrupts

#### Conditions for port input-interrupt generation

Each port input interrupt can be generated by the edge or level of the input signal. The SEPTx bit of the edge/level select register (0x402C9) is used for this selection. When SEPTx is set to "1", the FPTx interrupt will be generated at the signal edge. When SEPTx is set to "0", the FPTx interrupt will be generated by the input signal level.

Furthermore, the signal polarity can be selected using the SPPTx bit of the input porarity select register (0x402C8).

With these registers, the port input interrupt condition is decided as shown in Table 9.4.

SEPTx	SPPTx	FPTx interrupt condition
1	1	Rising edge
1	0	Falling edge
0	1	High level
0	0	Low level

Table 9.4 Port Input Interrupt Condition

When the input signal goes to the selected status, the interrupt factor flag FP is set to "1" and, if other interrupt conditions set by the interrupt controller are met, an interrupt is generated.

**Note:** When using a port input interrupt as the trigger for a restart from HALT2 mode or SLEEP mode, the interrupt is generated by the input signal level even if edge is set as the interrupt condition.

# Key Input Interrupt

The key input interrupt circuit has two interrupt systems (FPK1 and FPK0) and a port group can be selected for generating each interrupt factor.

The interrupt condition can also be set by software.

Figure 9.3 shows the configuration of the port input interrupt circuit.





#### Selecting input pins

For the FPK1 interrupt system, a four-bit input pin group can be selected from the four predefined groups. For the FPK0 system, a five-bit input pin group can be selected.

Table 9.5 shows the control bits and the selectable groups for each factor.

Interrupt	Control bit	SPPK settings				
factor		11	10	01	00	
FPK1	SPPK1[1:0] (D[3:2])/Key input interrupt select register (0x402CA)	P2[7:4]	P0[7:4]	-	-	
FPK0	SPPK0[1:0] (D[1:0])/Key input interrupt select register (0x402CA)	P2[4:0]	P0[4:0]	_	_	

<b>T</b> 1 1 0 <b>F</b>		· · · ·		
I able 9.5	Selecting Pins	for Key	Input	Interrupts

#### Conditions for key input-interrupt generation

The key input interrupt circuit has two input mask registers (SMPK0[4:0] for FPK0 and SMPK1[3:0] for FPK1) and two input comparison registers (SCPK0[4:0] for FPK0 and SCPK1[3:0] for FPK1) to set input-interrupt conditions.

The input mask register SMPK is used to mask the input pin that is not used for an interrupt. This register masks each input pin, whereas the interrupt enable register of the interrupt controller masks the interrupt factor for each interrupt group.

The input comparison register SCPK is used to select whether an interrupt for each input port is to be generated at the rising or falling edge of the input.

A change in state occurs so that the input pin enabled for interrupt by the interrupt mask register SMPK and the content of the input comparison register SCPK become unmatched after being matched, the interrupt factor flag FK is set to "1" and, if other interrupt conditions are met, an interrupt is generated.

Figure 9.4 shows cases in which a FPK0 interrupt is generated. Here, it is assumed that the K5[4:0] pins are selected for the input-pin group and the control register of the interrupt controller is set so as to enable generation of a FPK0 interrupt.



Figure 9.4 FPK0 Interrupt Generation Example (when P0[4:0] is selected by SPPK[1:0])

Since P00 is masked from interrupt by SMPK00, no interrupt occurs at that point (2) above. Next, because P03 becomes "0" at (3), an interrupt is generated due to the lack of a match between the data of the input pin P0[4:1] that is enabled for interrupt and that of the input comparison register SCPK0[4:1]. Since only a change in states in which the input data and the content of the input comparison register SCPK become unmatched after being matched constitutes an interrupt generation condition as described above, no interrupt is generated when a change in states from one unmatched state to another, as in (4), occurs. Consequently, if another interrupt is to be generated again following the occurrence of an interrupt, the state of the input pin must be temporarily restored to the same content as that of the input comparison register SCPK, or the input comparison register SCPK must be set again. Note that the input pins masked from interrupt by the SMPK register do not affect interrupt generation conditions.

An interrupt is generated for FPK1 in the same way as described above.

## Control Registers of the Interrupt Controller

Table 9.6 shows the control registers of the interrupt controller that are provided for each input-interrupt system.

System	Interrupt factor flag	Interrupt enable register	Interrupt priority register
FPT7	FP7(D5/0x40287)	EP7(D5/0x40277)	PP7L[2:0](D[6:4]/0x4026D)
FPT6	FP6(D4/0x40287)	EP6(D4/0x40277)	PP6L[2:0](D[2:0]/0x4026D)
FPT5	FP5(D3/0x40287)	EP5(D3/0x40277)	PP5L[2:0](D[6:4]/0x4026C)
FPT4	FP4(D2/0x40287)	EP4(D2/0x40277)	PP4L[2:0](D[2:0]/0x4026C)
FPT3	FP3(D3/0x40280)	EP3(D3/0x40270)	PP3L[2:0](D[6:4]/0x40261)
FPT2	FP2(D2/0x40280)	EP2(D2/0x40270)	PP2L[2:0](D[2:0]/0x40261)
FPT1	FP1(D1/0x40280)	EP1(D1/0x40270)	PP1L[2:0](D[6:4]/0x40260)
FPT0	FP0(D0/0x40280)	EP0(D0/0x40270)	PP0L[2:0](D[2:0]/0x40260)
FPK1	FK1(D5/0x40280)	EK1(D5/0x40270)	PK1L[2:0](D[6:4]/0x40262)
FPK0	FK0(D4/0x40280)	EK0(D4/0x40270)	PK0L[2:0](D[2:0]/0x40262)

Table 9.6 Control Registers of Interrupt Controller

When the interrupt generation condition described above is met, the corresponding interrupt factor flag is set to "1". If the interrupt enable register bit for that interrupt factor has been set to "1", an interrupt request is generated.

Interrupts due to an interrupt factor can be disabled by leaving the interrupt enable register bit for that factor set to "0". The interrupt factor flag is set to "1" whenever interrupt generation conditions are met, regardless of the setting of the interrupt enable register.

The interrupt priority register sets the interrupt priority level (0 to 7) for each interrupt system. An interrupt request to the CPU is accepted only when no other interrupt request of a higher priority has been generated. In addition, only when the PSR's IE bit = "1" (interrupts enabled) and the set value of the IL is smaller than the input interrupt level set using the interrupt priority register will the input interrupt request actually be accepted by the CPU.

For details on these interrupt control registers, as well as the device operation when an interrupt has occurred, refer to "ITC (Interrupt Controller)".

## **Trap vectors**

The trap-vector address of each input default interrupt factor is set as follows:

FPT0 input interrupt:	0x0C00040
FPT1 input interrupt:	0x0C00044
FPT2 input interrupt:	0x0C00048
FPT3 input interrupt:	0x0C0004C
FPK0 input interrupt:	0x0C00050
FPK1 input interrupt:	0x0C00054
FPT4 input interrupt:	0x0C00110
FPT5 input interrupt:	0x0C00114
FPT6 input interrupt:	0x0C00118
FPT7 input interrupt:	0x0C0011C

The base address of the trap table can be changed using the TTBR register (0x48134 to 0x48137).

## I/O Memory for Input Interrupts

Table 9.7 shows the control bits for the port input and key input interrupts.

Table 97	Control Bits	for	Input	Interrupts
1 4010 5.7	CONTROL DIG	101	input	michupis

Register name	Address	Bit	Name	Function		Set	ting	3	Init.	R/W	Remarks
Port input 0/1	0040260	D7	_	reserved		-	_		_	-	0 when being read.
interrupt	(B)	D6	PP1L2	Port input 1 interrupt level		0 t	o 7		Х	R/W	<u> </u>
priority register	. ,	D5	PP1L1						х		
		D4	PP1L0					х			
		D3	-	reserved		-	-		-	-	0 when being read.
		D2	PP0L2	Port input 0 interrupt level		0 t	o 7		Х	R/W	
		D1	PP0L1						X		
		D0	PP0L0						Х		
Port input 2/3	0040261	D7	-	reserved		-	-		-	-	0 when being read.
interrupt	(B)	D6	PP3L2	Port input 3 interrupt level		0 t	o 7		Х	R/W	
priority register		D5	PP3L1						Х		
		D4	PP3L0						Х		
		D3	-	reserved		-	-		-	-	0 when being read.
		D2	PP2L2	Port input 2 interrupt level		0 t	o 7		Х	R/W	
		D1	PP2L1						Х		
		D0	PP2L0						Х		
Key input	0040262	D7	-	reserved		-	-		-	-	0 when being read.
interrupt	(B)	D6	PK1L2	Key input 1 interrupt level		0 t	o 7		Х	R/W	
priority register		D5	PK1L1						Х		
		D4	PK1L0						Х		
		D3	-	reserved		-	-		-	-	0 when being read.
		D2	PK0L2	Key input 0 interrupt level		0 t	07		X	R/W	
		D1	PK0L1						X		
		Do	PKOLO						X		
Port input 4/5	004026C	D7	-	reserved		-	-		-	-	0 when being read.
interrupt	(B)	D6	PP5L2	Port input 5 interrupt level		0 t	07		X	R/W	
priority register		D5	PP5L1						X		
		D4	PP5L0						X		O uch an h air an an d
		D3	-	Port input 4 interrupt lovel	-	0.1	- 7		- -	- DAM	0 when being read.
				Port input 4 interrupt level		01	07		Ŷ	FX/ V V	
									x		
Port input 6/7	004026D	D7	_	reserved	+						0 when being read
interrunt	(B)	D6	- PP7I 2	Port input 7 interrupt level		0 t	07		- X		o when being read.
priority register	(2)	D5	PP7I 1			01	01		x	10,11	
,, · · · · · ·		D4	PP7L0						X		
		D3	-	reserved		-	-		-	-	0 when being read.
		D2	PP6L2	Port input 6 interrupt level		0 t	o 7		Х	R/W	
		D1	PP6L1						X		
		D0	PP6L0						Х		
Key input,	0040270	D7–6	-	reserved		-	-		-	-	0 when being read.
port input 0-3	(B)	D5	EK1	Key input 1	1	Enabled	0	Disabled	0	R/W	
interrupt		D4	EK0	Key input 0					0	R/W	
enable register		D3	EP3	Port input 3					0	R/W	
		D2	EP2	Port input 2					0	R/W	
		D1	EP1	Port input 1					0	R/W	
		D0	EP0	Port input 0					0	R/W	
Port input 4–7,	0040277	D7–6	-	reserved		-	-		-	-	0 when being read.
clock timer,	(B)	D5	EP7	Port input 7	1	Enabled	0	Disabled	0	R/W	
Interrupt		D4	EP6	Port input 6					0	R/W	
enable register		D3	EP5	Port input 5					0	R/W	
		D2	EP4	Port input 4					0	R/W	
			ECIM		$\vdash$				0	R/W	
		00	-	reserved	-	-	-		0	R/W	vvriting 1 not allowed.
Key input,	0040280	D7-6	-	reserved		-	-		-	-	0 when being read.
port input 0–3	(B)	D5	FK1	Key input 1	1	Factor is	0	No factor is	X	R/W	
Interrupt factor		D4	FKU	Rey Input 0		generated		generated	X	R/W	4
nag register		03	FP3	Port input 2	$\left  \right $				×		
			FP2	Port input 1							
			FPO	Port input 0					×	R/W	
1	1		LI FV	n on input o	1			1	· ^	11/11	1

#### **III PERIPHERAL BLOCK: INPUT/OUTPUT PORTS**

Register name	Address	Bit	Name	Function	Setting			Init.	R/W	Remarks			
Port input 4–7,	0040287	D7–6	-	reserved			-	-			-	-	0 when being read.
clock timer,	(B)	D5	FP7	Port input 7	1	1 Factor is 0 No factor is			Х	R/W	-		
Interrupt factor	.,	D4	FP6	Port input 6	1	generated generated				erated	Х	R/W	
flag register		D3	FP5	Port input 5	1			-		Х	R/W		
		D2	FP4	Port input 4	1						Х	R/W	
		D1	FCTM	Clock timer	1						Х	R/W	
		D0	-	reserved	-			Х	R/W	Writing 1 not allowed.			
Port input	00402C6	D7	SPT31	FPT3 interrupt input port selection		11	10	(	01	00	0	R/W	
interrupt select	(B)	D6	SPT30		P	°23	P03		-	-	0		
register 1		D5	SPT21	FPT2 interrupt input port selection		11	10	(	01	00	0	R/W	
		D4	SPT20		P	22	P02		-	-	0		
		D3	SPT11	FPT1 interrupt input port selection		11	10	(	)1	00	0	R/W	
		D2	SPT10		P	°21	P01		_	-	0		
		D1	SPT01	FPT0 interrupt input port selection		11	10	(	)1	00	0	R/W	
		D0	SPT00		P	°20	P00		-	-	0		
Port input	00402C7	D7	SPT71	FPT7 interrupt input port selection		11	10	(	01	00	0	R/W	
interrupt select	(B)	D6	SPT70		P	P27	P07	F	33	-	0		
register 2		D5	SPT61	FPT6 interrupt input port selection		11	10	(	)1	00	0	R/W	
		D4	SPT60		P	26	P06	P	32	-	0		
		D3	SPT51	FPT5 interrupt input port selection		11	10	(	01	00	0	R/W	
		D2	SPI50	EDT4 intermed instal a set a de stiere		25	P05	P	31	-	0	DAA	
			SP141	FP14 Interrupt input port selection		11	10	(	J.I	00	0	R/W	
		00	5P140		P	24	P04	_	-		0		
Port input	00402C8	D7	SPPT7	FPT7 input polarity selection	1	Hig	h level	0	Lo	w level	1	R/W	
interrupt	(B)	D6	SPP16	FP16 input polarity selection	-	D:-:-	or		_	or	1	R/W	
Input polarity		D5	SPPIS	FP15 input polarity selection	-	RISI	ng eage		F	alling	1	R/W	
select register		D4	SPP14	EPT3 input polarity selection	-					age	1		
		D3	SPPT2	FPT2 input polarity selection	1						1	R/W	
		D1	SPPT1	FPT1 input polarity selection	1						1	R/W	
		D0	SPPT0	FPT0 input polarity selection	1						1	R/W	
Port input	0040209	D7	SEPT7	FPT7 edge/level selection	1	Eda	0	0		<u>اد</u>	1	R/M	
interrunt	(B)	D6	SEPT6	FPT6 edge/level selection	1'	Lug	6	0	Leve	51	1	R/W	
edge/level	(2)	D5	SEPT5	FPT5 edge/level selection	1						1	R/W	
select register		D4	SEPT4	FPT4 edge/level selection	1						1	R/W	
		D3	SEPT3	FPT3 edge/level selection	1						1	R/W	
		D2	SEPT2	FPT2 edge/level selection	1						1	R/W	
		D1	SEPT1	FPT1 edge/level selection	1						1	R/W	
		D0	SEPT0	FPT0 edge/level selection	1						1	R/W	
Key input	00402CA	D7-4	-	reserved			-	-			-	-	0 when being read.
interrupt select	(B)	D3	SPPK11	FPK1 interrupt input port selection		11	10	(	)1	00	0	R/W	-
register		D2	SPPK10		P2	[7:4]	P0[7:4]		_	-	0		
		D1	SPPK01	FPK0 interrupt input port selection		11	10	(	01	00	0	R/W	
		D0	SPPK00		P2	[4:0]	P0[4:0]		-	-	0		
Key input	00402CC	D7–5	-	reserved			-	-			-	-	0 when being read.
interrupt	(B)	D4	SCPK04	FPK04 input comparison	1	High	1	0	Low		0	R/W	
(FPK0) input		D3	SCPK03	FPK03 input comparison							0	R/W	
comparison		D2	SCPK02	FPK02 input comparison	1						0	R/W	
register		D1	SCPK01	FPK01 input comparison	4						0	R/W	
		D0	SCPK00	FPK00 input comparison							0	R/W	
Key input	00402CD	D7–4	-	reserved				-			-	-	0 when being read.
interrupt	(B)	D3	SCPK13	FPK13 input comparison	1	High	1	0	Low		0	R/W	
(FPK1) input		D2	SCPK12	FPK12 input comparison	-						0	R/W	
comparison		D1	SCPK11	FPK11 input comparison	-						0	R/W	
register		DU	SCPK10	FPK10 Input comparison	<u> </u>						0	R/W	
Key input	00402CE	D7-5		reserved	-	la:	-	-	la t		-	-	0 when being read.
interrupt	(B)	D4	SMPK04	FPK04 input mask	1	Inter	rupt	0	Inte	rupt	0	R/W	
(PPRO) Input		03	SMPKUS		1	enat	Jea		uisa	ueu	0	R/W	
mask register			SMPK02		1						0		
			SMPKOO	FPK00 input mask	$\mathbf{I}$						0	R/W	
Koy incut	0040205			rosonvod	-	I					5	10.00	0 when heing read
interrunt	(P)	D2	-	FPK13 input mask	1	Inter	runt	-	Inte	runt	-	R///	o when being read.
(FPK1) input	(3)	23	SMPK12	FPK12 input mask	1'	enst	hapt	0	disa	hled	0	R/M	
mask register		D1	SMPK11	FPK11 input mask	1	Gildi			uiod	5150	0	R/W	
		D0	SMPK10	FPK10 input mask	1						0	R/W	
L								_					

SPT71-SPT70:	FPT7 interrupt input port selection (D[7:6]) / Port input interrupt select register 2 (0x402C7)
SPT61-SPT60:	FPT6 interrupt input port selection (D[5:4]) / Port input interrupt select register 2 (0x402C7)
SPT51-SPT50:	FPT5 interrupt input port selection (D[3:2]) / Port input interrupt select register 2 (0x402C7)
SPT41-SPT40:	FPT4 interrupt input port selection (D[1:0]) / Port input interrupt select register 2 (0x402C7)
SPT31-SPT30:	FPT3 interrupt input port selection (D[7:6]) / Port input interrupt select register 1 (0x402C6)
SPT21-SPT20:	FPT2 interrupt input port selection (D[5:4]) / Port input interrupt select register 1 (0x402C6)
SPT11-SPT10:	FPT1 interrupt input port selection (D[3:2]) / Port input interrupt select register 1 (0x402C6)
SPT01-SPT00:	FPT0 interrupt input port selection (D[1:0]) / Port input interrupt select register 1 (0x402C6)

Select an input pin for port interrupt generation.

ļ	Table 9.8 Selecting Pins for Port Input Interrup								
	Interrupt	SPT settings							
	system	11	10	01	00				
	FPT7	P27	P07	P33	-				
	FPT6	P26	P06	P32	-				
	FPT5	P25	P05	P31	-				
	FPT4	P24	P04	-	-				
	FPT3	P23	P03	-	-				
	FPT2	P22	P02	-	-				
	FPT1	P21	P01	-	-				
	FPT0	P20	P00	-	-				

At cold start, SPT is set to "00". At hot start, SPT retains its state from prior to the initial reset.

SPPT7-SPPT0: Input polarity selection (D[7:0]) / Port interrupt input polarity select register (0x402C8)

Selects input signal porarity for port interrupt generation.

Write "1": High level or Rising edge

Write "0": Low level or Falling edge

Read: Valid

SPPTx is the input polarity select bit corresponding to the FPTx interrupt. When SPPTx is set to "1", the FPTx interrupt will be generated by a high level input or at the rising edge. When SPPTx is set to "0", the interrupt will be generated by a low level input or at the falling edge. An edge or a level interrupt is selected by the SEPTx bit. At cold start, SPPT is set to "0" (low level). At hot start, SPPT retains its state from prior to the initial reset.

SEPT7-SEPT0: Edge/level selection (D[7:0]) / Port interrupt edge/level select register (0x402C9)

Selects an edge trigger or a level trigger for port interrupt generation.

Write "1": Edge Write "0": Level Read: Valid

SEPTx is the edge/level select bit corresponding to the FPTx interrupt. When SEPTx is set to "1", the FPTx interrupt will be generated at the signal edge. Either falling edge or rising edge can be selected by the SPPTx bit. When SEPTx is set to "0", the interrupt will be generated by the level (high or low) specified with the SPPTx bit. At cold start, SEPT is set to "0" (level). At hot start, SEPT retains its state from prior to the initial reset.

**SPPK11–SPPK10**: FPK1 interrupt input port selection (D[3:2]) / Key input interrupt select register (0x402CA) **SPPK01–SPPK00**: FPK0 interrupt input port selection (D[1:0]) / Key input interrupt select register (0x402CA)

Select an input-pin group for key interrupt generation.

4010 0.0	selecting I me for itey input interrupte									
Interrupt	SPPK settings									
system	11	10	01	00						
FPK1	P2[7:4]	P0[7:4]	-	-						
FPK0	P2[4:0]	P0[4:0]	-	-						

Table 9.9 Selecting Pins for Key Input Interrupts

At cold start, SPPK is set to "00". At hot start, SPPK retains its state from prior to the initial reset.

**SCPK13–SCPK10**: FPK1 input comparison (D[3:0]) / FPK1 input comparison register (0x402CD) **SCPK04–SCPK00**: FPK0 input comparison (D[4:0]) / FPK0 input comparison register (0x402CC)

Sets the conditions for key-input interrupt generation (timing of interrupt generation).

Write "1": Generated at falling edgeWrite "0": Generated at rising edgeRead: Valid

SCPK0[4:0] is compared with the input state of five bits of the FPK0 input ports, and SCPK1[3:0] is compared with the input state of four bits of the FPK1 input ports, and when a change in states from a matched to an unmatched state occurs in either, an interrupt is generated (except for the inputs disabled from interrupt by the SMPK register). At cold start, SCPK is set to "0" (rising edge). At hot start, SCPK retains its state from prior to the initial reset.

SMPK13–SMPK10: FPK1 input mask (D[3:0]) / FPK1 input mask register (0x402CF) SMPK04–SMPK00: FPK0 input mask (D[4:0]) / FPK0 input mask register (0x402CE)

Sets conditions for key-input interrupt generation (interrupt enabled/disabled).

Write "1": Interrupt enabled Write "0": Interrupt disabled Read: Valid

SMPK is an input mask register for each key-input interrupt system. Interrupts for bits set to "1" are enabled, and interrupts for bits set to "0" are disabled. A change in the state of an input pin that is disabled from interrupt does not affect interrupt generation.

At cold start, SMPK is set to "0" (interrupt disabled). At hot start, SMPK retains its state from prior to the initial reset.

PP0L2–PP0L0: Port input 0 interrupt level (D[2:0]) / Port input 0/1 interrupt priority register (0x40260) PP1L2–PP1L0: Port input 1 interrupt level (D[6:4]) / Port input 0/1 interrupt priority register (0x40261) PP2L2–PP2L0: Port input 2 interrupt level (D[2:0]) / Port input 2/3 interrupt priority register (0x40261) PP3L2–PP3L0: Port input 3 interrupt level (D[6:4]) / Port input 2/3 interrupt priority register (0x40261) PP4L2–PP4L0: Port input 4 interrupt level (D[2:0]) / Port input 4/5 interrupt priority register (0x4026C) PP5L2–PP5L0: Port input 5 interrupt level (D[6:4]) / Port input 4/5 interrupt priority register (0x4026C) PP6L2–PP6L0: Port input 6 interrupt level (D[2:0]) / Port input 6/7 interrupt priority register (0x4026D) PP7L2–PP7L0: Port input 7 interrupt level (D[6:4]) / Port input 6/7 interrupt priority register (0x4026D) PK0L2–PK0L0: Key input 0 interrupt level (D[2:0]) / Key input interrupt priority register (0x40262) PK1L2–PK1L0: Key input 1 interrupt level (D[6:4]) / Key input interrupt priority register (0x40262)

Sets the priority level of the input interrupt.

PPxL and PKxL are interrupt priority registers corresponding to each port-input interrupt and key-input interrupt, respectively.

The priority level can be set for each interrupt group in the range of 0 to 7.

At initial reset, these registers becomes indeterminate.

 EP3–EP0: Port input 3–0 interrupt enable (D[3:0]) / Key input, port input 0–3 interrupt enable register (0x40270)
 EP7–EP4: Port input 7–4 interrupt enable (D[5:2]) / Port input 4–7, clock timer, interrupt enable register (0x40277)
 EK1, EK0: Key input 1, 0 interrupt enable (D[5:4]) / Key input, port input 0–3 interrupt enable register (0x40270)

Enables or disables the generation of an interrupt to the CPU.

Write "1": Interrupt enabled Write "0": Interrupt disabled Read: Valid

EP and EK are interrupt enable bits corresponding to the port-input interrupt and the key-input interrupt, respectively. Interrupts for input systems set to "1" are enabled, and interrupts for input systems set to "0" are disabled.

At initial reset, these bits are set to "0" (interrupt disabled).

FP3-FP0: Port input	3-0 interrupt factor flag (D[3:0]) /
	Key input, port input 0–3 interrupt factor flag register (0x40280)
FP7-FP4: Port input	7-4 interrupt factor flag (D[5:2]) /
	Port input 4–7, clock timer, interrupt factor flag register (0x40287)
FK1, FK0: Key input	1, 0 interrupt factor flag (D[5:4]) /
	Key input, port input 0-3 interrupt factor flag register (0x40280)

Indicates the status of an input interrupt factor generated.

#### When read

Read "1": Interrupt factor has occurred Read "0": No interrupt factor has occurred

#### When written using the reset-only method (default)

Write "1": Interrupt factor flag is reset Write "0": Invalid

#### When written using the read/write method

Write "1": Interrupt flag is set Write "0": Interrupt flag is reset

FP and FK are an interrupt factor flags corresponding to the port-input interrupt and the key-input interrupt, respectively. The flag is set to "1" when interrupt generation conditions are met.

At this time, if the following conditions are met, an interrupt to the CPU is generated:

- 1. The corresponding interrupt enable register bit is set to "1".
- 2. No other interrupt request of a higher priority has been generated.
- 3. The IE bit of the PSR is set to "1" (interrupts enabled).

4. The value set in the corresponding interrupt priority register is higher than the interrupt level (IL) of the CPU.

The interrupt factor flag is set to "1" whenever interrupt generation conditions are met, regardless of how the interrupt enable and interrupt priority registers are set.

If the next interrupt is to be accepted after an interrupt has occurred, it is necessary that the interrupt factor flag be reset, and that the PSR be set again (by setting the IE bit to "1" after setting the IL to a value lower than the level indicated by the interrupt priority register, or by executing the reti instruction).

The interrupt factor flag can be reset only by writing to it in the software. Note that if the PSR is set again to accept interrupts generated (or if the reti instruction is executed) without resetting the interrupt factor flag, the same interrupt occurs again. Note also that the value to be written to reset the flag is "1" when the reset-only method (RSTONLY = "1") is used, and "0" when the read/write method (RSTONLY = "0") is used.

At initial reset, all the flags become indeterminate, so be sure to reset them in the software.

# **Programming Notes**

- (1) After an initial reset, the interrupt factor flags become indeterminate. To prevent generation of an unwanted interrupt, be sure to reset the flags in a program.
- (2) To prevent regeneration of interrupts due to the same factor following the occurrence of an interrupt, always be sure to reset the interrupt factor flag before resetting the PSR or executing the reti instruction.
- (3) When using a port input interrupt as a the trigger for a restart from HALT2 mode or SLEEP mode, the interrupt is generated by the input signal level even if edge is set as the interrupt condition.

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# S1C33S01 FUNCTION PART Appendix I/O MAP

Register name	Address	Bit	Name	Function	Setting		Init.	R/W	Remarks
8-bit timer	0040146	D7-4	_	reserved		-	_	_	0 when being read.
clock select	(B)	D3	Р8ТРСК3	8-bit timer 3 clock selection	1 0/1	0 Divided clk.	0	R/W	θ: selected by
register		D2	P8TPCK2	8-bit timer 2 clock selection	1 θ/1	0 Divided clk.	0	R/W	Prescaler clock select
		D1	P8TPCK1	8-bit timer 1 clock selection	1 θ/1	0 Divided clk.	0	R/W	register (0x40181)
		D0	P8TPCK0	8-bit timer 0 clock selection	1 θ/1	0 Divided clk.	0	R/W	
16-bit timer 0	0040147	D7–4	-	reserved	-	-	-	_	0 when being read.
clock control	(B)	D3	P16TON0	16-bit timer 0 clock control	1 On	0 Off	0	R/W	<b>J</b>
register		D2	P16TS02	16-bit timer 0	P16TS0[2:0]	Division ratio	0	R/W	θ: selected by
		D1	P16TS01	clock division ratio selection	1 1 1	0/4096	0		Prescaler clock select
		D0	P16TS00		1 1 0	θ/1024	0		register (0x40181)
					1 0 1	0/256			
					1 0 0	0/64			16-bit timer 0 can be
					0 1 1	θ/16			used as a watchdog
					0 1 0	θ/4			timer.
					0 0 1	θ/2			
					0 0 0	θ/1			
16-bit timer 1	0040148	D7-4	-	reserved	-	-	-	-	0 when being read.
clock control	(B)	D3	P16TON1	16-bit timer 1 clock control	1 On	0 Off	0	R/W	
register		D2	P16TS12	16-bit timer 1	P16TS1[2:0]	Division ratio	0	R/W	θ: selected by
		D1	P16TS11	clock division ratio selection	1 1 1	0/4096	0		Prescaler clock select
		D0	P16TS10		1 1 0	0/1024	0		register (0x40181)
					1 0 1	0/256			
					1 0 0	0/64			
					0 1 1	θ/16			
					0 1 0	θ/4			
					0 0 1	θ/2			
			1			0/ I			
16-bit timer 2	0040149 (P)	D7-4	-	reserved	-	-	-	- D///	0 when being read.
rogistor	(6)	D3	P16TS22	16-bit timer 2	P16TS2[2:0]	Division ratio	0		A: solocted by
register			P101322	clock division ratio soloction		DIVISION TALLO	0	R/ W	0. Selected by Proscalar clock salact
			P16TS20			0/4030 0/1024	0		register (0x40181)
		20				0/256	Ŭ		
					1 0 0	0/64			
					0 1 1	θ/16			
					0 1 0	0/4			
					0 0 1	0/2			
					0 0 0	θ/1			
16-bit timer 3	004014A	D7–4	-	reserved	-	_	-	-	0 when being read.
clock control	(B)	D3	P16TON3	16-bit timer 3 clock control	1 On	0 Off	0	R/W	
register		D2	P16TS32	16-bit timer 3	P16TS3[2:0]	Division ratio	0	R/W	θ: selected by
		D1	P16TS31	clock division ratio selection	1 1 1	0/4096	0		Prescaler clock select
		D0	P16TS30		1 1 0	0/1024	0		register (0x40181)
					1 0 1	0/256			
					1 0 0	0/64			
					0 1 1	θ/16			
					0 1 0	0/4			
					0 0 1	θ/2			
						0/1			
16-bit timer 4	004014B	D7-4	-		-	-	-	-	U when being read.
CIOCK CONTROL	(B)	D3	P1610N4	16-bit timer 4 clock control			0	R/W	Or colocitorid by
register			P101342	clock division ratio soloction	1 1 1	A/1096	0	R/ W	0. Selected by Prescaler clock select
			P161341	CIOCK DIVISION TALLO SELECTION		0/4090			register (0x40181)
			101040			e/256			10913101 (0740101)
						θ/64			
						θ/16			
					0 1 0	θ/4			
					0 0 1	θ/2			
					0 0 0	θ/1			

(B) in [Address] indicates an 8-bit register and (HW) indicates a 16-bit register.

The meaning of the symbols described in [Init.] are listed below:

- 0, 1: Initial values that are set at initial reset.
  - (However, the registers for the bus and input/output ports are not initialized at hot start.)
- X: Not initialized at initial reset.
- -: Not set in the circuit.

#### APPENDIX: I/O MAP

Register name	Address	Bit	Name	Function		Setting			Init.	R/W	Remarks
16-bit timer 5	004014C	D7-4	-	reserved		_		_	_	0 when being read.	
clock control	(B)	D3	P16TON5	16-bit timer 5 clock control	1 (	On		0 Off	0	R/W	Ŭ
register		D2	P16TS52	16-bit timer 5	P16	STS5	[2:0]	Division ratio	0	R/W	θ: selected by
		D1	P16TS51	clock division ratio selection	1	1	1	θ/4096	0		Prescaler clock select
		D0	P16TS50		1	1	0	θ/1024	0		register (0x40181)
					1	0	1	θ/256			
					1	0	0	θ/64			
					0	1	1	θ/16			
					0	1	0	θ/4			
					0	0	1	θ/2			
					0	0	0	θ/1			
8-bit timer 0/1	004014D	D7	P8TON1	8-bit timer 1 clock control	1 (	On		0 Off	0	R/W	
clock control	(B)	D6	P8TS12	8-bit timer 1	P8	TS1[	2:0]	Division ratio	0	R/W	θ: selected by
register		D5	P8TS11	clock division ratio selection	1	1	1	θ/4096	0		Prescaler clock select
		D4	P8TS10		1	1	0	θ/2048	0		register (0x40181)
					1	0	1	θ/1024			
					1	0	0	θ/512			8-bit timer 1 can
					0	1	1	θ/256			generate the OSC3
					0	1	0	θ/128			oscillation-stabilize
					0	0	1	0/64			waiting period.
		<b>D</b> 2	DOTONO	9 hit times 0 clock control	0	0	0	0/32	0	DAA	
		D3	POTONU	8-bit timer 0			2.01		0		0: colocted by
			POI SUZ	o-bit unier 0	1	130[	2.0j	Division ratio		R/W	9. Selected by
			POTSON	CIOCK DIVISION TALLO SELECTION				0/230			register (0x40181)
		00	101000				1	0/120 0/64	Ŭ		
					1	0	0	θ/32			8-bit timer 0 can
					0	1	1	θ/16			generate the DRAM
					0	1	0	θ/8			refresh clock.
					0	0	1	θ/4			
					0	0	0	θ/2			
8-bit timer 2/3	004014E	D7	P8TON3	8-bit timer 3 clock control	1 (	On		0 Off	0	R/W	
clock control	(B)	D6	P8TS32	8-bit timer 3	P8	TS3[	2:0]	Division ratio	0	R/W	θ: selected by
register		D5	P8TS31	clock division ratio selection	1	1	1	0/256	0		Prescaler clock select
		D4	P8TS30		1	1	0	θ/128	0		register (0x40181)
					1	0	1	θ/64			
					1	0	0	θ/32			8-bit timer 3 can
					0	1	1	θ/16			generate the clock for
					0	1	0	θ/8			the serial I/F Ch.1.
					0	0	1	θ/4			
			DOTONO		0	0	0	θ/2		DAM	
		D3	P8TON2	8-bit timer 2 clock control	10	Un	2.01	0 Off	0	R/W	Or appertant by
			POI 322	o-bit umer 2	1	132[	2:0j	Division ratio		R/W	9. Selected by
			POTS21	CIOCK DIVISION TALLO SELECTION				0/2049			register (0v40191)
			F01320				1	0/2040	0		
								6/32			8-hit timer 2 can
					0	1	1	0/16			generate the clock for
					0		0	θ/8			the serial I/F Ch 0
					0	0	1	θ/4			
					0	0	0	θ/2			

#### APPENDIX: I/O MAP

Register name	Address	Bit	Name	Function	Setting				I	Init.	R/W	Remarks	
Clock timer	0040151	D7-2	-	reserved	T			_	_	0 when being read.			
Run/Stop	(B)	D1	TCRST	Clock timer reset	1	1 Reset		0	0 Invalid		w	0 when being read.	
register	. ,	D0	TCRUN	Clock timer Run/Stop control	1	1 Run		0	0 Stop		R/W	<u> </u>	
Clock timer	0040152	D7	TCISE2	Clock timer interrupt factor	Т		SEI	2.01	Inte	rrunt factor	x	R/W	
interrunt	(B)	D6	TCISE1	selection	H	1	1	1	into	None	x	10.00	
control register	(2)	D5	TCISEO			1	1	0		Dav	x		
g						1	0	1		Hour			
					1	1	0	0		Minute			
						o	1	1		1 Hz			
						o	1	0		2 Hz			
					0	o	0	1		8 Hz			
						o	0	0		32 Hz			
		D4	TCASE2	Clock timer alarm factor selection	Т	CA	SE	[2:0]	Ala	arm factor	Х	R/W	
		D3	TCASE1		1	1	Х	X		Day	Х		
		D2	TCASE0			×	1	Х		Hour	Х		
						×	Х	1		Minute			
					(	0	0	0		None			
		D1	TCIF	Interrupt factor generation flag	1	G	ene	erated	1 0	Not generated	Х	R/W	Reset by writing 1.
		D0	TCAF	Alarm factor generation flag	1	G	Sene	erated	1 0	Not generated	X	R/W	Reset by writing 1.
Clock timer	0040153	D7	TCD7	Clock timer data 1 Hz	1	Н	ligh		0	Low	Х	R	
divider register	(B)	D6	TCD6	Clock timer data 2 Hz	1	Н	ligh	1	0	Low	Х	R	
		D5	TCD5	Clock timer data 4 Hz	1	Н	ligh		0	Low	Х	R	
		D4	TCD4	Clock timer data 8 Hz	1	H	ligh	1	0	Low	X	R	
		D3	TCD3	Clock timer data 16 Hz	1	н	ligh	1	0	Low	Х	R	
		D2	TCD2	Clock timer data 32 Hz	1	<u> </u>	ligh	1	0	Low	X	R	
		D1	TCD1	Clock timer data 64 Hz	1	н	ligh	1	0	Low	X	R	
		DU	TCDU		<u>  '</u>	П	High		0	LOW	^	ĸ	
Clock timer	0040154	D7-6	-	reserved	╞	-			-	-	0 when being read.		
second	(B)	D5	TCMD5	Clock timer second counter data		0 to 59 seconds		onas	×	ĸ			
register		D4 D2	TCMD4								Ŷ		
		D3	TCMD3	I CMD0 = L3B							Ŷ		
		D1	TCMD1								x		
			TCMD0								x		
Clock timer	0040155	D7_6	_	reserved	t			_		-	_	0 when being read	
minute register	(B)	D7 0	TCHD5	Clock timer minute counter data	0 to 59 minutes			х	R/W	o when being read.			
uio rogiotoi	(-)	D4	TCHD4	TCHD5 = MSB				X					
		D3	TCHD3	TCHD0 = LSB				х					
		D2	TCHD2								х		
		D1	TCHD1								х		
		D0	TCHD0						Х				
Clock timer	0040156	D7–5	-	reserved	Γ	_			-	-	0 when being read.		
hour register	(B)	D4	TCDD4	Clock timer hour counter data		0 to 23 hours			urs	Х	R/W		
		D3	TCDD3	TCDD4 = MSB					Х				
		D2	TCDD2	TCDD0 = LSB						Х			
		D1	TCDD1						Х				
		D0	TCDD0						Х				
Clock timer	0040157	D7	TCND7	Clock timer day counter data	Γ	0 to 65535 days			Х	R/W			
day (low-order)	(B)	D6	TCND6	(low-order 8 bits)		(low-order 8 bits)			Х				
register		D5	TCND5	TCND0 = LSB						Х			
		D4	TCND4					Х					
		D3	TCND3					X					
		D2	TCND2						X				
			TCND1						×				
	0040450	00	TONDU		+		_	<u></u>			^ 	DAA	
Clock timer	0040158 (P)		TCND15	Clock timer day counter data			4	0106	5535	days	×	R/W	
day (nign-	(6)	D6	TCND14			(nign-order 8 bits)			Ŷ				
order) register			TCND12							Ŷ			
			TCND11					x					
		D2	TCND10						x				
		D1	TCND9					X					
		D0	TCND8								X		
Clock timer	0040159	D7-6	-	reserved	t				_		_	_	0 when being read
minute	(B)	D5	TCCH5	Clock timer minute comparison	$\uparrow$			0 to 5	9 mir	utes	х	R/W	
comparison	. ,	D4	TCCH4	data	()	Note	e) (	Can b	e set	within 0–63.	х		
register		D3	тсснз	TCCH5 = MSB	È						х		
		D2	TCCH2	TCCH0 = LSB							х		
		D1	TCCH1								Х		
		D0	TCCH0								Х		

#### APPENDIX: I/O MAP

Register name	Address	Bit	Name	Function	Setting	Init.	R/W	Remarks			
Clock timer	004015A	D7–5	-	reserved	_	-	-	0 when being read.			
hour	(B)	D4	TCCD4	Clock timer hour comparison data	0 to 23 hours	Х	R/W				
comparison		D3	TCCD3	TCCD4 = MSB	(Note) Can be set within 0-31.	X					
register		D2	TCCD2	TCCD0 = LSB		X					
		D1	TCCD1			Х					
		D0	TCCD0			Х					
Clock timer	004015B	D7–5	-	reserved	-	-	-	0 when being read.			
day	(B)	D4	TCCN4	Clock timer day comparison data	0 to 31 days	Х	R/W	Compared with			
comparison		D3	TCCN3	TCCN4 = MSB		X		TCND[4:0].			
register		D2	TCCN2	TCCN0 = LSB		Х					
		D1	TCCN1			Х					
		D0	TCCN0			Х					
Register name	Address	Bit	Name	Function	Setting				Init.	R/W	Remarks
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8-bit timer 0	0040160	D7_3	_	reserved				2			0 when being read
control registor	(B)			8-bit timer 0 clock output control	1		0	Off	-		o when being read.
control register	(5)	D1	PSETO	8-bit timer 0 preset	1	Preset	0	Invalid	-	W	0 when being read
			PTRUNO	8-bit timer 0 Run/Stop control	1	Run	0	Stop	0	R/W	o when being roud.
8-bit timor 0	0040161			8-bit timer 0 relead data	<u> </u>	0 to	25	5	v	D/M	
o-bit timer u	(B)					0.10	20	5	L Ŷ		
register	(6)	D5	RI D05						Ŷ		
register									Ŷ		
		D3							Ŷ		
									Î.		
									1		
0. h it tim on 0.	0040400	D0	DTD07			0.4-	05	r			
8-bit timer 0	0040162			8-bit timer 0 counter data		0 to	25	5		R	
counter data	(B)	D6	PTD06	PTD07 = MSB					X		
register		D5	PTD05	PIDO0 = LSB							
		D4	PTD04								
		D3	PTD03								
		D2	PTD02								
		D0	PIDOU						_ ^		
8-bit timer 1	0040164	D7–3	-	reserved		-	-		-	-	0 when being read.
control register	(B)	D2	PTOUT1	8-bit timer 1 clock output control	1	On	0	Off	0	R/W	
		D1	PSET1	8-bit timer 1 preset	1	Preset	0	Invalid	-	W	0 when being read.
		Do	PTRUN1	8-bit timer 1 Run/Stop control	1	Run	0	Stop	0	R/W	
8-bit timer 1	0040165	D7	RLD17	8-bit timer 1 reload data		0 to	25	5	X	R/W	
reload data	(B)	D6	RLD16	RLD17 = MSB					X		
register		D5	RLD15	RLD10 = LSB					X		
		D4	RLD14						X		
		D3	RLD13						X		
		D2	RLD12						X		
		D1	RLD11						X		
		D0	RLD10						X		
8-bit timer 1	0040166	D7	PTD17	8-bit timer 1 counter data		0 to	25	5	X	R	
counter data	(B)	D6	PTD16	PTD17 = MSB					X		
register		D5	PTD15	PTD10 = LSB					X		
		D4	PTD14						X		
		D3	PTD13						X		
		D2	PTD12						X		
		D1	PID11						X		
		DU	PID10						X		
8-bit timer 2	0040168	D7–3	-	reserved		-	-		-	-	0 when being read.
control register	(B)	D2	PTOUT2	8-bit timer 2 clock output control	1	On	0	Off	0	R/W	
		D1	PSEIZ	8-bit timer 2 preset	1	Preset	0	Invalid	-	VV	0 when being read.
		DU	PIRUNZ	8-bit timer 2 Ruh/Stop control		Kuli	0	Stop		R/W	
8-bit timer 2	0040169	D7	RLD27	8-bit timer 2 reload data		0 to	25	5	X	R/W	
reload data	(B)	D6	RLD26	RLD27 = MSB					X		
register		D5	RLD25	RLD20 = LSB					X		
		D4	RLD24								
		03	RLD23								
		D2	RLD22								
			RLD21								
	0046153		DED20		-		07				
8-bit timer 2	004016A		PTD27	8-bit timer 2 counter data		0 to	25	5		R	
counter data	(B)	D6	PTD26								
register		05	PTD25	F1D20 = LSB							
			PTD24								
		03	PTD23								
			PTD22								
			PTD20						Îx		

Register name	Address	Bit	Name	Function	Setting					R/W	Remarks
8-bit timer 3	004016C	D7-3	-	reserved		-	-		-	-	0 when being read.
control register	(B)	D2	PTOUT3	8-bit timer 3 clock output control	1	On	0	Off	0	R/W	
		D1	PSET3	8-bit timer 3 preset	1	Preset	0	Invalid	-	W	0 when being read.
		D0	PTRUN3	8-bit timer 3 Run/Stop control	1	Run	0	Stop	0	R/W	
8-bit timer 3	004016D	D7	RLD37	8-bit timer 3 reload data	0 to 255				Х	R/W	
reload data	(B)	D6	RLD36	RLD37 = MSB					X		
register		D5	RLD35	RLD30 = LSB					Х		
		D4	RLD34						X		
		D3	RLD33						X		
		D2	RLD32						Х		
		D1	RLD31						Х		
		D0	RLD30						Х		
8-bit timer 3	004016E	D7	PTD37	8-bit timer 3 counter data		0 to	25	5	Х	R	
counter data	(B)	D6	PTD36	PTD37 = MSB					X		
register		D5	PTD35	PTD30 = LSB					X		
		D4	PTD34						X		
		D3	PTD33						X		
		D2	PTD32						X		
		D1	PTD31						X		
		D0	PTD30						Х		

Register name	Address	Bit	Name	Function	Setting					R/W	Remarks
Watchdog	0040170	D7	WRWD	EWD write protection	1	Write enabled	0	Write-protect	0	R/W	
timer write-	(B)	D6-0	-	-		-				-	0 when being read.
protect register											
Watchdog	0040171	D7–2	-	-		-	-		-	-	0 when being read.
timer enable	(B)	D1	EWD	Watchdog timer enable	1	NMI enabled	0	NMI disabled	0	R/W	
register		D0	-	-	-				-	-	0 when being read.

Register name	Address	Bit	Name	Function	Setting			Init.	R/W	Remarks
Power control	0040180	D7	CLKDT1	System clock division ratio	CLK	DT[1:0]	Division ratio	0	R/W	
register	(B)	D6	CLKDT0	selection	1	1	1/8	0		
					1	0	1/4			
					0	1	1/2			
					0	0	1/1			
		D5	PSCON	Prescaler On/Off control	1 0	า	0 Off	1	R/W	
		D4–3	-	reserved			_	0	-	Writing 1 not allowed.
		D2	CLKCHG	CPU operating clock switch	1 0	SC3	0 OSC1	1	R/W	
		D1	SOSC3	High-speed (OSC3) oscillation On/Off	1 0	n	0 Off	1	R/W	
		D0	SOSC1	Low-speed (OSC1) oscillation On/Off	1 0	า	0 Off	1	R/W	
Prescaler clock	0040181	D7–1	-	reserved			-	0	-	
select register	(B)	D0	PSCDT0	Prescaler clock selection	1 0	SC1	0 OSC3/PLL	0	R/W	
Clock option	0040190	D7–4	-	-			_	-	-	0 when being read.
register	(B)	D3	HLT2OP	HALT clock option	1 0	า	0 Off	0	R/W	
		D2	8T1ON	OSC3-stabilize waiting function	1 01	f	0 On	1	R/W	
		D1	-	reserved			-	0	-	Writing 1 not allowed.
		D0	PF10N	OSC1 external output control	1 0	า	0 Off	0	R/W	
Power control	004019E	D7	CLGP7	Power control register protect flag	Writin	g 10010	110 (0x96)	0	R/W	
protect register	(B)	D6	CLGP6		remov	es the v	vrite protection of	0		
		D5	CLGP5		the po	wer con	trol register	0		
		D4	CLGP4		(0x40	180) and	the clock option	0		
		D3	CLGP3		register (0x4019		190).	0		
		D2	CLGP2		Writin	g anothe	er value set the	0		
		D1	CLGP1		write p	protectio	n.	0		
		D0	CLGP0					0		

Register name	Address	Bit	Name	Function	Setting		g	Init.	R/W	Remarks		
Serial I/F Ch.0	00401E0	D7	TXD07	Serial I/F Ch.0 transmit data			0x0 to	0xFF	(0x7F)	Х	R/W	7-bit asynchronous
transmit data	(B)	D6	TXD06	TXD07(06) = MSB						х		mode does not use
register		D5	TXD05	TXD00 = LSB						Х		TXD07.
_		D4	TXD04							х		
		D3	TXD03							Х		
		D2	TXD02							х		
		D1	TXD01							х		
		D0	TXD00							Х		
Serial I/F Ch.0	00401E1	D7	RXD07	Serial I/F Ch.0 receive data			0x0 to	0xFF	(0x7F)	Х	R	7-bit asynchronous
receive data	(B)	D6	RXD06	RXD07(06) = MSB						Х		mode does not use
register		D5	RXD05	RXD00 = LSB						х		RXD07 (fixed at 0).
		D4	RXD04							х		
		D3	RXD03							х		
		D2	RXD02							Х		
		D1	RXD01							х		
		D0	RXD00							Х		
Serial I/F Ch.0	00401E2	D7-6	-	-				-		-	-	0 when being read.
status register	(B)	D5	TEND0	Ch.0 transmit-completion flag	1	Tra	nsmittin	g 0	End	0	R	
		D4	FER0	Ch.0 flaming error flag	1	Err	or	0	Normal	0	R/W	Reset by writing 0.
		D3	PER0	Ch.0 parity error flag	1	Err	or	0	Normal	0	R/W	Reset by writing 0.
		D2	OER0	Ch.0 overrun error flag	1	Err	or	0	Normal	0	R/W	Reset by writing 0.
		D1	TDBE0	Ch.0 transmit data buffer empty	1	Em	npty	0	Buffer full	1	R	
		D0	RDBF0	Ch.0 receive data buffer full	1	But	ffer full	0	Empty	0	R	
Serial I/F Ch.0	00401E3	D7	TXEN0	Ch.0 transmit enable	1	En	abled	0	Disabled	0	R/W	
control register	(B)	D6	RXEN0	Ch.0 receive enable	1	En	abled	0	Disabled	0	R/W	
		D5	EPR0	Ch.0 parity enable	1	Wit	th parity	/ 0	No parity	Х	R/W	Valid only in
		D4	PMD0	Ch.0 parity mode selection	1	Od	d	0	Even	Х	R/W	asynchronous mode.
		D3	STPB0	Ch.0 stop bit selection	1	2 b	its	0	1 bit	Х	R/W	
		D2	SSCK0	Ch.0 input clock selection	1	#S	CLK0	0	Internal clock	Х	R/W	
		D1	SMD01	Ch.0 transfer mode selection	s	MD	0[1:0]	Tra	nsfer mode	Х	R/W	
		D0	SMD00			1	1	8-bit	asynchronous	Х		
						1	0	7-bit	asynchronous			
						0	1	Cloc	k sync. Slave			
						0	0	Cloc	sync. Master			
Serial I/F Ch.0	00401E4	D7–5	-	-				_		-	-	0 when being read.
IrDA register	(B)	D4	DIVMD0	Ch.0 async. clock division ratio	1	1/8		0	1/16	Х	R/W	
		D3	IRTL0	Ch.0 IrDA I/F output logic inversion	1	Inv	erted	0	Direct	X	R/W	Valid only in
		D2	IRRL0	Ch.0 IrDA I/F input logic inversion	1	Inv	erted	0	Direct	X	R/W	asynchronous mode.
		D1	IRMD01	Ch.0 interface mode selection	IR	MD	0[1:0]		/⊢ mode	X	R/W	
		D0	IRMD00			1	1		eserved	Х		
						1	0		IrDA 1.0			
						υ	1	_	reserved			
			1	1	1 (	0	0	G	eneral I/F			

Register name	Address	Bit	Name	Function	Setting			Init.	R/W	Remarks	
Serial I/F Ch.1	00401E5	D7	TXD17	Serial I/F Ch.1 transmit data			0x0 to 0	xFF(0x7F)	Х	R/W	7-bit asynchronous
transmit data	(B)	D6	TXD16	TXD17(16) = MSB					Х		mode does not use
register		D5	TXD15	TXD10 = LSB					Х		TXD17.
		D4	TXD14						Х		
		D3	TXD13						Х		
		D2	TXD12						Х		
		D1	TXD11						Х		
		D0	TXD10						Х		
Serial I/F Ch.1	00401E6	D7	RXD17	Serial I/F Ch.1 receive data			0x0 to 0	xFF(0x7F)	Х	R	7-bit asynchronous
receive data	(B)	D6	RXD16	RXD17(16) = MSB					Х		mode does not use
register		D5	RXD15	RXD10 = LSB					Х		RXD17 (fixed at 0).
		D4	RXD14						Х		
		D3	RXD13						Х		
		D2	RXD12						Х		
		D1	RXD11						Х		
		D0	RXD10						Х		
Serial I/F Ch.1	00401E7	D7–6	-	-				-	-	-	0 when being read.
status register	(B)	D5	TEND1	Ch.1 transmit-completion flag	1	Tra	Insmitting	0 End	0	R	
		D4	FER1	Ch.1 flaming error flag	1	Err	or	0 Normal	0	R/W	Reset by writing 0.
		D3	PER1	Ch.1 parity error flag	1	Err	or	0 Normal	0	R/W	Reset by writing 0.
		D2	OER1	Ch.1 overrun error flag	1	Err	or	0 Normal	0	R/W	Reset by writing 0.
		D1	TDBE1	Ch.1 transmit data buffer empty	1	Em	npty	0 Buffer full	1	R	
		D0	RDBF1	Ch.1 receive data buffer full	1	But	ffer full	0 Empty	0	R	
Serial I/F Ch.1	00401E8	D7	TXEN1	Ch.1 transmit enable	1	Ena	abled	0 Disabled	0	R/W	
control register	(B)	D6	RXEN1	Ch.1 receive enable	1	Ena	abled	0 Disabled	0	R/W	
		D5	EPR1	Ch.1 parity enable	1	Wit	th parity	0 No parity	Х	R/W	Valid only in
		D4	PMD1	Ch.1 parity mode selection	1	Od	d	0 Even	Х	R/W	asynchronous mode.
		D3	STPB1	Ch.1 stop bit selection	1	2 b	oits	0 1 bit	Х	R/W	
		D2	SSCK1	Ch.1 input clock selection	1	#S	CLK1	0 Internal clock	Х	R/W	
		D1	SMD11	Ch.1 transfer mode selection	S	MD	1[1:0]	Transfer mode	Х	R/W	
		D0	SMD10			1	1 8	-bit asynchronous	Х		
						1	0 7	-bit asynchronous			
					(	0	1	Clock sync. Slave			
					(	0	0 0	Clock sync. Master			
Serial I/F Ch.1	00401E9	D7–5	-	_				-	-	-	0 when being read.
IrDA register	(B)	D4	DIVMD1	Ch.1 async. clock division ratio	1	1/8	8	0 1/16	Х	R/W	
		D3	IRTL1	Ch.1 IrDA I/F output logic inversion	1	Inv	rerted	0 Direct	Х	R/W	Valid only in
		D2	IRRL1	Ch.1 IrDA I/F input logic inversion	1	Inv	rerted	0 Direct	Х	R/W	asynchronous mode.
		D1	IRMD11	Ch.1 interface mode selection	IR	MD	1[1:0]	I/F mode	Х	R/W	
		D0	IRMD10			1	1	reserved	X		
						1	0	IrDA 1.0			
					0 1		1	reserved			
						o l	0	General I/F			

Register name	Address	Bit	Name	Function	Setting	Init.	R/W	Remarks
Port input 0/1	0040260	D7	-	reserved	_	-	-	0 when being read.
interrupt	(B)	D6	PP1L2	Port input 1 interrupt level	0 to 7	Х	R/W	
priority register		D5	PP1L1			Х		
		D4	PP1L0			Х		
		D3	-	reserved	_	-	-	0 when being read.
		D2	PP0L2	Port input 0 interrupt level	0 to 7	Х	R/W	
		D1	PP0L1			X		
		D0	PPOLO			X		
Port input 2/3	0040261	D7	-	reserved	_	-	-	0 when being read.
interrupt	(B)	D6	PP3L2	Port input 3 interrupt level	0 to 7	X	R/W	
priority register		D5	PP3L1			X		
		D4	PP3L0	reconved		×		0 when being read
		D3 D2	- PP2  2	Port input 2 interrupt level		- X	- R/\/	o when being read.
		D2	PP2I 1		0107	x	17/14	
		D0	PP2L0			x		
Key input	0040262	 D7	_	reserved	_	-	_	0 when being read
interrupt	(B)	D6	PK11 2	Key input 1 interrupt level	0 to 7	x	R/W	o when being read.
priority register	(-)	D5	PK1L1		0.01	X		
		D4	PK1L0			х		
		D3	-	reserved	-	-	-	0 when being read.
		D2	PK0L2	Key input 0 interrupt level	0 to 7	Х	R/W	
		D1	PK0L1			Х		
		D0	PK0L0			Х		
16-bit timer 0/1	0040266	D7	-	reserved	-	-	-	0 when being read.
interrupt	(B)	D6	P16T12	16-bit timer 1 interrupt level	0 to 7	Х	R/W	
priority register		D5	P16T11			Х		
		D4	P16T10			X		
		D3	-	reserved	-	-	-	0 when being read.
			P16102	16-bit timer 0 interrupt level	0 to 7		R/W	
			P16T00			Ŷ		
16-bit timor 2/3	0040267		_	reserved				0 when being read
interrunt	(B)	D6	- P16T32	16-bit timer 3 interrupt level	- 0 to 7	- X		o when being read.
priority register	(-)	D5	P16T31		0.01	X		
		D4	P16T30			x		
		D3	-	reserved	-	-	-	0 when being read.
		D2	P16T22	16-bit timer 2 interrupt level	0 to 7	Х	R/W	
		D1	P16T21			Х		
		D0	P16T20			Х		
16-bit timer 4/5	0040268	D7	-	reserved	-	-	-	0 when being read.
interrupt	(B)	D6	P16T52	16-bit timer 5 interrupt level	0 to 7	Х	R/W	
priority register		D5	P16T51			X		
		D4	P16150	reconved		X		0 when being read
		D3 D2	- P16T42	16-bit timer 4 interrupt level		- X	- R/\/	o when being read.
		D1	P16T41		0107	x	10,00	
		DO	P16T40			X		
8-bit timer.	0040269	D7	_	reserved	_	- 1	-	0 when being read.
serial I/F Ch.0	(B)	D6	PSIO02	Serial interface Ch.0	0 to 7	X	R/W	o mion boing road.
interrupt	. ,	D5	PSIO01	interrupt level		Х		
priority register		D4	PSIO00			Х		
		D3	-	reserved	-	-	-	0 when being read.
		D2	P8TM2	8-bit timer 0–3 interrupt level	0 to 7	Х	R/W	
		D1	P8TM1			X		
		D0	P8TM0			X		
Serial I/F Ch.1,	004026A	D7-3	-	reserved	-	-	-	0 when being read.
Interrupt	(B)	D2	PSIO12	Serial interface Ch.1	0 to 7	X	R/W	
priority register			PSI011	Interrupt level				
	0040005		13010			 		
CIOCK timer	004026B	D7-3	-	Clock timer interrunt lawal	-	-	- D///	vvriting 1 not allowed.
niterrupt	(8)		PCTM2 PCTM1	Clock limer interrupt level	U (O 7		FK/ VV	
Priority register			PCTM0			x		
L					I	1		

Register name	Address	Bit	Name	Function		Set	ting	3	Init.	R/W	Remarks
Port input 4/5	004026C	D7	-	reserved	İ	-	-		_	_	0 when being read
interrupt	(B)	D6	PP5I 2	Port input 5 interrupt level	-	0 t	0.7		x	R/W	o mion boing road.
priority register	(-)	D5	PP5L1				• •		x		
priority register		D4	PP5L0						x		
		D3	-	reserved	$\vdash$	-	-		-	-	0 when being read.
		D2	PP4L2	Port input 4 interrupt level		0 t	07		х	R/W	
		D1	PP4L1	· ·····					X		
		D0	PP4L0						х		
Port input 6/7	004026D	D7	_	reserved	1		_		_	_	0 when being read
interrunt	(B)	D6	PP7I 2	Port input 7 interrupt level	-	0 t	0.7		X	R/W	o when being read.
nriority register	(5)	D5	PP7L2			01	07		x	10,00	
priority register			PP7L0						x		
		D3	_	reserved	+		_		_	_	0 when being read
		D2	PP6I 2	Port input 6 interrupt level		0 t	07		x	R/W	o mion boing road.
		D1	PP6L1				• •		x		
		DO	PP6L0						X		
Key input	0040270	D7-6	_	reserved	1		_		_	_	0 when being read
nort input 0-3	(B)	D5	FK1	Key input 1	1	Enabled	0	Disabled	0	R/W	o when being roud.
interrunt	(2)	D4	EKO	Key input 0	1.	Enabled	ľ	Disablea	0	R/W	
enable register		D3	EP3	Port input 3	1				0	R/W	
chable register		D2	EP2	Port input 2	1				0	R/W	
		D1	FP1	Port input 1	1				0	R/W	
		D0	EP0	Port input 0	1				0	R/W	
16 hit timer 0/1	0040070	D7	EACT CA	16 hit times 1 comparison A	4	Enchlad		Dischlad		DAM	
interrunt	(B)		E16TU1	16-bit timer 1 comparison B	1'	LIIabieu	ľ	Disableu	0	R/W	
enable register	(5)	D5-4	_	reserved	-				_	_	0 when being read
chable register		D3	F16TC0	16-bit timer 0 comparison A	1	Enabled	0	Disabled	0	R/W	o when being roud.
		D2	E16TU0	16-bit timer 0 comparison B	1.	Enabled	ľ	Disabica	0	R/W	
		D1-0	_	reserved	+	-	-		_	_	0 when being read
16-bit timer 2/3	0040273		F16TC3	16-bit timer 3 comparison A	1	Enabled	0	Disabled	0	R/W	
interrunt	(B)		E16TU2	16-bit timer 3 comparison B	1'	LIIabieu	ľ	Disableu	0	D/M	
anable register	(5)	D5_4		reserved	-	-			0	10/00	0 when being read
chable register		D3 4	F16TC2	16-bit timer 2 comparison A	1	Enabled	0	Disabled	0	R/W	o when being read.
		D2	E16TU2	16-bit timer 2 comparison B	1.	Enabled	ľ	Disabica	0	R/W	
		D1_0	_	reserved	-				_		0 when being read
40 hit tim on 4/5	0040074		FACTOR			Franklad		Disablad		DAA	o when being read.
interrunt	0040274 (D)		EIGIUS	16-bit timer 5 comparison A	1'	Enabled	0	Disabled	0		
anable register	(6)		E10105	reconved	-					N/ W	0 when being read
enable register		D3-4	- E16TC4	16-bit timer 4 comparison A	1	Enabled	-	Disabled	-		o when being read.
		D3	E16TUA	16-bit timer 4 comparison B	1'	LIIabieu	ľ	Disableu	0	D/M	
		D1_0	E10104	reserved	-				0	N/ W	0 when being read
	0040075	07-0	-	leserved	-		_				o when being read.
8-bit timer	0040275 (B)	D7-4	-	reserved	1	- Enabled	-	Dischlad	-	-	0 when being read.
anable register	(6)	D3	EOTUS	8 bit timer 2 underflow	1'	Enableu	0	Disableu	0		
enable register			E0102	8 bit timer 1 underflow	1				0		
			ESTUD	8-bit timer 0 underflow	1						
0	0040070	D7 0	20100							10,00	O where he is a second
Serial I/F	0040276 (D)	D7-6	-	RIE Ch 1 transmit huffar amptu	4	- Enabled	-	Dischlad	-		0 when being read.
anable register	(6)	D3	ESDY1	SIF Ch.1 transmit bullet empty	1'	Enableu	0	Disableu			
enable register		D3	ESEDD1	SIE Ch 1 receive orror	1				0	D/M	
		D2	ESTYO	SIE Ch 0 transmit buffor ompty	1					D/M	
		D1	ESRX0	SIF Ch 0 receive buffer full	1				0	R/W	
			ESFRR0	SIF Ch 0 receive error	1				0	R/W	
Port input 4_7	0040277	D7_6	_	reserved	1				-		0 when being read
clock timer	(B)	D7 0	EP7	Port input 7	1	Enabled	0	Disabled	0	R/W	o when being read.
interrupt	(2)	D4	EP6	Port input 6	1.	Enabled	ľ	Disabica	0	R/W	
enable register		D3	EP5	Port input 5	1				0	R/W	
		D2	EP4	Port input 4	1				0	R/W	
		D1	ECTM	Clock timer	1				0	R/W	
		D0	-	reserved	1	-	-	1	0	R/W	Writing 1 not allowed.
Key input.	0040280	D7–6	-	reserved	İ	-	_		-	-	0 when being read
port input 0-3	(B)	D5	FK1	Key input 1	1	Factor is	0	No factor is	Х	R/W	
interrupt factor		D4	FK0	Key input 0	1	generated		generated	Х	R/W	1
flag register		D3	FP3	Port input 3	1	-			Х	R/W	1
		D2	FP2	Port input 2	1				Х	R/W	1
		D1	FP1	Port input 1	1				Х	R/W	1
		D0	FP0	Port input 0	1				Х	R/W	

Register name	Address	Bit	Name	Function			Set	ting	3		Init.	R/W	Remarks
16-bit timer 0/1	0040282	D7	F16TC1	16-bit timer 1 comparison A	1	Fact	tor is	0	No f	actor is	Х	R/W	
interrupt factor	(B)	D6	F16TU1	16-bit timer 1 comparison B		gene	erated		gene	erated	Х	R/W	
flag register		D5–4	-	reserved			-	-			-	-	0 when being read.
		D3	F16TC0	16-bit timer 0 comparison A	1	Fact	tor is	0	No f	actor is	Х	R/W	
		D2	F16TU0	16-bit timer 0 comparison B		gene	erated		gene	erated	Х	R/W	
		D1–0	-	reserved		-	-	-			-	-	0 when being read.
16-bit timer 2/3	0040283	D7	F16TC3	16-bit timer 3 comparison A	1	Fact	tor is	0	No f	actor is	Х	R/W	
interrupt factor	(B)	D6	F16TU3	16-bit timer 3 comparison B		gene	erated		gene	erated	Х	R/W	
flag register		D5-4	-			<b>F</b> 4	-	-	NI- 4	+ ! -	- V	-	0 when being read.
		D3	F16162	16-bit timer 2 comparison A	1	Fact	or is	0		actor is	X	R/W	
		D2	-	reserved		gene	erateu		gen	erateu	_	N/W	0 when being read
16 hit timor 4/5	0040294		EIETCE		1	Foot	or in	0	No f	ootor in	v		o when being read.
interrunt factor	(B)	DA	F16TU5	16-bit timer 5 comparison B	ť	raci	orated			aciul is	X	R/W	
flag register	(2)	D5-4	-	reserved		gon	-	-	gon	Juiou	-	-	0 when being read.
		D3	F16TC4	16-bit timer 4 comparison A	1	Fact	tor is	0	No f	actor is	Х	R/W	
		D2	F16TU4	16-bit timer 4 comparison B		gene	erated		gene	erated	Х	R/W	
		D1–0	-	reserved			-	-			-	-	0 when being read.
8-bit timer	0040285	D7–4	-	reserved			-	-			_	-	0 when being read.
interrupt factor	(B)	D3	F8TU3	8-bit timer 3 underflow	1	Fact	tor is	0	No f	actor is	Х	R/W	
flag register		D2	F8TU2	8-bit timer 2 underflow		gene	erated		gene	erated	Х	R/W	
		D1	F8TU1	8-bit timer 1 underflow							X	R/W	
		D0	F8TU0	8-bit timer 0 underflow							Х	R/W	
Serial I/F	0040286	D7-6	-	reserved			-	-			-	-	0 when being read.
Interrupt factor	(B)	D5	FSIX1	SIF Ch.1 transmit buffer empty	1	Fact	IOT IS	0	NO T	actor is	X	R/W	
nag register		D4 D3	FSERR1	SIF Ch.1 receive error		gene	eraled		gene	erated	X	R/W	
		D2	FSTX0	SIF Ch.0 transmit buffer empty							X	R/W	
		D1	FSRX0	SIF Ch.0 receive buffer full	1						X	R/W	
		D0	FSERR0	SIF Ch.0 receive error							Х	R/W	
Port input 4–7,	0040287	D7–6	-	reserved			-	-			-	-	0 when being read.
clock timer,	(B)	D5	FP7	Port input 7	1	Fact	tor is	0	No f	actor is	Х	R/W	
interrupt factor		D4	FP6	Port input 6		gene	erated		gene	erated	X	R/W	
flag register		D3	FP5	Port input 5							X	R/W	
		D2 D1	FP4	Clock timer							X	R/W	
		D0	-	reserved			-	-			X	R/W	Writing 1 not allowed.
Flag set/reset	004029F	D7–1	_	reserved	İ		-	_			_	_	
method select	(B)	D0	RSTONLY	Interrupt factor flag reset method	1	Res	et only	0	RD/	WR	1	R/W	
register				selection									
Port input	00402C6	D7	SPT31	FPT3 interrupt input port selection		11	10		01	00	0	R/W	
interrupt select	(B)	D6	SPT30		F	P23	P03		-	-	0		
register 1		D5	SPT21	FPT2 interrupt input port selection		11	10		01	00	0	R/W	
		D4	SP120	EPT1 interrupt input part selection		11	10		-	-	0	D/\/	
		D3	SPT10		F	221	P01		-	-	0	10/00	
		D1	SPT01	FPT0 interrupt input port selection		11	10		01	00	0	R/W	
		D0	SPT00		F	P20	P00		-	-	0		
Port input	00402C7	D7	SPT71	FPT7 interrupt input port selection	1	11	10		01	00	0	R/W	
interrupt select	(B)	D6	SPT70		F	P27	P07	F	<b>°</b> 33	-	0		
register 2		D5	SPT61	FPT6 interrupt input port selection		11	10		01	00	0	R/W	
		D4	SPT60		F	P26	P06	F	°32	-	0		
		D3	SPT51	FP15 interrupt input port selection	-	11	10		01	00	0	R/W	
		D2 D1	SPT41	EPT4 interrupt input port selection		11	10	-	01	- 00	0	R/W	
		D0	SPT40		F	 224	P04		-	-	0		
Port input	00402C8	D7	SPPT7	FPT7 input polarity selection	1	Hig	h level	0	Lo	w level	1	R/W	
interrupt	(B)	D6	SPPT6	FPT6 input polarity selection			or			or	1	R/W	
input polarity		D5	SPPT5	FPT5 input polarity selection	1	Risi	ng edge		F	alling	1	R/W	
select register		D4	SPPT4	FPT4 input polarity selection	-				6	edge	1	R/W	
		D3	SPPT3	FP13 input polarity selection	-						1	R/W	
			SPPT1	FPT1 input polarity selection	1						1	R/W	
		D0	SPPT0	FPT0 input polarity selection	1						1	R/W	
		-											

Register name	Address	Bit	Name	Function		Set	ting	3	Init.	R/W	Remarks
Port input	00402C9	D7	SEPT7	FPT7 edge/level selection	1	Edge	0	Level	1	R/W	
interrupt	(B)	D6	SEPT6	FPT6 edge/level selection		- <b>3</b> -	-		1	R/W	
edge/level	. ,	D5	SEPT5	FPT5 edge/level selection					1	R/W	
select register		D4	SEPT4	FPT4 edge/level selection					1	R/W	
-		D3	SEPT3	FPT3 edge/level selection	1				1	R/W	
		D2	SEPT2	FPT2 edge/level selection	1				1	R/W	
		D1	SEPT1	FPT1 edge/level selection					1	R/W	
		D0	SEPT0	FPT0 edge/level selection					1	R/W	
Key input	00402CA	D7–4	-	reserved		-	-		-	-	0 when being read.
interrupt select	(B)	D3	SPPK11	FPK1 interrupt input port selection		11 10	(	01 00	0	R/W	
register		D2	SPPK10		P2	2[7:4] P0[7:4]			0		
		D1	SPPK01	FPK0 interrupt input port selection		11 10	(	01 00	0	R/W	
		D0	SPPK00		P2	2[4:0] P0[4:0]			0		
Key input	00402CC	D7–5	-	reserved		-	-		-	-	0 when being read.
interrupt	(B)	D4	SCPK04	FPK04 input comparison	1	High	0	Low	0	R/W	
(FPK0) input		D3	SCPK03	FPK03 input comparison					0	R/W	
comparison		D2	SCPK02	FPK02 input comparison					0	R/W	
register		D1	SCPK01	FPK01 input comparison					0	R/W	
		D0	SCPK00	FPK00 input comparison					0	R/W	
Key input	00402CD	D7–4	-	reserved		-	-	I	-	-	0 when being read.
interrupt	(B)	D3	SCPK13	FPK13 input comparison	1	High	0	Low	0	R/W	
(FPK1) input		D2	SCPK12	FPK12 input comparison					0	R/W	
comparison		D1	SCPK11	FPK11 input comparison					0	R/W	
register		D0	SCPK10	FPK10 input comparison					0	R/W	
Key input	00402CE	D7–5	-	reserved		-	-		-	-	0 when being read.
interrupt	(B)	D4	SMPK04	FPK04 input mask	1	Interrupt	0	Interrupt	0	R/W	
(FPK0) input		D3	SMPK03	FPK03 input mask		enabled		disabled	0	R/W	
mask register		D2	SMPK02	FPK02 input mask					0	R/W	
		D1	SMPK01	FPK01 input mask					0	R/W	
		DU	SMPKOU	FPK00 input mask					0	R/W	
Key input	00402CF	D7-4	-	reserved		-	-		-	-	0 when being read.
interrupt	(B)	D3	SMPK13	FPK13 input mask	1	Interrupt	0	Interrupt	0	R/W	
(FPK1) input		D2	SMPK12	FPK12 input mask		enabled		disabled	0	R/W	
mask register		DI	SMPK11	FPK11 Input mask					0	R/W	
		D0	SWPKIU			<b>#0000</b>	0	<b>D</b> 07	0	R/W	
PU function	00402D0		CFP07	P07 function selection	1	#SRDY1	0	P07	0	R/W	Extended functions
select register	(6)	D6	CEPOS	P06 function selection	1	#SULKI	0	P06	0		(0X402DF)
		D3	CFP03	P04 function selection	1	SUUT SINI1	0	P03	0	R/W	
		D3	CEP03	P03 function selection	1	#SRDY0	0	P03	0	R/W	
		D2	CFP02	P02 function selection	1	#SCLK0	0	P02	0	R/W	
		D1	CFP01	P01 function selection	1	SOUT0	0	P01	0	R/W	
		D0	CFP00	P00 function selection	1	SIN0	0	P00	0	R/W	
P0 I/O port data	00402D1	D7	P07D	P07 I/O port data	1	Hiah	0	Low	0	R/W	
register	(B)	D6	P06D	P06 I/O port data	1	5	-	-	0	R/W	
Ū	. ,	D5	P05D	P05 I/O port data					0	R/W	
		D4	P04D	P04 I/O port data	1				0	R/W	
		D3	P03D	P03 I/O port data	1				0	R/W	
		D2	P02D	P02 I/O port data					0	R/W	
		D1	P01D	P01 I/O port data					0	R/W	
		D0	P00D	P00 I/O port data					0	R/W	
P0 I/O control	00402D2	D7	IOC07	P07 I/O control	1	Output	0	Input	0	R/W	
register	(B)	D6	IOC06	P06 I/O control					0	R/W	
		D5	IOC05	P05 I/O control					0	R/W	
		D4	IOC04	P04 I/O control					0	R/W	
		D3	IOC03	P03 I/O control	1				0	R/W	
		D2	IOC02	P02 I/O control	1				0	R/W	
		D1	10C01	P01 I/O control						R/W	
		D0	10C00	P00 I/O control					0	R/W	

Register name	Address	Bit	Name	Function		Sett	ing	9	Init.	R/W	Remarks
P1 function	00402D4	D7	-	reserved		-	-		-	-	0 when being read.
select register	(B)	D6	CFP16	P16 function selection	1	EXCL5	0	P16	0	R/W	
		D5	CFP15	P15 function selection	1	EXCL4	0	P15	0	R/W	
		D4	CFP14	P14 function selection	1	FOSC1	0	P14	0	R/W	Extended functions
		D3	CFP13	P13 function selection	1	EXCL3	0	P13	0	R/W	(0x402DF)
						T8UF3					
		D2	CFP12	P12 function selection	1	EXCL2	0	P12	0	R/W	
						T8UF2					
		D1	CFP11	P11 function selection	1	EXCL1	0	P11	0	R/W	
						T8UF1	_	<b>B</b> / A			
		DO	CFP10	P10 function selection	1	EXCL0	0	P10	0	R/W	
						180F0					
P1 I/O port data	00402D5	D7	-	reserved		-	-		-	-	0 when being read.
register	(B)	D6	P16D	P16 I/O port data	1	High	0	Low	0	R/W	
		D5	P15D	P15 I/O port data					0	R/W	
		D4	P14D	P14 I/O port data					0	R/W	
		D3	P13D	P13 I/O port data					0	R/W	
		D2 D1	P11D	P12 I/O port data					0	R/W	
			P10D	P10 I/O port data					0	R/M	
D1 I/O control	00402D6	D7								10/11	O when heing read
P1 I/O control	00402D6		-	R16 I/O control	1	Output	0	Innut	-	- D///	0 when being read.
register	(6)	DE	10016	P16 I/O control	'	Output	0	input	0		
		D3	10013						0	R/M	
		50	10014						0	R/M	
		D2	10013						0	R/W	
		D1	IOC11	P11 I/O control					0	R/W	
		D0	IOC10	P10 I/O control					0	R/W	
P2 function	00402D8	D7	CEP27	P27 function selection	1	TM5	0	P27	0	R/M	
select register	(B)	D6	CFP26	P26 function selection	1	TM3 TM4	0	P26	0	R/W	
concerneg.com	(-)	D5	CFP25	P25 function selection	1	TM3	0	P25	0	R/W	
		D4	CFP24	P24 function selection	1	TM2	0	P24	0	R/W	
		D3	CFP23	P23 function selection	1	TM1	0	P23	0	R/W	
		D2	CFP22	P22 function selection	1	TM0	0	P22	0	R/W	
		D1	CFP21	P21 function selection	1	#DWE	0	P21	0	R/W	Ext. func.(0x402DF)
		D0	CFP20	P20 function selection	1	#DRD	0	P20	0	R/W	
P2 I/O port data	00402D9	D7	P27D	P27 I/O port data	1	High	0	Low	0	R/W	
register	(B)	D6	P26D	P26 I/O port data		-			0	R/W	
		D5	P25D	P25 I/O port data					0	R/W	
		D4	P24D	P24 I/O port data					0	R/W	
		D3	P23D	P23 I/O port data					0	R/W	
		D2	P22D	P22 I/O port data					0	R/W	
		D1	P21D	P21 I/O port data					0	R/W	
		D0	P20D	P20 I/O port data					0	R/W	
P2 I/O control	00402DA	D7	IOC27	P27 I/O control	1	Output	0	Input	0	R/W	
register	(B)	D6	IOC26	P26 I/O control					0	R/W	
		D5	IOC25	P25 I/O control					0	R/W	
		D4	IOC24	P24 I/O control					0	R/W	
		D3	10C23	P23 I/O control					0	R/W	
		D2	10022						0	R/W	
			10021	P21 I/O control					0		
		D0	10020						0	N/ VV	<u> </u>
P3 function	00402DC	D7-6	-	reserved	1		-	DOF	-	-	0 when being read.
select register	(6)	D5	CEP24	P35 function selection	1	#BUSACK	0	P30 D24	0		
		D4	GFF34	F 34 TUTICIION Selection		#DUSKEQ #CE6	0	F 34	0	R/ VV	
		D3-2	_	reserved		#010			0	R/W	Writing 1 not allowed
		D0 2	CFP31	P31 function selection	1	#BUSGET	0	P31	0	R/W	Ext_func (0x402DE)
		D0	CFP30	P30 function selection	1	#WAIT	0	P30	0	R/W	
		-				#CE4/#CE5					
P3 I/O port data	00402DD	D7–6	-	reserved			-		-	_	0 when being read
register	(B)	D5	P35D	P35 I/O port data	1	High	0	Low	0	R/W	
-		D4	P34D	P34 I/O port data		-			0	R/W	
		D3	P33D	P33 I/O port data	1				0	R/W	
		D2	P32D	P32 I/O port data	1				0	R/W	
		D1	P31D	P31 I/O port data					0	R/W	
		D0	P30D	P30 I/O port data					0	R/W	

Register name	Address	Bit	Name	Function			S	Settin	g	Init.	R/W	Remarks
P3 I/O control	00402DE	D7–6	-	reserved				_	-	_	_	0 when being read.
register	(B)	D5	IOC35	P35 I/O control	1	Ou	utput	0	Input	0	R/W	<u> </u>
U U		D4	IOC34	P34 I/O control	1		•			0	R/W	
		D3	IOC33	P33 I/O control	1					0	R/W	
		D2	IOC32	P32 I/O control	1					0	R/W	
		D1	IOC31	P31 I/O control	1					0	R/W	
		D0	IOC30	P30 I/O control						0	R/W	
Port function	00402DF	D7-4	-	reserved				-		0	R/W	Writing 1 not allowed.
extension	(B)	D3	CFEX3	P31 port extended function	1	#C	GARD	0	P31, etc.	0	R/W	
register		D2	CFEX2	P21 port extended function	1	#C	GAAS	0	P21, etc.	0	R/W	
		D1	CFEX1	P10, P11, P13 port extended	1	DS	ST0	0	P10, etc.	1	R/W	
				function		DS	ST1		P11, etc.			
						DF	PC0		P13, etc.			
		D0	CFEX0	P12, P14 port extended function	1	DS	ST2	0	P12, etc.	1	R/W	
						DC	CLK		P14, etc.			
Address bus	0040300	D7	CFA23	A23 function selection	1	PC	)7 etc.	0	A23	0	R/W	
function select		D6	CFA22	A22 function selection	1	P3	35 etc.	0	A22	0	R/W	
register		D5	CFA21	A21 function selection	1	P3	34 etc.	0	A21	0	R/W	
		D4	CFA20	A20 function selection	1	P3	33	0	A20	0	R/W	
		D3-0	-	reserved		_		_			_	0 when being read.
Chip enable	0040301	D7–6	-	reserved				_		-	-	0 when being read.
function select		D5	CFCE9	#CE9 function selection	1	P3	32	0	#CE9, etc.	0	R/W	
register		D4	CFCE8	#CE8 function selection	1	P3	31, etc.	0	#CE8, etc.	0	R/W	
		D3	CFCE7	#CE7 function selection	1	P2	21, etc.	0	#CE7, etc.	0	R/W	
		D2	CFCE6	#CE6 function selection	1	P2	20, etc.	0	#CE6, etc.	0	R/W	
		D1	CFCE5	#CE5 function selection	1	P1	16, etc.	0	#CE5, etc.	0	R/W	
		D0	CFCE4	#CE4 function selection	1	P1	5, etc.	0	#CE4, etc.	0	R/W	
Areas 18–15	0048120	DF	-	reserved		_		-		-	-	0 when being read.
set-up register	(HW)	DE	A18SZ	Areas 18–17 device size selection	1	81	bits	0	16 bits	0	R/W	
			A18DF1	Areas 18–17	A	18L	0+[1:0]	Num	ber of cycles	1	R/W	
		DC	ATODEO	output disable delay time		1			3.5	'		
						י ח			2.0			
						n			0.5			
		DB	_	reserved		<u> </u>	v		0.0	_	_	0 when being read
		DA	A18WT2	Areas 18–17 wait control	A1	181	VT[2:0]	V	ait cycles	1	R/W	
		D9	A18WT1		1	Τ	1 1		7	1		
		D8	A18WT0		1		1 0		6	1		
					1		0 1		5			
					1		0 0		4			
					0		1 1		3			
					0		1 0		2			
					0		0 1		1			
					0		0 0		0			
		D7	-	reserved				-	1.01.1	-	-	0 when being read.
		D6	A16SZ	Areas 16–15 device size selection	1	181	DITS	10	16 bits	0	R/W	
		D5	A16DF1	Areas 16–15	A1	16L	0F[1:0] ↓ ↓	Num	ber of cycles	1	R/W	
		D4	A16DFU	output disable delay time		1			3.5	1		
						0			2.0			
						n			0.5			
		D3	_	reserved		0	0		0.0	_	_	0 when being read
		D2	A16WT2	Areas 16–15 wait control	A1	161	VT[2:0]	V	ait cvcles	1	R/W	o mion boing roadi
		D1	A16WT1		1	T	1 1		7	1		
		D0	A16WT0		1		1 0		6	1		
					1		0 1		5			
					1		0 0		4			
					0		1 1		3			
					0		1 0		2			
					0		0 1		1			
					0		0 0		0			

Register name	Address	Bit	Name	Function	Setting				3	Init.	R/W	Remarks
Areas 14–13	0048122	DF-9	-	reserved	_		-	-	0 when being read.			
set-up register	(HW)	D8	A14DRA	Area 14 DRAM selection	1	Used	d	0	Not used	0	R/W	0
	. ,	D7	A13DRA	Area 13 DRAM selection	1	Used	d	0	Not used	0	R/W	
		D6	A14SZ	Areas 14–13 device size selection	1 8	3 bit	s	0	16 bits	0	R/W	
		D5	A14DF1	Areas 14–13	A14	4DF	[1:0]	Num	ber of cycles	1	R/W	
		D4	A14DF0	output disable delay time	1		1		3.5	1		
					1		0		2.5			
					0		1		1.5			
					0		0		0.5			
		D3	-	reserved				-		-	-	0 when being read.
		D2	A14WT2	Areas 14–13 wait control	A14	IWT	[2:0]	W	ait cycles	1	R/W	
		D1	A14WT1			1	1		7	1		
		Do	A14WT0			1	0		6	1		
						0	1		5			
						0	0		4			
						1			3			
									2			
									0			
Aroas 12_11	00/812/		_	reserved	<u> </u>	Ŭ	Ľ		0			0 when being read
set-up register	(HW)		- 41297	Areas 12-11 device size selection	1	R hit	e		16 hits	0	= R/M	o when being read.
Set up register	(,	D5	A12DF1	Areas 12–11	A18		[1:0]	Num	ber of cycles	1	R/W	
		D4	A12DF0	output disable delay time	1		1		3.5	1		
					1		0		2.5			
					0		1		1.5			
					0		0		0.5			
		D3	-	reserved				-		-	-	0 when being read.
		D2	A12WT2	Areas 12–11 wait control	A18	BWT	[2:0]	W	ait cycles	1	R/W	
		D1	A12WT1		1	1	1		7	1		
		D0	A12WT0		1	1	0		6	1		
						0	1		5			
					1	0	0		4			
					0	1	1		3			
									2 1			
					0	0			0			
Aroas 10_0	00/8126	DE		reserved	Ē	Ŭ	l °		0	_	_	0 when being read
set-un register	(HW)	DE	- 410IR2	Area 10 internal ROM wait control	Δ1	0181	2.01	-	OM size	1		o when being read.
cot up rogiotoi	(,		A10IR1	Area 10 internal ROM size	1	1	1		2MB	1		
		DC	A10IR0	selection	1	1	0		1MB	1		
					1	0	1		512KB			
					1	0	0		256KB			
					0	1	1		128KB			
					0	1	0		64KB			
					0	0	1		32KB			
					0	0	0		16KB			
		DB	-	reserved						-	-	0 when being read.
		DA	A10BW1	Areas 10–9	A10	BW	[1:0]	W	ait cycles	0	R/W	
		D9	A10BW0	burst ROM	1		1		3	0		
				buist read cycle wait control			1		∠ 1			
							0		0			
		D8	A10DRA	Area 10 burst ROM selection	1	Used	d L	0	Not used	0	R/W	
		D7	A9DRA	Area 9 burst ROM selection	1	Used	d	0	Not used	0	R/W	
		D6	A10SZ	Areas 10–9 device size selection	1 8	3 bit	s	0	16 bits	0	R/W	
		D5	A10DF1	Areas 10–9	A1(	DF	[1:0]	Num	ber of cycles	1	R/W	
		D4	A10DF0	output disable delay time	1		1		3.5	1		
					1		0		2.5			
							1		1.5			
		D3	_	reserved			U	L	0.0	_	_	0 when being read
		D2	A10WT2	Areas 10–9 wait control	A1(	wT	[2.0]	W	ait cycles	1	R/W	o when being read.
		D1	A10WT1		1	1	1		7	1		
		D0	A10WT0		1	1	0		6	1		
					1	0	1		5			
					1	0	0		4			
					0	1	1		3			
					0	1	0		2			
					0	0			1			
					U	0	10		U			

Register name	Address	Bit	Name	Function		Se	etting	Init.	R/W	Remarks
Areas 8–7	0048128	DF-9	-	reserved			-	_	_	0 when being read.
set-up register	(HW)	D8	A8DRA	Area 8 DRAM selection	1 Used		0 Not used	0	R/W	<u> </u>
	. ,	D7	A7DRA	Area 7 DRAM selection	1 Used		0 Not used	0	R/W	
		D6	A8SZ	Areas 8–7 device size selection	1 8 bits		0 16 bits	0	R/W	
		D5	A8DF1	Areas 8–7	A8DF[1:	:0]	Number of cycles	1	R/W	
		D4	A8DF0	output disable delay time	1	1	3.5	1		
					1	0	2.5			
					0	1	1.5			
					0	0	0.5			
		D3	-	reserved	A 014/TT0	01	-	-	-	0 when being read.
		D2	A8W12	Areas 8–7 wait control	A8W1[2	:0]	vvait cycles	1	R/W	
			ASWIT			1	1	1		
		00	AOWIU			1	5			
							3			
						1	3			
					0 1	0	2			
					0 0	1	1			
					0 0	0	0			
Areas 6–4	004812A	DF-E	-	reserved			-	-	-	0 when being read.
set-up register	(HW)	DD	A6DF1	Area 6	A6DF[1	:0]	Number of cycles	1	R/W	
		DC	A6DF0	output disable delay time	1	1	3.5	1		
					1	0	2.5			
					0	1	1.5			
					0	0	0.5			<u></u>
		DB	-	Area 6 wait control	A 6\A/T[2	01	-	-	- D///	0 when being read.
			A6WT1	Area o wait control	1 1	1	7	1	10/00	
		D8	AGWTO			0	6	1		
					1 0	1	5			
					1 0	0	4			
					0 1	1	3			
					0 1	0	2			
					0 0	1	1			
					0 0	0	0			
		D7	-	reserved			-	-	-	0 when being read.
		D6	A5SZ	Areas 5–4 device size selection	1 8 bits	.01	0 16 bits	0	R/W	
		D5	A5DF1	Aleas 5-4		1	Number of cycles	1	R/W	
		04	AJDI U	output disable delay time			2.5			
					0	1	1.5			
					0	0	0.5			
		D3	-	reserved				-	-	0 when being read.
		D2	A5WT2	Areas 5-4 wait control	A5WT[2	:0]	Wait cycles	1	R/W	
		D1	A5WT1		1 1	1	7	1		
		D0	A5WT0		1 1	0	6	1		
					1 0	1	5			
					1 0	0	4			
					0 1	1	3			
						1	2			
						0	0			
TTBR write	004812D	D7	TBRP7	TTBR register write protect	Writing 0	1011	001(0x59)	0	w	Undefined in read
protect register	(B)	D6	TBRP6		removes	the T	TBR (0x48134)	0		e
	(	D5	TBRP5		write prot	ectio	n.	0		
		D4	TBRP4		Writing of	ther c	data sets the	0		
		D3	TBRP3		write prot	ectio	n.	0		
		D2	TBRP2					0		
		D1	TBRP1					0		
		D0	TBRP0		1			0	1	

Register name	Address	Bit	Name	Function			S	etting	3	Init.	R/W	Remarks
Bus control	004812E	DF	RBCLK	BCLK output control	1	Fix	xed at ⊦	1 0	Enabled	0	R/W	
register	(HW)	DE	-	reserved				_		0	-	Writing 1 not allowed.
		DD	RBST8	Burst ROM burst mode selection	1	8-s	successi	ve 0	4-successive	0	R/W	
		DC	REDO	DRAM page mode selection	1	ED	00	0	Fast page	0	R/W	
		DB	RCA1	Column address size selection	F	RCA	A[1:0]		Size	0	R/W	
		DA	RCA0			1	1		11	0		
						1	0		10			
						0	1		9			
		<b>D</b> 0	<b>DD00</b>	Defeash anabla	(		0		8 Disabled		DAA	
		D9	RPC2	Refresh enable	1	En	abled	0	Disabled	0	R/W	
			RPC1	Refresh RBC dolov actus	1	Se	eit-retres	sn U	CBR-refresh	0	R/W	
				Refresh RAS pulse width			0 \[1:0]	Num	1.0	0		
		D0	RRAD	selection		1	4[1.0] 1	NUITI	5	0		
		05		301001011		1			4			
						0	1		3			
						0	0		2			
		D4	-	reserved				-		0	-	Writing 1 not allowed.
		D3	SBUSST	External interface method selection	1	#B	BSL	0	A0	0	R/W	
		D2	SEMAS	External bus master setup	1	Ex	disting	0	Nonexistent	0	R/W	
		D1	SEPD	External power-down control	1	En	nabled	0	Disabled	0	R/W	
		D0	SWAITE	#WAIT enable	1	En	nabled	0	Disabled	0	R/W	
DRAM timing	0048130	DF-C	-	reserved				-		-	-	0 when being read.
set-up register	(HW)	DB	A3EEN	Area 3 emulation	1	Inte	ernal RC	0 M	Emulation	1	R/W	
		DA	CEFUNC1	#CE pin function selection	CF	FUI	NC[1:0]	#(	CE output	0	R/W	
		D9	CEFUNC0			1	X	#CE7	7/8#CE17/18	0		
						0	1	#C	E6#CE17			
		Do	CDAS	Sussessive DAS mode actur	(	0	0	#C	E4#CE10	_	DAA	
			DDDC1			DD		Num	hor of cyclos	0		
		D6	RPRC0	BAS precharge cycles selection		1	1	Num	4	0	10.00	
		20				1	0		3	Ŭ		
						0	1		2			
					(	0	0		1			
		D5	-	reserved				-		-	-	0 when being read.
		D4	CASC1	DRAM	С	AS	C[1:0]	Num	ber of cycles	0	R/W	
		D3	CASC0	CAS cycles selection		1	1		4	0		
						1	0		3			
						0			۲ ۱			
		D2	_	reserved		0	0	_	1	-	_	0 when being read.
		D1	RASC1	DRAM	R	AS	C[1:0]	Num	ber of cvcles	0	R/W	
		D0	RASC0	RAS cycles selection		1	1		4	0		
						1	0		3			
					(	0	1		2			
					(	0	0		1			
Access control	0048132	DF	A18IO	Area 18, 17 internal/external access	1	Int	ternal	0	External	0	R/W	
register	(HW)	DE	A16IO	Area 16, 15 internal/external access		ac	cess		access	0	R/W	
		DD	A14IO	Area 14, 13 internal/external access						0	R/W	
		DC	A12IO	Area 12, 11 internal/external access						0	R/W	Quitan baing and
			-	Area 8. 7 internal/external access	1	Int	ornal		Extornal	0	- D///	o when being read.
			A610	Area 6 internal/external access	1	200	COSS	0		0		
		D3	4510	Area 5 4 internal/external access		ac	0033		access	0	R/W	
		D7	A18EC	Area 18, 17 endian control	1	Bio	a endia	n 0	Little endian	0	R/W	
		D6	A16EC	Area 16, 15 endian control			9			0	R/W	
			A14EC	Area 14, 13 endian control						0	R/W	1
		D4	A12EC	Area 12, 11 endian control	1					0	R/W	
		D3	A10EC	Area 10, 9 endian control						0	R/W	
		D2	A8EC	Area 8, 7 endian control						0	R/W	
		D1	A6EC	Area 6 endian control						0	R/W	
		D0	A5EC	Area 5, 4 endian control						0	R/W	

Register name	Address	Bit	Name	Function			S	etting	9	Init.	R/W	Remarks
TTBR low-	0048134	DF	TTBR15	Trap table base address [15:10]						0	R/W	
order register	(HW)	DE	TTBR14							0		
_		DD	TTBR13							0		
		DC	TTBR12							0		
		DB	TTBR11							0		
		DA	TTBR10							0		
		D9	TTBR09	Trap table base address [9:0]			Fix	ed at	0	0	R	0 when being read.
		D8	TTBR08							0		Writing 1 not allowed.
		D7	TTBR07							0		
		D6	TTBR06							0		
		D5	TTBR05							0		
		D4	TTBR04							0		
		D3	TTBR03							0		
		D2	TTBR02							0		
		D1	TTBR01							0		
		D0	TTBR00							0		
TTBR high-	0048136	DF	TTBR33	Trap table base address [31:28]			Fix	ed a	t 0	0	R	0 when being read.
order register	(HW)	DE	TTBR32							0		Writing 1 not allowed.
		DD	TTBR31							0		
		DC	TTBR30							0		
		DB	TTBR2B	Trap table base address [27:16]	Th	ne init	tial val	ue: 0	x0C0	$\leftarrow$	R/W	
		DA	TTBR2A									
		D9	TTBR29									
		D8	TTBR28									
		D7	TTBR27									
		D6	TTBR26									
		D5	TTBR25									
		D4	TTBR24									
		D3	TTBR23									
		D2	TTBR22									
		D1	TTBR21									
		D0	TTBR20									
G/A read signal	0048138	DF	A18AS	Area 18, 17 address strobe signal	1	Ena	bled	0	Disabled	0	R/W	
control register	(HW)	DE	A16AS	Area 16, 15 address strobe signal						0	R/W	
		DD	A14AS	Area 14, 13 address strobe signal						0	R/W	
		DC	A12AS	Area 12, 11 address strobe signal						0	R/W	1
		DB	-	reserved				-		0	-	0 when being read.
		DA	A8AS	Area 8, 7 address strobe signal	1	Ena	bled	0	Disabled	0	R/W	
		D9	A6AS	Area 6 address strobe signal						0	R/W	
		D8	A5AS	Area 5, 4 address strobe signal						0	R/W	
		D7	A18RD	Area 18, 17 read signal	1	Enal	bled	0	Disabled	0	R/W	
		D6	A16RD	Area 16, 15 read signal						0	R/W	
		D5	A14RD	Area 14, 13 read signal						0	R/W	
		D4	A12RD	Area 12, 11 read signal						0	R/W	
		D3	-	reserved				-		0	-	0 when being read.
		D2	A8RD	Area 8, 7 read signal	1	Enal	bled	0	Disabled	0	R/W	
		D1	A6RD	Area 6 read signal						0	R/W	
		D0	A5RD	Area 5, 4 read signal						0	R/W	
BCLK select	004813A	D7-4	-	reserved				-		0	-	0 when being read.
register	(B)	D3	A1X1MD	Area 1 access-speed	1	2 cy	cles	0	4 cycles	0	R/W	x2 speed mode only
		D2	-	reserved				-		0	-	0 when being read.
		D1	BCLKSEL1	BCLK output clock selection	BCL	LKSE	L[1:0]		BCLK	0	R/W	
		D0	BCLKSEL0		1	1 T	1	F	PLL_CLK	0		
					1	1	0	0	SC3_CLK			
					0	D	1	В	CU_CLK			
					0	o	0	С	PU_CLK			

Register name	Address	Bit	Name	Function		Set	ting	9	Init.	R/W	Remarks
16-bit timer 0	0048180	DF	CR0A15	16-bit timer 0 comparison data A		0 to 6	55	35	Х	R/W	
comparison	(HW)	DE	CR0A14	CR0A15 = MSB					х		
register A	. ,	DD	CR0A13	CR0A0 = LSB					х		
		DC	CR0A12						х		
		DB	CR0A11						х		
		DA	CR0A10						х		
		D9	CR0A9						х		
		D8	CR0A8						х		
		D7	CR0A7						х		
		D6	CR0A6						х		
		D5	CR0A5						х		
		D4	CR0A4						х		
		D3	CR0A3						Х		
		D2	CR0A2						х		
		D1	CR0A1						Х		
		D0	CR0A0						Х		
16-bit timer 0	0048182	DF	CR0B15	16-bit timer 0 comparison data B		0 to 6	55	35	Х	R/W	
comparison	(HW)	DE	CR0B14	CR0B15 = MSB					х		
register B		DD	CR0B13	CR0B0 = LSB					х		
		DC	CR0B12						Х		
		DB	CR0B11						Х		
		DA	CR0B10						Х		
		D9	CR0B9						Х		
		D8	CR0B8						Х		
		D7	CR0B7						Х		
		D6	CR0B6						Х		
		D5	CR0B5						Х		
		D4	CR0B4						Х		
		D3	CR0B3						Х		
		D2	CR0B2						X		
		D1	CR0B1						X		
		DU	CRUBU				_		X	_	
16-bit timer 0	0048184	DF	TC015	16-bit timer 0 counter data		0 to 6	55	35	X	R	
counter data	(HW)	DE	10014	1C015 = MSB					X		
register			10013	1C00 = LSB							
			TC012								
			TC010								
		DA	10010								
		D9	1009						Ŷ		
			1000						Ŷ		
		D6	TC06						x		
		D5	TC05						x		
		D4	TC04						x		
		D3	TC03						х		
		D2	TC02						х		
		D1	TC01						х		
		D0	TC00						х		
16-bit timer 0	0048186	D7	-	reserved		-	-		0	-	0 when being read.
control register	(B)	D6	SELFM0	16-bit timer 0 fine mode selection	1	Fine mode	0	Normal	0	R/W	
		D5	SELCRB0	16-bit timer 0 comparison buffer	1	Enabled	0	Disabled	0	R/W	
		D4	OUTINV0	16-bit timer 0 output inversion	1	Invert	0	Normal	0	R/W	
		D3	CKSL0	16-bit timer 0 input clock selection	1	External clock	0	Internal clock	0	R/W	
		D2	PTM0	16-bit timer 0 clock output control	1	On	0	Off	0	R/W	
		D1	PRESETO	16-bit timer 0 reset	1	Reset	0	Invalid	0	W	0 when being read.
		D0	PRUNO	16-bit timer 0 Run/Stop control	1	Run	0	Stop	0	R/W	

Register name	Address	Bit	Name	Function		Sett	ting	q	Init.	R/W	Remarks
16-bit timer 1	0048188	DF	CR1A15	16-bit timer 1 comparison data A		0 to 6	555	35	х	R/W	
comparison	(HW)	DE	CR1A14	CR1A15 = MSB					x		
register A	` '	DD	CR1A13	CR1A0 = LSB					х		
		DC	CR1A12						х		
		DB	CR1A11						х		
		DA	CR1A10						Х		
		D9	CR1A9						х		
		D8	CR1A8						Х		
		D7	CR1A7						Х		
		D6	CR1A6						Х		
		D5	CR1A5						Х		
		D4	CR1A4						Х		
		D3	CR1A3						Х		
		D2	CR1A2						Х		
		D1	CR1A1						X		
		D0	CR1A0						Х		
16-bit timer 1	004818A	DF	CR1B15	16-bit timer 1 comparison data B		0 to 6	655	35	Х	R/W	
comparison	(HW)	DE	CR1B14	CR1B15 = MSB					X		
register B		DD	CR1B13	CR1B0 = LSB					X		
		DC	CR1B12						X		
		DB	CR1B11						X		
		DA	CR1B10						X		
		D9	CRIB9								
			CR188								
			CR1B/						Ŷ		
		D5	CR1B5						x		
		D3	CR1B4						x		
		D3	CR1B3						x		
		D2	CR1B2						x		
		D1	CR1B1						x		
		D0	CR1B0						х		
16-bit timer 1	004818C	DF	TC115	16-bit timer 1 counter data		0 to 6	555	35	Х	R	
counter data	(HW)	DE	TC114	TC115 = MSB					х		
register	` '	DD	TC113	TC10 = LSB					х		
-		DC	TC112						х		
		DB	TC111						Х		
		DA	TC110						Х		
		D9	TC19						Х		
		D8	TC18						Х		
		D7	TC17						Х		
		D6	TC16						X		
		D5	TC15						X		
		D4	TC14						X		
		D3	TC13						X		
			TC12								
		DI	TC11								
	0040405	00							^		
16-bit timer 1	004818E	D7		reserved		-	-	N a second	0	-	0 when being read.
control register	(В)	D6	SELFINI	16-bit timer 1 fine mode selection	1	Fine mode	0	Normal	0	R/W	
		05		16-bit timer 1 output inversion	1		0	Normal	0	R/W	
		D4 D3	CKSI 1	16-bit timer 1 input clock selection		External clock	0	Internal clock	0	R/M	
		D2	PTM1	16-bit timer 1 clock output control	1	On	0	Off	0	R/W	
		D1	PRESET1	16-bit timer 1 reset	1	Reset	0	Invalid	0	W	0 when being read.
		D0	PRUN1	16-bit timer 1 Run/Stop control	1	Run	0	Stop	0	R/W	

Register name	Address	Bit	Name	Function		Sett	ting	9	Init.	R/W	Remarks
16-bit timer 2	0048190	DF	CR2A15	16-bit timer 2 comparison data A		0 to 6	655	35	Х	R/W	
comparison	(HW)	DE	CR2A14	CR2A15 = MSB					х		
register A		DD	CR2A13	CR2A0 = LSB					х		
		DC	CR2A12						х		
		DB	CR2A11						х		
		DA	CR2A10						х		
		D9	CR2A9						х		
		D8	CR2A8						Х		
		D7	CR2A7						Х		
		D6	CR2A6						Х		
		D5	CR2A5						Х		
		D4	CR2A4						Х		
		D3	CR2A3						Х		
		D2	CR2A2						Х		
		D1	CR2A1						X		
		D0	CR2A0						Х		
16-bit timer 2	0048192	DF	CR2B15	16-bit timer 2 comparison data B		0 to 6	655	35	Х	R/W	
comparison	(HW)	DE	CR2B14	CR2B15 = MSB					X		
register B		DD	CR2B13	CR2B0 = LSB					X		
		DC	CR2B12						X		
		DB	CR2B11						X		
		DA	CR2B10								
		D9	CR2D9						$\hat{\mathbf{v}}$		
			CP2B7						Ŷ		
		De	CR2B6						x		
		D5	CR2B5						x		
		D4	CR2B4						x		
		D3	CR2B3						x		
		D2	CR2B2						x		
		D1	CR2B1						х		
		D0	CR2B0						Х		
16-bit timer 2	0048194	DF	TC215	16-bit timer 2 counter data		0 to 6	655	35	Х	R	
counter data	(HW)	DE	TC214	TC215 = MSB					Х		
register		DD	TC213	TC20 = LSB					Х		
		DC	TC212						Х		
		DB	TC211						Х		
		DA	TC210						X		
		D9	TC29						X		
		D8	TC28						X		
			1627								
		D6	TC25						Ŷ		
		D3	TC24						x		
			TC23						x		
		D2	TC22						x		
		D1	TC21						х		
		D0	TC20						х		
16-bit timer 2	0048196	D7	-	reserved		-	_		0	-	0 when being read.
control register	(B)	D6	SELFM2	16-bit timer 2 fine mode selection	1	Fine mode	0	Normal	0	R/W	<u> </u>
_		D5	SELCRB2	16-bit timer 2 comparison buffer	1	Enabled	0	Disabled	0	R/W	
		D4	OUTINV2	16-bit timer 2 output inversion	1	Invert	0	Normal	0	R/W	
		D3	CKSL2	16-bit timer 2 input clock selection	1	External clock	0	Internal clock	0	R/W	
		D2	PTM2	16-bit timer 2 clock output control	1	On	0	Off	0	R/W	
		D1	PRESET2	16-bit timer 2 reset	1	Reset	0	Invalid	0	W	0 when being read.
		D0	PRUN2	16-bit timer 2 Run/Stop control	1	Run	0	Stop	0	R/W	

Register name	Address	Bit	Name	Function		Set	ting	9	Init.	R/W	Remarks
16-bit timer 3	0048198	DF	CR3A15	16-bit timer 3 comparison data A	Ē	0 to 6	655	35	Х	R/W	
comparison	(HW)	DE	CR3A14	CR3A15 = MSB					х		
register A	、 <i>´</i>	DD	CR3A13	CR3A0 = LSB					х		
Ū		DC	CR3A12						х		
		DB	CR3A11						х		
		DA	CR3A10						х		
		D9	CR3A9						х		
		D8	CR3A8						Х		
		D7	CR3A7						Х		
		D6	CR3A6						Х		
		D5	CR3A5						Х		
		D4	CR3A4						Х		
		D3	CR3A3						Х		
		D2	CR3A2						Х		
		D1	CR3A1						X		
		D0	CR3A0						Х		
16-bit timer 3	004819A	DF	CR3B15	16-bit timer 3 comparison data B		0 to 6	655	35	Х	R/W	
comparison	(HW)	DE	CR3B14	CR3B15 = MSB					X		
register B		DD	CR3B13	CR3B0 = LSB					X		
		DC	CR3B12						X		
		DB	CR3B11						X		
		DA	CR3B10						X		
		D9	CR3B9						X		
		Do	CR3Bo								
			CROBI								
		D0	CR3B5						Ŷ		
		D3	CR3B3						X		
		D3	CR3B3						X		
		D2	CR3B2						x		
		D1	CR3B1						X		
		D0	CR3B0						x		
16-bit timer 3	004819C	DF	TC315	16-bit timer 3 counter data		0 to 6	\$55	35	X	R	
counter data	(HW)	DE	TC314	TC315 = MSB				00	X	'`	
register	,	_ DD	TC313	TC30 = LSB					x		
		DC	TC312						х		
		DB	TC311						х		
		DA	TC310						х		
		D9	TC39						Х		
		D8	TC38						Х		
		D7	TC37						Х		
		D6	TC36						Х		
		D5	TC35						Х		
		D4	TC34						X		
		D3	TC33						X		
		D2	TC32						X		
		D1	TC31						X		
		DU	1030						X		
16-bit timer 3	004819E	D7	-	reserved		-	-		0	-	0 when being read.
control register	(B)	D6	SELFM3	16-bit timer 3 fine mode selection	1	Fine mode	0	Normal	0	R/W	
		D5	SELCRB3	16-bit timer 3 comparison buffer	1	Enabled	0	Disabled	0	R/W	
		D4	CKSL2	16-bit timer 3 output Inversion	1	Invert External clock	0	Internal clock	0	R/W	
		D3 D2	DTM2	16-bit timer 3 clock output control	1		0		0		
		D2 D1	PRESET3	16-bit timer 3 reset	1	Reset	0	Invalid	0	W	0 when being read
		D0	PRUN3	16-bit timer 3 Run/Stop control	1	Run	0	Stop	0	R/W	o when being read.

Register name	Address	Bit	Name	Function		Set	ting	9	Init.	R/W	Remarks
16-bit timer 4	00481A0	DF	CR4A15	16-bit timer 4 comparison data A		0 to 6	655	35	Х	R/W	
comparison	(HW)	DE	CR4A14	CR4A15 = MSB					х		
register A	. ,	DD	CR4A13	CR4A0 = LSB					х		
		DC	CR4A12						х		
		DB	CR4A11						х		
		DA	CR4A10						х		
		D9	CR4A9						х		
		D8	CR4A8						х		
		D7	CR4A7						х		
		D6	CR4A6						Х		
		D5	CR4A5						х		
		D4	CR4A4						х		
		D3	CR4A3						Х		
		D2	CR4A2						Х		
		D1	CR4A1						Х		
		D0	CR4A0						Х		
16-bit timer 4	00481A2	DF	CR4B15	16-bit timer 4 comparison data B		0 to 6	655	35	Х	R/W	
comparison	(HW)	DE	CR4B14	CR4B15 = MSB					Х		
register B		DD	CR4B13	CR4B0 = LSB					Х		
		DC	CR4B12						Х		
		DB	CR4B11						Х		
		DA	CR4B10						Х		
		D9	CR4B9						Х		
		D8	CR4B8						Х		
		D7	CR4B7						Х		
		D6	CR4B6						X		
		D5	CR4B5						Х		
		D4	CR4B4						Х		
		D3	CR4B3						X		
		D2	CR4B2						X		
			CR4B1								
	0040444			AC hittingen Alegensten dete		0.4- 0		05	×		
10-bit timer 4	00461A4 /LIM/		TC415			0 10 6	000	30	$\hat{\mathbf{v}}$	ĸ	
rogistor	(П₩)		TC414	TC40 = 1 SB					Ŷ		
register			TC413	1040 - LSD					Ŷ		
		DB	TC411						x		
			TC410						x		
			TC49						x		
		D8	TC48						x		
		D7	TC47						x		
		D6	TC46						x		
		D5	TC45						х		
		D4	TC44						х		
		D3	TC43						х		
		D2	TC42						х		
		D1	TC41						х		
		D0	TC40						Х		
16-bit timer 4	00481A6	D7	-	reserved		-	-		0	-	0 when being read.
control register	(B)	D6	SELFM4	16-bit timer 4 fine mode selection	1	Fine mode	0	Normal	0	R/W	
		D5	SELCRB4	16-bit timer 4 comparison buffer	1	Enabled	0	Disabled	0	R/W	
		D4	OUTINV4	16-bit timer 4 output inversion	1	Invert	0	Normal	0	R/W	
		D3	CKSL4	16-bit timer 4 input clock selection	1	External clock	0	Internal clock	0	R/W	
		D2	PTM4	16-bit timer 4 clock output control	1	On (	0	Off	0	R/W	
		U1	PRESET4	16-bit timer 4 reset	1	Reset	U	Invalid	0	W DAA'	U when being read.
1		D0	PRUN4	10-bit timer 4 Kun/Stop control	11	rkun	U	Stop	U	K/W	

Register name	Address	Bit	Name	Function		Set	ting	9	Init.	R/W	Remarks
16-bit timer 5	00481A8	DF	CR5A15	16-bit timer 5 comparison data A	Ē	0 to 6	555	35	Х	R/W	
comparison	(HW)	DE	CR5A14	CR5A15 = MSB					х		
register A	, ,	DD	CR5A13	CR5A0 = LSB					х		
Ū		DC	CR5A12						х		
		DB	CR5A11						х		
		DA	CR5A10						х		
		D9	CR5A9						Х		
		D8	CR5A8						Х		
		D7	CR5A7						Х		
		D6	CR5A6						Х		
		D5	CR5A5						Х		
		D4	CR5A4						Х		
		D3	CR5A3						Х		
		D2	CR5A2						Х		
		D1	CR5A1						X		
		D0	CR5A0						Х		
16-bit timer 5	00481AA	DF	CR5B15	16-bit timer 5 comparison data B		0 to 6	655	35	Х	R/W	
comparison	(HW)	DE	CR5B14	CR5B15 = MSB					X		
register B		DD	CR5B13	CR5B0 = LSB					X		
		DC	CR5B12						X		
		DB	CR5B11						X		
		DA	CR5B10						X		
		D9	CR5B9						X		
		D8	CR5B8								
			CROBI								
		D0	CR5B5						Ŷ		
		D3	CR5B4						X		
		D3	CR5B3						X		
		D2	CR5B2						x		
		D1	CR5B1						X		
		D0	CR5B0						x		
16-bit timer 5	00481AC	DF	TC515	16-bit timer 5 counter data		0 to 6	555	35	X	R	
counter data	(HW)	DE	TC514	TC515 = MSB			02	00	X	'`	
register	,	_ DD	TC513	TC50 = LSB					x		
		DC	TC512						х		
		DB	TC511						х		
		DA	TC510						х		
		D9	TC59						Х		
		D8	TC58						Х		
		D7	TC57						Х		
		D6	TC56						Х		
		D5	TC55						Х		
		D4	TC54						X		
		D3	TC53						X		
		D2	TC52						X		
		D1	TC51						X		
		D0	TC50						X		
16-bit timer 5	00481AE	D7	-	reserved		-	-		0	-	0 when being read.
control register	(B)	D6	SELFM5	16-bit timer 5 fine mode selection	1	Fine mode	0	Normal	0	R/W	
		D5	SELCRB5	16-bit timer 5 comparison buffer	1	Enabled	0	Disabled	0	R/W	
		D4	CKSLE	16-bit timer 5 output inversion	1	Invert External clock	0	Internal clock	0	R/W	
		D3	PTM5	16-bit timer 5 clock output control	1		0		0	R/W	
		D2 D1	PRESET5	16-bit timer 5 reset	1	Reset	0	Invalid	0	W	0 when being read
		D0	PRUN5	16-bit timer 5 Run/Stop control	1	Run	0	Stop	0	R/W	o whom boing road.

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